RENESAS

RAA215300

High Performance 9-Channel PMIC Supporting DDR Memory, with Built-In Charger and RTC

The RAA215300 is a high-performance, low-cost 9-channel PMIC designed for 32-bit and 64-bit MCU and MPU applications. It supports DDR3, DDR3L, DDR4, and LPDDR4 memory power requirements. The internally compensated regulators, built-in Real-Time Clock (RTC), 32kHz crystal oscillator, and coin cell battery charger provide a highly integrated, small footprint power solution ideal for System-On-Module (SOM) applications. A spread spectrum feature provides an ease-of-use solution for noise-sensitive audio or RF applications.

The RAA215300 has six high-efficiency buck regulators and three LDOs to provide a complete power system. The internal device registers and EEPROM can configure and optimize the RAA215300 for different application requirements, for example, power sequences, output voltages, and switching frequencies. Dynamic Voltage Scaling (DVS) and Sleep modes are supported.

The RAA215300 is available in an 8x8mm, 0.5mm pitch thermally enhanced 56-lead QFN package and is specified for operation across a -40°C to 105°C ambient and -40°C to 125°C junction temperature range.

Features

- Input operating voltage range: 2.7V to 5.5V
- 6 synchronous buck regulators (supporting 5A, 3.5A, 2x1.5A, 1A, 0.6A), with settable V_{OUT}
- 3 LDOs (supporting 2x300mA, 50mA), with bypass mode, and settable V_{OUT}
- Dedicated VTTREF for DDR memory
- Auto PFM/PWM, FPWM and ultrasonic modes, with selectable PWM $\rm f_{SW}$
- Built-in 32kHz crystal oscillator (with bypass), RTC, and coin cell/supercapacitor battery charger
- DVS and sleep modes
- Internally compensated
- Spread spectrum
- I²C serial interface (up to 1MHz)
- Pb-free (RoHS compliant)

Applications

- MCU/MPU/SoC consumer and industrial power
- FPGA system power
- Building/factory automation system power

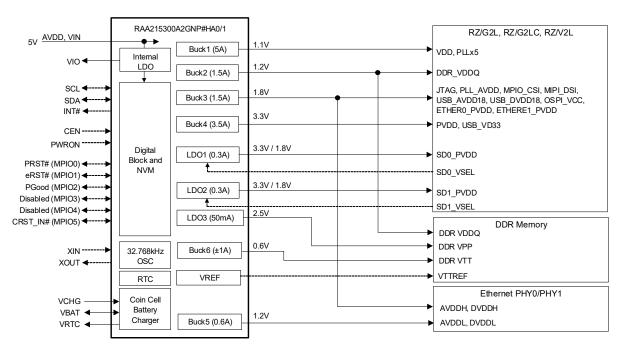


Figure 1. Typical Application Diagram - MPU Power (RZ/G2L, RZ/G2LC, RZ/V2L)



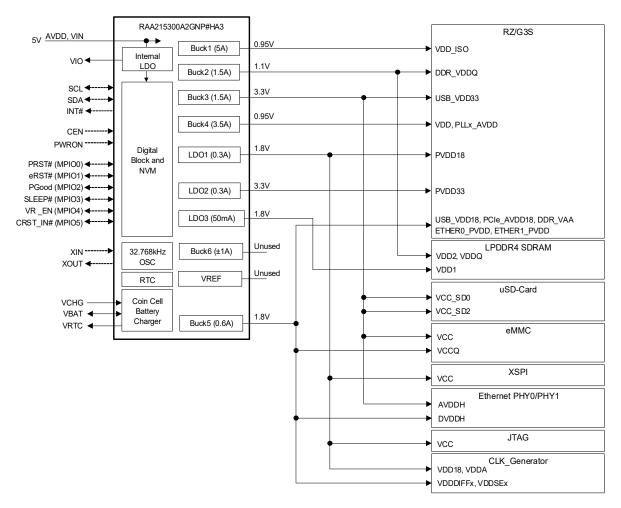
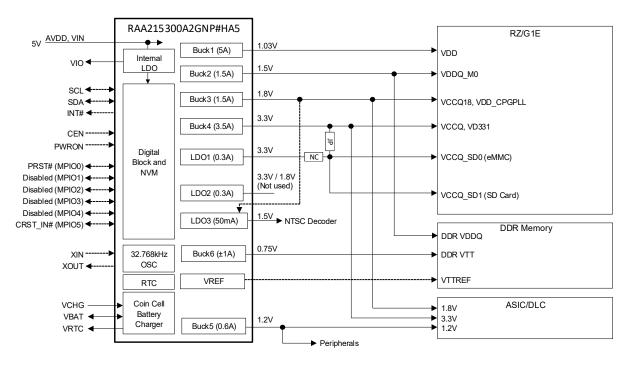


Figure 2. Typical Application Diagram - MPU Power(RZ/G3S)







Contents

1.	Over	riew	7
	1.1	Block Diagram	7
2.	Pin Ir	formation	3
	2.1	Pin Assignments	3
	2.2	Pin Descriptions	3
3.	Spec	fications	1
	3.1	Absolute Maximum Ratings	1
	3.2	Thermal Information	
	3.3	Recommended Operation Conditions	2
	3.4	Electrical Specifications	2
4.	Туріс	al Performance Graphs	3
5.	Seria	Interface	9
	5.1	I ² C General Operation	9
	0.1	5.1.1 Data Validity	
		5.1.2 START and STOP Condition	
		5.1.3 Byte Format	9
		5.1.4 Acknowledge (ACK)	9
		5.1.5 Not Acknowledge (NACK))
		5.1.6 Device Address and R/W Bit)
	5.2	Device Communication Protocol)
		5.2.1 7-bit Device Addresses	
		5.2.2 Register Size	
		5.2.3 I ² C Write Operation	
		5.2.4 I ² C Read Operation	
	5.0	5.2.5 I ² C Timing	
	5.3	Unimplemented Registers	
6.	Regis	ters and EEPROM	
	6.1	EEPROM	-
		6.1.1 Writing to the EEPROM	
		6.1.2 Recalling the EEPROM	
	6.2	EEPROM Error Correction	
		6.2.1 ECC Bank Detail Bits	
7.	Powe	r Supplies	
	7.1	Internal LDO (VIO)	
	7.2	VCHG, VBAT, and VRTC	5
8.	Oper	ating {States} and Transition Conditions	3
	8.1	{RESET}	3
	8.2	{READ_EE}	
	8.3	{WAIT_FOR_VIO}	
	8.4	{STANDBY}	
		8.4.1 {STANDBY_EXIT}	
		8.4.2 {STANDBY_TO_ACTIVE}	
	0 5	8.4.3 {ACTIVE_TO_STANDBY}	
	8.5	{ACTIVE}	C

	8.6	{IORES	ET}	37
		8.6.1	{IORESET_TO_ACTIVE}	37
	8.7	{SLEEP]	}	37
		8.7.1	{ACTIVE_TO_SLEEP}	37
		8.7.2	{SLEEP_TO_ACTIVE}	37
	8.8	{FAULT_	_OUT}	37
9.	Func	tional Bl	ocks and Application Information	39
	9.1	Chip Ena	able	39
	9.2	•	l	
	9.3	Multi Pu	rpose I/O	39
		9.3.1	Unused MPIOx Pin	40
		9.3.2	External VR PGOOD Input	40
		9.3.3	Input to I ² C Register	42
		9.3.4	PGOOD Output	42
		9.3.5	Reset Output	42
		9.3.6	External VR EN Output	42
		9.3.7	Output to I ² C Register	43
		9.3.8	32kHz Clock (32K_CLK)	
		9.3.9	SLEEP#	43
		9.3.10	WDT RST#	43
		9.3.11	CRST_IN#	44
		9.3.12	Alternative Decodes for MPIOx functions	45
	9.4	Watchdo	og Timer	45
	9.5	Power S	Sequencing	47
		9.5.1	Power-ON	47
		9.5.2	Power-OFF	47
	9.6	Warm ar	nd Cold Reset	50
	9.7	Output E	Discharge	51
	9.8	DVS		51
	9.9	Real-Tim	ne Clock	52
		9.9.1	Clock	52
		9.9.2	Alarm	53
		9.9.3	Frequency Output	53
		9.9.4	General Purpose User SRAM	54
		9.9.5	Power Control Operation	54
		9.9.6	Power Failure Detection	54
		9.9.7	Crystal Oscillator	54
		9.9.8	Using an External Clock	57
		9.9.9	Real-Time Clock Registers	57
	9.10	Coin Ce	ll Battery Charger	
		9.10.1	Supercapacitor Backup Time	
	9.11	Buck Re	gulators	
		9.11.1	Buck1	
		9.11.2	Buck2	
		9.11.3	Buck3	
		9.11.4	Buck4	
		9.11.5	Buck5	
		9.11.6	Buck6	
		9.11.7	Buck Operating Modes	63

			JItrasonic Mode	
			Jnused Buck	
			Switching Frequency	
			Spread Spectrum	
			Phase Synchronization	
	9.12	•	ulators	
			_DO1/2	
			_DO3	
			_DOx Bypass	
			Jnused LDOx	
	9.13			
			Jnused VTTREF	
			Startup	
	9.15		onitors, Warnings, and Protections	
			nput Voltage Monitor (AVDD Undervoltage Power Down)	
			Over-Temperature Warning and Protection	
			High Current Warning	
			Overvoltage and Undervoltage Protection	
	0.40		Fault and Status Monitoring	
			Recommended Power Dissipation	
10.	Exter	nal Comp	onent Selection	71
	10.1	•	ters	
		10.1.1 I	nductor Selection	71
			Output Capacitor Selection	
		• •	acitor Selection	
			ended External Components	
	10.4	Recomme	ended Effective Capacitance	74
11.	Layo	ut Guideli	nes	75
	11.1	Power Gr	ound (PGND)	75
	11.2	Analog G	round (AGND)	75
	11.3	Digital Gro	ound	75
	11.4	Exposed	Pad (EPAD)	75
	11.5	Buck Reg	ulators	75
	11.6		gulators (LDOs)	
	11.7	•	scillator	
	11.8	Device Sp	pecific Layout Guidelines	76
12.	Regis	ster Map		79
	12.1	Register N	Map Detail	79
13.			e Drawing	
14.	Part I	Number Di	ifferences	120
	14.1	RAA2153	00A2GNP#HA1	120
			Register Map Detail	
	14.2		00Å2GNP#HA3	
		14.2.1 F	Register Map Detail	120

	14.3	RAA21	5300A2GNP#HA5	 	 	. 131
		14.3.1	Register Map Detail	 	 	. 131
15.	Orde	ering Info	ormation	 	 	. 135
16.	Revi	sion His	tory	 	 	. 136



1. Overview

1.1 Block Diagram

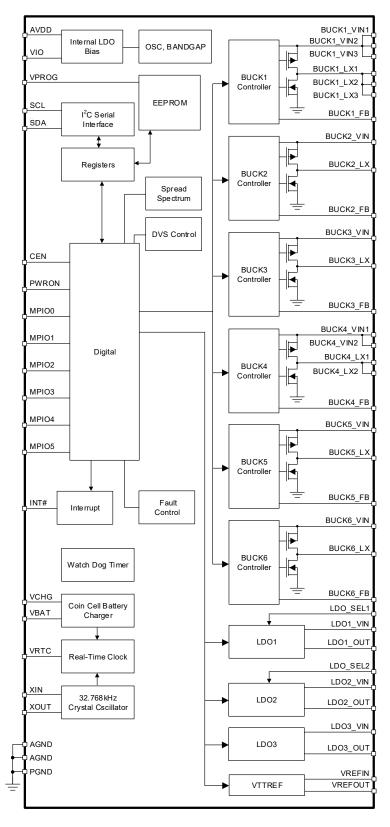
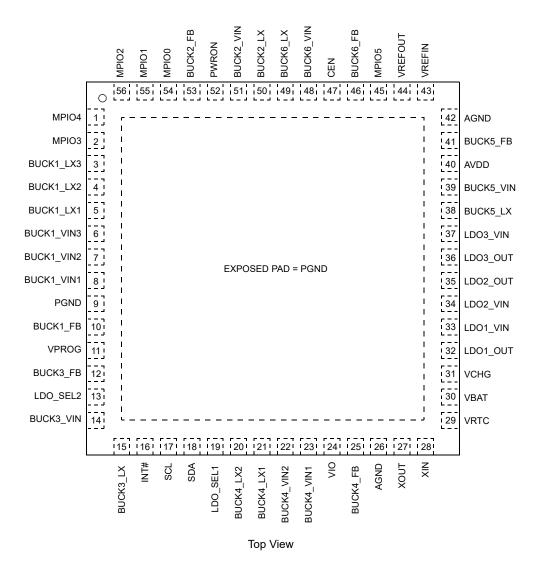


Figure 4. Block Diagram

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2. Pin Information

2.1 Pin Assignments



2.2 Pin Descriptions

Pin Number	Pin Name	Туре	Description
1	MPIO4 ^[1]	Input/Output	Multiple general purpose input-output 4
2	MPIO3 ^[1]	Input/Output	Multiple general purpose input-output 3
3	BUCK1_LX3	Output	Buck1 switch node
4	BUCK1_LX2	Output	Buck1 switch node
5	BUCK1_LX1	Output	Buck1 switch node
6	BUCK1_VIN3 ^[2]	Power	Buck1 supply
7	BUCK1_VIN2 ^[2]	Power	Buck1 supply
8	BUCK1_VIN1 ^[2]	Power	Buck1 supply
9	PGND	Ground	Power ground



Pin Number	Pin Name	Туре	Description
10	BUCK1_FB	Input	Buck1 feedback
11	VPROG	Power	High voltage supply input for EEPROM programming. Connect to ground in typical application.
12	BUCK3_FB	Input	Buck3 feedback
13	LDO_SEL2	Input	Logic input. Select LDO2 output voltage.
14	BUCK3_VIN ^[2]	Power	Buck3 supply
15	BUCK3_LX	Output	Buck3 switch node
16	INT#	Output	Interrupt output, open-drain, active low. It can also be configured as clock signal output in Frequency Output (FOUT) mode of the RTC.
17	SCL	Input	I ² C serial clock
18	SDA	Input/Output	Bidirectional I ² C serial data
19	LDO_SEL1	Input	Logic input. Select LDO1 output voltage.
20	BUCK4_LX2	Output	Buck4 switch node
21	BUCK4_LX1	Output	Buck4 switch node
22	BUCK4_VIN2 ^[2]	Power	Buck4 supply
23	BUCK4_VIN1 ^[2]	Power	Buck4 supply
24	VIO	Output	Internal 1.8V LDO output
25	BUCK4_FB	Input	Buck4 feedback
26, 42	AGND	Ground	Analog and digital ground
27	XOUT	Output	Crystal oscillator output. Connect to ground if not used.
28	XIN	Input	Crystal oscillator input. Connect to ground if not used.
29	VRTC	Power	Real-time clock (RTC) power supply. An output that provides power to the RTC and is generated internally from the higher of VBAT and VCHG.
30	VBAT	Power	Charger output to coin cell battery or supercapacitor, or RTC input supply when running from coin cell battery or supercapacitor. If not used, connect to GND.
31	VCHG	Power	Input Supply for VIO LDO, Coin cell battery charger and RTC input power. AVDD, VCHG, and BUCKx_VINx must be the same voltage.
32	LDO1_OUT	Output	LDO1 output
33	LDO1_VIN	Power	LDO1 supply
34	LDO2_VIN	Power	LDO2 supply
35	LDO2_OUT	Output	LDO2 output
36	LDO3_OUT	Output	LDO3 output
37	LDO3_VIN	Power	LDO3 supply
38	BUCK5_LX	Output	Buck5 switch node
39	BUCK5_VIN ^[2]	Power	Buck5 supply
40	AVDD	Power	Analog and digital supply. AVDD, VCHG, and BUCKx_VINx must be the same voltage.
41	BUCK5_FB	Input	Buck5 feedback
43	VREFIN	Input	Input to VTTREF block. <i>Note:</i> Pin has a 1M Ω (typical) internal resistor to GND.



Pin Number	Pin Name	Туре	Description
44	VREFOUT	Output	Output from VTTREF block, with value equal to (VREFIN/2). Used as reference for VTT.
45	MPIO5 ^[1]	Input/Output	Configurable multiple purpose input-output 5
46	BUCK6_FB	Input	Buck6 feedback
47	CEN	Input	Chip enable, active high
48	BUCK6_VIN ^[2]	Power	Buck6 supply
49	BUCK6_LX	Output	Buck6 switch node
50	BUCK2_LX	Output	Buck2 switch node
51	BUCK2_VIN ^[2]	Power	Buck2 supply
52	PWRON	Input	Regulator output enable
53	BUCK2_FB	Input	Buck2 feedback
54	MPIO0 ^[1]	Input/Output	Configurable multiple purpose input-output 0
55	MPIO1 ^[1]	Input/Output	Configurable multiple purpose input-output 1
56	MPIO2 ^[1]	Input/Output	Configurable multiple purpose input-output 2
-	EPAD	Ground	Exposed thermal pad. Power ground. All regulator PGNDs are internally downbonded to the EPAD.

1. See Multi Purpose I/O for pin function mapping.

2. All buck supplies (BUCKx_VINx) = AVDD = VCHG.



3. Specifications

3.1 Absolute Maximum Ratings

CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions can adversely impact product reliability and result in failures not covered by warranty.

Parameter	Minimum	Maximum	Unit
Initiage (to PGND unless otherwise stated) -0.3 6 V JCKx_VINx, AVDD, VCHG -0.3 6 V BAT -0.3 6 V JCKx_FB -0.3 6 V JCKx_LXx -0.3 6 V JCKx_LXx -0.3 6 V JCKx_LXx11 - 6.7 V GND, PGND -0.3 0.3 V PROG -0.3 24 V other pins -0.3 6 V uman Body Model (Tested per JS-001-2017) - ±2 kV			
BUCKx_VINx, AVDD, VCHG	-0.3	6	V
VBAT	-0.3	6	V
BUCKx_FB	-0.3	6	V
BUCKx_LXx	-0.3	6	V
BUCKx_LXx ^[1]	-	6.7	V
AGND, PGND	-0.3	0.3	V
VPROG	-0.3	24	V
All other pins	-0.3	6	V
Human Body Model (Tested per JS-001-2017)	-	±2	kV
Charged Device Model (Tested per JS-002-2018)	-	±500	V
Latch-Up (Tested per JESD78E; Class 2, Level A)	-	100	mA

1. ≤20ns duration

3.2 Thermal Information

Parameter	Package	Symbol	Conditions	Typical Value	Unit
Thermal Resistance	56LD, 8x8mm QFN	θ _{JA} [1]	Junction to air	23	°C/W
	Package	θ _{JC} ^[2]	Junction to case	0.7	°C/W

 θ_{JA} is measured in free air with the component mounted on a high-effective thermal conductivity test board with direct attach features. See TB379.

2. For θ_{JC} , the case temperature location is the center of the exposed metal pad on the package underside.

Parameter	Minimum	Maximum	Unit
Maximum Junction Temperature (T _J)	-	+150	°C
Maximum Storage Temperature Range (T _S)	-65	+150	°C
Pb-Free Reflow Profile		see TB493	



3.3 Recommended Operation Conditions

Voltages referred to PGND unless otherwise stated.

Parameter	Minimum	Maximum	Unit
Ambient Operating Temperature Range (T _A)	-40	+105	°C
Operating Junction Temperature (T _J)	-	+125	°C
BUCKx_VINx, AVDD, VCHG	2.7	5.5	V
VBAT	1.8	5.5	V
MPIOx	-	5	V
CEN, PWRON	-	5	V
VPROG	0	23	V
SCL, SDA	0	3.3	V

3.4 Electrical Specifications

Parameter	Symbol	Test Conditions ^[1]	Min ^[2]	Тур	Max ^[2]	Unit
Input Supply						
AVDD Input Operating Range	AVDD _{OP}	AVDD = VCHG = BUCKx_VINx	2.7	5	5.5	V
BUCK Input Operating Range	BUCK _{OP}	BUCKx_VINx	2.7	5	5.5	V
LDO Input Operating Range	LDO _{OP}	LDOx_VIN	2.7	3.3	5.5	V
VCHG Input Operating Range	VCHG _{OP}	AVDD = VCHG = BUCKx_VINx	2.7	5	5.5	V
VCHG Falling Slew Rate ^[3]	VCHG _{FALL}	To ensure POR operation of RTC do not exceed the maximum falling slew rate. AVDD = VCHG = BUCKx_VINx	-	-	5	V/ms
	AVDD _{UVLO_R}	Rising threshold	-	2.3	-	V
AVDD Undervoltage	AVDD _{UVLO_F}	Falling threshold	-	2.1	-	V
Lockout Threshold	AVDD _{UVLO_HYS}	AVDD _{UVLO_HYS} = AVDD _{UVLO_R} - AVDD _{UVLO_F}	-	200	-	mV
AVDD Undervoltage		Falling AVDD, 2.7V setting	-	2.7	-	
Power Down	AVDD _{UVPD_F}	Falling AVDD, 3.0V setting	-	3.0	-	V
Threshold		Falling AVDD, 4.25V setting	-	4.25	-	
AVDD Undervoltage Power Down Threshold Accuracy	AVDD _{UVPD_ACC}	Falling AVDD	-3		3	%
AVDD Undervoltage Power Down Threshold Hysteresis	AVDD _{UVPD_HYS}	AVDD _{UVPD_HYS} = AVDD _{UVPD_R} - AVDD _{UVPD_F}	-	100	-	mV



Parameter	Symbol	Test Conditions ^[1]	Min ^[2]	Тур	Max ^[2]	Unit
AVDD UVPD Delay	AVDD _{UVPD_DLY}	Falling AVDD	-	100	-	μs
Operating Bias Curren	t					
{SHUTDOWN} Supply Current	I _{SHDN_AVDD}	Current into AVDD, CEN = LOW, $T_A = 25^{\circ}C$	-	<1	7	μA
{SHUTDOWN} Supply Current	I _{SHDN_VCHG}	Current into VCHG, VBAT < VCHG CEN = LOW, T _A = 25°C	-	400	950	nA
RTC Battery Supply Current	I _{BAT}	VBAT = 3V, AVDD = VCHG = 0V. RTC is enabled in 0x6C[6]. Internal oscillator is enabled in 0x07[6] with external crystal.	-	400	950	nA
		VBAT = 3V, Shipping mode (RTC is disabled in 0x6C[6])	-	120	320	
{STANDBY} Supply Current	I _{OP_STANDY}	Total input current. CEN = HIGH, AVDD > UVLO, PWRON = LOW. RTC off.	-	360	470	μA
{ACTIVE} Supply Current	I _{OP_ACTIVE}	Total input current. CEN = HIGH, AVDD > UVLO, PWRON = HIGH All bucks enabled, auto PFM/PWM mode, no load, not switching. All LDOs enabled, no load. RTC on. I ² C on and idle, MPIOx static.	-	3.2	4.8	mA
RTC State Supply Current	I _{OP_RTC}	Total input current, VBAT. VBAT = 3.3V, BUCKx_VINx = AVDD = VCHG = 0V, RTC is enabled and clocking, FOUT is enabled at INT#	-	-	5	μA
VIO LDO						
VIO LDO Output Voltage	VIO _{OUT}	Not in dropout, no external loading	1.62	1.8	1.96	V
VIO LDO Current Capability	VIO _{IOUT_RNG}	Additional external loading ^[4]	-	20	-	mA
VIO LDO Current Limit	VIO _{ILIM}	VIO = 90% * VIO _{OUT}	24	-	41	mA
VIO Load Transient Response	VIO _{LOAD_TR}	Step: 0 to 20mA in 1µs Step: 20mA to 0 in 1µs	-3	-	3	%
VIO LDO Power-Good Rising Threshold	VIO _{PGOOD_Rise}	VIO rising. Percentage of VIO _{OUT}	-10	-5	-2	%
VIO LDO Power-Good Falling Threshold	VIO _{PGOOD_Fall}	VIO falling. Percentage of VIO _{OUT}	-15	-10	-7	%
VIO LDO Power-Good Threshold Hysteresis	VIO _{PGOOD_HYS}	VIO _{PGOOD_HYS} = VIO _{PGOOD_Rise} - VIO _{PGOOD_Fall}	-	5	-	%



Parameter	Symbol	Test Conditions ^[1]	Min ^[2]	Тур	Max ^[2]	Unit
EEPROM				1	1	
EEPROM Endurance	EE _{ENDR}	Programming cycles	1000	-	-	Cycles
Loading EEPROM Data to Registers at Power-On	t _{EE_LOAD}	AVDD valid. CEN = HIGH	-	-	10	ms
EEPROM Programming Cycle Time	^t EE_WRITE	Total time for writing customer banks	-	216	238	ms
BUCK1 (5A) Components as describ	ed in Recommended	External Components. Additional application	n details in	Buck1.		
Buck1 Output Voltage Target Resolution	BK1 _{RES}			4		bits
Buck1 Output Voltage Range	BK1 _{OUT}	BUCK1_FB	0.8		1.5	V
Buck1 Output Voltage Step	BK1 _{STEP}	BUCK1_FB	-	50	-	mV
Buck1 Output Voltage DC Accuracy	BK1 _{ACC}	BUCK1_FB. PWM operation, I _{OUT} = 5mA, V _{OUT} = 1.1V	-1		1	%
Buck1 Output Voltage Ripple FPWM	BK1 _{RIP_FPWM}	I _{OUT} = 100mA, FPWM mode	-	10	-	mV _{P-P}
Buck1 Maximum Output Current Capability ^[5]	BK1 _{IOUT_MAX}	-	5	-	-	А
Buck1 Output Load Regulation	BK1 _{LOAD_REG}	FPWM, VOUT = 1.1V, Over I _{OUT} = 100mA to 5A range	-	±0.1	-	%
Buck1 Output Line Regulation	BK1 _{LINE_REG}	FPWM, BUCK1_VINx = $4.5V \leftrightarrow 5.5V$, VOUT = $1.1V$, $I_{OUT} = BK1_{IOUT_MAX}$	-	±0.1	-	%
Buck1 Peak Efficiency	BK1 _{EFF}	Peak efficiency, L = default, BK1 _{FSW} set to default ^[7] , maximum V _{OUT}	-	92	-	%
		BUCK1_FB. Slow setting enabled	35	50	65	Ω
Buck1 Discharge Resistance	BK1 _{RDCHG}	BUCK1_FB. Medium setting enabled	26	37.5	49	Ω
		BUCK1_FB. Fast setting enabled	17.5	25	32.5	Ω
Buck1 High-Side MOSFET Current Limit	BK1 _{ILIM_HS}	PWM operation, sourcing (supplying)	6.1	7	7.7	А
MOSFET Current	BK1 _{ILIM_LS}	PWM operation, sourcing (supplying)	-	7.5	-	
	BK1 _{ILIMNEG}	FPWM mode, sinking (receiving)	-	-0.7	-	A



Parameter	Symbol	Test Conditions ^[1]	Min ^[2]	Тур	Max ^[2]	Unit
			3.6	4.6	5.6	
Buck1 High-Side Overcurrent Warning	DK4	Desister estteble velves ^[5]	4.4	5.4	6.4	
Threshold Range	BK1 _{IHC}	Register settable values ^[5]	4.7	5.7	6.7	A
			5.1	6.1	7.1	
Buck1 High-Side Overcurrent Warning Threshold Accuracy	BK1 _{IHC_ACC}	default BK1 _{IHC} setting	-1	-	1	A
Buck1 PWM Switching Frequency	BK1 _{FSW}	FPWM mode, 1.11MHz (default) setting	-	1.11	-	MHz
Buck1 PWM Switching Frequency Accuracy	BK1 _{FSW_ACC}	FPWM mode, I _{OUT} = 0mA, default frequency	-10	-	10	%
Buck1 Soft-Start Slew Rate Range	BK1 _{SS_SR_RNG}	BUCK1_FB	0.5	1	4	ms
Buck1 Shutdown Slew Rate Range	BK1 _{SHTDN_} sr_rng	BUCK1_FB	0.5	1	4	ms
Buck1 DVS Slew Rate Range	BK1 _{DVS_SR_RNG}	BUCK1_FB. Applies to both DVS up and down ramps.	2	8	16	mV/µs
Buck1 High-Side PMOS On-resistance	BK1 _{RDSON_HS}	BUCK1_VINx to BUCK1_LXx, I _{LX} = -150mA	-	40	-	mΩ
Buck1 Low-Side NMOS On-Resistance	BK1 _{RDSON_LS}	BUCK1_LXx to PGND, I _{LX} = 150mA	-	28	-	mΩ
BUCK2 (1.5A) Components as describ	ed in Recommended E	External Components. Additional application	on details in	Buck2.		
Buck2 Output Voltage Target Resolution	BK2 _{RES}	-		4		bits
Buck2 Output Voltage Range	BK2 _{OUT}	BUCK2_FB	1.1	-	1.85	V
Buck2 Output Voltage Step	BK2 _{STEP}	BUCK2_FB	-	50	-	mV
Buck2 Output Voltage DC Accuracy	BK2 _{ACC}	BUCK2_FB. PWM operation, I _{OUT} = 5mA, V _{OUT} = 1.2V	-1	-	1	%
Buck2 Output Voltage Ripple FPWM	BK2 _{RIP_FPWM}	I _{OUT} = 100mA, FPWM mode	-	10	-	mV _{P-P}
Buck2 Maximum Output Current Capability ^[5]	BK2 _{IOUT_MAX}	-	1.5	-	-	A
Buck2 Output Load Regulation	BK2 _{LOAD_REG}	FPWM, VOUT = 1.2V, Over I _{OUT} = 100mA to 1.5A range	-	±0.15	-	%
Buck2 Output Line Regulation	BK2 _{LINE_REG}	BUCK2_VINx = 4.5V \leftrightarrow 5.5V, VOUT = 1.2V, $I_{OUT} = BK2_{IOUT_MAX}$	-	±0.15	-	%



Parameter	Symbol	Test Conditions ^[1]	Min ^[2]	Тур	Max ^[2]	Unit
Buck2 Peak Efficiency	BK2 _{EFF}	Peak efficiency, L = default, BK2 _{FSW} set to default ^[7] , maximum V _{OUT}	-	90	-	%
		BUCK2_FB. Slow setting	35	50	65	
Buck2 Discharge Resistance	BK2 _{RDCHG}	BUCK2_FB. Medium setting	26	37.5	49	Ω
		BUCK2_FB. Fast setting	17.5	25	32.5	
Buck2 High-Side MOSFET Current Limit	BK2 _{ILIM_HS}	PWM operation, sourcing (supplying)	2.27	2.5	2.78	A
Buck2 Low-Side	BK2 _{ILIM_LS}	PWM operation, sourcing (supplying)	-	3	-	A
MOSFET Current Limit	BK2 _{ILIMNEG}	FPWM mode, sinking (receiving)	-	-0.66	-	А
Buck2 PWM Switching Frequency	BK2 _{FSW}	FPWM mode, 0.769MHz (default) setting	-	0.769	-	MHz
Buck2 PWM Switching Frequency Accuracy	BK2 _{FSW_ACC}	FPWM mode, I _{OUT} = 0mA, default frequency	-10	-	10	%
Buck2 Soft-start Slew Rate Range	BK2 _{SS_SR_RNG}	BUCK2_FB	0.5	1	4	ms
Buck2 Shutdown Slew Rate Range	BK2 _{SHTDN_} SR_RNG	BUCK2_FB	0.5	1	4	ms
Buck2 DVS Slew Rate Range	BK2 _{DVS_SR_RNG}	BUCK2_FB. Applies to both DVS up and down ramps.	2	8	16	mV/µs
Buck2 High-Side PMOS On-Resistance	BK2 _{RDSON_HS}	BUCK2_VINx to BUCK2_LXx, I _{LX} = -150mA	-	120	-	mΩ
Buck2 Low-Side NMOS On-Resistance	BK2 _{RDSON_LS}	BUCK2_LXx to PGND, I _{LX} = 150mA	-	70	-	mΩ
BUCK3 (1.5A) Components as describe	ed in Recommended E	external Components. Additional application	on details in	Buck3.		
Buck3 Output Voltage Target Resolution	BK3 _{RES}			4		bits
Buck3 Output Voltage Range	BK3 _{OUT}	BUCK3_FB	1.8	-	3.3	V
Buck3 Output Voltage Step	BK3 _{STEP}	BUCK3_FB	-	100	-	mV
Buck3 Output Voltage DC Accuracy	BK3 _{ACC}	BUCK3_FB. PWM operation, I _{OUT} = 5mA, V _{OUT} = 1.8V	-1	-	1	%
Buck3 Output Voltage Ripple FPWM	BK3 _{RIP_FPWM}	I _{OUT} = 100mA, FPWM mode	-	10	-	mV _{P-P}
Buck3 Maximum Output Current Capability ^[5]	BK3 _{IOUT_MAX}		1.5	-	-	A

Capability^[5]



Parameter	Symbol	Test Conditions ^[1]	Min ^[2]	Тур	Max ^[2]	Unit
Buck3 Output Load Regulation	BK3 _{LOAD_REG}	FPWM, VOUT = 1.8V, Over I _{OUT} = 100mA to 1.5A range	-	±0.1	-	%
Buck3 Output Line Regulation	BK3 _{LINE_REG}	BUCK3_VINx = $4.5V \leftrightarrow 5.5V$, VOUT = $1.8V$, $I_{OUT} = BK3_{IOUT_MAX}$	-	±0.1	-	%
Buck3 Peak Efficiency	BK3 _{EFF}	Peak efficiency, L = default, BK3 _{FSW} set to default ^[7] , maximum V _{OUT}	-	92	-	%
		BUCK3_FB. Slow setting	35	50	75	
Buck3 Discharge Resistance	BK3 _{RDCHG}	BUCK3_FB. Medium setting	26	37.5	49	Ω
		BUCK3_FB. Fast setting	17.5	25	32.5	
Buck3 High-Side MOSFET Current Limit	BK3 _{ILIM_HS}	PWM mode, sourcing (supplying)	2.12	2.5	3	A
Buck3 Low-Side	BK3 _{ILIM_LS}	PWM operation, sourcing (supplying)	-	3	-	_
MOSFET Current Limit	BK3 _{ILIMNEG}	FPWM mode, sinking (receiving)	-	-0.55	-	A
Buck3 PWM Switching Frequency	BK3 _{FSW}	FPWM mode, 1.54MHz (default) setting	-	1.54	-	MHz
Buck3 PWM Switching Frequency Accuracy	BK3 _{FSW_ACC}	FPWM mode, I _{OUT} = 0mA, default frequency	-10	-	10	%
Buck3 Soft-Start Slew Rate Range	BK3 _{SS_SR_RNG}	BUCK3_FB	0.5	1	4	ms
Buck3 Shutdown Slew Rate Range	BK3 _{SHTDN_} SR_RNG	BUCK3_FB	0.5	1	4	ms
Buck3 DVS Slew Rate Range	BK3 _{DVS_SR_RNG}	BUCK3_FB. Applies to both DVS up and down ramps.	2	8	16	mV/µs
Buck3 High-Side PMOS On-Resistance	BK3 _{RDSON_HS}	BUCK3_VINx to BUCK3_LXx, I _{LX} = -150mA	-	93	-	mΩ
Buck3 Low-Side NMOS On-Resistance	BK3 _{RDSON_LS}	BUCK3_LXx to PGND, I _{LX} = 150mA	-	57	-	mΩ
BUCK4 (3.5A) Components as describe	ed in Recommended E	External Components. Additional application	on details in	Buck4		
Buck4 Output Voltage Target Resolution	BK4 _{RES}			4		bits
Buck4 Output Voltage Range	BK4 _{OUT}	BUCK4_FB 0.8V, 0.85V, 0.9V, 0.95V, 1V, 1.05V, 1.1V, 1.15V, 1.2V, 1.5V, 1.6V 1.8V, 1.85V, 2.2V, 2.5V and 3.3V	0.8	-	3.3	V



Parameter	Symbol	Test Conditions ^[1]	Min ^[2]	Тур	Max ^[2]	Unit
		BUCK4_FB. PWM operation, $I_{OUT} = 5mA$, $V_{OUT} = 3.3V^{[6]}$	-1	-	1	%
Buck4 Output Voltage DC Accuracy	BK4 _{ACC}	BUCK4_FB. PWM operation, $I_{OUT} = 5mA$, $V_{OUT} = 0.95V$ (Only applicable to RAA215300A2GNP#HA3)	-2.5	-	2.5	%
Buck4 Output Voltage Ripple FPWM	BK4 _{RIP_FPWM}	I _{OUT} = 100mA, FPWM mode	-	15	-	mV _{P-P}
Buck4 Maximum Output Current Capability ^[5]	BK4 _{IOUT_MAX}	-	3.5	-	-	A
Buck4 Output Load Regulation	BK4 _{LOAD_REG}	FPWM, VOUT = 3.3V, Over I _{OUT} = 100mA to 3.5A range	-	±0.1	-	%
Buck4 Output Line Regulation	BK4 _{LINE_REG_3V3}	BUCK4_VINx = $4.5V \leftrightarrow 5.5V$, VOUT = $3.3V$, $I_{OUT} = BK4_{IOUT_MAX}$	-	±0.1	-	%
Buck4 Peak Efficiency	BK4 _{EFF}	Peak efficiency, L = default, BK4 _{FSW} set to default ^[7] , maximum V _{OUT}	-	95	-	%
		BUCK4_FB. Slow setting	35	50	65	
Buck4 Discharge Resistance	BK4 _{RDCHG}	BUCK4_FB. Medium setting	26	37.5	49	Ω
		BUCK4_FB. Fast setting	17.5	25	32.5	
Buck4 High-Side MOSFET Current Limit	BK4 _{ILIM_HS}	PWM operation, sourcing (supplying)	4	4.5	5	A
Buck4 Low-Side	BK4 _{ILIM_LS}	PWM operation, sourcing (supplying)	-	5	-	
MOSFET Current	BK4 _{ILIMNEG}	FPWM mode, sinking (receiving)	-	-0.675	-	A
Buck4 PWM Switching Frequency	BK4 _{FSW}	FPWM mode, 1.54MHz (default) setting	-	1.54	-	MHz
Buck4 PWM Switching Frequency Accuracy	BK4 _{FSW_ACC}	FPWM mode, I _{OUT} = 0mA, default frequency	-10	-	10	%
Buck4 Soft-Start Slew Rate Range	BK4 _{SS_SR_RNG}	BUCK4_FB	0.5	1	4	ms
Buck4 Shutdown Slew Rate Range	BK4 _{SHTDN_} SR_RNG	BUCK4_FB	0.5	1	4	ms
Buck4 DVS Slew Rate Range	BK4 _{DVS_SR_RNG}	BUCK4_FB. Applies to both DVS up and down ramps.	2	8	16	mV/µs
Buck4 High-Side PMOS On-Resistance	BK4 _{RDSON_HS}	BUCK4_VINx to BUCK4_LXx, I _{LX} = -150mA	-	60	-	mΩ
Buck4 Low-Side NMOS On-Resistance	BK4 _{RDSON_LS}	BUCK4_LXx to PGND, I _{LX} = 150mA	-	30	-	mΩ
			-			•



Parameter	Symbol	Test Conditions ^[1]	Min ^[2]	Тур	Max ^[2]	Unit
BUCK5 (0.6A)						
Components as describ	ed in Recommended E	xternal Components. Additional applicatio	on details in	Buck5.		1
Buck5 Output Voltage Target Resolution	BK5 _{RES}	-		3		bits
Buck5 Output Voltage Range	BK5 _{OUT}	BUCK5_FB	1.2	-	3.3	V
Buck5 Output Voltage DC Accuracy	BK5 _{ACC}	BUCK5_FB. PWM operation, I _{OUT} = 5mA, V _{OUT} = 1.8V	-1	-	1	%
Buck5 Output Voltage Ripple FPWM	BK5 _{RIP_FPWM}	I _{OUT} = 100mA, FPWM mode	-	15	-	mV _{P-P}
Buck5 Maximum Output Current Capability ^[5]	BK5 _{IOUT_MAX}	-	0.6	-	-	A
Buck5 Output Load Regulation	BK5 _{LOAD_REG}	FPWM, VOUT = 1.2V, Over I _{OUT} = 100mA to 600mA range	-	±0.1	-	%
Buck5 Output Line Regulation	BK5 _{LINE_REG}	BUCK5_VINx = $4.5V \leftrightarrow 5.5V$, VOUT = $1.2V$, $I_{OUT} = BK5_{IOUT_MAX}$	-	±0.1	-	%
Buck5 Peak Efficiency	BK5 _{EFF}	Peak efficiency, L = default, BK5 _{FSW} set to default ^[7] , maximum V _{OUT}	-	94	-	%
		BUCK5_FB. Slow setting	35	50	65	
Buck5 Discharge Resistance	BK5 _{RDCHG}	BUCK5_FB. Medium setting	26	37.5	49	Ω
		BUCK5_FB. Fast setting	17.5	25	32.5	
Buck5 High-Side MOSFET Current Limit	BK5 _{ILIM_HS}	PWM operation, sourcing (supplying)	0.9	1	1.1	A
Buck5 Low-Side	BK5 _{ILIM_LS}	PWM operation, sourcing (supplying)	-	1.4	-	
MOSFET Current Limit	BK5 _{ILIMNEG}	FPWM mode, sinking (receiving)	-	-0.55	-	A
Buck5 PWM Switching Frequency	BK5 _{FSW}	FPWM mode, 1.54MHz (default) setting	-	1.54	-	MHz
Buck5 PWM Switching Frequency Accuracy	BK5 _{FSW_ACC}	FPWM mode, I _{OUT} = 0mA, default frequency	-10	-	10	%
Buck5 Soft-start Slew Rate Range	BK5 _{SS_SR_RNG}	BUCK5_FB	0.5	1	4	ms
Buck5 Shutdown Slew Rate Range	BK5 _{SHTDN_} SR_RNG	BUCK5_FB	0.5	1	4	ms
Buck5 DVS Slew Rate Range	BK5 _{DVS_SR_RNG}	BUCK5_FB. Applies to both DVS up and down ramps.	2	8	16	mV/µs
Buck5 High-Side PMOS On-Resistance	BK5 _{RDSON_HS}	BUCK5_VINx to BUCK5_LXx, I _{LX} = -150mA	-	220	-	mΩ



Parameter	Symbol	Test Conditions ^[1]	Min ^[2]	Тур	Max ^[2]	Unit
Buck5 Low-Side NMOS On-Resistance	BK5 _{RDSON_LS}	BUCK5_LXx to PGND, $I_{LX} = 150$ mA	-	105	-	mΩ
BUCK6 (±1A) VTT Mode. Components	as described in Reco	mmended External Components. Addition	al applicati	on details ir	n Buck6.	
Buck6 Output Voltage VTT Mode	BK6 _{OUT_VTT}	BUCK6_FB. DDR JEDEC spec. DDR VTT output	-	VREF OUT	-	V
Buck6 Output Voltage DC Accuracy	BK6 _{ACC}	BUCK6_FB. FPWM mode, I _{OUT} = 5mA, V _{OUT} = 1.8V	-1	-	1	%
Buck6 Output Total Accuracy VTT Mode	BK6 _{ACC_TOT}	BUCK6_FB.DC + Ripple + Transient. FPWM mode, over line/load/temp. VOUT = $0.6V$ I_{OUT} -1A \rightarrow +1A at 2.5A/µs	-30	-	30	mV
Buck6 Output Voltage Ripple FPWM	BK6 _{RIP_FPWM}	I _{OUT} = 100mA, FPWM mode	-	30	-	mV _{P-P}
Buck6 Maximum Output Current BK6 _{IOI} Capability ^[5]	DIKO	VTT mode. Source (supply) current for DDR VTT	1	-	-	А
	BK6 _{IOUT_MAX}	VTT mode. Sink (receive) current from DDR VTT	1	-	-	А
Buck6 Output Load Regulation	BK6 _{LOAD_REG}	FPWM, VOUT = 0.6V, Over I _{OUT} = 100mA to 1A range	-	±0.1	-	%
Buck6 Output Line Regulation	BK6 _{LINE_REG}	BUCK6_VINx = $4.5V \leftrightarrow 5.5V$, VOUT = $0.6V$, $I_{OUT} = BK6_{IOUT_MAX}$	-	±0.1	-	%
Buck6 Peak Efficiency	BK6 _{EFF}	Peak efficiency, L = default, BK6 _{FSW} set to default ^[7] , FPWM mode, VOUT = 0.6V	-	76	-	%
		BUCK6_FB. Slow setting	35	50	65	
Buck6 Discharge Resistance	BK6 _{RDCHG}	BUCK6_FB. Medium setting	26	37.5	49	Ω
		BUCK6_FB. Fast setting	17.5	25	32.5	
Buck6 High-Side MOSFET Current Limit	BK6 _{ILIM_HS}	FPWM mode, sourcing (supplying), VTTREF_EN = 1	2.4	2.75	3.2	A
Buck6 Low-Side	BK6 _{ILIM_LS}	FPWM mode, sourcing (supplying), VTTREF_EN = 1	-	3.25	-	
MOSFET Current	BK6 _{ILIMNEG}	FPWM mode, sinking (receiving), VTTREF_EN = 1	-	-2.3	-	A
Buck6 PWM Switching Frequency	BK6 _{FSW}	FPWM mode, 0.667MHz (default) setting	-	0.667	-	MHz
Buck6 PWM Switching Frequency Accuracy	BK6 _{FSW_ACC}	FPWM mode, I _{OUT} = 0mA, default frequency	-10	-	10	%
Buck6 Soft-start Slew Rate Range	BK6 _{SS_SR_RNG}	BUCK6_FB	0.5	1	4	ms



Parameter	Symbol	Test Conditions ^[1]	Min ^[2]	Тур	Max ^[2]	Unit
Buck6 Shutdown Slew Rate Range	BK6 _{SHTDN} _ SR_RNG	BUCK6_FB	0.5	1	4	ms
Buck6 DVS Slew Rate Range	BK6 _{DVS_SR_RNG}	BUCK6_FB. Applies to both DVS up and down ramps.	2	8	16	mV/µs
Buck6 High-Side PMOS On-Resistance	BK6 _{RDSON_HS}	BUCK6_VINx to BUCK6_LXx, I _{LX} = -150mA	-	125	-	mΩ
Buck6 Low-Side NMOS On-Resistance	BK6 _{RDSON_LS}	BUCK6_LXx to PGND, I _{LX} = 150mA	-	75	-	mΩ
LDO1 and LDO2 (300m Components as describe		ixternal Components. Additional applicatio	on details in	LDO1/2.		•
LDO12 Output Voltage Range	LDO12 _{OUT}	LDO1_OUT, LDO2_OUT 0.8V, 0.9V,1.2V, 1.5V, 1.8V, 2.5V, 3.0V, 3.3V	0.8	-	3.3	V
LDO12 Output Voltage DC Accuracy	LDO12 _{ACC_H}	I _{OUT} = 1mA and 300mA LDO _{OUT} = 2.5V to 3.3V	-3	-	3	
	LDO12 _{ACC_M}	I _{OUT} = 1mA and 300mA LDO _{OUT} = 1.5V to 1.8V	-4	-	4	%
	LDO12 _{ACC_L}	I _{OUT} = 1mA and 300mA LDO _{OUT} = 0.8V to 1.2V	-5	-	5	
LDO12 Maximum Output Current Capability	LDO12 _{IOUT}	LDO1_OUT, LDO2_OUT. External load, sourcing (supplying)	300	-	-	mA
LDO12 Output Current Limit	LDO12 _{ILIM}	LDOx_OUT = 10% below regulation target (less positive voltage). LDO1/2 is not expected to operate at this current level continuously.	-	500	-	mA
		Rising threshold is a percentage of the programmed LDO output voltage	-15	-10	-5	
LDO12 Power-Good	LDO12 _{PGOOD}	Falling threshold is a percentage of the programmed LDO output voltage	-21	-15	-10	%
		Hysteresis	4	5	6	
LDO12 Load Transient	LDO12 _{LOAD}	Step: $60mA \rightarrow 240mA$ in $1A/\mu s$ Step: $240mA \rightarrow 60mA$ in $1A/\mu s$	-3	-	3	%
		VOUT = 2.5V to 3.3V range, I _{OUT} = 1mA to 300mA ^[5]	-1	-	1	
LDO12 Load Regulation	LDO12 _{LOAD_REG}	VOUT = 1.8V, I _{OUT} = 1mA to 300mA	-1.25	-	1.25	%
		VOUT = 0.8V, I _{OUT} = 1mA to 300mA ^[5]	-2.5	-	2.5	
LDO12 Line Regulation	LDO12 _{LINE_REG}	LDOx_VIN = $2.7V \leftrightarrow 5.5V$, VOUT = $1.8V$, I _{OUT} = $300mA$	-2	-	2	%

Symbol	Test Conditions ^[1]	Min ^[2]	Тур	Max ^[2]	Unit
10012	vs. LDOx_VIN, AVDD. DC to 100kHz, C _{OUT} = default, LDOx_VIN = LDOx_OUT + 0.3V (Not in dropout)	-	-	-40	dB
LDOTZPSRR	vs. LDOx_VIN, AVDD. 100kHz to 2MHz, C _{OUT} = default, LDOx_VIN = LDOx_VOUT + 0.3V (not in dropout)	-	-	-20	uв
LDO12 _{RDSON}	I _{OUT} = 100mA	-	0.33	0.5	Ω
LDO12 _{DROPOUT}	I _{OUT} = LDO12 _{IOUT(max)}	-	-	300	mV
	LDOx_OUT. Slow setting	35	50	65	
LDO12 _{RDCHG}	LDOx_OUT. Medium setting	26	37.5	49	Ω
	LDOx_OUT. Fast setting	17.5	25	32.5	
ed in Recommended E	ixternal Components. Additional applicatio	on details in	LDO3.		
LDO3 _{OUT}	LDO3_OUT 0.8V, 0.9V,1.2V, 1.5V, 1.8V, 2.5V, 3.0V, 3.3V	0.8	-	3.3	V
LDO3 _{ACC_H}	I_{OUT} = 1mA and 50mA LDO _{OUT} = 2.5V to 3.3V	-3	-	3	
LDO3 _{ACC_M}	I _{OUT} = 1mA and 50mA LDO _{OUT} = 1.5V to 1.8V	-4	-	4	%
LDO3 _{ACC_L}	I _{OUT} = 1mA and 50mA LDO _{OUT} = 0.8V to 1.2V	-5	-	5	
LDO3 _{IOUT}	LDO3_OUT. External load, sourcing (supplying)	50	-	-	mA
LDO3 _{ILIM}	LDO3_OUT = 10% below regulation target (less positive voltage). LDO3 is not expected to operate at this current level continuously.	-	80	-	mA
	Rising threshold is a percentage of the programmed LDO output voltage	-15	-10	-5	
LDO3 _{PGOOD}	Falling threshold is a percentage of the programmed LDO output voltage	-21	-15	-10	%
	Hysteresis 4 5	5	6		
LDO3 _{LOAD}	Step: 1mA \rightarrow 50mA in 1A/µs Step: 50mA \rightarrow 1mA in 1A/µs	-3	-	3	%
	LDO12 _{PSRR} LDO12 _{RDSON} LDO12 _{DROPOUT} LDO12 _{RDCHG} d in Recommended E LDO3 _{OUT} LDO3 _{ACC_H} LDO3 _{ACC_L} LDO3 _{ACC_L} LDO3 _{IOUT} LDO3 _{IOUT}	$ LDO12_{PSRR} \begin{cases} vs. LDOX_VIN, AVDD. \\ DC to 100KHz, C_{OUT} = default, \\ LDOX_VIN = LDOX_OUT + 0.3V (Not in dropout) \\ vs. LDOX_VIN = LDOX_OUT + 0.3V (Not in dropout) \\ vs. LDOX_VIN = LDOX_VOUT + 0.3V (not in dropout) \\ LDO12_{RDSON} & l_{OUT} = 100mA \\ LDO12_{RDCHG} & LDOX_OUT. Slow setting \\ LDOX_OUT. Slow setting \\ LDOX_OUT. Medium setting \\ LDOX_OUT. Fast setting \\ d in Recommended External Components. Additional application \\ LDO3_{OUT} & 0.8V, 0.9V, 1.2V, 1.5V, 1.8V, 2.5V, 3.0V, 3.3V \\ LDO3_{ACC_H} & l_{OUT} = 1mA and 50mA \\ LDO3_{ACC_H} & l_{OUT} = 1mA and 50mA \\ LDO3_{ACC_L}H & l_{OUT} = 1mA and 50mA \\ LDO3_{ACC_L}H & l_{OUT} = 1mA and 50mA \\ LDO3_{IUT} = 1.5V to 1.8V \\ LDO3_{IOUT} & LDO3_{OUT} = 0.8V to 1.2V \\ LDO3_{IOUT} & LDO3_{OUT} = 10\% below regulation target (less positive voltage). LDO3 is not expected to operate at this current level continuously. \\ LDO3_{PGOOD} & Falling threshold is a percentage of the programmed LDO output voltage for the program$	$ LD012_{PSRR} \begin{cases} vs. LD0x_VIN, AVDD. \\ DC to 100KHz, C_{OUT} = default, \\ LD0x_VIN = LD0x_OUT + 0.3V (Not in dropout) \\ vs. LD0x_VIN, AVDD. \\ 100KHz to 2MHz, C_{OUT} = default, \\ LD0x_VIN = LD0x_VOUT + 0.3V (not in dropout) \\ \\ LD012_{RDSON} & l_{OUT} = 100mA & - \\ LD012_{DROPOUT} & l_{OUT} = LD012_{IOUT(max)} & - \\ \\ LD012_{RDCHG} & LD0x_OUT. Slow setting & 35 \\ LD0x_OUT. Slow setting & 26 \\ LD0x_OUT. Fast setting & 17.5 \\ \\ \\ d in Recommended External Components. Additional application details in \\ \\ \\ LD03_{OUT} & 0.8V, 0.9V, 1.2V, 1.5V, 1.8V, 2.5V, 0.8 \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\$	$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	$ \begin{array}{c c c c c c c c c c c c c c c c c c c $



Parameter	Symbol	Test Conditions ^[1]	Min ^[2]	Тур	Max ^[2]	Unit
LDO3 Load		V _{OUT} = 2.5V to 3.3V range, I _{OUT} = 1mA to 50mA ^[5]	-1	-	1	
Regulation	LDO3 _{LOAD_REG}	V_{OUT} = 1.8V, I_{OUT} = 1mA to 50mA	-1.5	-	1.5	%
		V _{OUT} = 0.8V, I _{OUT} = 1mA to 50mA ^[5]	-3	-	3	
LDO3 Line Regulation	LDO3 _{LINE_REG}	LDO3_VIN = $2.7V \leftrightarrow 5.5V$, VOUT = $1.8V$,I _{OUT} = $50mA$	-	1	2	%
LDO3 PSRR	1003	vs. LDO3_VIN, AVDD. DC to 100kHz, C _{OUT} = default, LDOx_IN = LDO3_OUT + 0.3V (not in dropout)	-	-	-40	dB
LDO3 PSKR	LDO3 _{PSRR}	vs. LDO3_VIN, AVDD. 100kHz to 2MHz, C _{OUT} = default, LDOx_IN = LDO3_OUT+ 0.3V (not in dropout)	-	-	-20	
LDO3 Bypass Mode ON-Resistance	LDO3 _{RDSON}	I _{OUT} = 10mA	-	1.3	1.8	Ω
LDO3 Dropout Voltage	LDO3 _{DROPOUT}	I _{OUT} = LDO3 _{IOUT(max)}	-	-	300	mV
		LDO3_OUT. Slow setting	35	50	65	
LDO3 Discharge Resistance	LDO3 _{RDCHG}	LDO3_OUT. Medium setting	26	37.5	49	Ω
		LDO3_OUT. Fast setting	17.5	25	32.5	
VTTREF Components as describ	ed in Recommended E	xternal Components. Additional application	on details in	VTTREF.		
VREFIN Input Operating Range	VREFIN _{OP}	-	1.1	-	1.8	V
VREFIN Undervoltage Lockout Threshold	VREFIN _{UVLO_F}	Falling VREFIN	0.72	0.78	0.84	V
VREFIN Undervoltage Lockout Hystersis	VREFIN _{UVLO_HYS}	VREFIN _{UVLO_R} = VREFIN _{UVLO_F} + V REFIN _{UVLO_HYS}	-	20	-	mV
VREFIN UVLO Falling Delay	t _{VREFIN_UVLO_} F_DLY	Falling VREFIN	-	1	-	ms
VREFOUT Output Range	VREFOUT _{RNG}	VREFOUT = buffered version of VREFIN/2	0.55	-	0.9	V
VREFOUT Output		sourcing (supplying)	10	-	-	
Current	VREFOUT _{IOUT}	sinking (receiving)	10	-	-	mA
VREFOUT Output	VREEOUT	sourcing (supplying)	22	40	58	mA
Current Limit		sinking (receiving)	-	40	-	ШA
VEFOUT	VREFOUT _{ACC_AC}	VTTREF_EN = 1 DDR JEDEC spec	0.49* VREFIN	0.5* VREFIN	0.51* VREFIN	V
VREFOUT Accuracy	VREFOUT _{ACC_DC}	VTTREF_EN = 1 DDR JEDEC spec	-0.01* VREFIN	-	0.01* VREFIN	V



Parameter	Symbol	Test Conditions ^[1]	Min ^[2]	Тур	Max ^[2]	Unit
		VREFOUT. Fast setting	-	50	65	
VREFOUT Discharge Resistance	VREFOUT _{RDCHG}	VREFOUT. Medium setting	-	75	97	Ω
		VREFOUT. Slow setting	-	100	130	
Charger		1	1	1	I	
Components as describe	ed in Recommended E	xternal Components. Additional application	on details in	Coin Cell E	Battery Cha	rger.
VCHG Operating Voltage Range	VCHG _{OP}	-	2.7	5	5.5	V
VBAT Charging Voltage Termination Range	VBAT _{RNG}	sets VBAT voltage to automatically disable charger operation	1.8	3.3	3.3	v
VBAT Charging Voltage Termination Step	VBAT _{STEP}	VBAT	-	100	-	mV
VCHG Headroom	VCHG _{HD}	Input voltage headroom. VCHG needs to be above VBAT + VCHG _{HD} to make the charger operate at the programmed charge current	300	-	-	mV
VRTC Voltage Hysteresis	VRTC _{HYS}	Threshold for VRTC supply switching to being derived from VCHG (rather than VBAT), VCHG rising above VBAT + VBAT _{HYS}	-	50	-	mV
Charge Current Setting Range	VBAT _{IOUT}	VBAT. 60µA (default) setting	20	60	60	μA
Charge Current Accuracy	VBAT _{IOUT_ACC}	VBAT	-20	-	20	%
RTC Components as describe	ed in Recommended E	xternal Components. Additional applicatic	on details in	Real-Time	Clock.	
VBAT Operating Voltage Range	VBAT _{OP}	Battery backup mode	1.8	3.3	5.5	V
VRTC Operating Voltage Range	VRTC _{OP}	Generated internally from higher of VCHG or VBAT	1.8	5	5.5	V
Oscillator Frequency	RTC _{FREQ}	-	-	32.768	-	kHz
Oscillator Duty Cycle	RTC _{DUTY}	-	-	50	-	%
l ² C		1		ı	1	
7-bit Slave Address	I2C _{ADDR_MAIN}	Access to non-RTC related registers. 7-bit uniquely programmable in EEPROM	1	12	7F	Lloy
Range	I2C _{ADDR_RTC}	Access to RTC related registers. 7-bit uniquely programmable in EEPROM	1	6F	7F	Hex
SCL Clock Frequency	f _{SCL}	Supports standard 100kHz, 400kHz, 1MHz	-	-	1	MHz



Parameter	Symbol	Test Conditions ^[1]	Min ^[2]	Тур	Max ^[2]	Unit
Logic I/O		-				
	V _{OP_EN}	CEN, PWRON	0	-	5.5	V
Operating Input	V _{OP_MPIO}	MPIOx	0	-	5.5	V
Voltage Range	V _{OP_I2C}	SCL, SDA	0	-	5.5	V
	V _{OP_LDOSEL}	LDO_SEL1, LDO_SEL2	0	-	5.5	V
	V _{IH_EN}	CEN, PWRON	1.2	-	-	V
HIGH 1 Input Voltage	V _{IH_MPIO}	MPIOx	1.2	-	-	V
Threshold	V _{IH_I2C}	SCL, SDA	1.2	-	-	V
	V _{IH_LDOSEL}	LDO_SEL1, LDO_SEL2, in {ACTIVE}	1.2	-	-	V
	V _{IL_EN}	CEN, PWRON	-	-	0.4	V
LOW 0 Input Voltage	V _{IL_MPIO}	MPIOx	-	-	0.4	V
Threshold	V _{IL_I2C}	SCL, SDA	-	-	0.4	V
	V _{IL_LDOSEL}	LDO_SEL1, LDO_SEL2, in {ACTIVE}	-	-	0.4	V
	V _{EN_HYS}	CEN, PWRON	-	150	-	mV
	V _{MPIO_HYS}	MPIOx	-	150	-	mV
Input Hysteresis	V _{I2C_HYS}	SCL, SDA	-	150	-	mV
	V _{LDOSEL_HYS}	LDO_SEL1, LDO_SEL2, in {ACTIVE}	-	150	-	mV
	I _{L_EN}	CEN, PWRON. CEN = 5.5V, PWRON = 5.5V ^[8]	-3.5	-	3.5	
Input Leakage Current	I _{L_MPIO}	MPIOx. MPIOx = 5.5V ^[8]	-3.5	-	3.5	μA
	I _{L_I2C}	SDA, SCL SDA = SCL = 5.5V	-1	-	1	
	I _{L_LDOSEL}	LDO_SELx, LDO_SELx = 5.5V ^[8]	-3.5	-	3.5	
Low Level Output	V _{OL_MPIO}	MPIOx as output, open-drain. Pull up to 1.8V, sinking 2mA	-	-	0.4	V
Voltage	V _{OL_SDA} SDA. Pull up to 1.8V, sinking 2mA			0		
	V _{OL_INT}	INT#. Pull up to 1.8V, sinking 2mA	-	-	0.4	
High Level Output Voltage	V _{OH_MPIO}	MPIOx as full CMOS output, sourcing 2mA	1.2	-	-	V



Parameter	Symbol	Test Conditions ^[1]	Min ^[2]	Тур	Max ^[2]	Unit
Protections						
	PIZ	BUCKx_FB rising. Percentage of output voltage target setting (Bucks 1, 2, 3)	6	8.5	11	
Output Overvoltage Protection Threshold	BK _{OVP_R}	BUCKx_FB rising. Percentage of output voltage target setting (Bucks 5 and 6)	6	8.5	12.5	
	PK	BUCKx_FB falling. Percentage of output voltage target setting (Bucks 1, 2, 3)	4	6.5	9	
	BK _{OVP_F}	BUCKx_FB falling. Percentage of output voltage target setting (Bucks 5 and 6)	3	6.5	9	%
	BK _{OVP_HYS}	BK _{OVP_HYS} = BK _{OVP_R} - BK _{OVP_F} . Percentage of output target setting. (Bucks 1, 2, 3, 5, and 6)	-	2	-	
	BK4 _{OVP_R}	BUCK4_FB rising. Percentage of output voltage target setting	5	10	15	
	BK4 _{OVP_F}	BUCK4_FB falling below BK _{OVP} . Percentage of output target setting	4	8.5	13	
	BK4 _{OVP_HYS}	BK4 _{OVP_HYS} = BK4 _{OVP_R} - BK4 _{OVP_F} . Percentage of output target setting.	-	1.5	-	
	BK _{UVP_R}	BUCKx_FB rising. Percentage of output voltage target setting. (Bucks 1, 2, 3, 5, and 6)	-8	-5.5	-2	
-	PIZ	BUCKx_FB falling. Percentage of output target setting. (Bucks 1, 2, 3)	-13	-11	-8	
	BK _{UVP_F}	BUCKx_FB falling. Percentage of output target setting. (Bucks 5 and 6)	-13	-11	-6	
Output Undervoltage Protection Threshold	BK _{UVP_HYS}	$\begin{array}{l} BK_{UVP_HYS} = BK_{UVP_R} - BK_{UVP_F}.\\ Percentage \ of \ output \ target \ setting.\\ (Bucks \ 1, 2, 3, 5, \ \text{and} \ 6) \end{array}$	-	5.5	-	%
	BK4 _{UVP_R}	BUCK4_FB rising. Percentage of output voltage target setting.	-12	-7	-2.5	
	BK4 _{UVP_F}	BUCK4_FB falling. Percentage of output target setting.	-18	-13	-8	
	BK4 _{UVP_HYS}	BK4 _{UVP_HYS} = BK4 _{UVP_R} - BK4 _{UVP_F} . Percentage of output target setting.	-	6	-	



Parameter	Symbol	Test Conditions ^[1]	Min ^[2]	Тур	Max ^[2]	Unit
Output Fault Deglitch Time	^t flt_deglitch	Deglitch time from fault event to INT# assertion for unmasked faults, including: BUCK OV and UV, LDO PGOOD, Thermal Warning and Shutdown.	0.8	1	1.2	ms
High Current Warning Deglitch Time	^t HC_DEGLITCH	Buck1 high current warning	-	100	-	μs
Thermal Shutdown Threshold	T _{SHDN}	Junction temperature rising. Thermal shutdown asserted.	125	135	145	°C
	T _{SHDN_HYS}	Junction temperature falling below T _{SHDN} . Thermal shutdown de-asserted.	-	30	-	°C
Thermal Warning	T _{WARN}	Junction temperature rising. Thermal warning asserted. 120°C setting	110	120	130	°C
Threshold	T _{WARN_HYS}	Junction temperature falling below T _{WARN} Thermal warning de-asserted.	-	25	-	°C
Timing		·				
PWRON Deglitch Time	ch t _{PWRON_DEGLITCH} -		-	100	-	μs
MPIOx Deglitch Time	litch Time t _{MPIO_DEGLITCH} -		-	1.5	-	μs

1. All the C_{OUT} listed in Test Condition are nominal values (not derated), unless stated as derated or effective. For details on the recommended components, see External Component Selection.

2. Parameters with MIN and/or MAX limits are 100% tested at +25°C, unless otherwise specified. Temperature limits established by characterization and are not production tested.

3. Follow this supply timing to ensure correct timekeeping of the RTC.

- 4. When a MPIOx is configured as full CMOS output, the sourcing current comes from VIO.
- 5. Compliance to datasheet limits is established by one or more methods: production test, characterization, and/or design.

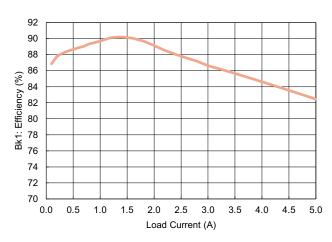
6. This is not applicable to RAA215300A2GNP#HA3.

- 7. At light loads, switching frequency is lower than the setting.
- 8. There is an internal 2MΩ pull-down resistor at each of the following pins: CEN, PWRON, MPIOx, and LDO_SELx.



4. Typical Performance Graphs

AVDD = VCHG = BUCKx_VINx = 5V, BUCK1_FB = 1.1V, BUCK2_FB = 1.2V, BUCK3_FB = 1.8V, BUCK4_FB = 3.3V, BUCK5_FB = 1.2V, BUCK6_FB = 0.6V, CEN = HIGH, PWRON = HIGH, $T_A = +25^{\circ}$ C, unless otherwise stated. Refer to the RTKA215300DE0000BU BOM for the components used in the following measurements.



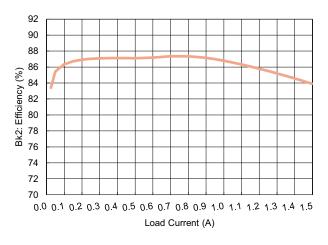
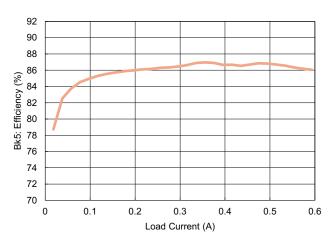


Figure 5. Buck1 Efficiency in Auto PFM/PWM mode



Figure 7. Buck3 Efficiency in Auto PFM/PWM mode



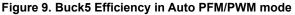


Figure 6. Buck2 Efficiency in Auto PFM/PWM mode

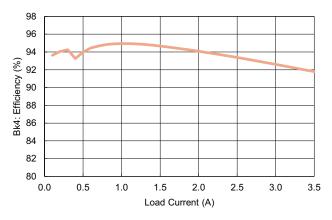
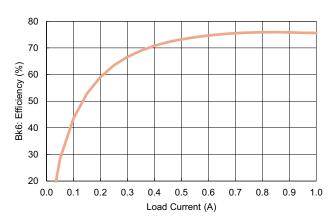
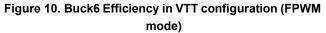


Figure 8. Buck4 Efficiency in Auto PFM/PWM mode







5. Serial Interface

The RAA215300 includes a standard I²C serial interface. The 2-wire interface links one or more Masters and uniquely addressable Slave devices. The Master generates clock signals and is responsible for initiating data transfers. The serial clock is on the SCL line and the serial data (bidirectional) is on the SDA line. The RAA215300 supports clock rates up to 1MHz (Fast mode plus) and is downward compatible with standard 100kHz (Standard mode), and 400kHz (Fast mode) clock rates.

The SDA and SCL lines must be HIGH when the bus is free (not in use). An external pull-up resistor (typically $1k\Omega$ to $4.7k\Omega$ depending on clock speed, pull-up voltage, and bus capacitance) or current source is required for SDA and SCL.

The I²C interface is not functional until VIO_PGOOD is high. See VCHG, VBAT, and VRTC for more details.

5.1 I²C General Operation

5.1.1 Data Validity

The data on the SDA line must be stable (clearly defined as HIGH or LOW) during the HIGH period of the clock signal. The state of the SDA line can only change when the SCL line is low (except to create a START or STOP condition). The voltage levels used to indicate a logical 0 (LOW) and logical 1(HIGH) are determined by the V_{IL} and V_{IH} thresholds, respectively, see Electrical Specifications.

5.1.2 START and STOP Condition

All I²C communication begins with a START condition (indicating the beginning of a transaction) and ends with a STOP condition (signaling the end of the transaction).

A START condition is signified by a HIGH-to-LOW transition on the serial data line (SDA) while the serial clock line (SCL) is HIGH. A STOP condition is signified by a LOW-to-HIGH transition on the SDA line while SCL is HIGH. See timing specifications in Electrical Specifications.

The Master always initiates START and STOP conditions. After a START condition, the bus is considered busy. After a STOP condition, the bus is considered free. The device supports repeated STARTs, where the bus remains busy for the continued transaction(s).

5.1.3 Byte Format

Every byte on SDA must be 8 bits in length. After every byte of data sent by the transmitter, there must be an Acknowledge bit (from the receiver) to signify that the previous 8 bits were transferred successfully. Data is always transferred on SDA with the most significant bit (MSB) first. If the data is larger than 8 bits, it can be separated into multiple 8-bit bytes.

5.1.4 Acknowledge (ACK)

Each 8-bit data transfer is followed by an Acknowledge (ACK) bit from the receiver. The ACK bit signifies that the previous 8 bits of data were transferred successfully (master-slave or slave-master).

When the Master sends data to the Slave (for example, during a WRITE transaction), after the 8th bit of a data byte is transmitted, the Master tri-states the SDA line during the 9th clock. The Slave device acknowledges that it received all 8 bits by pulling down the SDA line, generating an ACK bit.

When the Master receives data from the Slave (for example, during a data READ transaction), after the 8th bit is transmitted, the Slave tri-states the SDA line during the 9th clock. The Master acknowledges that it received all 8 bits by pulling down the SDA line, generating an ACK bit.



5.1.5 Not Acknowledge (NACK)

A Not Acknowledge (NACK) bit is generated when the receiver does not pull down the SDA line during the acknowledge clock (that is, the SDA line remains HIGH during the 9th clock), indicating to the Master that it can generate a STOP condition to end the transaction and free the bus.

A NACK bit can be generated for various reasons, for example:

- After an I²C device address is transmitted, there is NO receiver with that address on the bus to respond.
- The receiver is busy performing an internal operation (for example, reset or recall) and cannot respond.
- The Master (acting as a receiver) needs to indicate the end of a transfer with the Slave (acting as a transmitter).

5.1.6 Device Address and R/W Bit

After a valid START condition, the first byte sent in a transaction contains the 7-bit Device (Slave) Address plus a direction (R/\overline{W}) bit (Device Address Byte). The Device Address identifies which device (of up to 127 addresses on the I²C bus) the Master wishes to communicate with.

After a START condition, the device monitors the first 8 bits received (Device Address byte), and checks for its 7-bit Device Address in the MSBs. If it recognizes the correct Device Address, it ACKs and becomes ready for further communication. If it does not see its Device Address, it sits idle until another START condition is issued on the bus.

Note: The 8th bit (LSB) of the Device Address byte indicates the direction of transfer, READ or WRITE (R/W). A 0 indicates a WRITE operation - the Master transmits data to the RAA215300 (receiver). A 1 indicates a Read operation - the Master receives data from the RAA215300 (transmitter).

5.2 Device Communication Protocol

5.2.1 7-bit Device Addresses

The RAA215300 employs two 7-bit I²C device/slave addresses. One address accesses settings related to the RTC function (RTC Slave Address) - default address **0x6F** (1101111x). Another address accesses the remainder of the device settings (Main Slave Address) - default address **0x12** (0010010x). The LSB is a direction bit, which can be 0 for a WRITE or 1 for a READ, which is not part of the unique 7-bit I²C device address.

Both addresses are programmable in EEPROM with possible values in the range 0x01 to 0x7F. The two slave addresses can be the same value for single slave address access to the register space.

5.2.2 Register Size

All the device registers contain 8-bit (byte) data. The data is latched-in after the 8th bit (LSB) is received. If a partial data byte is received, that byte is ignored, but any previously acknowledged bytes are accepted.

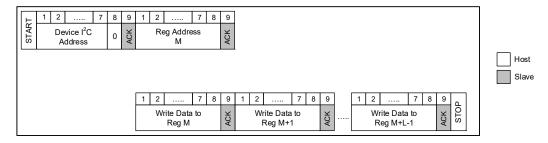
5.2.3 I²C Write Operation

A Write operation consists of the master sending a START condition, followed by a valid device address byte (R/W bit set to 0), a Register Address Byte, Data Byte, and a STOP condition. After each byte, the device responds with an ACK. The I²C protocol supports burst writing (automatic incrementing of address pointer). After every successfully transmitted data byte, the device automatically increments the internal register address, so subsequent data bytes are written to sequentially incremental register locations. The master must send a STOP condition after sending at least one full data byte and receiving the associated ACK. If a STOP is issued in the middle of a data byte, the Write for that byte is not performed. The basic write transaction structure is shown in Figure 11.



E	1	2		7	8	9	1	2		7	8	9	1	2		7	8	9	Ь	Host
STAR			vice I ² C ddress		0	ACK		Re	eg Addre M	ess		ACK		W	rite Data Reg M	ı to		ACK	STOF	Slave

Figure 11. 1-Byte Write to Register M





5.2.4 I²C Read Operation

The master sends a START condition, followed by a valid device address byte (R/W bit set to 0), a register address byte, a second (repeated) START, and a valid device address byte (R/W bit set to 1). After each of the three bytes, the device responds with an ACK. The device then transmits data bytes back to the master, and the master ACKs after each byte. The master terminates the Read operation by issuing a NACK and sending a STOP condition.

After every successfully transmitted data byte, the device automatically increments the internal register address, so data bytes are sent out from sequential register locations.

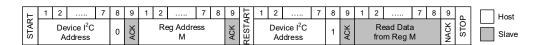


Figure 13. 1-Byte Read to Register M

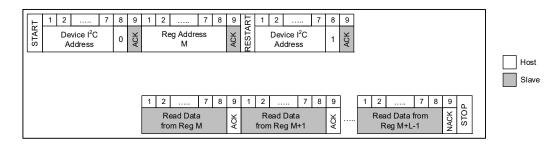


Figure 14. L-Byte Sequential Data Read Starting at Register M

5.2.5 I²C Timing

The timing specifications of the I^2C I/O from the I^2C specification are shown in Figure 15 and Table 1. The I^2C controller provides a slave I^2C transceiver capable of interpreting I^2C protocol in Standard, Fast, and Fast-mode plus modes.

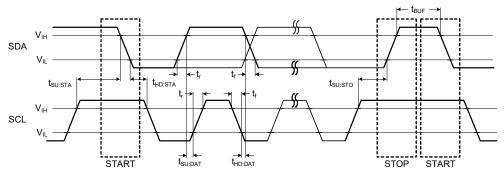


Figure 15. I²C Timing Definitions

Parameter	Symbo		ndard ode	Fast Mode		Fast Mo Plus		Unit
	•	Min	Max	Min	Мах	Min	Max	
SCL Clock Frequency	f _{SCL}	0	100	0	400	0	1000	kHz
Hold Time (repeated) START Condition	t _{HD:STA}	4.0	-	0.6	-	0.26	-	μs
LOW Period of the SCL Clock	t _{LOW}	4.7	-	1.3	-	0.5	-	μs
HIGH Period of the SCL Clock	t _{HIGH}	4.0	-	0.6	-	0.26	-	μs
Set-Up Time for a Repeated START Condition	t _{SU:STA}	4.7	-	0.6	-	0.26	-	μs
Data Hold Time ^[1]	t _{HD:DAT}	0	-	0	-	0	-	μs
Data Set-Up Time	t _{SU:DAT}	250	-	100	-	50	-	ns
Rise Time of SDA and SCL	t _r	-	1000	0	300	-	120	ns
Fall Time of SDA and SCL ^{[2][3]}	t _f	-	300	20 x (V _{DD} /5.5V)	300	20 x (V _{DD} /5.5V)	120	ns
Set-Up Time for a STOP Condition	t _{SU:STO}	4.0	-	0.6	-	0.26	-	μs
Bus Free Time Between a STOP and START Condition	t _{BUF}	4.7	-	1.3	-	0.5	-	μs
Capacitive Load for Each Bus Line	Cb	-	400	-	400	-	550	pF
Pulse Width of Spikes that must be Suppressed by the Input Filter	t _{SP}	-	-	0	50	0	50	ns
Input Capacitance for each SDA and SCL	Ci	-	10	-	10	-	10	pF

Table 1. I²C Timing Characteristics

1. t_{HD:DAT} is the data hold time that is measured from the falling edge of SCL, applies to data in transmission and the acknowledge.

2. V_{DD} = External pull-up voltage.

3. In Fast mode Plus, fall time is specified the same for both output stage and bus timing. If series resistors are used, designers should allow for this when considering bus timing.

5.3 Unimplemented Registers

All register addresses that are defined in the register map ACK write commands and return data to read commands that address them. Unimplemented registers address ACK write commands but data is ignored, and returns a fixed value of 0x00 to read commands.

6. Registers and EEPROM

The RAA215300 features both volatile (RAM/registers) and non-volatile (EEPROM) memory. The volatile value of each register can be set by writing data to the appropriate register using the selected interface, or it can be recalled and loaded from the integrated EEPROM.

When the device enters into {READ_EE}, digital logic loads the pre-programmed EEPROM data into the volatile register space. When all data is loaded successfully, the device does not reload EEPROM data again unless there has been a power cycle, CEN toggle, or software reset command. See Operating {States} and Transition Conditions.

Volatile register data can be written or read back on the fly, as fast as the I²C interface can support.

6.1 EEPROM

The RAA215300 integrates high endurance EEPROM to store all IC configurations. The EEPROM is capable of 1000 plus endurance cycles and 10yrs at 85C of data retention.

6.1.1 Writing to the EEPROM

EEPROM programming is initiated through a control byte register. When setting the write bit to 1 in the control byte (0xFF), all the related non-volatile register data are copied to EEPROM on the subsequent I²C STOP condition. During the EEPROM programming cycle time, the device is internally busy and NACKs to any interface commands, however the buck, LDO outputs, and other IC operations are not halted during the programming time.

When the programming cycle completes, the stored EEPROM data is automatically read back into the register. This provides a way for the host to validate successful programming by reading back the register(s) and comparing it with the value(s) intended to be programmed. If values match, programming was successful. However, if the register data reverts to the previous stored EEPROM value, the EEPROM values were not successfully updated.

6.1.1.1 EEPROM Banks

The RAA215300 EEPROM is partitioned into eight separate banks. All customer banks are (re)programmed each time an EEPROM programming operation commences. For details about each register and bits, see the Register Map.

6.1.1.2 EEPROM Programming Voltage

When programming the EEPROM, the minimum voltage requirement must be met:

VPROG ≥ 21V

If the condition is not met, the EEPROM programming operations are not successful. If there was insufficient EEPROM programming or reading voltage, the NVM_Error_Latched and EE_Error_Latched bits are set to 1. The fault flags do not affect the power-on sequencer.

6.1.1.3 Step-by-step EEPROM Programming Instructions

- 1. The device should be in {STANDBY} or onward.
- 2. Write/set up all the required register values (volatile).
- 3. Apply sufficient EEPROM programming cycle voltage to VPROG, see EEPROM Programming Voltage. *Note:* This step can occur before Step 2.

RENESAS

- Set the write bit in the control byte write register address 0xFF[1] = 1. On the subsequent I²C stop condition, the EEPROM programming cycle commences.
- The system must wait for the maximum t_{EE_WRITE} time to elapse before attempting further interface activity with RAA215300, or making any changes to the supplies as the device is internally busy with programming operations.

6.1.2 Recalling the EEPROM

There are two ways to load EEPROM data to the device volatile registers:

- Automatic Recall: Occurs during initial power-on (or power cycle). See Operating {States} and Transition Conditions.
- Manual/Software Recall: Issue an I²C reset command to the control byte (register 0xFF).

When the EEPROM is being loaded to the registers, the device is internally busy and NACKs to any I²C commands. When all data is loaded successfully, the RAA215300 does not reload the data unless there has been a new power cycle, toggle of CEN, or software recall command.

6.1.2.1 Valid EEPROM Data Check

During the initial automatic recall, the device provides a safety mechanism to effectively stall the power-on process (sequencer) before any blocks become enabled, and output sequencing starts if it is determined that the EEPROM data has not been programmed or checked by the host. This is accomplished by putting the device into {FAULT_OUT}, which allows the system host to first read back by I²C and initially program the EEPROM data loaded to the registers or confirm loaded data are valid for the application. This helps prevent any undesirable application system behavior. The host can verify this event occurred by reading the fault registers and observing if the NVM_Error_Latched fault and Valid_EE_Data latched fault bits are set to 1. This feature is not enabled if registers 0xD9 - 0xDD are all at zero value.

If the register and/or EEPROM data needs to be changed after the host checks any required register data, the host can make the necessary programming changes. When correct register data is set, the host should clear the NVM_Error_Latched fault by writing 1 to it, which clears both NVM_Error_Latched and Valid_EE_Data bits and releases the device to continue the power-on as determined by PWRON and configuration register settings. This gives the host authority to validate the register settings and specifically control when the device is allowed to start the system.

When the required RAA215300 settings are fixed and programmed to EEPROM (that is, the host no longer needs to validate the data at each power-on), programming register EEPROM_ID_1 or EEPROM_ID_2 to any non-zero value in EEPROM authorizes that the EEPROM data is valid. Therefore, the device no longer enters {FAULT_OUT} and awaits host intervention at subsequent power-on events. *Note:* Reprogramming register EEPROM_ID_1 and EEPROM_ID_2 back to 0x00 value causes the device to enter {FAULT_OUT} at future power-on events.

6.2 **EEPROM Error Correction**

Data stored in EEPROM is protected by error correction codes (ECC), which allows a single bit error in a given memory bank to be corrected. Each EEPROM bank is covered by its own error correction code.

When a bank of EEPROM is programmed, the error correction code for that bank is automatically generated internally and stored in the same bank. When the EEPROM is recalled, the error correction code is checked, and a correctable (single bit) error is automatically corrected.

Should a single bit correction occur, the EE_Bank#_ECC_Corrected status flag and NVM_Error_Latched bit are set. INT# is asserted. The device still transitions states normally to start up. The host can clear the NVM_Error_Latched fault by writing 1 to it, which clears both NVM_Error_Latched and EE_Bank#_ECC_Corrected bits and de-asserts the INT# output. Two-bit errors in any bank are detected and reported as uncorrectable errors by setting the INT# interrupt event, NVM_Error_Latched bit, and EE_Bank#_ECC_Error status flags. The device ignores the other control inputs (such as PWRON) and enters

{FAULT_OUT}. The host should clear the NVM_Error_Latched fault by writing 1 to it, which clears both NVM_Error_Latched and EE_Bank#_ECC_Error bits and releases the device to continue the power-on sequence.

6.2.1 ECC Bank Detail Bits

Each RAA215300 memory bank has dedicated ECC bank detail fault bits to uniquely report if a given bank had either an uncorrected, or corrected ECC error occur. These bits do not affect IC operation, they are simply used to provide additional information in the event of ECC operation.

When an ECC error is uncorrected for a given bank # (that is, EEPROM EE_Read_Error interrupt event occurs), a corresponding detail status bit (EE_Bank#_ECC_Error) is set to 1. The EE_Bank#_ECC_Error status bits can be cleared by writing 1 to the NVM_Error_Latched bit.

When an ECC error is corrected for a given bank #, a corresponding detail status bit (EE_Bank#_ECC_Corrected) is set to 1. The bit(s) can be cleared by the host by writing 1 to the NVM_Error_Latched bit.

7. Power Supplies

The RAA215300 requires one input power supply to power everything. To describe various usage of the power supply, it is helpful to give it various names, but all named parts must be connected together by the PCB. AVDD and VCHG are defined in Pin Descriptions. The input power supply provides power to all voltage regulators, and these connections have various names defined in Pin Descriptions. Connection to the IC is made at many physical locations, identified by name, and each location must have dedicated decoupling capacitance.

7.1 Internal LDO (VIO)

An LDO rejects noise from the VCHG supply and provides a quiet and stable internal supply, VIO, for interface logic.

The LDO is output-compensated and requires a minimum of 1.2µF effective output capacitance, placed close to the VIO pin. See External Component Selection and Device Specific Layout Guidelines.

VIO is enabled as soon as AVDD exceeds its UVLO rising threshold. VIO power-good (VIO_PGOOD) is monitored only after EEPROM is read. The timeout period starts as soon as the FSM enters {WAIT_FOR_VIO}. The timeout period is set by a 2-bit register. See {WAIT_FOR_VIO}.

A register bit is assigned to mask or unmask the VIO_PGOOD signal from INT#. Another register bit shows the status of the VIO power-good fault. When asserted, this fault flag is latched and does not clear automatically. It can only be cleared by writing 1 to the register, hardware reset, or input power cycle.

The VIO LDO is capable of supporting an additional external load of up to 20mA continuously.

7.2 VCHG, VBAT, and VRTC

VRTC is an output that provides power to the RTC. VRTC is generated internally from the higher of VBAT and VCHG. If RTC is used, Renesas recommends placing a capacitor footprint between VRTC and AGND. The capacitor is not populated by default. If RTC is not used, leave VRTC open.

VCHG is the power supply for the coin cell charger and the internal LDO VIO. VCHG must be connected to AVDD, allowing I²C to be operational when the RTC is in battery mode while AVDD remains above its UVLO falling threshold (for example, AVDD = 2.7V, VBAT = 3V). Given that the input thresholds of the I²C signals depend on the VIO supply, which is derived from VCHG, the I/Os are effectively disabled when VIO_PGOOD is LOW (invalid). This could occur when CEN is LOW (the main IC is shut down) if AVDD is below its UVLO level, or when the VIO LDO is powering up.

VBAT can be connected to a coin cell battery or a supercapacitor. VBAT is selected to supply VRTC when VCHG falls below the VBAT voltage - entering battery mode operation. When VCHG rises above (VBAT + VBAT_{HYS}), the system selects VCHG to supply VRTC.

8. Operating {States} and Transition Conditions

The RAA215300 has a finite-state machine (FSM) to execute transitions between various operational states. The following describes those states and the conditions for transitions.

8.1 {RESET}

If AVDD is below its UVLO falling threshold in any state or CEN = LOW in {STANDBY} or {FAULT_OUT}, the device enters {RESET}. In {RESET}, the digital circuit is held in reset, and if CEN = LOW, the device is powered down. When AVDD is above its UVLO rising threshold and CEN = LOW, the device is in the SHUTDOWN condition.

8.2 {READ_EE}

When AVDD is above its UVLO rising threshold and CEN = HIGH, EEPROM values are read into the registers. When EEPROM reading/loading is successfully completed, the device sets the NVM_Read_Complete latched flag and then transitions to {WAIT_FOR_VIO}.

Note: There is an error correction system (1-bit error correction and 2-bit error detection) that checks the EEPROM loads correct data. If EE_Bankx_ECC_Error or Valid_EE_Data errors are detected, the state machine sets the NVM_Error_Latched flag bit. If this occurs, the part ignores control inputs (for example, PWRON) and enters {FAULT_OUT}. See Valid EEPROM Data Check and EEPROM Error Correction.

8.3 {WAIT_FOR_VIO}

{WAIT_FOR_VIO} follows successful {READ_EE}. Providing that AVDD is valid and that CEN is high, on entry to {WAIT_FOR_VIO}, a programmable timer (VIO Timeout) starts, and monitoring of VIO_PGOOD begins. If VIO_PGOOD is asserted before the timer expires, the FSM transitions to {STANDBY} before the end of the timeout period. If VIO_PGOOD is not asserted when the timer expires, the FSM transitions to {FAULT_OUT}.

8.4 {STANDBY}

In {STANDBY}, MPIOx (if configured as inputs) and PWRON are responded to. The I²C interface becomes operational as well. When PWRON is asserted, the FSM enters {STANDBY_EXIT}.

8.4.1 {STANDBY_EXIT}

The FSM stays in this state until a timer expires (typically around 80µs). When the timer expires, the FSM enters {STANDBY_TO_ACTIVE}.

8.4.2 {STANDBY_TO_ACTIVE}

In {STANDBY_TO_ACTIVE}, the output rails are turned on if enabled in the register settings, and MPIOx is asserted if configured as outputs in the register settings. MPIOx can also be configured to inputs that control regulator output power-on timing. See Power-ON for details.

8.4.3 {ACTIVE_TO_STANDBY}

In {ACTIVE}, if PWRON is de-asserted, the FSM transitions to {ACTIVE_TO_STANDBY}. The FSM enters {STANDBY} when the outputs complete the programmed power-off sequence.

8.5 {ACTIVE}

When the output rails and MPIOx complete the programmed power-on sequence, the FSM enters {ACTIVE}.



8.6 {IORESET}

There are three possible causes of the device entering {IORESET}:

- CRST_IN# is asserted when CRST_Fault_EN = LOW
- The watchdog timer expires when WD_PD_EN = LOW
- WD_RST_EN = HIGH; or Warm Reset = HIGH

The MPIOx reset outputs are asserted immediately. See Warm and Cold Reset for details. While in this state, if PWRON is de-asserted, the device transitions to {ACTIVE_TO_STANDBY}.

8.6.1 {IORESET_TO_ACTIVE}

When reset is complete, the reset register bit is cleared automatically and the device enters {IORESET_TO_ACTIVE}. While in {IORESET_TO_ACTIVE}, if PWRON is de-asserted, the FSM enters {ACTIVE_TO_STANDBY}.

8.7 {SLEEP}

{SLEEP} is a mode of operation with selectable alternative power rails settings. Different output voltages may be set, and the buck regulators can each be set to a different operating mode.

While in {ACTIVE}, if SLEEP# is asserted or the SLEEP_State_EN bit is HIGH, the FSM enters {ACTIVE_TO_SLEEP}.

8.7.1 {ACTIVE_TO_SLEEP}

There are two output voltage settings for each rail - one for {ACTIVE} and one for {SLEEP}. When entering {SLEEP}, the voltage transitions to {SLEEP} settings following the power-off sequence. If the voltage settings are different for the two states, the voltages ramp up or ramp down according to the programmed DVS slew rate. When slewing of all output voltages completes, the FSM enters {SLEEP}.

8.7.2 {SLEEP_TO_ACTIVE}

While in {SLEEP}, if SLEEP# is de-asserted or the SLEEP_State_EN bit is LOW, the FSM transitions to {SLEEP_TO_ACTIVE} following the power-on sequence. If the voltage settings are different for the two states, the voltages ramp up or ramp down according to the programmed DVS slew rate. When all output voltage changes complete, the FSM enters {ACTIVE}.

8.8 {FAULT_OUT}

If a fault condition occurs, the FSM enters {FAULT_OUT} after completing the power-off sequence (see Device Monitors, Warnings, and Protections). Depending on the fault type and configured response, the device may turn off all outputs in {FAULT_OUT}. INT# is pulled LOW if not masked from that particular fault. If CEN = LOW, the device enters {RESET}. To exit {FAULT_OUT} and enter {STANDBY}, the fault condition(s) must cease, and all latched fault bits must be cleared by writing 1 to the fault register bit(s).

If the latched fault bit is cleared before all the outputs have finished turning off, the power-up sequence can begin with some outputs already enabled. This behavior can be avoided if necessary by ensuring that there is sufficient delay before clearing the latched fault bit. Alternatively, the cold reset function (Warm and Cold Reset) can be triggered immediately before clearing the latched fault bit to ensure that the power-down sequence completes before powering up again.



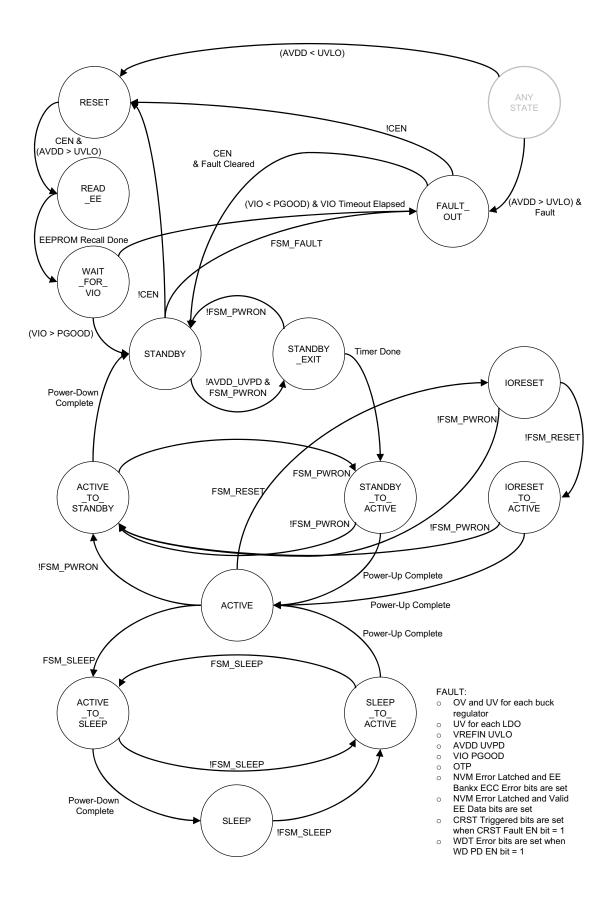


Figure 16. State Diagram



9. Functional Blocks and Application Information

9.1 Chip Enable

The device chip enable (CEN) is an active high, level-sensitive input. When asserted (HIGH), it provides a whole chip enable signal, and when de-asserted (LOW), it disables the device, and all outputs are tri-stated. CEN supports being tied to AVDD. See Electrical Specifications for pin capability.

When asserted, the internal bias circuits power up and check to see if AVDD is above the UVLO threshold. CEN going low in any state where outputs are active causes a sequenced power-down and a transition to {STANDBY}, then onward to {RESET}. If CEN goes low in {ACTIVE} and goes high before the power-off sequence completes, the outputs restart following the power-on sequence when CEN = HIGH and PWRON is asserted without entering {RESET}.

When the power-off sequence is triggered by CEN going low, a shutdown period starts when the last output is powered off. The maximum Tshutdown setting of the output rails sets the shutdown period. At the end of the shutdown period, the FSM transitions to {STANDBY} and then {RESET}, which means the on-chip active discharge circuit stops working, and the output capacitors discharge by the external load current.

Note: When a fault or PWRON de-assertion triggers the power-off sequence, CEN being low is ignored if CEN goes low during the sequencing and goes back high before the sequence completes.

9.2 PWRON

Power-on (PWRON) is a configurable input offering with an on/off switch or push button support. PWRON polarity is configurable in both on/off switch and push-button mode. When configured as an on/off switch, the input is an active high or low (depending on the polarity setting) level-sensitive input. When configured as a push-button input, the input must be asserted low or high (depending on the polarity setting) for a programmable long duration (in seconds) to internally set the PWRON signal. The supported periods are 1s, 1.5s, 2s, and 3s. A long push button is required for initiating each of the power-on and power-off sequences.

When the internal PWRON signal is asserted, the FSM enters {STANDBY_EXIT}, then onwards to {STANDBY_TO_ACITVE} where it enables the regulators and starts the power-on sequence following the configurations loaded from EEPROM. When the internal signal is de-asserted, all the regulators are powered down, and the MPIOx outputs are asserted following the sequence configured in the register settings.

9.3 Multi Purpose I/O

The RAA215300 includes a set of multiple purpose inputs/outputs (MPIO0 to 5) with programmable functionalities.

If configured as either a Reset Output, External VR EN Output, or External VR power-good Input, during power-on/off each MPIOx has a power-on/off delay, which is set in MPIOx Power-On and MPIOx Power-Off registers. The power-on and power-off delay can be programmed from 0 to 127ms. The polarity, type, and function of each MPIOx can be configured independently by the MPIOx_Config registers. Each MPIOx can be set to either active low or active high using the register bit MPIOx_Invert. Each MPIOx can be set to general purpose input/output or a specific function. The supported functions for each pin are shown in Table 2. When an MPIOx is set as a general purpose input, its status is read from the MPIO_Input_Status register. When an MPIOx is set as a general purpose output, it can be set to LOW or HIGH using the MPIO_I2C_Output register.

When an MPIOx is set to output, four different types can be selected from register bits MPIOx_Type[1:0]: high impedance, open-drain NMOS output, open-drain PMOS output, or full CMOS output. When set to an open-drain NMOS output, the MPIO needs to be pulled up to an external voltage higher than the VIH threshold through a resistor, but within its allowable operating range. When set to open-drain PMOS output, the MPIO needs to be pulled down to GND through a resistor. When set to full CMOS output, the MPIO does not need an external pull-up voltage as it is pulled up to VIO internally.

It is acceptable to have multiple MPIOx configured with the same function.



The MPIOx configuration registers (0x8A - 0x8F) can be locked by the MPIO Config Lock bit to prevent the user from accidentally changing the MPIOx configurations. When this bit is set to 1, the registers at 0x8A - 0x8F are locked, which means that writing to those registers is ignored. The values in those registers can still be read back. After being set to 1, this bit cannot be set back to 0 until POR.

See the pin mapping shown in Table 2.

Function	Туре	MPIO0	MPIO1	MPIO2	MPIO3	MPIO4	MPIO5
Unused MPIOx Pin	-	Yes	Yes	Yes	Yes	Yes	Yes
External VR PGOOD Input	Input	Yes	Yes	Yes	Yes	Yes	Yes
Input to I ² C Register	Input	Yes	Yes	Yes	Yes	Yes	Yes
PGOOD Output	Output	Yes	Yes	Yes	Yes	Yes	Yes
Reset Output	Output	Yes	Yes	Yes	Yes	Yes	Yes
External VR EN Output	Output	Yes	Yes	Yes	Yes	Yes	Yes
Output to I ² C Register	Output	Yes	Yes	Yes	Yes	Yes	Yes
32kHz Clock (32K_CLK)	Output	-	-	Yes	-	-	-
SLEEP#	Input	-	-	-	Yes	-	-
WDT_RST#	Input	-	-	-	-	Yes	-
CRST_IN#	Input	-	-	-	-	-	Yes

Table 2. MPIOx Supported Functions

9.3.1 Unused MPIOx Pin

If an MPIO is not used, Renesas recommends setting the respective MPIO Type to Disabled (high impedance) and MPIO Function to Disabled in EEPROM. Any MPIO can be disabled. When disabled, it is high-impedance.

If the user does not want to program EEPROM when an MPIO is not used, the MPIO that is configured as an output can be left floating. The MPIO that is configured as an input needs to be connected to a known voltage to ensure it is in the de-assertion state.

9.3.2 External VR PGOOD Input

Any MPIO can be set to perform this function. When asserted, this signal pauses the power-on or power-off sequence timing of the RAA215300, providing a way to sequence the RAA215300 with an external regulator. The expected External VR PGOOD Input delays are set by the applicable MPIO power-on and power-off delays. Only the outputs with delay settings that are larger than the External VR PGOOD Input MPIO delay setting (relative to PWRON) are affected by the assertion or de-assertion of this MPIO input signal.

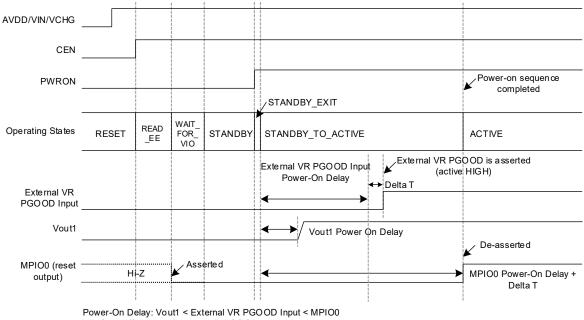
During power-on, when PWRON is asserted, the External VR PGOOD Input is expected to be asserted by the host within the delay time set in the MPIO Power-On register. If External VR PGOOD Input is not asserted before the MPIO delay expires, the power sequence pauses and waits for the signal to toggle. The delay timers of the outputs start to count when PWRON is asserted and are paused when the External VR PGOOD Input MPIO delay timer expires. When this input is asserted by the host, the power sequence continues. If External VR PGOOD Input MPIO delay Input is asserted by the host, the power sequence continues. If External VR PGOOD Input is asserted by the host, the power sequence continues.

During power-off, when PWRON or CEN is de-asserted, the External VR PGOOD Input is expected to be deasserted within the delay time set in the MPIO Power-Off register. If External VR PGOOD Input is not de-asserted, the power sequence pauses and waits for the signal to toggle. The delay timers of the outputs start to count when PWRON or CEN is de-asserted and are paused when the External VR PGOOD Input MPIO delay timer expires. When External VR PGOOD Input is de-asserted by the host, the power sequence continues. If External VR PGOOD Input is de-asserted before the MPIO delay expires, the outputs are not paused. When only one MPIO is set to the External VR PGOOD Input function, the power-on or power-off delay of each output is calculated using Equation 1 where t_x is the delay setting of the output, T is the time when the External VR PGOOD Input is asserted or de-asserted after PWRON is asserted or de-asserted, and t_{MPIO} is the delay setting of the External VR PGOOD Input.

(EQ. 1) $t_{delay} = t_x + max(0, T - t_{MPIO})$

When multiple MPIOs are set to the External VR PGOOD Input function, the power-on or power-off delay of each output is calculated using Equation 2.

(EQ. 2) $t_{delay} = t_x + max(0, T_y - t_{MPIOy}, ..., T_N - t_{MPION})$



MPIO0 is affected by External VR PGOOD assertion.

Figure 17. Power-On Example - External VR PGOOD Input



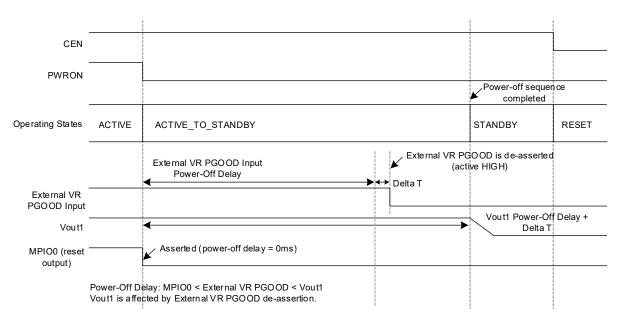


Figure 18. Power-Off Example - External VR PGOOD Input

9.3.3 Input to I²C Register

Any MPIO can be set to support this function. When an MPIO is set to this function, it is a general-purpose input. Its status can be read from the MPIO Input Status register.

9.3.4 PGOOD Output

Any MPIO can be set to support this function. The MPIOx can each be configured to assert PGOOD dependent on the internal power-good signal of a selected rail, or the logical AND of all enabled buck and the power-good signals of the LDO rails. An internal PGOOD signal is asserted when the output voltage is above the PGOOD threshold. PGOOD assertion during power-on signifies the rising threshold has been met, and the soft-start sequence is complete.

When an MPIO is set as a PGOOD output, the MPIO Power-On Delay register bits [3:0] are used to set which regulator output is used for the PGOOD output. In this case, Bits [6:0] in this register are no longer used as a power-on delay.

Note: If any buck or LDO regulator is disabled, and PGOOD output is set to **AND of all regulators PGOOD**, the PGOOD signal is not asserted during power-on. In this case, the PGOOD output needs to be set to another regulator PGOOD.

9.3.5 Reset Output

Any MPIO can be set to support this function. The reset output provides a system reset signal. There can be more than one reset output required in the system, including processor reset (PRST#) and eMMC reset (eRST#). Multiple MPIO can be configured as reset outputs.

The reset output is asserted as soon as the EEPROM recall is completed. During power-on when PWRON is asserted, the reset output is de-asserted after the delay time set in the MPIOx Power-On register. During power-off when CEN or PWRON is de-asserted, the reset output is asserted after the delay time set in the MPIOx Power-Off register.

9.3.6 External VR EN Output

Any MPIO can be set to support this function. This output can be used as an enable signal to control an external regulator power-on/off. It should be configured such that when asserted by RAA215300 the signal enables the external regulator, and when de-asserted it should disable the external regulator.



Any MPIOx with this function is initially de-asserted as soon as the EEPROM recall is completed. During power-on when PWRON is asserted, the VR_EN Output is asserted after the delay time set in the MPIOx Power-On register. During power-off when CEN or PWRON is de-asserted, the VR_EN is de-asserted after the delay time set in the MPIOx Power-Off register.

9.3.7 Output to I²C Register

Any MPIO can be set to support this function. The MPIOx can be asserted HIGH or LOW with software control by setting the related bit in the register.

9.3.8 32kHz Clock (32K_CLK)

Only MPIO2 supports this function. The function provides a driven clock signal output for external devices. The clock frequency is programmable with a maximum setting of 32.768kHz, which is the RTC crystal oscillator frequency. The RTC needs to be enabled by the RTC_EN bit to output this clock signal. If the user does not have an external pull-up voltage, the MPIO2 needs to be configured as a Full CMOS output.

When this function is selected, the MPIO2 Power-Off Delay register Bits [3:0] are used to select the clock frequency. In this case, Bits [6:0] in this register are no longer used as a power-off delay. See the Register Map.

9.3.9 SLEEP#

Only MPIO3 supports this function. This is an edge-triggered, hardware control input to control switching the device between {SLEEP} and {ACTIVE} operating states. The RAA215300 transitions from {ACTIVE} to {SLEEP} (through {ACTIVE_TO_SLEEP}) when SLEEP# is asserted, and transitions from {SLEEP} to {ACTIVE} (through {SLEEP_TO_ACTIVE}) when SLEEP# is de-asserted.

When MPIO3 is set to other functions, the sleep/active state can be controlled by software using the SLEEP_State_EN bit to control {SLEEP} mode entry/exit. When SLEEP State EN bit = 1, the device transitions to {ACTIVE_TO_SLEEP}, and when SLEEP_State_EN bit = 0, the device transitions to {SLEEP_TO_ACTIVE}. The hardware input and software bit control have a logical OR relationship, see Table 3. To maintain hardware control, the bit should be kept at 0, whereas to maintain bit (software) control the hardware input must internally de-assert the signal (0) as determined by the MPIO3_Invert configuration.

SLEEP# State	SLEEP_State_EN bit setting (0x6C[7])	Selected Operating State								
When configured active LOW, MPIO3_Invert = Active low										
LOW (1)	{SLEEP}									
LOW (1)	1	{SLEEP}								
HIGH (0)	0	{ACTIVE}								
HIGH (0)	1	{SLEEP}								
When configured active HIGH, M	PIO3_Invert = Active high									
HIGH (1)	0	{SLEEP}								
HIGH (1)	1	{SLEEP}								
LOW (0)	0	{ACTIVE}								
LOW (0)	1	{SLEEP}								

Table 3. {	{SLEEP}<->	{ACTIVE}	Mode	Control
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9.3.10 WDT_RST#

Only MPIO4 supports this function. This is a falling edge triggered input signal. When the watchdog timer is enabled, this signal is used to reset it before the timer expires. If the watchdog timer is disabled, this signal is ignored. See Watchdog Timer for the details.

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9.3.11 CRST_IN#

Only MPIO5 supports this function. The CRST_IN# input is edge triggered and acts as a hardware reset signal. When the MPIO5_Invert = Active LOW, the signal is asserted on the falling edge of MPIO5. When MPIO5 Invert = Active HIGH, the signal is asserted on the rising edge of MPIO5. The minimum pulse width requirement is 1.5µs (typical) because of internal de-glitching and synchronization to the internal clock. This signal is only valid in {ACTIVE} or {SLEEP}.

When CRST_IN# is asserted:

- If currently in {SLEEP}, the RAA215300 enters {ACTIVE}. The device does not enter {SLEEP} until the reset cycle has been completed or the related latched fault has been cleared.
- The CRST_Triggered_Latched and CRST_Triggered_Live fault bits are set. INT# is pulled LOW if not masked.
- The following occurs if the CRST_Fault_EN bit = Disabled:
 - The RAA215300 enters {IORESET}. Any MPIOx configured as reset outputs are asserted immediately.
 - When CRST_IN# is de-asserted by the host, the reset outputs are de-asserted following the configured power-on sequence. The CRST_Triggered fault bits cannot be cleared until CRST_IN# is de-asserted.
- The following occurs if the CRST_Fault_EN bit = Enabled:
 - Any MPIOx configured as reset outputs are asserted and the output rails are shut down following the power-off sequence configured in the register settings. RAA215300 enters {FAULT_OUT}.
 - If the latched fault bit is subsequently cleared, the device transitions to {STANDBY}.

Note: Assertion of CRST_IN# is latched until the Sequencer FSM reaches {IORESET}. If CRST_IN# is asserted in {ACTIVE_TO_STANDBY} or {STANDBY_TO_ACTIVE}, the FSM can not reach {IORESET} at that time. The next time the FSM reaches {ACTIVE}, it can act on the latched CRST_IN# assertion, and jumps to {IORESET}.

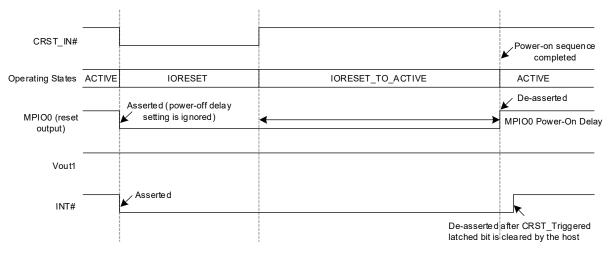
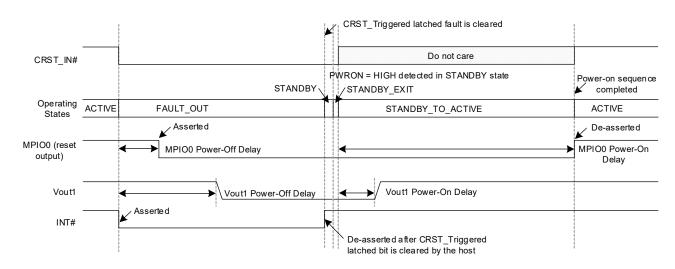


Figure 19. Example of CRST_IN# Operation - CRST_FAULT_EN = Disabled







9.3.12 Alternative Decodes for MPIOx functions

When an MPIO is configured as a PGOOD output, 32K_CLK, or Watchdog Timer Reset (WDT_RST#), the respective MPIOx Power-On Delay or MPIOx Power-Off Delay register bits settings are changed to a different set of decodes which works for this particular function. In this case, Bits [6:0] in this register are no longer used as power-on or power-off delay. See Table 4 for details.

MPIOx and Configured Function	Register Bits	Alternative Settings for the Register Bits
MPIO0 configured as PGOOD output	MPIO0 Power-On Delay register Bits [3:0]	Set which regulator is used for PGOOD output at MPIO0
MPIO1 configured as PGOOD output	MPIO1 Power-On Delay register Bits [3:0]	Set which regulator is used for PGOOD output at MPIO1
MPIO2 configured as PGOOD output	MPIO2 Power-On Delay register Bits [3:0]	Set which regulator is used for PGOOD output at MPIO2
MPIO2 configured as 32K_CLK	MPIO2 Power-Off Delay register Bits [2:0]	Set frequency for the 32K_CLK signal
MPIO3 configured as PGOOD output	MPIO3 Power-On Delay register Bits [3:0]	Set which regulator is used for PGOOD output at MPIO3
MPIO4 configured as PGOOD output	MPIO4 Power-On Delay register Bits [3:0]	Set which regulator is used for PGOOD output at MPIO4
MPIO4 configured as Watchdog Timer Reset	MPIO4 Power-Off Delay register Bits [3:0]	Set timeout period for the WDT
MPIO5 configured as PGOOD output	MPIO5 Power-On Delay register Bits [3:0]	Set which regulator is used for PGOOD output at MPIO5

Table 4. Alternative Decodes for MPIOx Functions

9.4 Watchdog Timer

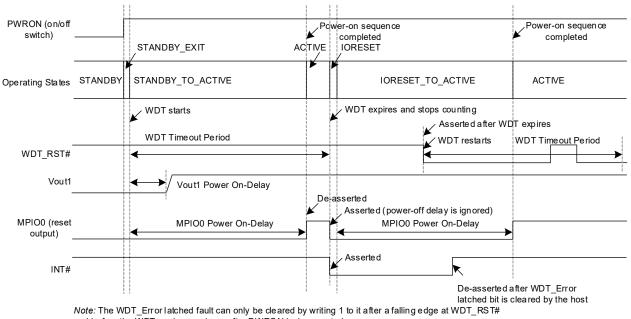
The WDT starts when the device reaches {STANDBY_TO_ACTIVE}, and is disabled again when the device reaches {STANDBY}. The function can be enabled/disabled in EEPROM.

The WDT feature can be used to detect a system boot-up failure. The function of MPIO4 needs to be set to WDT_RST# and the WD_EN bit needs to be set to 1 to enable this feature. MPIO4 Power-Off register Bits [3:0] are used to set the timeout period when MPIO4 is set to WDT_RST#. Register bits WD_PD_EN and WD_RST_EN are used to set the device behavior when the WDT feature is enabled.

The WDT_RST# input needs to be asserted by the host to reset the timer before it expires. If the watchdog timer expires, the RAA215300 takes the following steps:

- 1. If currently in {SLEEP}, the RAA215300 enters {ACTIVE} through {SLEEP_TO_ACTIVE}.
- 2. The WDT_Error_Latched and WDT_Error_Live fault bits are set. INT# is pulled LOW if not masked.
- 3. The following occurs if the WD_RST_EN bit = Enabled, WD_PD_EN bit = Disabled:
 - a. Any MPIOx configured as reset outputs are asserted immediately. The reset outputs are then de-asserted automatically following the power-on sequence.
 - b. The WDT stops counting when the WDT_Error fault bits are set. It does not start counting until WDT_RST# is asserted by the host. The WDT_Error fault can only be cleared by writing 1 after WDT_RST# is asserted and before the WDT expires again, or after PWRON is de-asserted.
- 4. The following occurs if the WD_PD_EN bit = Enabled:
 - a. Any MPIOx configured as reset outputs are asserted and the output rails are shut down following the power-off sequence configured in the register settings.
 - b. The WDT stops counting when the WDT_Error fault bits are set. It does not start counting until the WDT_Error bit is subsequently cleared by writing 1. The WDT_Error fault cannot be cleared until the power-off sequence finishes and the device enters {FAULT_OUT}. When the fault is cleared, the WDT starts counting (restarts power-on sequence).

Note: If both WD_PD_EN and WD_RST_EN are set to be enabled, the WD_PD_EN bit has higher priority and WD_RST_EN is ignored.



and before the WDT expires again, or after PWRON is de-asserted.



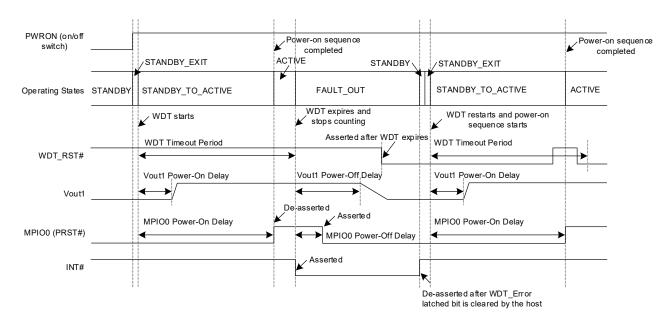


Figure 22. Example of WDT_RST# Operation - WD_PD_EN bit = Enabled

9.5 Power Sequencing

The power sequencing starts when PWRON is asserted in {STANDBY} and the device transitions to {ACTIVE}. The RAA2153000 regulators and MPIOx power-on delays are configured in the EEPROM.

The output voltage of each rail is monitored after it completes soft-start. If there is an undervoltage or overvoltage condition detected, the PGOOD output (if any MPIO is configured to this function) is de-asserted and the device enters {FAULT_OUT} (if these faults are configured to shut down the device).

9.5.1 Power-ON

The power-on delays for all rails are independently programmable from 0 to 127ms, with a 1ms step. All timing is based on entry to {ACTIVE}.

Each rail has a programmable startup slew rate.

9.5.2 Power-OFF

The power-off delays for all rails are independently programmable from 0 to 127ms, with a 1ms step. All timing is based on entry to {ACTIVE}.

Each rail has a programmable shutdown slew rate.

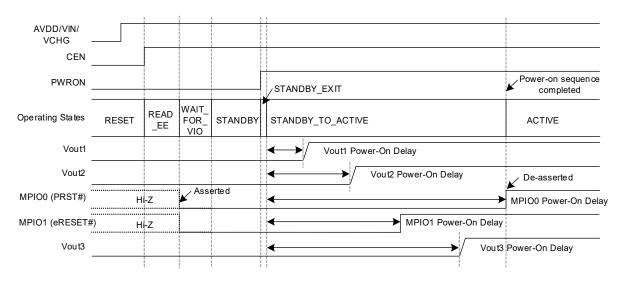
9.5.2.1 I²C Trigger Power-Off

The device includes a feature to trigger sequenced power-off operations triggered by an I²C command. Triggering requires sending a specific 8-bit key to the I2C_Trigger_Power_Off_Key bits.

This function is intended for use when the device is configured in long-push button mode, see PWRON.

The following are examples of power-on and power-off sequences in various configurations.







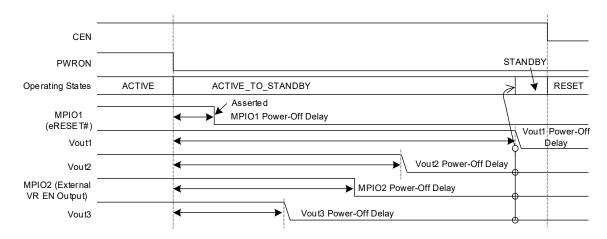


Figure 24. Typical Power-Off Example - PWRON as On/Off Switch

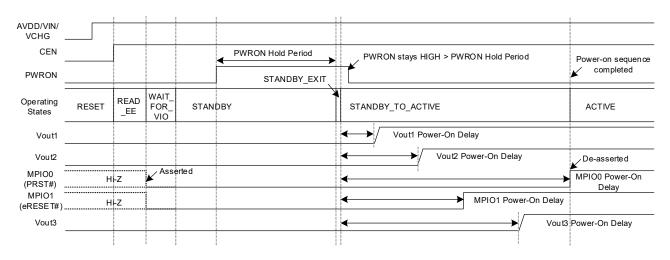
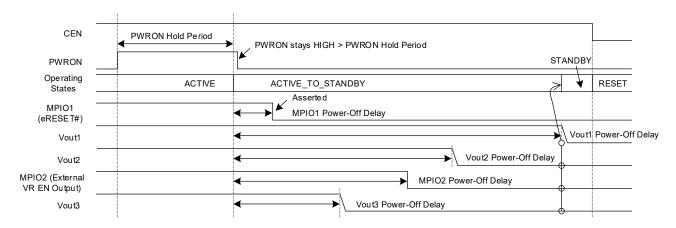
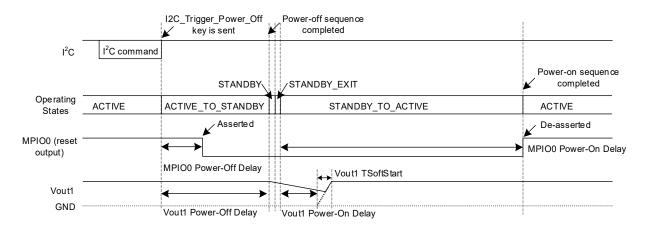
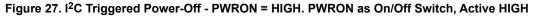


Figure 25. Typical Power-On Example - PWRON as Long Push Button









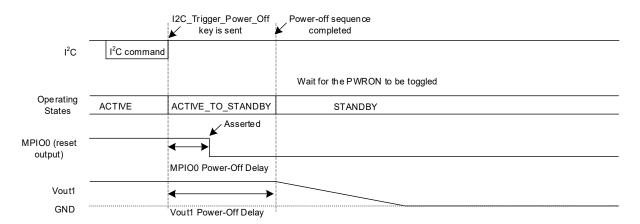


Figure 28. I²C Triggered Power-Off - PWRON = LOW. PWRON as Long Push Button, Active HIGH

9.6 Warm and Cold Reset

The RAA215300 features two types of software-controlled reset functions for controlling the application system (warm reset and cold reset). These resets can be separately triggered by setting the related volatile register bit to 1. Warm and cold reset bits should not be set simultaneously. When the selected reset operation is completed, the bit is automatically cleared to 0 in the volatile register.

The warm reset register bit is used to generate a system reset only. It does not recycle the RAA215300 output power rails. When triggered, the MPIO configured as reset outputs are asserted immediately. The reset signals are then de-asserted following the power-on timing set in their respective MPIOx Power-On Delay register. The LDO_SELx status may be changed because of the processor being reset, and the device responds accordingly.

The cold reset register bit generates a system reset and recycles the output power rails. When triggered, the MPIO configured as reset outputs are asserted following their power-off delay settings, and the output rails power down following their programmed sequence settings. When power-down completes, the FSM enters {STANDBY}. After a programmable delay set by the Cold Reset Delay register bits, the output rails are restarted based on their programmed sequence settings. The reset signals are then de-asserted following the power-on timing set in the respective MPIOx Power-On Delay register.

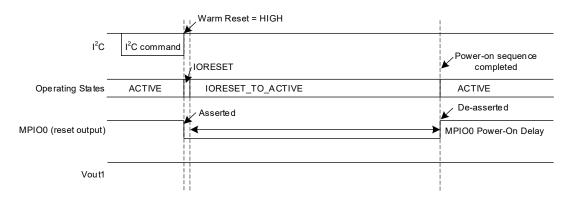


Figure 29. Warm Reset Operation

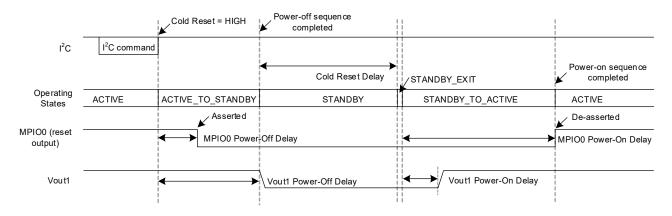


Figure 30. Cold Reset Operation



9.7 Output Discharge

There are four programmable options for the discharge of the buck rails:

- Set the regulator into Forced PWM (FPWM) mode and ramp down the reference following the programmed slew rate.
- Set the regulator into PFM/PWM mode and ramp down the reference following the programmed slew rate.
- Discharge the output rails using programmable discharge resistors. This option disables the regulator, turns the discharge switch on, and ramps down the reference following the programmed slew rate.
- Discharge the output rails using programmable discharge resistors. This option disables the regulator and turns the discharge switch on without ramping down the reference first providing a simple RC discharge rate.

There are two programmable options for the discharge of the LDO rails:

- Discharge the output rails using programmable discharge resistors. This option disables the regulator, turns the discharge switch on, and ramps down the reference following the programmed slew rate.
- Discharge the output rails using programmable discharge resistors. This option disables the regulator and turns on the discharge switch without ramping down the reference first providing a simple RC discharge rate.

During startup, there is no active discharge. Discharge functionality is disabled until after the state machine reaches {ACTIVE} or {ACTIVE_TO_STANDBY}. Active discharge is disabled in {RESET}.

Note: In VTT mode, check that the DDR manufacturer's recommendations are achieved during the discharge of VDDQ (typically Buck2) and VTT (Buck6).

9.8 DVS

The RAA215300 employs dynamic voltage scaling (DVS) to optimize power and efficiency in the system. The DVS features programmable DVS ramp-up/down slew rates for each rail that are applied when the output voltage(s) are changed. The common usage is to change the output voltages between {ACTIVE} and {SLEEP}. Exiting {SLEEP} often occurs to handle a real-time request; therefore, a fast slew rate is often required.

DVS is also used when changing the output voltage during {ACTIVE}. When the new output voltage is written into the register, the DVS block slews the output voltage to the new target based on the programmed rate.

Figure 31 illustrates the DVS between {ACTIVE} <-> {SLEEP} state transitions with delays.

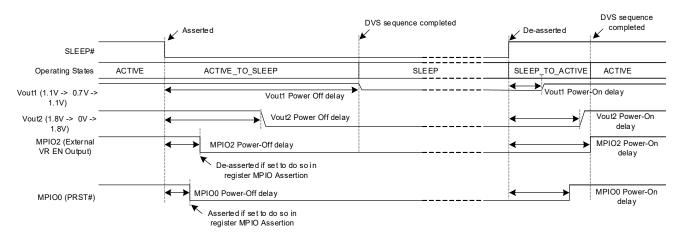


Figure 31. {ACTIVE} <-> {SLEEP} DVS Transition Example

Note: Not all DVS rate setting options (primarily the faster rate options) for the buck and LDO rails may be attainable in certain application configurations and conditions. DVS settings program a target for the rate of change of output voltage. The maximum rate of increase for the output voltage is limited by current limit, load current, and load capacitance. The maximum rate of decrease for the output voltage is limited by load current and

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load capacitance. The maximum and minimum rates of increase and decrease in the output voltage can be less than the DVS setting.

9.9 Real-Time Clock

9.9.1 Clock

The RTC is a low-power real-time clock with timing and crystal compensation, clock/calendar, power fail indicator, periodic or polled alarm, intelligent battery backup switching, and battery-backed user SRAM. The oscillator uses either an external, low-cost 32.768kHz crystal or an external clock IC. The real-time clock tracks time with separate registers for hours, minutes, and seconds. The clock format can be set to either AM/PM or 24-hour. There are calendar registers for the date, month, year, and day of the week. The calendar is accurate until 2099.

The RTC clock/calendar portion is fully operational from 1.8V to 5.5V. See VCHG, VBAT, and VRTC for more details.

The accuracy of the real-time clock depends on the external 32.768KHz crystal or clock IC. The RAA215300 provides on-chip crystal compensation networks to adjust load capacitance to tune the crystal oscillator frequency. See Oscillator Frequency Accuracy for details.

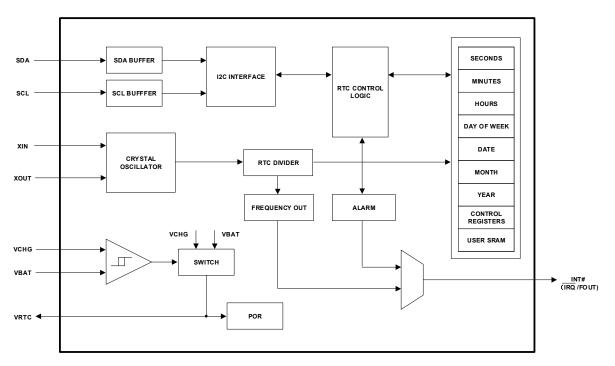


Figure 32. RTC Block Diagram

Note: To activate the RTC, the host must first set the RTC EN bit = 1 and the WRTC bit = 1. If using an external crystal, the XTOSCB bit needs to be set at 0 to enable the crystal oscillator. If using an external clock signal, set the XTOSCB bit as 1 to disable the crystal oscillator. Then, the date and time registers can be set accordingly, and the RTC is clocking and maintaining time. The clock does not increment until at least 1 byte is written to the clock/calendar registers.

INT# is a multi-functional output that can issue an interrupt or frequency signal. The function is selected by frequency out (FO) control bits. In interrupt mode, if an alarm condition occurs, the Interrupt Request (IRQ) is sent to the host processor. In Frequency Output (FOUT) mode, the output is a clock signal at a frequency generated from the crystal frequency.

The I²C interface is not functional if VIO_PGOOD is low. See VCHG, VBAT, and VRTC for more details.

9.9.2 Alarm

The flexible alarm of the RTC can be set to any clock/calendar value for a match. For example, every minute, every Tuesday, or at 5:23 AM on March 21. The alarm status is available by checking the Status Register, or the device can be configured to provide a hardware interrupt using INT#. A backup power input (VBAT) allows the device to be powered by a battery or supercapacitor with an automatic switchover between VCHG and VBAT.

The alarm compares the alarm registers with the RTC registers. As the RTC advances, the alarm is triggered when a match occurs. The alarm is enabled by the ALME bit. There are two alarm modes: single-event mode and periodic interrupt mode.

Single-event mode is enabled by setting the ALME bit to 1, the IM bit to 0, and the FO[3:0] bits to 0000. This mode detects a one-time match between the alarm registers and RTC registers. When this match occurs, the interrupt request (IRQ) is sent to the host processor. The ALM bit is set to 1, and the INT# output is pulled low and remains low until the ALM bit is reset.

The periodic interrupt mode allows for repetitive or recurring alarm functionality. This mode is enabled by setting the ALME bit to 1, the IM bit to 1, and the FO[3:0] bits to 0000. There is an alarm each time there is a match of the alarm time and present time. Therefore, there is an alarm as often as every minute (if only the nth second is set) or as infrequently as once a year (if at least the nth month is set). During Periodic Interrupt Mode, INT# is pulled low for 250ms, and the alarm status bit (ALM) is set to 1.

Note: The ALM bit can be reset by writing 0 to it or cleared by a valid read operation in the auto reset mode. The alarm function can be enabled/disabled during battery backup mode using the FOBATB bit.

The INT# output is updated every 250ms (typical) when used as the IRQ output. The INT# output is pulled low 250ms after the alarm is triggered. After the INT# output is pulled low, it is low for at least 250ms, even if the correct action is taken to clear it. It is impossible to clear ALM if it is still active. The host must wait for the RTC to progress past the alarm time plus the 250ms delay before clearing ALM. Alternatively, the host may set ALME = 0 before clearing ALM. There is an internal delay (typically around 250µs) from setting ALME = 0 to disabling the alarm function, so the user must add a short delay of greater than 250µs between setting ALME = 0 and clearing ALM. Therefore, the host must wait for 250ms plus the short delay to detect the release of INT# after INT# is pulled low.

9.9.3 Frequency Output

A clock signal related to the oscillator frequency can output from INT# or MPIO2.

FOUT from INT# is enabled by setting FO[3:0] bits to a non-zero value. The frequency is selected using the I^2C bus. See Table 5.

FO3	FO2	FO1	FO0	FOUT from INT# (Hz)
0	0	0	0	0
0	0	0	1	32768
0	0	1	0	4096
0	0	1	1	1024
0	1	0	0	64
0	1	0	1	32
0	1	1	0	16
0	1	1	1	8
1	0	0	0	4
1	0	0	1	2
1	0	1	0	1

Table 5. Frequency Selection of FOUT at INT#



FO3	FO2	FO1	FO0	FOUT from INT# (Hz)
1	0	1	1	1/2
1	1	0	0	1/4
1	1	0	1	1/8
1	1	1	0	1/16
1	1	1	1	1/32

Table 5. Frequency Selection of FOUT at INT#

If enabled, a clock signal is outputted from MPIO2(see Table 6). For detailed information about MPIO2 frequency output, see 32kHz Clock (32K_CLK).

MPIO2 Power-Off Delay[2:0]	MPIO2 (Hz) - MPIO2 configured as 32K_CLK
000	32768
001	16384
010	8192
011	4096
100	2048
101	1024
110	512
111	256

Table 6. Frequency Selection of Clock Signal at MPIO2

9.9.4 General Purpose User SRAM

The RTC has 2 bytes of user SRAM, which continue to operate in battery backup mode. However, the I²C bus is disabled if VCHG falls below the AVDD UVLO falling threshold.

9.9.5 **Power Control Operation**

There are two power supply inputs for the RTC circuit (VCHG and VBAT). The RAA215300 contains internal circuitry to automatically switch over to the backup battery when the main VCHG supply fails and switches back from the battery to VCHG when the main supply recovers. See VCHG, VBAT, and VRTC for details.

9.9.6 Power Failure Detection

The RAA215300 has a Real-Time Clock Failure (RTCF) bit to indicate total power failure. The RTCF bit is read-only and is set to 1 if the RTC has powered up after the failure of both VCHG and VBAT.

The bit is set regardless of whether VCHG or VBAT is applied first. At power-up after a total power failure, all registers are set to their default states, and the clock does not increment until at least 1 byte is written to the clock register. The first valid write to the RTC section resets the RTCF bit to 0.

9.9.7 Crystal Oscillator

A crystal can be used to generate the 32.768kHz clock and provide the time base for the RTC.

9.9.7.1 Oscillator Frequency Accuracy

The oscillator frequency accuracy primarily depends on the crystal accuracy and the match between the crystal and the load capacitance. If the load capacitance is too small or too large, the oscillator is too fast or too slow, respectively. RAA215300 provides an oscillator frequency adjustment mechanism that includes analog



compensation in the RTC ATR register and digital compensation in the RTC DTR register. The combination of analog and digital trimming can give a maximum range of adjustment of -80ppm to +130ppm.

Note: Both of the frequency outputs on INT# and MPIO2 are affected by the setting in the RTC ATR register. The frequency on INT# is affected by the RTC DTR setting at all frequencies except the 32.768kHz setting. The frequency on MPIO2 is not affected by the RTC DTR setting.

9.9.7.2 Crystal Oscillator Frequency Trimming

The RAA215300 provides the option of timing correction of the crystal oscillator. Analog and digital compensation mechanisms are available as follows.

9.9.7.2.1 Analog Trimming with On-Chip Load Capacitance

The analog trimming register bits (ATR[5:0]) are used to trim oscillator frequency by selecting on-chip load capacitance. There are six bits for ATR, and the selectable range is from 4.5pF to 20.25pF. The available trim range of the oscillator frequency accuracy in ppm varies with crystals, operating temperature, and the stray capacitance of the PCB. As an example, the available PPM range for an ECX-.327-CDX-1293 crystal is -20ppm to 70ppm measured on the device evaluation board at 25°C.

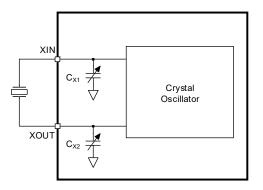


Figure 33. Diagram of On-Chip Load Capacitance

The on-chip load capacitance (C_{LOAD}) is the series combination of C_{X1} and C_{X2} shown in Figure 33. C_{X1} and C_{X2} range from 9pF to 40.5pF. The values of C_{X1} and C_{X2} are given in Equation 3:

(EQ. 3) $C_x = (16 \cdot \overline{b5} + 8 \cdot b4 + 4 \cdot b3 + 2 \cdot b2 + 1 \cdot b1 + 0.5 \cdot b0 + 9) pF$

1

The series load capacitance (C_{LOAD}) is derived by Equation 4:

(EQ. 4)

$$C_{LOAD} = \frac{1}{\left(\frac{1}{C_{X1}} + \frac{1}{C_{X2}}\right)}$$
$$C_{LOAD} = \left(\frac{16 \cdot \overline{b5} + 8 \cdot b4 + 4 \cdot b3 + 2 \cdot b2 + 1 \cdot b1 + 0.5 \cdot b0 + 9}{2}\right) pF$$

For example, $C_{LOAD} = 12.5$ pF when ATR[5:0] = 00000, $C_{LOAD} = 4.5$ pF when ATR[5:0] = 00000, and $C_{LOAD} = 20.25$ pF when ATR[5:0] = 011111.

9.9.7.2.2 Battery Backup Mode Analog Trimming

The crystal oscillator frequency accuracy can change when the RTC is supplied by different power sources (VCHG or VBAT). The on-chip load capacitance offset between VCHG mode (VRTC supplied by VCHG) and battery backup mode (VRTC supplied by VBAT) is adjustable by BMATR[1:0]. The available range is from -0.5pF to 1pF.

9.9.7.2.3 Digital Trimming

The oscillator frequency is also affected by the digital trimming bits DTR[2:0] in the RTC DTR register. The DTR trim setting modifies the divider stage in the RTC digital block. The available trim range is from -60ppm to +60ppm. It is used for coarse adjustments of frequency drift over temperature or extending the adjustment range provided by the ATR settings.

9.9.7.2.4 Crystal Oscillator Frequency Adjustment

The Initial accuracy of the crystal oscillator can be adjusted by enabling the frequency output on INT# and monitoring it with a calibrated frequency counter. The gating time on the counter should be set long enough to ensure the accuracy of the reading. The ATR[5:0] bits can be set to 000000, to begin with. After the initial measurement is made, the RTC ATR register can be changed to tune the frequency. If the initial measurement shows the frequency is far off, then the DTR[2:0] can be used to do a coarse adjustment. Most crystal oscillators have tight enough accuracy at room temperature that the RTC ATR register adjustment should be all that is needed.

9.9.7.3 Temperature Compensation

The external crystal temperature drift is progressively worse as the crystal temperature deviates from +25°C. Figure 34 shows an example of temperature drift characteristics. There is a turnover temperature (T0) where the drift is near zero. The shape is parabolic because it varies with the square of the difference between the actual temperature and the turnover temperature.

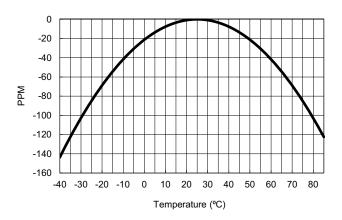


Figure 34. RTC Crystal Temperature Drift Example

A possible system to implement temperature compensation would consist of the RAA215300, a temperature sensor, and a microcontroller. These devices may already be in the system, so the function could just be a matter of implementing software and performing some calculations. Fairly accurate temperature compensation can be implemented just by using the crystal specifications for the turnover temperature T0 and the drift coefficient (β). Equation 5 is used to calculate the oscillator adjustment necessary,

(EQ. 5) Adjustment(ppm) = $(T - T_0)^2 * \beta$

When the temperature curve for a crystal is established, the designer should decide at what discrete temperatures the compensation changes.

A sample curve of the ATR[5:0] setting vs Frequency Adjustment for the RAA215300 and a typical RTC crystal is given in Figure 35. This curve may vary with different crystals and PCBs, so it is good practice to evaluate a given crystal in the RAA215300 circuit before establishing the adjustment values. The curve is then used to determine ATR[5:0] and DTR[2:0] settings. The results could be placed in a lookup table for the micro-controller to access.

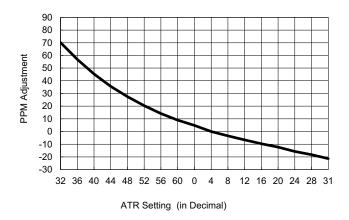


Figure 35. ATR Setting Vs. Crystal Oscillator Frequency Adjustment

9.9.8 Using an External Clock

The RTC can use either a standard 32.768kHz crystal or an external clock. XIN can be programmed for connection to an external clock input using the XTOSCB bit in the RTC SR register. When this bit is set to 1, the oscillator is disabled and XIN is a CMOS-compatible clock input.

The external clock input must be logic level CMOS (0.3 x VBAT LOW, 0.7 x VBAT HIGH), square wave preferred, frequency = 32.768KHz. The clock signal used for the XIN input must come from a source with the same voltage level as the VBAT of the RAA215300 device.

To check if the external clock is working properly, the following methods can be used to check the RTC function:

- Poll the time register to make sure the seconds are advancing at the correct rate.
- Enable the frequency on INT# or MPIO2: Clock and monitor the frequency for the correct value.

9.9.9 Real-Time Clock Registers

9.9.9.1 Clock and Calendar Registers [Address 0x00 to 0x06]

Time is set in BCD format by the following registers:

- RTC SC and RTC MN registers: Sets seconds and minutes that range from 0 to 59.
- RTC HR register: Sets hour that ranges from 0 to 23 or 1 to 12.
- RTC DT register: Sets date that ranges from 1 to 31.
- RTC MO register: Sets month that ranges from 1 to 12.
- RTC YR register: Sets year that ranges from 0 to 99.
- RTC DW register: Sets day of the week that ranges from 0 to 6.

See Register Map Detail for bits decoding.

A 12-hour or 24-hour format can be set by the MIL bit. If it is set to 1, the RTC uses a 24-hour format. If it is set to 0, the RTC uses a 12-hour format. In this case, the HR21 bit functions as an AM/PM indicator with 0 representing AM and 1 representing PM. The clock defaults to a 12-hour format time with HR21 = 0.



Note: To maintain correct month and date registers, the host must force the RTC MO and RTC DT registers to the correct values in specific years, as shown in Table 7.

Year	Action Required by the Host				
00/04/08/20/24/28/40/44/48/60/64/68/80/84/88	Force the RTC MO register to 00011 (March) after 11:59:59pm on February 29				
10/14/18/30/34/38/50/54/58/70/74/78/90/94/98	Force the RTC MO register to 00011 (March) and RTC DT register to 000001 (date 01) after 11:59:59pm on February 28				
12/16/32/36/52/56/72/76/92/96	Force the RTC MO register to 00010 (February) and RTC DT register to 101001 (date 29) after 11:59:59pm on February 28				

 Table 7. Actions Required by the Host in Specific Years

9.9.9.2 Control and Status Registers [Address 0x07 to 0x0B]

9.9.9.2.1 RTC Status Register (RTC SR)

This is a volatile register that sets RTC functions and reports status. The following sections detail each bit.

Real-Time Clock Fail Bit (RTCF)

This read-only bit is set to 1 by the device after a power failure where both VCHG and VBAT lose power. After a power failure, all registers are set to their default states when the device powers up again. The host must reactivate the RTC. The first valid write operation to the RTC registers after a power failure resets the RTCF bit to 0.

Battery Bit (BAT)

This bit is set to 1 by the device when the RTC enters battery backup mode. When VCHG is valid again, this bit can be reset either by the host (by writing 0 to it) or automatically reset if ARST = 1.

Alarm Bit (ALM)

This bit is set to 1 if the alarm matches the real-time clock. It can be reset to 0 by the host (by writing 0 to it) or automatically reset if ARST = 1. Writing 1 to this bit is not accepted.

If the ALM bit is set during an RTC SR register reading operation, it remains set after the reading operation is complete.

Write RTC Enable Bit (WRTC)

The WRTC bit enables or disables writing capability into the RTC clock and calendar registers. The factory default setting of this bit is 0. On initialization or power-up, the WRTC bit must be set to 1 to enable the RTC. At the completion of a valid write command (STOP), the RTC starts to count. The RTC internal 1Hz signal is synchronized to the STOP condition during a valid write cycle.

Crystal Oscillator Enable Bit (XTOSCB)

This bit enables/disables the internal crystal oscillator. When XTOSCB is set to 1, the oscillator is disabled, and XIN allows for an external 32.768kHz clock signal to drive the RTC. The XTOSCB bit is set to 0 on power-up.

Auto Reset Enable Bit (ARST)

This bit enables/disables the automatic reset of the BAT and ALM status bits only. When the ARST bit is set to 1, these status bits are automatically reset to 0 after a valid read operation of the respective status register (with a valid STOP condition). When ARST is set to 0, the host must reset the BAT and ALM bits.

9.9.9.2.2 RTC Interrupt Control Register (RTC INT)

This register can be used to control the frequency output and alarm function.

Frequency Out Control Bits (FO[3:0])

These bits enable/disable the Frequency Output function (FOUT) and select the output frequency at INT#. The selectable frequency is listed in Table 5. When the frequency mode is enabled, it overrides the alarm mode at INT#.

Frequency Output and Interrupt Bit (FOBATB)

This bit enables/disables the IRQ/FOUT function during battery backup mode (that is, VBAT power source active). When FOBATB is set to 0, both the Frequency Output and alarm output functions are disabled. When FOBATB is set to 1, the IRQ/FOUT function is enabled during battery backup mode.

Oscillator Bias Current Control Bit (LPMODE)

With LPMODE = 0, the device works with a normal oscillator bias current. With LPMODE = 1, the device works with a reduced oscillator bias current. Renesas does not recommend setting this bit to 1.

Alarm Enable Bit (ALME)

This bit enables/disables the alarm function. When the ALME bit is set to 1, the alarm function is enabled. When ALME is set to 0, the alarm function is disabled. The alarm function can operate in either single-event mode or periodic interrupt mode. See Alarm for more details.

Note: When the frequency output mode is enabled, the alarm function is disabled.

Interrupt/Alarm Mode Bit (IM)

This bit is used to select single-event mode or periodic interrupt mode. See Alarm for more details.

9.9.9.2.3 Trimming Registers RTC ATR and RTC DTR

Analog Trimming (ATR[5:0])

ATR[5:0] bits are used to trim the oscillator frequency by adjusting the on-chip load capacitance value. The on-chip load capacitance value ranges from 4.5pF to 20.25pF in 0.25pF steps. See Analog Trimming with On-Chip Load Capacitance for more details.

Battery Mode ATR Selection (BMATR [1:0])

BMATR[1:0] bits are used to set the on-chip capacitance offset between VCHG mode and battery backup mode. See Battery Backup Mode Analog Trimming for more details.

Digital Trimming (DTR [2:0])

DTR[2:0] bits are used to trim the oscillator frequency by modifying the digital stage in RTC. See Digital Trimming for more details.

9.9.9.3 Alarm Registers Addresses [0x0C to 0x11]

The alarm register bytes are mapped identical to the RTC register bytes, except that the MSB of each byte functions as an enable bit (1 means enabled). These enable bits specify which alarm registers are used to make the comparison. *Note:* There is no alarm byte for year.

The followings are examples of using single-event mode and periodic Interrupt mode.

Example 1 – Alarm set to single-event mode (IM = 0)

A single-event alarm occurs on January 1 at 11:30 am.

Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value	Description
RTC SCA	0	0	0	0	0	0	0	0	0×00	Seconds disabled
RTC MNA	1	0	1	1	0	0	0	0	0×B0	Minutes set to 30, enabled

Table 8. Register Settings in Example 1



Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value	Description
RTC HRA	1	0	0	1	0	0	0	1	0×91	Hours set to 11, enabled
RTC DTA	1	0	0	0	0	0	0	1	0×81	Date set to 1, enabled
RTC MOA	1	0	0	0	0	0	0	1	0×81	Month set to 1, enabled
RTC DWA	0	0	0	0	0	0	0	0	0×00	Day of week disabled
RTC INT	0	1	X ^[1]	X ^[1]	0	0	0	0	0×X0	Enable single-event mode

Table 8. Register Settings in Example 1 (Cont.)

1. X can be set to either 0 or 1 depending on the application.

After these registers are set, an alarm is generated when the RTC advances to exactly 11:30 am on January 1 (after seconds change from 59 to 00) by setting the ALM bit in the status register to 1 and also pulling the INT# output low.

Example 2 – Alarm set to periodic interrupt mode (IM = 1)

An interrupt occurs every minute when the value of the RTC SC register is at 30 seconds.

Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value	Description
RTC SCA	1	0	1	1	0	0	0	0	0×B0	Seconds set to 30, enabled
RTC MNA	0	0	0	0	0	0	0	0	0×00	Minutes disabled
RTC HRA	0	0	0	0	0	0	0	0	0×00	Hours disabled
RTC DTA	0	0	0	0	0	0	0	0	0×00	Date disabled
RTC MOA	0	0	0	0	0	0	0	0	0×00	Month disabled
RTC DWA	0	0	0	0	0	0	0	0	0×00	Day of week disabled
RTC INT	1	1	X ^[1]	X ^[1]	0	0	0	0	0×X0	Enable periodic interrupt mode

Table 9. Register Settings in Example 2

1. X can be set to either 0 or 1 depending on the application.

When the registers are set, the following waveform is seen at INT#. The status register ALM bit is set each time the alarm is triggered. See Alarm for details about clearing the ALM bit.

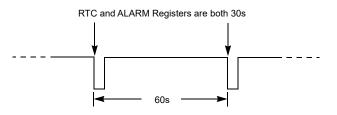


Figure 36. Periodic Interrupt Alarm Signal

9.10 Coin Cell Battery Charger

RAA215300 features a constant current charger to charge an external backup energy storage device to maintain power to the RTC when the VCHG supply falls. A typical energy storage device is a coin cell battery or supercapacitor connected to VBAT. The charger charges the external storage device when VCHG is higher than VBAT.

The charger is always off by default (after power-on or device reset) and must be enabled by I²C.

The charger supports selectable 20μ A or 60μ A (typical) charge currents. If the charger is enabled and VCHG is higher than VBAT, the charge current is supplied through VBAT. The charging termination voltage is selectable by I²C from 1.8V to 3.3V in 100mV steps.

The device does not automatically re-enable the charger when the voltage on the external storage device falls. The host should monitor the PGOODCCBAT fault bits (poll the register using I²C) to decide if and when the charger needs to be re-enabled to charge up the external storage device.

The battery sense comparator is disabled by default, and the PGOODCCBAT live bit stays at 0. The sense comparator is automatically enabled when the charger is enabled. The host can check the battery status by trying to enable the charger (writing 1 to CC Charger EN bit) every certain period of time (depending on the battery backup time), and the following occurs when the device receives the command:

- If VBAT voltage is above or at the target level (charging termination voltage), the charger is not turned on and CC Charger EN bit remains at 0.
- If VBAT voltage falls below the target level, the comparator and charger are enabled. The PGOODCCBAT live and latched bits are set. INT# is asserted if not masked.

The PGOODCCBAT latched bit can be cleared by writing 1 to it. This bit is edge sensitive. When cleared, it does not set until the next time VBAT falls below the target level. When VBAT reaches the target level, the charger and comparator are automatically disabled, and the PGOODCCBAT live bit is cleared, indicating VBAT PGOOD was attained.

9.10.1 Supercapacitor Backup Time

The supercapacitor backup time is calculated using Equation 6 where C_{BAT} is the capacitance value of the supercapacitor, V_{BAT1} is the battery voltage level when it is fully charged, V_{BAT2} is the voltage level when the battery needs to recharge, and I_{BAT} is the supply current drawn from the supercapacitor.

(EQ. 6)
$$T_{Backup}(seconds) = C_{BAT} \times \frac{V_{BAT1} - V_{BAT2}}{I_{BAT}}$$

For example, if $C_{BAT} = 0.1F$, $V_{BAT1} = 3V$, $V_{BAT2} = 1.8V$, and $I_{BAT} = 950nA$ (maximum) when RTC is clocking, the battery backup time is 126316 seconds which equals 35 hours, which means that the host needs to check the battery status every 35 hours.

Charging time is calculated using Equation 7 where I_{Charge} is the charge current set in the register.

(EQ. 7)
$$T_{Charge}(seconds) = C_{BAT} \times \frac{V_{BAT1} - V_{BAT2}}{I_{Charge} - I_{BAT}}$$

In the previous example, if $I_{Charge} = 60 \mu A$, the charge time is 2032 seconds which equals 0.56 hours.

Note: These examples provide an approximate estimation of the battery backup time and charging time. For precise results, characterize the supply current in relation to the voltage of the supercapacitor or coin-cell battery used in the system.

9.11 Buck Regulators

The RAA215300 has six synchronous buck regulators. Internal compensation is employed to simplify application design, reduce PCB space, and reduce the BOM cost. Each buck regulator has its own programmable output range, soft-start, power-up/down timing, switching frequency, and can be individually disabled by the register and EEPROM settings. Some of the buck regulators are optimized to support various DDR memory specifications but can also be used for general purposes. The buck regulators have various output voltage ranges and current ratings, allowing the system to be flexibly designed for improved performance, such as efficiency and voltage ripple. The buck regulators can be automatically reconfigured (by register settings) between {ACTIVE} and {SLEEP} for different applications or different power requirements.

The buck regulators have two operating modes: Auto PFM/PWM and FPWM. Each buck regulator can be set to the ultrasonic mode when operating in PFM (see Ultrasonic Mode) and can use a spread spectrum feature (see Spread Spectrum). A synchronous phase delay feature allows the switching of each buck regulator to be shifted in phase relative to the internal clock, which may improve EMC.

The buck regulators support Dynamic Voltage Scaling (DVS) with programmable ramp-up/down rates (see DVS), and offer various active discharge options (see Output Discharge). Various warnings and faults are monitored and reported (see Device Monitors, Warnings, and Protections).

Note: All buck supplies (BUCKx_VINx) = AVDD = VCHG.

9.11.1 Buck1

Buck1 supports the processor or SoC core power. It provides high efficiency, fast load transient response, and low ripple voltage. It can provide up to 5A. The output voltage can be set to 1.03V, and from 0.8V to 1.5Vin 50mV steps. *Note:* The switching frequency should be reduced when using outputs 1.03V and lower.

Buck1 supports high-current warning interrupt if the output current exceeds the programmable Buck1 High Current Threshold. It can be used as an early indicator for system thermal control. It is particularly helpful during the system design phase.

Buck1 configuration details are in registers 0x20 to 0x26.

9.11.2 Buck2

Buck2 supports DDR memory VDDQ rail. It can provide up to 1.5A. The output voltage can be set from 1.1V to 1.85V, in 50mV steps. If Buck2 powers DDR memory and VTT is required, connect VREFIN to the Buck2 output rail externally.

Buck2 configuration details are in registers 0x27 to 0x2D.

9.11.3 Buck3

Buck3 can provide up to 1.5A. The output voltage can be set from 1.8V to 3.3V, in 100mV steps. It can be used to power 1.8V or 3.3V I/O or other loads.

Buck3 configuration details are in registers 0x2E to 0x34.

9.11.4 Buck4

Buck4 can provide up to 3.5A. The output voltage can be set to 0.8V, 0.85V, 0.9V, 0.95V, 1.0V, 1.05V, 1.1V, 1.15V, 1.2V, 1.5V, 1.6V, 1.8V, 1.85V, 2.2V, 2.5V, or 3.3V. It can be used to power 1.8V or 3.3V I/O or other general loads. *Note:* Reduce the switching frequency when using outputs 1.6V and lower.

Buck4 configuration details are in registers 0x35 to 0x3B.

9.11.5 Buck5

Buck5 is a regulator for system peripherals such as WiFi or Ethernet. It can provide up to 0.6A. The output voltage can be set to 1.2V, 1.5V, 1.6V, 1.8V, 1.85V, 2.2V, 2.5V, or 3.3V. It can support up to 0.6A for outputs lower than 2.5V. When the set output voltage is 2.5V or 3.3V, the maximum load current capability derates.

Buck5 configuration details are in registers 0x3C to 0x42.

9.11.6 Buck6

Buck6 supports DDR VTT, which is required to sink (receive) and source (supply) currents up to ±1A. When the VTTREF EN bit = 1, Buck6 is configured for the DDR VTT application (VTT mode). The output voltage tracks the VREFIN input and the output voltage is fixed at VREFIN/2. The power-up/down sequence tracks the VREFIN per DDR memory specification. *Note:* Sink and source currents derate when the output voltage is 0.7V and higher. Also, sink currents and/or maximum input voltage derate when the output voltage is 0.575V or lower.

Buck6 configuration details are in registers 0x43 to 0x49.

9.11.7 Buck Operating Modes

The operating mode (Auto PFM/PWM and FPWM) is set by the Buckx_ACTIVE and Buckx_SLEEP registers.

In Auto PFM/PWM mode, the buck regulator transitions between PFM and PWM modes depending on load current. At light load, it enters PFM to reduce power consumption. As load current increases, the regulator transitions to PWM. PFM mode produces higher output voltage ripple than PWM mode. FPWM produces the lowest output voltage ripple at light load but it increases quiescent current.

FPWM mode makes the regulator operate at a fixed switching frequency, as programmed in EEPROM, irrespective of the load current. At light load, there is a negative inductor current (the current flows from output capacitance, through the inductor and low-side switch).

All bucks soft-start in PFM/PWM mode, irrespective of the mode setting. After soft-start completion, if selected, the device transitions to FPWM 300µs. The regulator is unable to create a negative inductor current until FPWM mode is established.

9.11.8 Ultrasonic Mode

Ultrasonic mode is an optional feature (set in EEPROM) of each buck regulator. Its purpose is to prevent PFM switching frequency from being within the audio frequency band.

9.11.9 Unused Buck

If a buck regulator is not required in a given application, configure that unused buck as follows:

- BUCKx_VINx = Always connect to the same supply as AVDD
- BUCKx_LXx = Open
- BUCKx_FB = GND
- Disable the BUCKx block in EEPROM by both Buckx_EN_ACTIVE and Buckx_EN_SLEEP bits.

A UV fault is triggered at startup if a buck regulator is enabled in the register settings but configured as unused on the board. The fault protection function is configured in the default settings to shut down all the outputs when a UV fault is detected. To avoid shutdown, disable the unused bucks in the EEPROM settings or before asserting PWRON.

When VTTREF_EN = Enabled and the register bit Link_Buck6_to_Buck2 is set to 1, Buck6 and Buck2 start up and shut down simultaneously, and settings of the following register bits are ignored: Buck6_EN_ACTIVE, Buck6_EN_SLEEP, Buck6_Power_On_Delay, and Buck6 Power_Off_Delay. When Link_Buck6_to_Buck2 is set to 0, sequencing of Buck6 and Buck2 is independent.

If VTTREF_EN = Enabled and Buck6 is unused, Link_Buck6_to_Buck2 must be set to 0.

9.11.10 Switching Frequency

The PWM switching frequency (f_{SW}) for each buck is programmable. Changing this setting on the fly using I²C is not recommended. It is preferred to change the frequency only when the output is disabled, or before PWRON assertion. See the Register Map for the available options for each regulator and default selections.



At the load where control changes from PFM to PWM, the switching frequency is not as high as its setting. As load increases, the switching frequency increases. The setting is a maximum.

9.11.11 Spread Spectrum

To improve EMC, spread spectrum operation is optional in each buck regulator. The switching frequency is modulated to reduce peak noise power.

9.11.11.1 PFM mode

The switching frequency depends on load current and peak switch current limit. A 10-bit pseudo-random pattern is applied to the peak switch current limit code to modulate the PFM switching frequency. The PFM spread spectrum modulation rate is adjusted using the 2-bit code Buck#_PFM_AM[1:0].

Each buck regulator has a bit to enable/disable PFM spread spectrum operation.

9.11.11.2 PWM Mode

There are two spread spectrum modulation schemes in PWM mode: pseudo-random and triangular, set by the SS_PWM_Mod bit. The 2-bit code PWM_AM[1:0] sets the amplitude of modulation. The PWM_AM bits can also be set to disable the PWM spread spectrum. The selected modulation scheme and modulation amplitude are applied to all buck regulators.

The pseudo-random scheme is implemented similarly to PFM spread spectrum modulation, but instead of modulating PFM current limit it directly modulates switching frequency. The modulation frequency is set by the 2-bit code Freq_SS[1:0]. The modulation rate is adjusted using the 2-bit code PWM_AM[1:0].

When the triangular modulation profile is selected, the PWM switching frequency is the center frequency (f_{CENTER}). A maximum frequency (f_{MAX}) and minimum frequency (f_{MIN}) are adjusted by the modulation amplitude 2-bit code PWM_AM[1:0]. The modulation frequency (f_{MOD}) is set by the 2-bit code Freq_SS[1:0].

9.11.12 Phase Synchronization

The phase relationships between the starts of switching cycles of different buck regulators can be programmed. The programmed switching frequencies of synchronized buck regulators must be the same, double, or half. When programmed, synchronization occurs when the buck regulators are running at the full switching frequency, which occurs at all loads in FPWM mode and at moderate to high load in Auto PFM/PWM mode. Phase synchronization can be used to improve EMC.

9.12 LDO Regulators

The RAA215300 has three LDO regulators, each with programmable output voltage, soft-start timing, and power on/off delay. Each can be disabled by the register and EEPROM settings. The LDOs support various DDR memory specifications, but can also be used for general purposes. The LDOs can be reconfigured by programmed settings during transitions between {ACTIVE} and {SLEEP}. In {ACTIVE}, hardware inputs (see LDOx Selection Inputs) can change the output voltages of LDO1 and LDO2 at rates determined by DVS settings and limitations caused by current limit, load current, and load capacitance.

DVS settings program a target for the rate of change of output voltage. The maximum rate of increase of output voltage is limited by current limit, load current, and load capacitance.

The maximum rate of decrease of output voltage during DVS is limited by load current and load capacitance.

The maximum rates of increase and decrease in the output voltage can be less than the DVS setting.

The LDO regulators offer various active discharge options (see Output Discharge) at power-off. Various types of LDO regulator faults are monitored and reported, see Device Monitors, Warnings, and Protections.

The maximum rate of decrease of output voltage during a shutdown is limited by load current, load capacitance, and active discharge setting.

9.12.1 LDO1/2

LDO1 and LDO2 use the same design. The output voltages can be set to 0.8V, 0.9V, 1.2V, 1.5V, 1.8V, 2.5V, 3.0V, and 3.3V. The output voltages for {ACTIVE} and {SLEEP} are separately programmable. These LDOs support SD card interface applications.

- LDO1 configuration details are in registers 0x4A to 0x4E.
- LDO2 configuration details are in registers 0x4F to 0x53.

9.12.1.1 LDOx Selection Inputs

The LDO_SELx inputs can be used to change the output voltages while in {ACTIVE}. For example, this can be useful when the LDOs power an SD card interface.

- When LDO_SELx = HIGH, the LDOx_Vo_1_ACTIVE setting is selected.
- When LDO_SELx = LOW, the LDOx_Vo_0_ACTIVE setting is selected.

LDO_SELx inputs are ignored during {SLEEP}, when powering on, or during transitions from {STANDBY} to {ACTIVE}.

9.12.2 LDO3

LDO3 output voltage can be set to 0.8V, 0.9V, 1.2V, 1.5V, 1.8V, 2.5V, 3.0V, and 3.3V. The output voltages for {ACTIVE} and {SLEEP} are separately programmable. LDO3 can provide power for the DDR memory VPP rail.

9.12.3 LDOx Bypass

Each LDO can be set in bypass mode where the input and output are internally connected through the enhanced pass MOSFET.

The LDO cannot be switched in or out of bypass mode between {ACTIVE} and {SLEEP}.

9.12.4 Unused LDOx

If an LDO regulator is not required in a given application, configure that unused LDO as follows:

- LDOx_VIN = GND
- LDOx_OUT = GND
- LDO_SEL1 = GND if LDO1 is not used
- LDO_SEL2 = GND if LDO2 is not used
- Disable the LDOx block in EEPROM by both LDOx_EN_ACTIVE and LDOx_EN_SLEEP bits.

A UV fault is triggered at startup if an LDO is enabled in the register settings but configured as unused on the board. The fault protection function is configured in the default settings to shut down all the outputs when a UV fault is detected. To avoid shutdown, disable the unused LDOs in the EEPROM settings or before asserting PWRON.

9.13 VTTREF

The VTTREF block provides the VTT reference voltage in DDR applications. VREFOUT = VREFIN/2.

In DDR applications, VREFIN is connected to the VDDQ rail, which is typically generated by Buck2.

When Buck6 is set to VTT mode, Buck6 output provides an active tracking termination voltage (VTT) equal to VREFOUT.

If VTTREF_EN = Enabled, VTTREF is enabled when Buck2 starts up and is disabled when Buck2 shuts down. VREFIN (the input to VTTREF) can be connected to the output of any of the regulators, or to any voltage source. VREFIN UVLO detection is active only after Buck2 completes soft-start and before Buck2 starts power-down.



When VREFIN UVLO is active, UVLO latched fault and live fault bits are set and all outputs shut down if VREFIN is less than its falling UVLO threshold for longer than the VREFIN UVLO Falling Delay period. See VREFIN UVLO.

VTTREF is enabled and disabled simultaneously with Buck2. Therefore, Buck6 must not start up earlier than Buck2 and must not shut down later than Buck2. During startup, VREFIN must be greater than two times the Buck6 output voltage, or Buck6 OV could be triggered. Many things affect the rise times. In FPWM, constraints of minimum on-time and switching frequency can make Buck6 output voltage rise quickly. Therefore, it is necessary to make VREFIN establish quickly or before Buck6. During shutdown, the voltage source connected to VREFIN cannot shut down earlier than Buck6, or Buck6 OV could be triggered.

9.13.1 Unused VTTREF

If VTTREF is not going to be configured for use as a reference for Buck6, configure the schematic and board design as follows:

- VREFIN = GND
- VREFOUT = GND
- Disable the VTTREF block in EEPROM.

9.14 Pre-bias Startup

In some use cases, the output capacitor/load of the regulator may have residual charge and therefore a non-zero output voltage when the device is (re)started (that is, pre-biased). The RAA215300 supports pre-biased start-up.

9.15 Device Monitors, Warnings, and Protections

The RAA215300 has various monitors, warnings, and fault protection features.

If a fault is detected during normal operation, both a latched (sticky) and a live fault status bit are set. INT# is asserted if the fault interrupt is supported and not masked out. Certain fault events can be configured to shut down all rails (enter {FAULT_OUT}), or to keep all rails operating (do not enter {FAULT_OUT}). A latched fault bit remains set until cleared by the host writing a 1 to the latched register bit after the event has subsided. The live status bits show the real-time condition and are used to indicate if the fault has subsided or persists. For more information see Interrupt and Fault and Status Monitoring.

If a fault event shuts down the RAA215300 power rails, all the reset outputs are asserted and the output rails are powered down following the power-off sequence.

9.15.1 Input Voltage Monitor (AVDD Undervoltage Power Down)

To help prevent uncontrolled power-down due to input power loss, an AVDD voltage monitor option is included to provide the host an early warning. It is also called the AVDD Undervoltage Power Down (UVPD) feature, which has a programmable threshold and can be enabled/disabled in the EEPROM. When the programmed threshold is reached, after a delay the AVDD_UVPD_Latched and AVDD_UVPD_Live status bits are set and, if not masked, INT# is asserted. The device powers down according to the power-down sequence and then enters {FAULT_OUT}. At power-on, the device remains in {STANDBY} until AVDD exceeds the UVPD setting if the AVDD UVPD feature is enabled, and stays in this state indefinitely if AVDD remains below its UVPD setting.

The threshold options are:

- 4.25V (for 5V systems)
- 3.0V (for Li-lon battery systems)
- 2.7V (for 3V systems)



9.15.2 AVDD UVLO

The AVDD input supply has UVLO protection. This checks the power supply is valid for normal operation. See the Electrical Specifications for detailed specifications. When AVDD is below its UVLO falling threshold, the device enters {RESET}. See Operating {States} and Transition Conditions for more details.

9.15.3 VREFIN UVLO

The VREFIN input has UVLO protection. When VREFIN is below its UVLO falling threshold, after a delay the VREFIN_UVLO_Latched and VREFIN_UVLO_Live fault bits are set and, if not masked, INT# is asserted. The device powers down according to the power-down sequence if it is configured to shut down all the rails by the VREFIN_UVLO_Disable bit and then enters {FAULT_OUT}.

Note: The device can be configured to either shut down all the rails or not shut down any rails by register bit VREFIN_UVLO_Disable. If the device is configured to not shut down any rails, the fault cannot be cleared until VREFIN exceeds its UVLO rising threshold. If the device is configured to shut down all the rails, the fault cannot be cleared until be cleared until the power-off sequence completes.

The VREFIN UVLO Falling Delay timer is enabled after Buck2 finishes soft-start and before Buck2 starts shutdown.

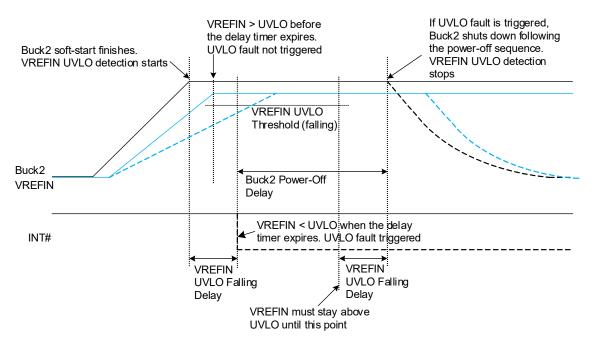


Figure 37. VREFIN UVLO Fault Detection at Power-On

9.15.4 Over-Temperature Warning and Protection

The RAA215300 continuously monitors its die temperature and responds at two thresholds. The lower threshold provides a warning that the temperature is near but less than the higher protection threshold.

The thermal warning threshold is programmable. When the warning threshold is reached, a latched fault flag and live status bit are set and if not masked, it asserts INT#. When the thermal shutdown threshold is reached, a latched fault flag and live status bit are set, INT# is asserted (if not masked), and the device powers down following the power-off sequence and it enters {FAULT_OUT}.

Note: OTP_WARN_Latched fault is edge triggered, that is, when the latched fault is cleared, it is only set again when the live fault goes LOW to HIGH. OTP_Latched fault is level triggered, that is, when the latched fault is cleared, it is set again if the live fault is high.

9.15.5 High Current Warning

Buck1 features a high-current warning with a programmable threshold. This can be used by the system, possibly in conjunction with the over-temperature warning, to moderate processor activity to avoid high-temperature operation. When Buck1 output current is higher than the threshold set in Buck1_High_Current_Threshold register bits, the Buck1_HC_Latched and Buck1_HC_Live bits are set, and INT# is asserted (if not masked). The device remains operating in this condition.

9.15.6 Overvoltage and Undervoltage Protection

All buck regulators have undervoltage (UV) and overvoltage (OV) fault protection. The LDOs have UV protection. PMIC response to a fault is configurable and can include assertion of INT#. When UV or OV protection threshold is reached, a latched fault flag and live status bit are set, and INT# is asserted (if not masked). If the UV_Disable or OV_Disable bit of the regulator is configured to shut down all the rails, the device powers down following the power-off sequence and enters {FAULT_OUT}. If it is configured to not shut down any rails, the device remains operating.

Note: The LDOx live status bits are PGOOD live status, and they are monitored when the related LDO is enabled and disabled. The LDOx latched status bits are UV latched status and are only monitored when the related LDO is enabled. Similarly, the BUCKx UV and OV status are only monitored when the related buck regulator is enabled. The INT# status depends on the latched fault status.

9.15.7 Interrupt

The RAA215300 has an interrupt (INT#) pin, which is an open-drain, active low output that can notify the system/host of a PMIC fault or alarm condition. Each latched fault can be configured to be unmasked or masked with respect to INT#. Unmasked faults assert INT#; masked faults do not. *Note:* The host can read latched and live faults from the status registers.

It is the responsibility of the host to de-assert/release INT# by clearing the latched fault bit(s). If INT# is not de-asserted, it is unable to notify the host of further qualifying events.

9.15.8 Fault and Status Monitoring

The RAA215300 supports numerous interrupt qualifying events and numerous status flags. Different fault events may have associated latched flags, live flags, and the ability to assert the INT# and power down all outputs (enter {FAULT_OUT}).

Note: Latched and live fault bits can be polled by the host at any time to check status. A latched fault sets the related flag to 1, and this remains until cleared by the host. The fault is re-triggered if the fault condition persists.

See Table 10 for a summary of all fault and status flags, see the Register Map for all details of the bits summarized.

Fault Register Partitioning	Fault/Status Name	Live Bit Status	Latched Bit Status	INT# Mask Option	Fault Response Option	Deglitch Time (ms)	Notes
	Buck6 UV	Yes	Yes	Yes	Yes	1	
	Buck5 UV	Yes	Yes	Yes	Yes	1	
Fault 1	Buck4 UV	Yes	Yes	Yes	Yes	1	
Fault	Buck3 UV	Yes	Yes	Yes	Yes	1	
	Buck2 UV	Yes	Yes	Yes	Yes	1	
	Buck1 UV	Yes	Yes	Yes	Yes	1	

Table 10. Fault and Status Flags: Behavior and Partitioning



Fault Register Partitioning	Fault/Status Name	Live Bit Status	Latched Bit Status	INT# Mask Option	Fault Response Option	Deglitch Time (ms)	Notes
Fault 2	VIO_PGOOD	Yes	Yes	Yes	No	1	
	LDO3 UV	Yes	Yes	Yes	Yes	1	
	LDO2 UV	Yes	Yes	Yes	Yes	1	
	LDO1 UV	Yes	Yes	Yes	Yes	1	
	Buck6 OV	Yes	Yes	Yes	Yes	1	
	Buck5 OV	Yes	Yes	Yes	Yes	1	
Fault 3	Buck4 OV	Yes	Yes	Yes	Yes	1	
	Buck3 OV	Yes	Yes	Yes	Yes	1	
	Buck2 OV	Yes	Yes	Yes	Yes	1	
	Buck1 OV	Yes	Yes	Yes	Yes	1	
Fault 4	Buck1_HC	Yes	Yes	Yes	No	0.1	
Fault 5	NVM Read	No	Yes	No	No	-	Ok/good when bit = 1
	PGOODCCBAT	Yes	Yes	Yes	No	0.1	
	VREFIN UVLO	Yes	Yes	Yes	Yes	1	Only monitored after Buck2 (VDDQ) rail soft-start is completed.
	AVDD UVPD	Yes	Yes	Yes	No	0.1	
Fault 6	NVM_Error	No	Yes	Yes	No	-	
	CRST Triggered	Yes	Yes	Yes	No	-	
	WDT Error	Yes	Yes	Yes	No	-	
	OTP	Yes	Yes	Yes	No	-	
	OTP Warn	Yes	Yes	Yes	No	-	
ECC Detail 1	EE Bank 7 ECC Corrected	No	Yes	No	No	-	Clear latched flag by writing 1 to the bit location
	EE Bank 6 ECC Corrected	No	Yes	No	No	-	Clear latched flag by writing 1 to the bit location
	EE Bank 5 ECC Corrected	No	Yes	No	No	-	Clear latched flag by writing 1 to the bit location
	EE Bank 4 ECC Corrected	No	Yes	No	No	-	Clear latched flag by writing 1 to the bit location
	EE Bank 3 ECC Corrected	No	Yes	No	No	-	Clear latched flag by writing 1 to the bit location
	EE Bank 2 ECC Corrected	No	Yes	No	No	-	Clear latched flag by writing 1 to the bit location
	EE Bank 1 ECC Corrected	No	Yes	No	No	-	Clear latched flag by writing 1 to the bit location
	EE Bank 0 ECC Corrected	No	Yes	No	No	-	Clear latched flag by writing 1 to the bit location

Table 10. Fault and Status Flags: Behavior and Partitioning (Cont.)



Fault Register Partitioning	Fault/Status Name	Live Bit Status	Latched Bit Status	INT# Mask Option	Fault Response Option	Deglitch Time (ms)	Notes	
ECC Detail 2	EE Bank 7 ECC Error	No	Yes	No	No	-	Clear latched flag by writing 1 to the bit location	
	EE Bank 6 ECC Error	No	Yes	No	No	-	Clear latched flag by writing 1 to the bit location	
	EE Bank 5 ECC Error	No	Yes	No	No	-	Clear latched flag by writing 1 to the bit location	
	EE Bank 4 ECC Error	No	Yes	No	No	-	Clear latched flag by writing 1 to the bit location	
	EE Bank 3ECC Error	No	Yes	No	No	-	Clear latched flag by writing 1 to the bit location	
	EE Bank 2 ECC Error	No	Yes	No	No	-	Clear latched flag by writing 1 to the bit location	
	EE Bank 1 ECC Error	No	Yes	No	No	-	Clear latched flag by writing 1 to the bit location	
	EE Bank 0 ECC Error	No	Yes	No	No	-	Clear latched flag by writing 1 to the bit location	
EE Detail	Valid EE Data	No	Yes	No	No	-	Clear latched flag by writing 1 to the bit location	
	EE Error Latched	No	Yes	No	No	-	Clear latched flag by writing 1 to the bit location	

Table 10. Fault and Status Flags: Behavior and Partitioning (Cont.)

9.16 Maximum Recommended Power Dissipation

The maximum power dissipation recommended in a package is calculated using Equation 8 where T_{JMAX} = Maximum junction temperature, T_{AMAX} = Maximum ambient temperature, θ_{JA} = Thermal resistance of the package, and P_{DMAX} = Maximum power dissipation recommended.

(EQ. 8)

$$\mathsf{P}_{\mathsf{DMAX}} = \frac{\mathsf{T}_{\mathsf{JMAX}} - \mathsf{T}_{\mathsf{AMAX}}}{\theta_{\mathsf{JA}}}$$

An example of the maximum recommended power dissipation versus ambient temperature curve is shown in Figure 38. In this example, the maximum power dissipation across the temperature range is specified at 25°C and the maximum junction temperature is set to 125°C, which is the maximum recommended operating junction temperature.

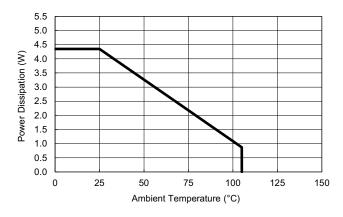


Figure 38. Power Dissipation vs Ambient Temperature

10. External Component Selection

The RAA215300 includes six synchronous buck regulators, three LDOs, and various features. It works with physically small components to reduce PCB assembly area and height. Switching MOSFETs are fully integrated and no external MOSFETs or diodes are needed.

10.1 Output Filters

The inductor and output capacitors are low-pass filters for the voltage at the buck switching node. Their characteristics influence the transfer function of the regulator and the control loop. It the transient load changes, the capacitors maintain output voltage with greater effective bandwidth than that achievable by the control loop alone. The permissible values of inductance and capacitance are dictated by PMIC design and settings. The values in Table 11 are consistent with stable operation and performance in accordance with Electrical Specifications.

10.1.1 Inductor Selection

At full load of the application, which is not necessarily the PMIC maximum rated load, inductors must have at least 90% of their low-current inductance. At 150% of PMIC maximum rated load, inductors must have at least 50% of their low-current inductance. For high efficiency, the inductors should have low resistance and low core loss. Choose molded or screened types for the best EMC.

Other similarly specified components may also be acceptable in the application, see Recommended External Components.

10.1.2 Output Capacitor Selection

Capacitors must be ceramic. When selecting for capacitance value, account for the effects of operating voltage and temperature.

Ceramic capacitors have temperature and voltage (bias) coefficients, which can significantly derate their effective capacitance value. When choosing capacitors, the effective capacitance rating for a given package size, voltage rating, and applied temperature and DC bias must be considered to ensure enough capacitance is used in the design. X5R and X7R types are recommended, depending on operating temperature. Other similarly specified components may also be acceptable in the application, see Recommended External Components.

10.2 Input Capacitor Selection

Ceramic input capacitors provide the high-frequency components of current flowing into the high-side MOSFETs. Place the capacitors close to the PMIC. If the power source is connected to the PMIC by long wires or traces, it may be necessary to add bulk capacitors near (not as close as the ceramic input capacitors) the PMIC to damp oscillation.



Other similarly specified components may also be acceptable in the application, see Recommended External Components.

10.3 Recommended External Components

Table 11. Recommended External Components

Name	Description	Qty	Part Number	Key Electrical Specifications	Imperial (Metric) Size	Manufacturer
All capacito	ors: ^[1]		1			1
Supplies						
C _{AVDD}	AVDD Input capacitance, MLCC	1	GRM188R61A106MAAL	10µF±20%, 10V, X5R	0603 (1608)	Murata
C _{VIO}	Output capacitance, MLCC	1	GRM155R61A225KE01D	2.2µF±10%, 10V, X5R	0402 (1005)	Murata
C _{VCHG}	Input capacitance, MLCC	1	GRM155R61A225KE01D	2.2µF±10%, 10V, X5R	0402 (1005)	Murata
C _{VRTC}	Input capacitance, MLCC	DNP	GRM155R61A225KE01D	2.2µF±10%, 10V, X5R	0402 (1005)	Murata
C _{VPROG}	Optional: Input capacitance for EEPROM Programming, MLCC	1	GRM155R6YA225KE11	2.2µF±20%, 35V, X5R	0402 (1005)	Murata
C _{VBAT}	Output capacitance, supercapacitor	1	FMR0H104ZF	0.1F, 5.5V	-	Kemet
Buck1	·			•		
	Inductor	1	HBED042T-1R0MS-99	1.0µH±20%, 8.2A I _{SAT} , 9mΩ DCR	(4.1x4.1 x2.0mm)	Cyntec
L _{BK1}	Option A 1		XGL4030-102ME	1.0μH±20%, 10.3A I _{SAT} , 7.2mΩ DCR	(4.0x4.0 x3.1mm)	Coilcraft
	Option B	1	SPM4020T-1R0M-LR	1.0μH±20%, 9A I _{SAT} , 28.1mΩ DCR	(4.4x4.1 x2.0mm)	трк
C _{BK1_VIN}	Input capacitance, MLCC	2	GRM188R61A106MAAL	10µF±20%, 10V, X5R	0603 (1608)	Murata
C _{BK1_OUT}	Output capacitance, MLCC	5	GRM188R60J476ME15	47µF±20%, 6.3V, X5R	0603 (1608)	Murata
Buck2						
L _{BK2}	Inductor	1	DFE322512F-1R5M	1.5μH±20%, 3.9A I _{SAT} , 48mΩ DCR	(3.2x2.5 x1.2mm)	Murata
C _{BK2_VIN}	Input capacitance, MLCC	1	GRM188R61A106MAAL	10µF±20%, 10V, X5R	0603 (1608)	Murata
C _{BK2_OUT}	Output capacitance, MLCC	3	GRM188R60J476ME15	47μF±20%, 6.3V, X5R	0603 (1608)	Murata
Buck3			•			•
L _{BK3}	Inductor	1	DFE322512F-1R5M	1.5μH±20%, 3.9A I _{SAT} , 48mΩ DCR	(3.2x2.5 x1.2mm)	Murata



Name	Description	Qty	Part Number	Key Electrical Specifications	Imperial (Metric) Size	Manufacture
C _{BK3_VIN}	Input capacitance, MLCC	1	GRM188R61A106MAAL	10µF±20%, 10V, X5R	0603 (1608)	Murata
C _{BK3_OUT}	Output capacitance, MLCC	2	LMK107BBJ226MA-T	22µF±20%, 10V, X5R	0603 (1608)	Taiyo Yuden
Buck4						
	Inductor	1	HBED042T-1R5MS-99	1.5μH±20%, 6.8A I _{SAT} , 14mΩ DCR	(4.1x4.1 x2.0mm)	Cyntec
L _{BK4}	Option A	1	XGL4030-152ME	1.5μH±20%, 8.8A I _{SAT} , 10.5mΩ DCR	(4.0x4.0 x3.1mm)	Coilcraft
	Option B	1	SPM4020T-1R5M-LR	1.5µH±20%, 6.3A I _{SAT} , 40mΩ DCR	(4.4x4.1 x2.0mm)	TDK
C _{BK4_VIN}	Input capacitance, MLCC	2	GRM188R61A106MAAL	10µF±20%, 10V, X5R	0603 (1608)	Murata
C _{BK4_OUT}	Output capacitance, MLCC	4	GRM21BR61A226ME44	22µF±20%, 10V, X5R	0805 (2012)	Murata
Buck5						
L _{BK5}	Inductor	1	DFE252012F-1R5M	1.5μH±20%, 3.8A I _{SAT} , 58mΩ DCR	(2.5x2.0x1. 2mm)	Murata
C _{BK5_VIN}	Input capacitance, MLCC	1	GRM188R61A106MAAL	10µF±20%, 10V, X5R	0603 (1608)	Murata
C _{BK5_OUT}	Output capacitance, MLCC	2	LMK107BBJ226MA-T	22µF±20%, 10V, X5R	0603 (1608)	Taiyo Yuden
Buck6 (supp	orting VTT Mode)					
L _{BK6}	Inductor	1	DFE252012F-R47M	0.47μH±20%, 6.7A I _{SAT} , 23mΩ DCR	(2.5x2.0 x1.2mm)	Murata
C _{BK6_VIN}	Input capacitance, MLCC	1	GRM188R61A106MAAL	10µF±20%, 10V, X5R	0603 (1608)	Murata
C _{BK6_OUT}	Output capacitance, MLCC	5	GRM188R60J476ME15	47μF±20%, 6.3V, X5R	0603 (1608)	Murata
LDO 1						
C _{LDO1_VIN}	Input capacitance, MLCC	1	GRM188R61A475KAAJ	4.7μF±10%, 10V, X5R	0603 (1608)	Murata
C _{LDO1_OUT}	Output capacitance, MLCC	2	LMK107BBJ226MA-T	22µF±20%, 10V, X5R	0603 (1608)	Taiyo Yuden
LDO 2			1	1	1	
C _{LDO2_VIN}	Input capacitance, MLCC	1	GRM188R61A475KAAJ	4.7μF±10%, 10V, X5R	0603 (1608)	Murata
C _{LDO2_OUT}	Output capacitance, MLCC	2	LMK107BBJ226MA-T	22µF±20%, 10V, X5R	0603 (1608)	Taiyo Yuden
		1		1	1	1

Table 11. Recommended External Components (Cont.)

Name	Description	Qty	Part Number	Key Electrical Specifications	Imperial (Metric) Size	Manufacturer
LDO 3			1	I		1
C _{LDO3_VIN}	Input capacitance, MLCC	1	GRM155R61A225KE01D	2.2µF±10%, 10V, X5R	0402 (1005)	Murata
C _{LDO3_OUT}	Output capacitance, MLCC	1	GRM155R61A475MEAA	4.7μF±20%, 10V, X5R	0402 (1005)	Murata
VTTREF			l	I		
C _{VREFIN}	Input capacitance, MLCC	1	GRM155R61A225KE01D	2.2µF±10%, 10V, X5R	0402 (1005)	Murata
C _{VREFOUT}	Output capacitance, MLCC	1	GRM155R61A475MEAA	4.7µF±20%, 10V, X5R	0402 (1005)	Murata
Crystal Osc	illator					
XTAL	Crystal	1	ECX327-CDX-1293	32.768kHz, ±5ppm, 70kΩ max ESR, 12.5pF load capacitance	(3.2x1.5x 0.9mm)	ECS
ATAL	Option A	1	ECX327-CDX-2096	32.768kHz, ±5ppm, 50kΩ max ESR, 12.5pF load capacitance	(3.2x1.5x 0.9mm)	ECS
C _{XIN} ^[2]	Input capacitance	DNP	-	Up to 10pF, COG	0402 (1005)	-
C _{XOUT} ^[2]	Output capacitance	DNP	-	Up to 10pF, COG	0402 (1005)	-
Resistance			1	L.		
R _{SDA} , R _{SCL}	I ² C Pull-up resistance	1	RC0402JR-0710KL	10kΩ±5%	0402 (1005)	Yageo
R _{INT}	INT# Pull-up resistance	1	RC0402FR-07100KL	100kΩ±5%	0402 (1005)	Yageo
R _{MPIO}	Optional: MPIOx Pull-up or Pull-down resistance	1	RC0402FR-074K75L	4.75kΩ±5%	0402 (1005)	Yageo

Table 11. Recommended External Components (Cont.)

1. The capacitance listed in the above table is not derated. Refer to the capacitors datasheets for effective capacitance.

2. Do Not Populate capacitors by default. They are only needed for oscillator tuning. Renesas recommends placing footprints for these components in the system design in case they are needed.

10.4 Recommended Effective Capacitance

The effective capacitance of the ceramic capacitors changes with the DC bias voltage. When choosing the input capacitors or output capacitors for each regulator, the total capacitance needs to be equivalent to the recommended value as shown in Table 12.

Regulator	Total Output Effective Capacitance (µF)	Total Input Effective Capacitance (µF)
Buck1	190	7.2
Buck2	110	3.6
Buck3	34	3.6

Table 12. Recommended Effective Capacitance ^[1]	Table 12	. Recommended	Effective	Capacitance ^[1]
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Regulator	Total Output Effective Capacitance (µF)	Total Input Effective Capacitance (μF)
Buck4	59	7.2
Buck5	40	3.6
Buck6 (VTT mode)	222	3.6
LDO1	22	3.2
LDO2	22	3.2
LDO3	3	0.6
VIO	1.5	N/A
VREFIN	1.8	N/A
VREFOUT	4.6	N/A

Table 12. Recommended Effective Capacitance^[1]

 The recommended effective capacitance is determined based on the RTKA215300DE0000BU BOM and the DC characteristics curves that are available on the capacitor vendor website. The DC bias voltages are the typical input and output voltages of each regulator as stated in Electrical Specifications.

11. Layout Guidelines

PCB design is crucial to proper performance of the PMIC and system. The following are recommendations to achieve proper device performance.

11.1 Power Ground (PGND)

PGND is the reference for all voltages of the power system. Many components must have low-impedance connections to PGND (most importantly the input and output capacitors). Create a PGND plane on at least one PCB layer and extend it to at least the connection points of all relevant components. The PGND plane is an important heatsink and it may also provide electrostatic screening. Aim to avoid interrupting the plane with non-PGND vias, especially if they are in a row and form a slit. The PGND plane is not perfect because it has impedance and there are unwanted voltages developed across it.

11.2 Analog Ground (AGND)

AGND is an electrically quiet reference for signals that could be corrupted if they were connected to PGND. These signals are the PMIC internal power supply and those associated with the RTC and its power supply. Create a small plane that connects these signals to Pin 26 and Pin 42. Connect this plane directly to PGND at the EPAD.

11.3 Digital Ground

Connect the grounds of digital signals to PGND.

11.4 Exposed Pad (EPAD)

Internal to the PMIC, all regulator power grounds are bonded to the EPAD. The EPAD is in close thermal contact with the PMIC die. Therefore, the connection between EPAD and PCB is important to both the grounding scheme and thermal management. Connect the EPAD to the PGND plane.

Place thermal vias, in a 1 to 1.2mm pitch grid formation, under the PMIC at least in the area of the EPAD, and connect them to the PGND plane. The vias must not wick solder from the EPAD joint.

11.5 Buck Regulators

The current through the MOSFETs is periodically and rapidly switched. The current generates a magnetic field that inductively couples current into nearby conductors. At some distance (dependent on frequency) from the



source, the magnetic field becomes electromagnetic radiation (noise). Voltage (noise) develops across impedance in the current paths.

To mitigate the effects of switched current, make paths short and low impedance, make loop areas small and avoid sharing ground connections with sensitive circuits.

The MOSFETs are internal to the PMIC, so their current paths are predetermined. The main external high-frequency current path is through input capacitors. Place input capacitors close to their respective buck regulator input terminals, which usually means placing them on the same side as the PMIC. Connect the positive side with short wide copper. If the negative side needs to connect to an inner-layer PGND plane, do so with multiple vias. In some applications, it might be helpful to place a physically small capacitor with a lower high-frequency impedance closest to the PMIC. Current in the inductor has smaller high-frequency content than the MOSFETs; however, it is still necessary to connect the inductor to the switch node PMIC terminals with low-impedance copper and to make low-impedance connections to the output capacitors. The output capacitors must be intimately connected to the PGND plane so use multiple vias if the PGND plane is on an inner layer.

The voltage at the switch node is periodically and rapidly switched. The voltage generates an electric field that capacitively couples voltage into nearby conductors. At some distance (dependent on frequency) from the source, the electric field becomes electromagnetic radiation (noise).

To mitigate the effects of switched voltage, make the copper area of the switched node small. This partially contradicts the requirement to make a low-impedance connection between the switch node and inductor, but this is a compromise that must happen. Make the path short but only wide enough to carry the current. Do not add copper that does not have a high current density. Most of the generated electric field is perpendicular to the copper surface. The PGND plane is an effective shield. The inductor terminal also generates an electric field, in directions perpendicular to its surfaces.

11.6 Linear Regulators (LDOs)

The LDOs require good high-frequency decoupling of their inputs and outputs. Connections to input and output capacitors must be low impedance at high frequency. Place capacitors close to PMIC pins and connect with short wide copper. Connect capacitors to the PGND plane with multiple vias.

11.7 Crystal Oscillator

Place the crystal close to the PMIC. Pin 28, XIN, has very high impedance, and oscillator circuits operating at low frequencies are susceptible to noise if good layout practice is not followed. Erratic clocking and accuracy errors can be caused by adjacent noisy signals. Do not route noisy traces near the crystal. Add a guard ring around the crystal and connect one end to AGND. To avoid affecting load capacitance, keep all layers clear of copper in the area of the crystal and its connecting traces.

11.8 Device Specific Layout Guidelines

The following table provides layout guidelines (such as trace routing and size, and component placements) for the various pins of RAA215300. *Note:* All buck supplies (BUCKx_VINx) = AVDD = VCHG.

Pin Number	Pin Name	Layout Guideline
1, 2	MPIO4, MPIO3	Digital input/output pin. Route trace away from any buck switch node. Consider placing the trace such that the PGND plane is between the trace and any buck switch node.
3, 4, 5	BUCK1_LX3, BUCK1_LX2, BUCK1_LX1	Place the inductor close to the pins. Connect the pins together and to the inductor with short, wide copper, but keep the area small. Do not place sensitive signal traces (for example, feedback) near this copper on the same layer, or in the same area on inner layers unless shielded by the PGND plane.
6, 7, 8	BUCK1_VIN3, BUCK1_VIN2, BUCK1_VIN1	Place input capacitors close to the pins and connect with short, wide copper.



Pin Number	Pin Name	Layout Guideline
9	PGND	Connect the PGND pin directly to the top layer of copper under the exposed pad (EPAD). The PGND pin may also be connected to top layer copper - for example to nearby input capacitors for BUCK1
10	BUCK1_FB	Run a dedicated trace to BUCK1 output capacitors. Connect directly to a capacitor but away from the main path of output current. Route the trace away from any noisy signals, switch nodes, or output inductors. Consider placing the trace such that the PGND plane is between the trace and any buck switch node.
11	VPROG	Connect to PGND (if programming EEPROM is not required).
12	BUCK3_FB	Run a dedicated trace to BUCK3 output capacitors. Connect directly to a capacitor but away from the main path of output current. Route the trace away from any noisy signals, switch nodes, or output inductors. Consider placing the trace such that the PGND plane is between the trace and any buck switch node.
13	LDO_SEL2	Digital input pin. Should be isolated from the high di/dt and dv/dt signals to minimize any coupling. This signal should be placed on a quiet layer.
14	BUCK3_VIN	Place input capacitors close to the pin and connect with short, wide copper.
15	BUCK3_LX	Place the inductor close to the pin. Connect the pin to the inductor with short, wide copper, but keep the area small. Do not place sensitive signal traces (for example, feedback) near this copper on the same layer, or in the same area on inner layers unless shielded by the PGND plane.
16	INT#	Digital output pin. Should be isolated from the high di/dt and dv/dt signals to minimize any coupling. This signal should be placed on a quiet layer.
17	SCL	Digital input pins. Should be isolated from the high di/dt and dv/dt signals to minimize any coupling.
18	SDA	These signals should be placed on a quiet layer. If not used, connect to VIO.
19	LDO_SEL1	Digital input pin. Should be isolated from the high di/dt and dv/dt signals to minimize any coupling. This signal should be placed on a quiet layer.
20, 21	BUCK4_LX2, BUCK4_LX1	Place the inductor close to the pins. Connect the pins to the inductor with short, wide copper, but keep the area small. Do not place sensitive signal traces (for example, feedback) near this copper on the same layer, or in the same area on inner layers unless shielded by the PGND plane.
22, 23	BUCK4_VIN2, BUCK4_VIN1	Place input capacitors close to the pins and connect with short, wide copper.
24	VIO	Place the decoupling capacitor close to the pin and connect with short, wide copper. Connect the other side of the capacitor to pin 26 (AGND) with short, wide copper.
25	BUCK4_FB	Run a dedicated trace to BUCK4 output capacitors. Connect directly to a capacitor but away from the main path of output current. Route the trace away from any noisy signals, switch nodes, or output inductors. Consider placing the trace such that the PGND plane is between the trace and any buck switch node.
26, 42	AGND	Analog ground (AGND) and power ground (PGND) of the IC should be separated on the board, but connected directly to EPAD. To avoid unwanted noise coupling into the AGND plane, keep the plane localized to the area where
07	VOUT	AGND is required.
27	XOUT	Avoid routing serial bus lines, any high-speed logic lines, high dv/dt, or di/dt signals in the vicinity of crystal pins. These can induce noise in the oscillator circuit causing misclocking. Add a ground trace around the crystal with one end terminated at the chip analog ground, providing termination for emitted noise in the vicinity of the RTC device. Avoid ground plane in the layer(s) under these pins, traces, and external crystal, as this affects the load capacitance on the pins and therefore, the oscillator accuracy of the circuit. Connect to ground if not used.
29	VRTC	When RTC is used, place a decoupling capacitor footprint close to the pin and connect with short, wide copper. Connect the other side of the capacitor footprint to AGND. This capacitor should be Do Not Populated by default.

Pin Number	Pin Name	Layout Guideline
30	VBAT	Connect to battery or supercapacitor with short trace. Connect to PGND if not used.
31	VCHG	AVDD, VCHG, and BUCKx_VINx must be the same voltage. Place the decoupling capacitor close to the pin and connect with short, wide copper. Connect the other side of the capacitor to PGND.
32, 35, 36	LDO1_OUT, LDO2_OUT, LDO3_OUT	Place decoupling capacitors close to their respective outputs and connect with wide traces.
33, 34, 37	LDO1_VIN, LDO2_VIN, LDO3_VIN	Place decoupling capacitors close to their respective inputs and connect with wide traces.
38	BUCK5_LX	Place the inductor close to the pin. Connect the pin to the inductor with short, wide copper, but keep the area small. Do not place sensitive signal traces (for example, feedback) near this copper on the same layer, or in the same area on inner layers unless shielded by the PGND plane.
39	BUCK5_VIN	Place input capacitors close to the pin and connect with short, wide copper.
40	AVDD	AVDD, VCHG, and BUCKx_VINx must be the same voltage. Place the decoupling capacitor close to the pin and connect with short, wide copper. Connect the other side of the capacitor to PGND.
41	BUCK5_FB	Run a dedicated trace to BUCK5 output capacitors. Connect directly to a capacitor but away from the main path of output current. Route the trace away from any noisy signals, switch nodes, or output inductors. Consider placing the trace such that the PGND plane is between the trace and any buck switch node.
43	VREFIN	Place the decoupling capacitor close to the pin and connect with short, wide copper. Connect the other side of the capacitor to PGND. <i>Note:</i> Pin has a $1M\Omega$ (typical) internal resistor to GND.
44	VREFOUT	Place the decoupling capacitor close to the pin and connect with short, wide copper. Connect the other side of the capacitor to PGND.
45	MPIO5	Digital input/output pin. Route trace away from any buck switch node. Consider placing the trace such that the PGND plane is between the trace and any buck switch node.
46	BUCK6_FB	Run a dedicated trace to BUCK3 output capacitors. Connect directly to a capacitor but away from the main path of output current. Route the trace away from any noisy signals, switch nodes, or output inductors. Consider placing the trace such that the PGND plane is between the trace and any buck switch node.
47	CEN	Digital input pin. Route trace away from any buck switch node. Consider placing the trace such that the PGND plane is between the trace and any buck switch node.
48	BUCK6_VIN	Place input capacitors close to the pin and connect with short, wide copper.
49	BUCK6_LX	Place the inductor close to the pin. Connect the pin to the inductor with short, wide copper, but keep the area small. Do not place sensitive signal traces (for example, feedback) near this copper on the same layer, or in the same area on inner layers unless shielded by the PGND plane.
50	BUCK2_LX	Place the inductor close to the pin. Connect the pin to the inductor with short, wide copper, but keep the area small. Do not place sensitive signal traces (for example, feedback) near this copper on the same layer, or in the same area on inner layers unless shielded by the PGND plane.
51	BUCK2_VIN	Place input capacitors close to the pin and connect with short, wide copper.
52	PWRON	Digital input pin. Should be isolated from the high di/dt and dv/dt signals to minimize any coupling. This signal should be placed on a quiet layer.



Pin Number	Pin Name	Layout Guideline
53	BUCK2_FB	Run a dedicated trace to BUCK2 output capacitors. Connect directly to a capacitor but away from the main path of output current. Route the trace away from any noisy signals, switch nodes, or output inductors. Consider placing the trace such that the PGND plane is between the trace and any buck switch node.
54	MPIO0	Digital input/output pin. Route the trace away from any buck switch node. Consider placing the trace such that the PGND plane is between the trace and any buck switch node.
55	MPIO1	Digital input/output pin. Route the trace away from any buck switch node. Consider placing the trace such that the PGND plane is between the trace and any buck switch node.
56	MPIO2	Digital input/output pin. Route trace away from any buck switch node. Consider placing the trace such that the PGND plane is between the trace and any buck switch node.
-	EPAD	Connect to PGND with matching shape. Connect to the GND layer using an array of equidistant vias to achieve better thermal performance.

12. Register Map

Any register addresses (pointers) not indicated in the following section, Register Map Detail, are reserved and should not be used.

Register addresses 0x00 to 13 are read and write accessed using only the RTC Slave Address (set in register 0x1F).

All other register addresses are read and write accessed using the Main Slave Address (set in register 0x1E). See 7-bit Device Addresses.

12.1 Register Map Detail

The default values in the following table are for RAA215300A2GNP#HA0. Any differences with other part numbers are outlined in Part Number Differences.

Register Pointer	Register Bit(s)	Bit(s)/Function Name	Description	Setting/Range	Default
0x00	•	lame - RTC SC W, Non EEPROM)			0x00 / 0
	[7]	not used			<0>
	[6]	SC22	Set seconds (0-59) in BCD format	RTC SC[6:0] BCD decode:	<0>
	[5]	SC21	-	0000000: 0sec	<0>
		SC20		0000001: 1sec	<0>
		SC13	-	0000010: 2sec	<0>
		SC12	-		<0>
		SC11	-	0001001: 9sec	<0>
	[0]	SC10	-	0010000: 10sec 0010001: 11sec	<0>
				1010111: 57sec	
				1011000: 58sec	
				1011001: 59sec	



0x01 Regi	ster Name - RTC MN	J		0x00 /
	e - (RW, Non EEPRC			0,000
. , , , ,	(,	,		
[7]	not used			<0>
[6]	MN22	Set minutes (0-59) in BCD format	RTC MN[6:0] BCD decode:	<0>
[5]	MN21		0000000: 0min	<0>
[4]	MN20		0000001: 1min	<0>
[3]	MN13		0000010: 2min	<0>
[2]	MN12			<0>
[1]	MN11		0001001: 9min	<0>
[0]	MN10		0010000: 10min 0010001: 11min	<0>
			 1010111: 57min	
			1011000: 58min	
			1011001: 59min	
x02 Regi	ster Name - RTC HR			0x00 /
	e - (RW, Non EEPRC			
	·			
[7]	MIL	12-hour or 24-hour format selection bit	0: 12-hour format	<0>
			1: 24-hour format	
[6]	not used			<0>
[5]	HR21	Set hours in BCD format. If the MIL bit is	If MIL = 1	<0>
[4]	HR20	"0", the RTC uses a 12-hour format and	RTC HR[5:0] decodes for 24-hour	<0>
[3]	HR13	HR21 bit functions as an AM/PM indicator		<0>
[2]	HR12	with a "1" representing PM.	000000: 0hr	<0>
[1]	HR11		000001: 1hr	<0>
[0]	HR10			<0>
			001001: 9hr	
			010000: 10hr	
			 011001: 19hr	
			100000: 20hr	
			100000.2011	
			 100011: 23hr	
			f MIL = 0	
			RTC HR[4:0] decodes for 12-hour	
			format with RTC HR [5] indicating	
			AM/PM:	
			00000: INVALID	
			00001: 1 AM/PM	
			00010: 2 AM/PM	
			01001: 9 AM/PM	
			10000: 10 AM/PM	
			10001: 11 AM/PM	
			10010: 12 AM/PM	
	ster Name - RTC DT			0x01 /
туре	e - (RW, Non EEPRC	M()		
[7:6]	not used			<00>
[5]	DT21	Set date (1-31) in BCD format	RTC DT[5:0] BCD decode:	<0>
[3]	DT20	To maintain correct month and date regis-		<0>
[4]	DT13	ters, the host must force the RTC MO and		<0>
	DT12	RTC DT registers to the correct values in		<0>
[2]		specific years. See the Clock and Calen-		-
[1]	DT11	dar Registers [Address 0x00 to 0x06] sec-	001001: date 9	<0>
[0]	DT10	tion for details.	010000: date 10	<1>
			011001: date 19	
			100000: date 20	
			101001: date 29	
1	1		110000: date 30	1
ļ			110001: date 31	



l yr				
1.1	pe - (RW, Non EEPR	UM)		
[7:5	5] not used			<000
[4]	-	Set month (1-12) in BCD format	RTC MO[4:0] BCD decode:	<000
	MO20 MO13	To maintain correct month and date regis-		<0>
[3]		ters, the host must force the RTC MO and		-
[2]		RTC DT registers to the correct values in	00010: 2nd month (Feb)	<0>
[1]		specific years. See the Clock and Calen-	00011: 3rd month (Mar)	<0>
[0]	MO10	dar Registers [Address 0x00 to 0x06] sec-		<1>
		tion for details.	01001: 9th month (Sep)	
			10000: 10th month (Oct)	
			10001: 11th month (Nov)	
			10010: 12th month(Dec)	
)5 Reg	gister Name - RTC Y	R	· · · · ·	0x00/
Тур	pe - (RW, Non EEPR	OM)		
[7]	YR23	Set year (0-99) in BCD format	RTC YR[7:0] decodes:	<0>
[6]	YR22		0000 0000: 0th year	<0>
[5]	YR21		0000 0001: 1st year	<0>
[4]	YR20			<0>
[3]	YR13		0001 0000: 10th year	<0>
[2]	YR12		0001 0001: 11th year	<0>
		——		<0>
[1]		———————————————————————————————————————	1000 0000: 80th year	-
[0]	YR10		1000 0001: 81st year	<0>
			1001 1000: 98th year	
)6 Red	gister Name - RTC D		1001 1001: 99th year	0x00/
Тур	pe - (RW, Non EEPR	OM)		
F-7 C	61 ()			
[7:3	-			
[2]	DW2	Set day of the week (1-7)	RTC DW[2:0] decodes:	<0000><0>
[2] [1]	DW2 DW1	Set day of the week (1-7)	000: 1st day of the week	
[2]	DW2 DW1	Set day of the week (1-7)	000: 1st day of the week 001: 2nd day of the week	<0> <0>
[2] [1]	DW2 DW1	Set day of the week (1-7)	000: 1st day of the week	<0> <0>
[2] [1]	DW2 DW1	Set day of the week (1-7)	000: 1st day of the week 001: 2nd day of the week 010: 3rd day of the week 	<0> <0>
[2] [1] [0]	DW2 DW1 DW0		000: 1st day of the week 001: 2nd day of the week	<0> <0> <0>
[2] [1] [0]	DW2 DW1 DW0 egister Name - RTC S	R	000: 1st day of the week 001: 2nd day of the week 010: 3rd day of the week 	<0> <0> <0>
[2] [1] [0]	DW2 DW1 DW0	R	000: 1st day of the week 001: 2nd day of the week 010: 3rd day of the week 	<0> <0> <0>
[2] [1] [0]	DW2 DW1 DW0 egister Name - RTC S	R	000: 1st day of the week 001: 2nd day of the week 010: 3rd day of the week 	<0> <0> <0>
[2] [1] [0] 07 Reg Typ	DW2 DW1 DW0 egister Name - RTC S pe - (RW, Non EEPR)	R OM)	000: 1st day of the week 001: 2nd day of the week 010: 3rd day of the week 110: 7th day of the week	<0> <0> <0>
[2] [1] [0]	DW2 DW1 DW0 egister Name - RTC S pe - (RW, Non EEPR)	R	000: 1st day of the week 001: 2nd day of the week 010: 3rd day of the week 110: 7th day of the week 0:Disable the automatic reset of the	<0> <0> <0>
[2] [1] [0] 07 Reg Typ	DW2 DW1 DW0 egister Name - RTC S pe - (RW, Non EEPR)	R OM)	000: 1st day of the week 001: 2nd day of the week 010: 3rd day of the week 110: 7th day of the week 0:Disable the automatic reset of the BAT and ALM status bits only	<0> <0> <0>
[2] [1] [0] 07 Reg Typ	DW2 DW1 DW0 egister Name - RTC S pe - (RW, Non EEPR)	R OM)	000: 1st day of the week 001: 2nd day of the week 010: 3rd day of the week 110: 7th day of the week 0:Disable the automatic reset of the BAT and ALM status bits only 1: Enable the automatic reset of the	<0> <0> <0>
[2] [1] [0] 07 Re(Tyr	DW2 DW1 DW0 egister Name - RTC S pe - (RW, Non EEPR ARST	R OM) Auto reset enable bit	000: 1st day of the week 001: 2nd day of the week 010: 3rd day of the week 110: 7th day of the week 0:Disable the automatic reset of the BAT and ALM status bits only 1: Enable the automatic reset of the BAT and ALM status bits only	<0> <0> <0> 0x01 <0>
[2] [1] [0] 07 Reg Typ	DW2 DW1 DW0 egister Name - RTC S pe - (RW, Non EEPR ARST	R OM) Auto reset enable bit Internal crystal oscillator enable bit.	000: 1st day of the week 001: 2nd day of the week 010: 3rd day of the week 110: 7th day of the week 0:Disable the automatic reset of the BAT and ALM status bits only 1: Enable the automatic reset of the BAT and ALM status bits only 0: Enable internal crystal oscillator	<0> <0> <0> 0x01 <0>
[2] [1] [0] 07 Re(Tyr	DW2 DW1 DW0 egister Name - RTC S pe - (RW, Non EEPR ARST	R OM) Auto reset enable bit Internal crystal oscillator enable bit. XTOSCB needs to be set to '0' when	000: 1st day of the week 001: 2nd day of the week 010: 3rd day of the week 110: 7th day of the week 0:Disable the automatic reset of the BAT and ALM status bits only 1: Enable the automatic reset of the BAT and ALM status bits only	<0> <0> <0> 0x01 <0>
[2] [1] [0] 07 Re(Tyr	DW2 DW1 DW0 egister Name - RTC S pe - (RW, Non EEPR ARST	R OM) Auto reset enable bit Internal crystal oscillator enable bit. XTOSCB needs to be set to '0' when external crystal is used. XTOSCB needs	000: 1st day of the week 001: 2nd day of the week 010: 3rd day of the week 110: 7th day of the week 0:Disable the automatic reset of the BAT and ALM status bits only 1: Enable the automatic reset of the BAT and ALM status bits only 0: Enable internal crystal oscillator	<0> <0> <0> 0x01 <0>
[2] [1] [0] 07 Re(Tyr	DW2 DW1 DW0 egister Name - RTC S pe - (RW, Non EEPR ARST	R OM) Auto reset enable bit Internal crystal oscillator enable bit. XTOSCB needs to be set to '0' when external crystal is used. XTOSCB needs to be set to 1' when external 32kHz clock	000: 1st day of the week 001: 2nd day of the week 010: 3rd day of the week 110: 7th day of the week 0:Disable the automatic reset of the BAT and ALM status bits only 1: Enable the automatic reset of the BAT and ALM status bits only 0: Enable internal crystal oscillator	<0> <0> <0> 0x01 <0>
[2] [1] [0] 07 Re(Tyr [7] [6]	DW2 DW1 DW0 egister Name - RTC S pe - (RW, Non EEPR ARST XTOSCB	R OM) Auto reset enable bit Internal crystal oscillator enable bit. XTOSCB needs to be set to '0' when external crystal is used. XTOSCB needs	000: 1st day of the week 001: 2nd day of the week 010: 3rd day of the week 110: 7th day of the week 0:Disable the automatic reset of the BAT and ALM status bits only 1: Enable the automatic reset of the BAT and ALM status bits only 0: Enable internal crystal oscillator	<0> <0> <0> 0x01, <0>
2] [1] [0])7 Reg Typ [7] [6]	DW2 DW1 DW0 egister Name - RTC S pe - (RW, Non EEPR ARST ARST XTOSCB	R OM) Auto reset enable bit Internal crystal oscillator enable bit. XTOSCB needs to be set to '0' when external crystal is used. XTOSCB needs to be set to 1' when external 32kHz clock signal is applied at XIN pin.	000: 1st day of the week 001: 2nd day of the week 010: 3rd day of the week 110: 7th day of the week 0:Disable the automatic reset of the BAT and ALM status bits only 1: Enable the automatic reset of the BAT and ALM status bits only 0: Enable internal crystal oscillator 1: Disable internal crystal oscillator	<pre></pre>
[2] [1] [0] 07 Re(Tyr [7] [6]	DW2 DW1 DW0 egister Name - RTC S pe - (RW, Non EEPR ARST ARST XTOSCB	R OM) Auto reset enable bit Internal crystal oscillator enable bit. XTOSCB needs to be set to '0' when external crystal is used. XTOSCB needs to be set to 1' when external 32kHz clock	000: 1st day of the week 001: 2nd day of the week 010: 3rd day of the week 110: 7th day of the week 0:Disable the automatic reset of the BAT and ALM status bits only 1: Enable the automatic reset of the BAT and ALM status bits only 0: Enable internal crystal oscillator 1: Disable internal crystal oscillator	<pre><0> <0> <0> <0> </pre> 0x01, <0> <0> <0>
2] [1] [0])7 Reg Typ [7] [6]	DW2 DW1 DW0 egister Name - RTC S pe - (RW, Non EEPR ARST ARST XTOSCB	R OM) Auto reset enable bit Internal crystal oscillator enable bit. XTOSCB needs to be set to '0' when external crystal is used. XTOSCB needs to be set to 1' when external 32kHz clock signal is applied at XIN pin.	000: 1st day of the week 001: 2nd day of the week 010: 3rd day of the week 110: 7th day of the week 0:Disable the automatic reset of the BAT and ALM status bits only 1: Enable the automatic reset of the BAT and ALM status bits only 0: Enable internal crystal oscillator 1: Disable internal crystal oscillator 1: Disable internal crystal oscillator 1: Disable write capability into the RTC timing registers	<pre><0> <0> <0> <0> </pre> 0x01, <0> <0> <0>
2] [1] [0])7 Reg Typ [7] [6]	DW2 DW1 DW0 egister Name - RTC S pe - (RW, Non EEPR ARST ARST XTOSCB	R OM) Auto reset enable bit Internal crystal oscillator enable bit. XTOSCB needs to be set to '0' when external crystal is used. XTOSCB needs to be set to 1' when external 32kHz clock signal is applied at XIN pin.	000: 1st day of the week 001: 2nd day of the week 010: 3rd day of the week 110: 7th day of the week 0:Disable the automatic reset of the BAT and ALM status bits only 1: Enable the automatic reset of the BAT and ALM status bits only 0: Enable internal crystal oscillator 1: Disable internal crystal oscillator 1: Disable internal crystal oscillator 1: Disable write capability into the RTC timing registers 1: Enable write capability into the	<pre><0> <0> <0> <0> </pre> 0x01, <0> <0> <0>
2] [1] [0])7 Reg Typ [7] [6]	DW2 DW1 DW0 egister Name - RTC S pe - (RW, Non EEPR ARST ARST XTOSCB	R OM) Auto reset enable bit Internal crystal oscillator enable bit. XTOSCB needs to be set to '0' when external crystal is used. XTOSCB needs to be set to 1' when external 32kHz clock signal is applied at XIN pin.	000: 1st day of the week 001: 2nd day of the week 010: 3rd day of the week 110: 7th day of the week 0:Disable the automatic reset of the BAT and ALM status bits only 1: Enable the automatic reset of the BAT and ALM status bits only 0: Enable internal crystal oscillator 1: Disable internal crystal oscillator 1: Disable internal crystal oscillator 1: Disable write capability into the RTC timing registers	<pre><0> <0> <0> <0> </pre> 0x01, <0> <0> <0>
[2] [0] [0] [7] [7] [6] [4]	DW2 DW1 DW0 egister Name - RTC S pe - (RW, Non EEPR ARST ARST XTOSCB	R OM) Auto reset enable bit Internal crystal oscillator enable bit. XTOSCB needs to be set to '0' when external crystal is used. XTOSCB needs to be set to 1' when external 32kHz clock signal is applied at XIN pin.	000: 1st day of the week 001: 2nd day of the week 010: 3rd day of the week 110: 7th day of the week 0:Disable the automatic reset of the BAT and ALM status bits only 1: Enable the automatic reset of the BAT and ALM status bits only 0: Enable internal crystal oscillator 1: Disable internal crystal oscillator 1: Disable internal crystal oscillator 1: Disable write capability into the RTC timing registers 1: Enable write capability into the	<pre></pre>
2] [1] [0])7 Reg Typ [7] [7] [6] [4] [3]	DW2 DW1 DW0 egister Name - RTC S pe - (RW, Non EEPR ARST ARST XTOSCB not used WRTC	R OM) Auto reset enable bit Internal crystal oscillator enable bit. XTOSCB needs to be set to '0' when external crystal is used. XTOSCB needs to be set to 1' when external 32kHz clock signal is applied at XIN pin.	000: 1st day of the week 001: 2nd day of the week 010: 3rd day of the week 110: 7th day of the week 0:Disable the automatic reset of the BAT and ALM status bits only 1: Enable the automatic reset of the BAT and ALM status bits only 0: Enable internal crystal oscillator 1: Disable internal crystal oscillator 1: Disable internal crystal oscillator 1: Disable write capability into the RTC timing registers 1: Enable write capability into the RTC timing registers	<pre></pre>
[2] [0] [0] [7] [7] [6] [4]	DW2 DW1 DW0 egister Name - RTC S pe - (RW, Non EEPR ARST ARST XTOSCB not used WRTC	R OM) Auto reset enable bit Internal crystal oscillator enable bit. XTOSCB needs to be set to '0' when external crystal is used. XTOSCB needs to be set to 1' when external 32kHz clock signal is applied at XIN pin. Write RTC enable bit	 000: 1st day of the week 001: 2nd day of the week 010: 3rd day of the week 010: 3rd day of the week 010: 7th day of the week 010: 7th day of the week 010: 7th day of the week 02: Disable the automatic reset of the BAT and ALM status bits only 03: Enable the automatic reset of the BAT and ALM status bits only 04: Enable the automatic reset of the BAT and ALM status bits only 05: Enable internal crystal oscillator 06: Disable write capability into the RTC timing registers 07: Enable write capability into the RTC timing registers 07: Alarm doesn't match the real time 	<0>
2] [1] [0])7 Reg Typ [7] [7] [6] [4] [3]	DW2 DW1 DW0 egister Name - RTC S pe - (RW, Non EEPR ARST ARST XTOSCB not used WRTC	R OM) Auto reset enable bit Internal crystal oscillator enable bit. XTOSCB needs to be set to '0' when external crystal is used. XTOSCB needs to be set to 1' when external 32kHz clock signal is applied at XIN pin. Write RTC enable bit	 000: 1st day of the week 001: 2nd day of the week 010: 3rd day of the week 110: 7th day of the week 110: 7th day of the week 0:Disable the automatic reset of the BAT and ALM status bits only 1: Enable the automatic reset of the BAT and ALM status bits only 0: Enable internal crystal oscillator 1: Disable internal crystal oscillator 1: Disable internal crystal oscillator 1: Enable write capability into the RTC timing registers 1: Enable write capability into the RTC timing registers 0: Alarm doesn't match the real time clock 	<pre></pre>
2] [1] [0] 7 Reg Tyr [7] [7] [6] [4] [2]	DW2 DW1 DW0 egister Name - RTC S pe - (RW, Non EEPRO ARST XTOSCB not used WRTC not used ALM	R OM) Auto reset enable bit Internal crystal oscillator enable bit. XTOSCB needs to be set to '0' when external crystal is used. XTOSCB needs to be set to 1' when external 32kHz clock signal is applied at XIN pin. Write RTC enable bit Alarm bit	000: 1st day of the week 001: 2nd day of the week 010: 3rd day of the week 110: 7th day of the week 0:Disable the automatic reset of the BAT and ALM status bits only 1: Enable the automatic reset of the BAT and ALM status bits only 0: Enable internal crystal oscillator 1: Disable internal crystal oscillator 1: Disable internal crystal oscillator 1: Disable write capability into the RTC timing registers 1: Enable write capability into the RTC timing registers 0: Alarm doesn't match the real time clock 1: Alarm matches the real time clock	<pre></pre>
2] [1] [0])7 Reg Typ [7] [7] [6] [4] [3]	DW2 DW1 DW0 egister Name - RTC S pe - (RW, Non EEPRO ARST XTOSCB not used WRTC not used ALM	R OM) Auto reset enable bit Internal crystal oscillator enable bit. XTOSCB needs to be set to '0' when external crystal is used. XTOSCB needs to be set to 1' when external 32kHz clock signal is applied at XIN pin. Write RTC enable bit	000: 1st day of the week 001: 2nd day of the week 010: 3rd day of the week 110: 7th day of the week 0:Disable the automatic reset of the BAT and ALM status bits only 1: Enable the automatic reset of the BAT and ALM status bits only 0: Enable internal crystal oscillator 1: Disable internal crystal oscillator 1: Disable internal crystal oscillator 1: Disable internal crystal oscillator 1: Enable write capability into the RTC timing registers 1: Enable write capability into the RTC timing registers 1: Enable write capability into the RTC timing registers 0: Alarm doesn't match the real time clock 1: Alarm matches the real time clock 0: No battery	<pre></pre>
2] [1] [0] 7 Reg Tyr [7] [7] [6] [4] [2]	DW2 DW1 DW0 egister Name - RTC S pe - (RW, Non EEPR ARST ARST XTOSCB not used WRTC not used ALM BAT	R OM) Auto reset enable bit Internal crystal oscillator enable bit. XTOSCB needs to be set to '0' when external crystal is used. XTOSCB needs to be set to 1' when external 32kHz clock signal is applied at XIN pin. Write RTC enable bit Alarm bit	000: 1st day of the week 001: 2nd day of the week 010: 3rd day of the week 110: 7th day of the week 0:Disable the automatic reset of the BAT and ALM status bits only 1: Enable the automatic reset of the BAT and ALM status bits only 0: Enable internal crystal oscillator 1: Disable internal crystal oscillator 1: Disable internal crystal oscillator 1: Disable write capability into the RTC timing registers 1: Enable write capability into the RTC timing registers 0: Alarm doesn't match the real time clock 1: Alarm matches the real time clock	<pre></pre>



	er Name - RTC IN⁻ (RW, Non EEPRC			0x10 /
.) 0	(,	,		
771	ha a		b. En alder single second also and a	101
[7]	IM	Interrupt/alarm mode bit	0: Enable single event alarm mode 1: Enable periodic interrupt alarm	<0>
			mode	
[6]	ALME	Alarm enable bit	0: Disable the alarm function	<0>
[0]			1: Enable the alarm function	104
[5]	LPMODE	Oscillator bias current control bit	0: Normal oscillator bias current	<0>
[0]			1: Reduced oscillator bias current	Ŭ
[4]	FOBATB	Enable/disable the FOUT/IRQ function in	0: Disable the FOUT/IRQ function in	<1>
		battery backup mode	battery backup mode	
			1: Enable the FOUT/IRQ function in	
			battery backup mode	
[3:0]	FO	Enable/disable the frequency output func-	0000: 0Hz	<0000
		tion and select the output frequency at the	0001: 32768Hz	
		INT# pin	0010: 4096Hz	
			0011: 1024Hz	
			0100: 64Hz	
			0101: 32Hz	
			0110: 16Hz	
			0111: 8Hz	
			1000: 4Hz	
			1001: 2Hz	
			1010: 1Hz	
			1011: 1/2Hz	
			1100: 1/4Hz	
			1101: 1/8Hz	
			1110: 1/16Hz	
			1111: 1/32Hz	
Registe	ed for Renesas In er Name - RTC AT (RW, Non EEPRC	R		0x00 /
Registe	er Name - RTC AT	R M) Battery mode ATR selection. Adjust the	00: 0pF	
Registe Type -	er Name - RTC AT (RW, Non EEPRC	R M) Battery mode ATR selection. Adjust the on-chip capacitance when the RTC power	01: -0.5pF	
Registe Type -	er Name - RTC AT (RW, Non EEPRC	R M) Battery mode ATR selection. Adjust the on-chip capacitance when the RTC power source switches between VCHG and	01: -0.5pF 10: +0.5pF	
Registe Type - [7:6]	er Name - RTC AT (RW, Non EEPRC BMATR	R M) Battery mode ATR selection. Adjust the on-chip capacitance when the RTC power source switches between VCHG and VBAT	01: -0.5pF 10: +0.5pF 11: 1pF	<00>
Registe Type -	er Name - RTC AT (RW, Non EEPRC	R M) Battery mode ATR selection. Adjust the on-chip capacitance when the RTC power source switches between VCHG and	01: -0.5pF 10: +0.5pF 11: 1pF Cload = [16 x (~ATR[5]) + 8 x ATR[4] + 4 x ATR[3] + 2 x ATR[2] + 1 x	<00>
Registe Type - [7:6]	er Name - RTC AT (RW, Non EEPRC BMATR	R M) Battery mode ATR selection. Adjust the on-chip capacitance when the RTC power source switches between VCHG and VBAT Adjust the on-chip load capacitance value	01: -0.5pF 10: +0.5pF 11: 1pF Cload = [16 x (~ATR[5]) + 8 x ATR[4] + 4 x ATR[3] + 2 x ATR[2] + 1 x ATR[1] + 0.5 x ATR[0] + 9]/2 (pF)	<00>
Registe Type - [7:6]	er Name - RTC AT (RW, Non EEPRC BMATR	R M) Battery mode ATR selection. Adjust the on-chip capacitance when the RTC power source switches between VCHG and VBAT Adjust the on-chip load capacitance value	01: -0.5pF 10: +0.5pF 11: 1pF Cload = [16 x (~ATR[5]) + 8 x ATR[4] + 4 x ATR[3] + 2 x ATR[2] + 1 x	<00>
Registe Type - [7:6]	er Name - RTC AT (RW, Non EEPRC BMATR	R M) Battery mode ATR selection. Adjust the on-chip capacitance when the RTC power source switches between VCHG and VBAT Adjust the on-chip load capacitance value	01: -0.5pF 10: +0.5pF 11: 1pF Cload = [16 x (~ATR[5]) + 8 x ATR[4] + 4 x ATR[3] + 2 x ATR[2] + 1 x ATR[1] + 0.5 x ATR[0] + 9]/2 (pF) RTC ATR[5:0] decode: 000000 : 12.5pF	<00>
Registe Type - [7:6]	er Name - RTC AT (RW, Non EEPRC BMATR	R M) Battery mode ATR selection. Adjust the on-chip capacitance when the RTC power source switches between VCHG and VBAT Adjust the on-chip load capacitance value	01: -0.5pF 10: +0.5pF 11: 1pF Cload = [16 x (~ATR[5]) + 8 x ATR[4] + 4 x ATR[3] + 2 x ATR[2] + 1 x ATR[1] + 0.5 x ATR[0] + 9]/2 (pF) RTC ATR[5:0] decode:	<00>
Registe Type - [7:6]	er Name - RTC AT (RW, Non EEPRC BMATR	R M) Battery mode ATR selection. Adjust the on-chip capacitance when the RTC power source switches between VCHG and VBAT Adjust the on-chip load capacitance value	01: -0.5pF 10: +0.5pF 11: 1pF Cload = [16 x (~ATR[5]) + 8 x ATR[4] + 4 x ATR[3] + 2 x ATR[2] + 1 x ATR[1] + 0.5 x ATR[0] + 9]/2 (pF) RTC ATR[5:0] decode: 000000 : 12.5pF 000001 : 12.75pF	<00>
Registe Type - [7:6]	er Name - RTC AT (RW, Non EEPRC BMATR	R M) Battery mode ATR selection. Adjust the on-chip capacitance when the RTC power source switches between VCHG and VBAT Adjust the on-chip load capacitance value	01: -0.5pF 10: +0.5pF 11: 1pF Cload = [16 x (~ATR[5]) + 8 x ATR[4] + 4 x ATR[3] + 2 x ATR[2] + 1 x ATR[1] + 0.5 x ATR[0] + 9]/2 (pF) RTC ATR[5:0] decode: 000000 : 12.5pF 000001 : 12.75pF	<00>
Registe Type - [7:6]	er Name - RTC AT (RW, Non EEPRC BMATR	R M) Battery mode ATR selection. Adjust the on-chip capacitance when the RTC power source switches between VCHG and VBAT Adjust the on-chip load capacitance value	01: -0.5pF 10: +0.5pF 11: 1pF Cload = [16 x (~ATR[5]) + 8 x ATR[4] + 4 x ATR[3] + 2 x ATR[2] + 1 x ATR[1] + 0.5 x ATR[0] + 9]/2 (pF) RTC ATR[5:0] decode: 000000 : 12.5pF 000001 : 12.75pF 000001 : 13.0pF 011110 : 20.0pF	<00>
Registe Type - [7:6]	er Name - RTC AT (RW, Non EEPRC BMATR	R M) Battery mode ATR selection. Adjust the on-chip capacitance when the RTC power source switches between VCHG and VBAT Adjust the on-chip load capacitance value	01: -0.5pF 10: +0.5pF 11: 1pF Cload = [16 x (~ATR[5]) + 8 x ATR[4] + 4 x ATR[3] + 2 x ATR[2] + 1 x ATR[1] + 0.5 x ATR[0] + 9]/2 (pF) RTC ATR[5:0] decode: 000000 : 12.5pF 000001 : 12.75pF 000010 : 13.0pF 	<00>
Registe Type - [7:6]	er Name - RTC AT (RW, Non EEPRC BMATR	R M) Battery mode ATR selection. Adjust the on-chip capacitance when the RTC power source switches between VCHG and VBAT Adjust the on-chip load capacitance value	01: -0.5pF 10: +0.5pF 11: 1pF Cload = [16 x (~ATR[5]) + 8 x ATR[4] + 4 x ATR[3] + 2 x ATR[2] + 1 x ATR[1] + 0.5 x ATR[0] + 9]/2 (pF) RTC ATR[5:0] decode: 000000 : 12.5pF 000001 : 12.75pF 000001 : 13.0pF 011110 : 20.0pF 011111 : 20.25pF	<00>
Registe Type - [7:6]	er Name - RTC AT (RW, Non EEPRC BMATR	R M) Battery mode ATR selection. Adjust the on-chip capacitance when the RTC power source switches between VCHG and VBAT Adjust the on-chip load capacitance value	01: -0.5pF 10: +0.5pF 11: 1pF Cload = [16 x (~ATR[5]) + 8 x ATR[4] + 4 x ATR[3] + 2 x ATR[2] + 1 x ATR[1] + 0.5 x ATR[0] + 9]/2 (pF) RTC ATR[5:0] decode: 000000 : 12.5pF 000001 : 12.75pF 000010 : 13.0pF 011110 : 20.0pF 011111 : 20.25pF 100000 : 4.5pF 1000001 : 4.75pF 111101 : 11.75pF	<00>
Registe Type - [7:6]	er Name - RTC AT (RW, Non EEPRC BMATR	R M) Battery mode ATR selection. Adjust the on-chip capacitance when the RTC power source switches between VCHG and VBAT Adjust the on-chip load capacitance value	01: -0.5pF 10: +0.5pF 11: 1pF Cload = [16 x (~ATR[5]) + 8 x ATR[4] + 4 x ATR[3] + 2 x ATR[2] + 1 x ATR[1] + 0.5 x ATR[0] + 9]/2 (pF) RTC ATR[5:0] decode: 000000 : 12.5pF 000001 : 12.75pF 000010 : 13.0pF 011110 : 20.0pF 011111 : 20.25pF 100000 : 4.5pF 1000001 : 4.75pF 111101 : 11.75pF 111110 : 12.0pF	<00>
Registe Type - [7:6]	BMATR	R M) Battery mode ATR selection. Adjust the on-chip capacitance when the RTC power source switches between VCHG and VBAT Adjust the on-chip load capacitance value for frequency compensation of the RTC	01: -0.5pF 10: +0.5pF 11: 1pF Cload = [16 x (~ATR[5]) + 8 x ATR[4] + 4 x ATR[3] + 2 x ATR[2] + 1 x ATR[1] + 0.5 x ATR[0] + 9]/2 (pF) RTC ATR[5:0] decode: 000000 : 12.5pF 000001 : 12.75pF 000010 : 13.0pF 011110 : 20.0pF 011111 : 20.25pF 100000 : 4.5pF 1000001 : 4.75pF 111101 : 11.75pF	<00>
Registe Type - [7:6] [5:0]	BMATR BMATR ATR ATR	R M) Battery mode ATR selection. Adjust the on-chip capacitance when the RTC power source switches between VCHG and VBAT Adjust the on-chip load capacitance value for frequency compensation of the RTC	01: -0.5pF 10: +0.5pF 11: 1pF Cload = [16 x (~ATR[5]) + 8 x ATR[4] + 4 x ATR[3] + 2 x ATR[2] + 1 x ATR[1] + 0.5 x ATR[0] + 9]/2 (pF) RTC ATR[5:0] decode: 000000 : 12.5pF 000001 : 12.75pF 000010 : 13.0pF 011110 : 20.0pF 011111 : 20.25pF 100000 : 4.5pF 1000001 : 4.75pF 111101 : 11.75pF 111110 : 12.0pF	<00>
Registe Type - [7:6] [5:0]	BMATR	R M) Battery mode ATR selection. Adjust the on-chip capacitance when the RTC power source switches between VCHG and VBAT Adjust the on-chip load capacitance value for frequency compensation of the RTC	01: -0.5pF 10: +0.5pF 11: 1pF Cload = [16 x (~ATR[5]) + 8 x ATR[4] + 4 x ATR[3] + 2 x ATR[2] + 1 x ATR[1] + 0.5 x ATR[0] + 9]/2 (pF) RTC ATR[5:0] decode: 000000 : 12.5pF 000001 : 12.75pF 000010 : 13.0pF 011110 : 20.0pF 011111 : 20.25pF 100000 : 4.5pF 1000001 : 4.75pF 111101 : 11.75pF 111110 : 12.0pF	<00>
Registe Type - [7:6] [5:0]	BMATR BMATR ATR ATR	R M) Battery mode ATR selection. Adjust the on-chip capacitance when the RTC power source switches between VCHG and VBAT Adjust the on-chip load capacitance value for frequency compensation of the RTC	01: -0.5pF 10: +0.5pF 11: 1pF Cload = [16 x (~ATR[5]) + 8 x ATR[4] + 4 x ATR[3] + 2 x ATR[2] + 1 x ATR[1] + 0.5 x ATR[0] + 9]/2 (pF) RTC ATR[5:0] decode: 000000 : 12.5pF 000001 : 12.75pF 000010 : 13.0pF 011110 : 20.0pF 011111 : 20.25pF 100000 : 4.5pF 1000001 : 4.75pF 111101 : 11.75pF 111110 : 12.0pF	<00> <00000
Registe Type - [7:6] [5:0] Registe Type -	ET Name - RTC AT (RW, Non EEPRC BMATR ATR ATR er Name - RTC DT (RW, Non EEPRC	R M) Battery mode ATR selection. Adjust the on-chip capacitance when the RTC power source switches between VCHG and VBAT Adjust the on-chip load capacitance value for frequency compensation of the RTC	01: -0.5pF 10: +0.5pF 11: 1pF Cload = [16 x (~ATR[5]) + 8 x ATR[4] + 4 x ATR[3] + 2 x ATR[2] + 1 x ATR[1] + 0.5 x ATR[0] + 9]/2 (pF) RTC ATR[5:0] decode: 000000 : 12.5pF 000001 : 12.75pF 000010 : 13.0pF 011110 : 20.0pF 011111 : 20.25pF 100000 : 4.5pF 1000001 : 4.75pF 111101 : 11.75pF 111110 : 12.0pF	<00> <000000
Registe Type - [7:6] [5:0] Registe Type -	ET Name - RTC AT (RW, Non EEPRC BMATR ATR ATR er Name - RTC DT (RW, Non EEPRC	R M) Battery mode ATR selection. Adjust the on-chip capacitance when the RTC power source switches between VCHG and VBAT Adjust the on-chip load capacitance value for frequency compensation of the RTC for frequency compensation of the RTC R M)	01: -0.5pF 10: +0.5pF 11: 1pF Cload = [16 x (~ATR[5]) + 8 x ATR[4] + 4 x ATR[3] + 2 x ATR[2] + 1 x ATR[1] + 0.5 x ATR[0] + 9]/2 (pF) RTC ATR[5:0] decode: 000000 : 12.5pF 000001 : 12.75pF 000010 : 13.0pF 011110 : 20.0pF 011111 : 20.25pF 100000 : 4.5pF 100001 : 4.75pF 111101 : 11.75pF 111110 : 12.0pF 111111 : 12.25pF	<00> <000000
Registe Type - [7:6] [5:0] Registe Type -	ET Name - RTC AT (RW, Non EEPRC BMATR ATR ATR er Name - RTC DT (RW, Non EEPRC	R M) Battery mode ATR selection. Adjust the on-chip capacitance when the RTC power source switches between VCHG and VBAT Adjust the on-chip load capacitance value for frequency compensation of the RTC	01: -0.5pF 10: +0.5pF 11: 1pF Cload = [16 x (~ATR[5]) + 8 x ATR[4] + 4 x ATR[3] + 2 x ATR[2] + 1 x ATR[1] + 0.5 x ATR[0] + 9]/2 (pF) RTC ATR[5:0] decode: 000000 : 12.5pF 000001 : 12.75pF 000010 : 13.0pF 011110 : 20.0pF 011111 : 20.25pF 100000 : 4.5pF 100000 : 4.5pF 100001 : 4.75pF 111101 : 11.75pF 111110 : 12.0pF 111111 : 12.25pF	<00> <00000
Registe Type - [7:6] [5:0] Registe Type -	ET Name - RTC AT (RW, Non EEPRC BMATR ATR ATR er Name - RTC DT (RW, Non EEPRC	R M) Battery mode ATR selection. Adjust the on-chip capacitance when the RTC power source switches between VCHG and VBAT Adjust the on-chip load capacitance value for frequency compensation of the RTC for frequency compensation of the RTC R M)	01: -0.5pF 10: +0.5pF 11: 1pF Cload = [16 x (~ATR[5]) + 8 x ATR[4] + 4 x ATR[3] + 2 x ATR[2] + 1 x ATR[1] + 0.5 x ATR[0] + 9]/2 (pF) RTC ATR[5:0] decode: 000000 : 12.5pF 000001 : 12.75pF 000001 : 12.75pF 000010 : 13.0pF 011110 : 20.0pF 011111 : 20.25pF 100000 : 4.5pF 1000001 : 4.75pF 111101 : 11.75pF 111110 : 12.0pF 111111 : 12.25pF 000: 0ppm 000: 0ppm 001: +20ppm	0x00 / <00> <00000 <00000 <0000 <0000
Registe Type - [7:6] [5:0] Registe Type -	ET Name - RTC AT (RW, Non EEPRC BMATR ATR ATR er Name - RTC DT (RW, Non EEPRC	R M) Battery mode ATR selection. Adjust the on-chip capacitance when the RTC power source switches between VCHG and VBAT Adjust the on-chip load capacitance value for frequency compensation of the RTC for frequency compensation of the RTC R M)	01: -0.5pF 10: +0.5pF 11: 1pF Cload = [16 x (~ATR[5]) + 8 x ATR[4] + 4 x ATR[3] + 2 x ATR[2] + 1 x ATR[1] + 0.5 x ATR[0] + 9]/2 (pF) RTC ATR[5:0] decode: 000000 : 12.5pF 000001 : 12.75pF 000001 : 12.75pF 000001 : 13.0pF 011110 : 20.0pF 011111 : 20.25pF 100000 : 4.5pF 1000001 : 4.75pF 111101 : 11.75pF 111110 : 12.0pF 111111 : 12.25pF 000: 0ppm 001: +20ppm 010: +40ppm	<000 <000000 0x00 /
Registe Type - [7:6] [5:0] Registe Type -	ET Name - RTC AT (RW, Non EEPRC BMATR ATR ATR er Name - RTC DT (RW, Non EEPRC	R M) Battery mode ATR selection. Adjust the on-chip capacitance when the RTC power source switches between VCHG and VBAT Adjust the on-chip load capacitance value for frequency compensation of the RTC for frequency compensation of the RTC R M)	01: -0.5pF 10: +0.5pF 11: 1pF Cload = [16 x (~ATR[5]) + 8 x ATR[4] + 4 x ATR[3] + 2 x ATR[2] + 1 x ATR[1] + 0.5 x ATR[0] + 9]/2 (pF) RTC ATR[5:0] decode: 000000 : 12.5pF 000001 : 12.75pF 000001 : 12.75pF 000001 : 13.0pF 011110 : 20.0pF 011111 : 20.25pF 100000 : 4.5pF 1000001 : 4.75pF 111101 : 11.75pF 111110 : 12.0pF 111111 : 12.25pF 000: 0ppm 001: +20ppm 010: +40ppm 011: +60ppm	<000 <000000 0x00 /
Registe Type - [7:6] [5:0] Registe Type -	ET Name - RTC AT (RW, Non EEPRC BMATR ATR ATR er Name - RTC DT (RW, Non EEPRC	R M) Battery mode ATR selection. Adjust the on-chip capacitance when the RTC power source switches between VCHG and VBAT Adjust the on-chip load capacitance value for frequency compensation of the RTC for frequency compensation of the RTC R M)	01: -0.5pF 10: +0.5pF 11: 1pF Cload = [16 x (~ATR[5]) + 8 x ATR[4] + 4 x ATR[3] + 2 x ATR[2] + 1 x ATR[1] + 0.5 x ATR[0] + 9]/2 (pF) RTC ATR[5:0] decode: 000000 : 12.5pF 000001 : 12.75pF 000010 : 13.0pF 011110 : 20.0pF 011111 : 20.25pF 100000 : 4.5pF 1000001 : 4.75pF 111101 : 11.75pF 111110 : 12.0pF 111111 : 12.25pF 000: 0ppm 001: +20ppm 010: +40ppm 011: +60ppm 100: 0ppm	<000 <000000 0x00 /



-	ter Name - RTC SC - (RW, Non EEPRC			0x00 / (
i ypc		, , , , , , , , , , , , , , , , , , ,		
[7]	ESCA	Enable or disable alarm register bytes for seconds	0: Disable the alarm register bytes for seconds 1: Enable the alarm register bytes for seconds	<0>
[6]	ASC22	Set alarm seconds (0-59) in BCD format.	RTC ASC[6:0] BCD decode:	<0>
[5]	ASC21	The alarm will be triggered once a match	0000000: 0sec	<0>
[4]	ASC20	occurs between the alarm registers and	0000001: 1sec	<0>
[3]	ASC13	the RTC registers for seconds	0000010: 2sec	<0>
[2]	ASC12			<0>
[1]	ASC11		0001001: 9sec	<0>
[0]	ASC10		0010000: 10sec 0010001: 11sec	<0>
			 1010111: 57sec 1011000: 58sec	
•	ter Name - RTC MN		1011001: 59sec	0x00 /
•	ter Name - RTC MN - (RW, Non EEPRC			0x00 /
•			1011001: 59sec	0x00 / <0>
Type	- (RW, Non EEPRC	DM) Enable or disable alarm register bytes for minutes	1011001: 59sec 0: Disable the alarm register bytes for minutes 1: Enable the alarm register bytes for	
Type	- (RW, Non EEPRC	DM) Enable or disable alarm register bytes for minutes Set alarm minutes (0-59) in BCD format. The alarm will be triggered once a match	1011001: 59sec 0: Disable the alarm register bytes for minutes 1: Enable the alarm register bytes for minutes RTC AMN[6:0] BCD decode: 0000000: 0min	<0>
Type - [7]	- (RW, Non EEPRC EMNA AMN22	DM) Enable or disable alarm register bytes for minutes Set alarm minutes (0-59) in BCD format. The alarm will be triggered once a match occurs between the alarm registers and	1011001: 59sec 0: Disable the alarm register bytes for minutes 1: Enable the alarm register bytes for minutes RTC AMN[6:0] BCD decode: 0000000: 0min 0000001: 1min	<0>
Type - [7] [6] [5]	- (RW, Non EEPRC EMNA AMN22 AMN21	DM) Enable or disable alarm register bytes for minutes Set alarm minutes (0-59) in BCD format. The alarm will be triggered once a match	1011001: 59sec 0: Disable the alarm register bytes for minutes 1: Enable the alarm register bytes for minutes RTC AMN[6:0] BCD decode: 0000000: 0min	<0> <0> <0>
Type - [7] [6] [5] [4]	- (RW, Non EEPRC EMNA AMN22 AMN21 AMN20	DM) Enable or disable alarm register bytes for minutes Set alarm minutes (0-59) in BCD format. The alarm will be triggered once a match occurs between the alarm registers and	1011001: 59sec 0: Disable the alarm register bytes for minutes 1: Enable the alarm register bytes for minutes RTC AMN[6:0] BCD decode: 0000000: 0min 0000001: 1min 0000010: 2min 	<0> <0> <0> <0> <0>
Type - [7] [6] [5] [4] [3]	- (RW, Non EEPRC EMNA AMN22 AMN21 AMN20 AMN13	DM) Enable or disable alarm register bytes for minutes Set alarm minutes (0-59) in BCD format. The alarm will be triggered once a match occurs between the alarm registers and	1011001: 59sec 0: Disable the alarm register bytes for minutes 1: Enable the alarm register bytes for minutes RTC AMN[6:0] BCD decode: 0000000: 0min 0000001: 1min 0000010: 2min 0001001: 9min	<0> <0> <0> <0> <0> <0> <0>
Type - [7] [6] [5] [4] [3] [2]	- (RW, Non EEPRC EMNA AMN22 AMN21 AMN20 AMN13 AMN12	DM) Enable or disable alarm register bytes for minutes Set alarm minutes (0-59) in BCD format. The alarm will be triggered once a match occurs between the alarm registers and	1011001: 59sec 0: Disable the alarm register bytes for minutes 1: Enable the alarm register bytes for minutes RTC AMN[6:0] BCD decode: 0000000: 0min 0000001: 1min 0000010: 2min 	<0> <0> <0> <0> <0> <0> <0> <0> <0>



-	er Name - RTC HF (RW, Non EEPRC			0>
	(,	,		
[7]	EHRA	Enable or disable alarm register bytes for	0: Disable the alarm register bytes	
		hours	for hours	
			1: Enable the alarm register bytes for	
·61	not used		hours	
[6]	not used	Dathaumain DOD farmat If the Mill hit is	5 NAU - 4	
[5]	AHR21		If MIL = 1 RTC AHR[5:0] decodes for 24-hour	
[4]	AHR20	AHR21 bit functions as an AM/PM indica-		
[3]	AHR13	tor with a "1" representing PM. The alarm		
[2]	AHR12		000001: 1hr	
[1]	AHR11	between the alarm registers and the RTC		
[0]	AHR10	registers for hours	001001: 9hr	
			010000: 10hr	
			011001: 19hr	
			100000: 20hr	
			100011: 23hr	
			f MIL = 0	
			If MIL = 0 RTC AHR[4:0] decodes for 12-hour	
			format with RTC AHR[5] indicating AM/PM:	
			AM/PM: 00000: INVALID	
			00001: 1 AM/PM	
			00010: 2 AM/PM	
			 01001: 9 AM/PM	
			10000: 10 AM/PM	
			10001: 11 AM/PM	
			10010: 12 AM/PM	
Registe	er Name - RTC DT	A		(
Гуре -	(RW, Non EEPRC	DM)		
[7]	EDTA	Enable or disable alarm register bytes for	0: Disable the alarm register bytes	
		date	for date	
			1: Enable the alarm register bytes for	
61	not used		date	
[6] [5]	ADT21	Set alarm date (1-31) in BCD format. The	RTC ADT[5:0] BCD decode:	
[4]	ADT20	alarm will be triggered once a match	000000: INVALID	
[3]	ADT20 ADT13	occurs between the alarm registers and	000001: date 1	
	ADT12		000010: date 2	
[2]			ļ	
[1]	ADT11		001001: date 9	
[0]	ADT10		010000: date 10	
			I	
			011001: date 19	
]				
			100000: date 20	
			 101001: date 29	



Туре -	er Name - RTC MC (RW, Non EEPRC			0x0
[7]	EMOA	Enable or disable alarm register bytes for	0: Disable the alarm register bytes	<
		month	for month 1: Enable the alarm register bytes for	
[6:5]	not used		month	<0
[0.5] [4]	AMO20	Set alarm month (1-12) in BCD format.	RTC AMO[4:0] BCD decode:	<
[3]	AMO13	The alarm will be triggered once a match	00000: INVALID	<
[2]	AMO12	occurs between the alarm registers and	00001: 1st month (Jan)	<
[1]	AMO11	the RTC registers for month	00010: 2nd month (Feb)	<
[0]	AMO10		00011: 3rd month (Mar)	<
			 01001: 9th month (Sep) 10000: 10th month (Oct) 10001: 11th month (Nov) 10010: 12th month(Dec)	
Registe	er Name - RTC DV	VA		0x0
Туре -	(RW, Non EEPRC	M)		
[7]	EDWA	Enable or disable alarm register bytes for day of the week	for day of the week 1: Enable the alarm register bytes for	<
[6:3]	not used		day of the week	<00
[2]	ADW12	Set alarm day of the week (1-7). The	RTC ADW[2:0] decodes:	<
	ADW12	alarm will be triggered once a match	000: 1st day of the week	<
[1] [0]		occurs between the alarm registers and		<
[0]	ADW10	occurs between the alarm registers and the RTC registers for day of the week	001: 2nd day of the week 010: 3rd day of the week 110: 7th day of the week	<
[0] Registe		occurs between the alarm registers and the RTC registers for day of the week	001: 2nd day of the week 010: 3rd day of the week …	
[0] Registe Type - [7]	ADW10 er Name - RTC US (RW, Non EEPRC USR17	occurs between the alarm registers and the RTC registers for day of the week	001: 2nd day of the week 010: 3rd day of the week …	0x0
[0] Regista Type - [7] [6]	ADW10 er Name - RTC US (RW, Non EEPRC USR17 USR16	occurs between the alarm registers and the RTC registers for day of the week R1 M)	001: 2nd day of the week 010: 3rd day of the week …	0x0 <
[0] Registe Type - [7]	ADW10 er Name - RTC US (RW, Non EEPRC USR17	occurs between the alarm registers and the RTC registers for day of the week R1 M)	001: 2nd day of the week 010: 3rd day of the week …	0x0 <
[0] Regista Type - [7] [6]	ADW10 er Name - RTC US (RW, Non EEPRC USR17 USR16	occurs between the alarm registers and the RTC registers for day of the week R1 M)	001: 2nd day of the week 010: 3rd day of the week …	0x0 < <
[0] Regista Type - [7] [6] [5] [4]	ADW10 er Name - RTC US (RW, Non EEPRC USR17 USR16 USR15	occurs between the alarm registers and the RTC registers for day of the week R1 M)	001: 2nd day of the week 010: 3rd day of the week …	0x0 < < <
[0] Regista Type - [7] [6] [5] [4] [3]	ADW10 er Name - RTC US (RW, Non EEPRC USR17 USR16 USR15 USR14 USR13	occurs between the alarm registers and the RTC registers for day of the week R1 M)	001: 2nd day of the week 010: 3rd day of the week …	0x0 < < < <
[0] Registe Type - [7] [6] [5] [4] [3] [2]	ADW10 er Name - RTC US (RW, Non EEPRC USR17 USR16 USR15 USR14 USR13 USR12	occurs between the alarm registers and the RTC registers for day of the week R1 M)	001: 2nd day of the week 010: 3rd day of the week …	0x0 < < < <
[0] Regista Type - [7] [6] [5] [4] [3] [2] [1]	ADW10 er Name - RTC US (RW, Non EEPRC USR17 USR16 USR15 USR14 USR13 USR12 USR11	occurs between the alarm registers and the RTC registers for day of the week R1 M)	001: 2nd day of the week 010: 3rd day of the week …	0x0 < < < < <
[0] Regista Type - [7] [6] [5] [4] [3] [2] [1] [0]	ADW10 er Name - RTC US (RW, Non EEPRC USR17 USR16 USR16 USR14 USR14 USR13 USR12 USR11 USR11 USR10	bccurs between the alarm registers and the RTC registers for day of the week IR1 M) Battery-backed user memory storage	001: 2nd day of the week 010: 3rd day of the week …	0x0 < < < < < <
[0] Regista Type - [7] [6] [5] [4] [3] [2] [1] [0] Regista	ADW10 er Name - RTC US (RW, Non EEPRC USR17 USR16 USR15 USR14 USR13 USR12 USR11	bccurs between the alarm registers and the RTC registers for day of the week	001: 2nd day of the week 010: 3rd day of the week …	 0x0
[0] Regista Type - [7] [6] [5] [4] [3] [2] [1] [0] Regista Type -	ADW10 er Name - RTC US (RW, Non EEPRC USR17 USR16 USR16 USR14 USR13 USR12 USR12 USR11 USR10 er Name - RTC US	bccurs between the alarm registers and the RTC registers for day of the week	001: 2nd day of the week 010: 3rd day of the week …	0x0 < < < < < < <
[0] Registe Type - [7] [6] [5] [4] [3] [2] [1] [0] Registe Type - [7]	ADW10 er Name - RTC US (RW, Non EEPRC USR17 USR16 USR16 USR15 USR14 USR13 USR12 USR11 USR10 er Name - RTC US (RW, Non EEPRC USR27	bccurs between the alarm registers and the RTC registers for day of the week	001: 2nd day of the week 010: 3rd day of the week …	0x0 < < < < < < < < < < < < < < < < < <
[0] Registe Type - [7] [6] [5] [4] [3] [2] [1] [0] Registe Type - [7] [6]	ADW10 er Name - RTC US (RW, Non EEPRC USR17 USR16 USR15 USR14 USR13 USR12 USR11 USR10 er Name - RTC US (RW, Non EEPRC USR27 USR26	bccurs between the alarm registers and the RTC registers for day of the week	001: 2nd day of the week 010: 3rd day of the week …	0x0 > > > > > > > > > > > > > > > > > >
[0] Registe Type - [7] [6] [4] [3] [4] [3] [3] [4] [3] [3] [7] [6] [5]	ADW10 er Name - RTC US (RW, Non EEPRC USR17 USR16 USR15 USR14 USR13 USR12 USR11 USR10 er Name - RTC US (RW, Non EEPRC USR27 USR26 USR25	bccurs between the alarm registers and the RTC registers for day of the week	001: 2nd day of the week 010: 3rd day of the week …	0x0 > > > > > > > > > > > > > > > > > >
[0] Registe Type - [7] [6] [3] [2] [1] [2] [1] [2] [3] [2] [1] [6] [5] [4]	ADW10 er Name - RTC US (RW, Non EEPRC USR17 USR16 USR16 USR14 USR13 USR12 USR11 USR10 er Name - RTC US (RW, Non EEPRC USR27 USR26 USR25 USR24	bccurs between the alarm registers and the RTC registers for day of the week	001: 2nd day of the week 010: 3rd day of the week …	0x0 > > > > > > > > > > > > > > > > > >
[0] Registe Type - [7] [6] [5] [4] [3] [2] [1] [3] [7] [6] [5] [4] [3]	ADW10 er Name - RTC US (RW, Non EEPRC USR17 USR16 USR15 USR14 USR13 USR12 USR11 USR10 er Name - RTC US (RW, Non EEPRC USR27 USR26 USR25 USR24 USR23	bccurs between the alarm registers and the RTC registers for day of the week	001: 2nd day of the week 010: 3rd day of the week …	0x0 > > > > > > > > > > > > > > > > > >
[0] Registe Type - [7] [6] [3] [2] [1] [2] [1] [2] [1] [2] [3] [2] [3] [4] [5] [4]	ADW10 er Name - RTC US (RW, Non EEPRC USR17 USR16 USR16 USR14 USR13 USR12 USR11 USR10 er Name - RTC US (RW, Non EEPRC USR27 USR26 USR25 USR24	bccurs between the alarm registers and the RTC registers for day of the week	001: 2nd day of the week 010: 3rd day of the week …	0x0 < < < < < < < < < < < < < < < < < <
[0] Registe Type - [7] [6] [3] [4] [3] [2] [1] [3] [7] [6] [5] [4] [3]	ADW10 er Name - RTC US (RW, Non EEPRC USR17 USR16 USR15 USR14 USR13 USR12 USR11 USR10 er Name - RTC US (RW, Non EEPRC USR27 USR26 USR25 USR24 USR23	bccurs between the alarm registers and the RTC registers for day of the week	001: 2nd day of the week 010: 3rd day of the week …	0x0 < < < < < < < < < < < < < < < < < <

	ster Name - Main Slave A - (RW, EEPROM)	ddress		0x00 / 0
,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	(, - ,			
[7]	not used			<0>
[6:0]	Main Slave Addr	Set the 7-bit main I2C slave address	0000000: slave address 0x12 0000001: slave address 0x01 0000010: slave address 0x02	<0000000
			 11111111: slave address 0x7F	
	ster Name - RTC Slave A - (RW, EEPROM)	ddress		0x00 / 0
[7]	not used			<0>
[6:0]	RTC Slave Addr	Set the 7-bit RTC I2C slave address	0000000: slave address 0x6F 0000001: slave address 0x01 0000010: slave address 0x02	<0000000
			1111111: slave address 0x7F	
	ster Name - Buck1 Enable - (RW, EEPROM)	9		0x07 / 7
[7:5]	not used			<000>
[4]	Buck1 Phase Sync EN	Enable Buck1 Phase Synchronization function	0: Disabled 1: Enabled	<0>
[3]	Buck1 SS EN	Enable Buck1 PFM Spread Spectrum function in PFM mode	0: Disabled 1: Enabled	<0>
[2]	Buck1 ABS EN	Enable Buck1 ABS (Ultrasonic) mode	0: Disabled 1: Enabled	<1>
[1]	Buck1 EN SLEEP	Enable Buck1 in SLEEP state	0: Disabled 1: Enabled	<1>
[0]	Buck1 EN ACTIVE	Enable Buck1 in ACTIVE state	0: Disabled 1: Enabled	<1>
01 D ·			1	0.00/0
Туре	ter Name - Buck1 ACTIV - (RW, EEPROM)	L /E		0x06 / 6
Type [7:6]	- (RW, EEPROM)		· · · · · · · · · · · · · · · · · · ·	0x06 / 6
Туре	- (RW, EEPROM)	E Set Buck1 operation mode in ACTIVE state	00: Auto PFM/PWM mode 01: Forced PWM mode	
Type [7:6] [5:4] [3:0]	- (RW, EEPROM) hot used Buck1 Mode ACTIVE Buck1 Vo ACTIVE	Set Buck1 operation mode in ACTIVE state Set Buck1 output voltage in ACTIVE state	00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved	<00> <00> <0110>
Type [7:6] [5:4] [3:0] (22 Regis	- (RW, EEPROM) hot used Buck1 Mode ACTIVE	Set Buck1 operation mode in ACTIVE state Set Buck1 output voltage in ACTIVE state	00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved 4'b0000 - 4'b1110: Buck1 = 0.8V + 0.05V x Buck1_Vo_ACTIVE[3:0]	<00>
Type [7:6] [5:4] [3:0] (22 Regis Type	- (RW, EEPROM) hot used Buck1 Mode ACTIVE Buck1 Vo ACTIVE Buck1 Vo ACTIVE ster Name - Buck1 SLEEF - (RW, EEPROM)	Set Buck1 operation mode in ACTIVE state Set Buck1 output voltage in ACTIVE state	00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved 4'b0000 - 4'b1110: Buck1 = 0.8V + 0.05V x Buck1_Vo_ACTIVE[3:0]	<00> <00> <0110> 0x06 / 6
Type [7:6] [5:4] [3:0] (22 Regis	- (RW, EEPROM) hot used Buck1 Mode ACTIVE Buck1 Vo ACTIVE Buck1 Vo ACTIVE ster Name - Buck1 SLEE - (RW, EEPROM) hot used	Set Buck1 operation mode in ACTIVE state Set Buck1 output voltage in ACTIVE state	00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved 4'b0000 - 4'b1110: Buck1 = 0.8V + 0.05V x Buck1_Vo_ACTIVE[3:0] 4'b1111: 1.03V	<00> <00> <0110>
Type [7:6] [5:4] [3:0] (22 Regis Type [7:6]	- (RW, EEPROM) hot used Buck1 Mode ACTIVE Buck1 Vo ACTIVE Buck1 Vo ACTIVE ster Name - Buck1 SLEE - (RW, EEPROM) hot used	Set Buck1 operation mode in ACTIVE state Set Buck1 output voltage in ACTIVE state	00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved 4'b0000 - 4'b1110: Buck1 = 0.8V + 0.05V x Buck1_Vo_ACTIVE[3:0] 4'b1111: 1.03V	<00> <00> <0110> 0x06 / 6 <00>
Type [7:6] [5:4] [3:0] (22 Regis Type [7:6] [5:4] [3:0] (23 Regis	- (RW, EEPROM) hot used Buck1 Mode ACTIVE Buck1 Vo ACTIVE Buck1 Vo ACTIVE (RW, EEPROM) hot used Buck1 Mode SLEEF	Set Buck1 operation mode in ACTIVE state Set Buck1 output voltage in ACTIVE state P Set Buck1 operation mode in SLEEP state Set Buck1 output voltage in SLEEP state	00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved 4'b0000 - 4'b1110: Buck1 = 0.8V + 0.05V x Buck1_Vo_ACTIVE[3:0] 4'b1111: 1.03V 00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved 4'b0000 - 4'b1110: Buck1 = 0.8V + 0.05V x Buck1_Vo_SLEEP[3:0]	<00> <00> <0110> 0x06 / 6 <00> <00>
Type [7:6] [5:4] [3:0] (22 Regis Type [7:6] [5:4] [3:0] (23 Regis Type	- (RW, EEPROM) hot used Buck1 Mode ACTIVE Buck1 Vo ACTIVE ster Name - Buck1 SLEEF (RW, EEPROM) hot used Buck1 Mode SLEEF Buck1 Vo SLEEP ster Name - Buck1 Power - (RW, EEPROM)	Set Buck1 operation mode in ACTIVE state Set Buck1 output voltage in ACTIVE state P Set Buck1 operation mode in SLEEP state Set Buck1 output voltage in SLEEP state	00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved 4'b0000 - 4'b1110: Buck1 = 0.8V + 0.05V x Buck1_Vo_ACTIVE[3:0] 4'b1111: 1.03V 00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved 4'b0000 - 4'b1110: Buck1 = 0.8V + 0.05V x Buck1_Vo_SLEEP[3:0]	<00> <00> <0110> 0x06 / 6 <00> <00> <0110> 0x02 / 2
Type [7:6] [5:4] [3:0] (22 Regis Type [7:6] [5:4] [3:0] (23 Regis Type [7]	- (RW, EEPROM) hot used Buck1 Mode ACTIVE Buck1 Vo ACTIVE ster Name - Buck1 SLEEF (RW, EEPROM) hot used Buck1 Vo SLEEP Buck1 Vo SLEEP ster Name - Buck1 Power - (RW, EEPROM)	Set Buck1 operation mode in ACTIVE state Set Buck1 output voltage in ACTIVE state P Set Buck1 operation mode in SLEEP state Set Buck1 output voltage in SLEEP state On	00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved 4'b0000 - 4'b1110: Buck1 = 0.8V + 0.05V x Buck1_Vo_ACTIVE[3:0] 4'b1111: 1.03V 00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved 4'b0000 - 4'b1110: Buck1 = 0.8V + 0.05V x Buck1_Vo_SLEEP[3:0] 4'b1111: 1.03V	<00> <00> <0110> 0x06 / 6 <00> <00> <00> <0110> 0x02 / 2 <0>
Type [7:6] [5:4] [3:0] (22 Regis Type [7:6] [5:4] [3:0] (23 Regis Type	- (RW, EEPROM) hot used Buck1 Mode ACTIVE Buck1 Vo ACTIVE ster Name - Buck1 SLEEF (RW, EEPROM) hot used Buck1 Mode SLEEF Buck1 Vo SLEEP ster Name - Buck1 Power - (RW, EEPROM)	Set Buck1 operation mode in ACTIVE state Set Buck1 output voltage in ACTIVE state P Set Buck1 operation mode in SLEEP state Set Buck1 output voltage in SLEEP state	00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved 4'b0000 - 4'b1110: Buck1 = 0.8V + 0.05V x Buck1_Vo_ACTIVE[3:0] 4'b1111: 1.03V 00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved 4'b0000 - 4'b1110: Buck1 = 0.8V + 0.05V x Buck1_Vo_SLEEP[3:0]	<00> <00> <0110> 0x06 / 6 <00> <00> <0110> 0x02 / 2



	0	Name - Buck1 Power W, EEPROM)	Off		0x3C / 6
.,)po (,			
[7]]	not used			<0>
	5:0]	Buck1 Power Off Delay	Delay timed from the beginning of power- off sequence	0: 0ms 1: 1ms 	<011110
				127: 127ms	
	-	Name - Buck1 SR W, EEPROM)			0x5A / 9
17	<u>/:6]</u>	Buck1 TSoftStart	Set Buck1 soft-start time	00: 4ms	<01>
_r .	.0]	Buckt rookolart		01: 2ms 10: 1ms	
15		Buck1 TShutDown	Sat Buck1 shutdown pariod	11: 0.5ms 00: 4ms	<01>
5	5:4]	Bucki iShulbown	Set Buck1 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to 2b'00, 2b'01 or 2b'10. In addition, when CEN goes from high to low, the shutdown period starts to count from the time when the last rail is turned off. At the end of the shutdown period the FSM transitions to	01: 2ms 10: 1ms 11: 0.5ms	<01>
			{STANDBY} then onward to {RESET}.		
[3:	9:2]	Buck1 DVS SRup	Set Buck1 output ramp-up slew rate	00: 2mV/µs 01: 4mV/µs 10: 8mV/µs 11: 16mV/µs	<10>
[1:	:0]	Buck1 DVS SRdn	Set Buck1 output ramp-down slew rate	00: 2mV/µs 01: 4mV/µs 10: 8mV/µs 11: 16mV/µs	<10>
26 Re	egister N	Name - Buck1 Config		Πητικήμο	0x12 / 1
		W, EEPROM)			
[7]]	not used			<0>
[6]	5]	Buck1 Phase Sync Delay	Set Buck1 phase shift relative to the inter- nal clock when Buck1 Phase Sync EN is enabled	00: 0deg 01: 90deg 10: 180deg 11: 270deg	<00>
[4]	:2]	Buck1 SW Freq	Set Buck1 switching frequency when in PWM operation	000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 100: 1.33MHz 110: 1.54MHz 111: 1.67MHz	<100>
[1:	:0]	Buck1 Discharge	Set Buck1 output discharge resistance	00: Disabled 01: Slow 10: Medium	<10>



0	er Name - Buck2 Enable			0x07
Туре -	(RW, EEPROM)			
[7:5]	not used			<00
[4]	Buck2 Phase Sync EN	Enable Buck2 Phase Synchronization function	0: Disabled 1: Enabled	<0
[3]	Buck2 SS EN	Enable Buck2 PFM Spread Spectrum	0: Disabled	<0
[2]	Buck2 ABS EN	function in PFM mode Enable Buck2 ABS (Ultrasonic) mode	1: Enabled 0: Disabled	<1
[1]	Buck2 EN SLEEP	Enable Buck2 in SLEEP state	1: Enabled 0: Disabled	<1
_			1: Enabled	
[0]	Buck2 EN ACTIVE	Enable Buck2 in ACTIVE state	0: Disabled 1: Enabled	<1
-	er Name - Buck2 ACTIV (RW, EEPROM)	E		0x02
[7:6]	not used			<00
[5:4]	Buck2 Mode ACTIVE	Set Buck2 operation mode in ACTIVE state	00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved	<00
12.01	Buck2 Vo ACTIVE	Set Buck2 output voltage in ACTIVE sta		<00
[3:0]				
Registe	er Name - Buck2 SLEEF		Buck2 Vo ACTIVE[3:0]	0x02
Registe Type -	er Name - Buck2 SLEEF (RW, EEPROM)			
Registe Type - [7:6]	er Name - Buck2 SLEEF (RW, EEPROM) hot used		Buck2 Vo ACTIVE[3:0]	<00
Registe Type -	er Name - Buck2 SLEEF (RW, EEPROM) hot used		Buck2 Vo ACTIVE[3:0]	<00
Registe Type - [7:6]	er Name - Buck2 SLEEF (RW, EEPROM) hot used		Buck2 Vo ACTIVE[3:0] ateD0: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved e Buck2 = 1.1V + 0.05V x	<00
Registe Type - [7:6] [5:4] [3:0]	er Name - Buck2 SLEEF (RW, EEPROM) not used Buck2 Mode SLEEF Buck2 Vo SLEEP er Name - Buck2 Power	Set Buck2 operation mode in SLEEP stat	Buck2 Vo ACTIVE[3:0] ate00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved	<00
Registe Type - [7:6] [5:4] [3:0]	er Name - Buck2 SLEEF (RW, EEPROM) not used Buck2 Mode SLEEF Buck2 Vo SLEEP	Set Buck2 operation mode in SLEEP stat	Buck2 Vo ACTIVE[3:0] ateD0: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved e Buck2 = 1.1V + 0.05V x	<00
Registe Type - [7:6] [5:4] [3:0] Registe Type -	er Name - Buck2 SLEEF (RW, EEPROM) not used Buck2 Mode SLEEF Buck2 Vo SLEEP er Name - Buck2 Power	Set Buck2 operation mode in SLEEP stat	Buck2 Vo ACTIVE[3:0] ateD0: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved e Buck2 = 1.1V + 0.05V x	<00 <00 <00 <00 0x03
Registe Type - [7:6] [5:4] [3:0]	er Name - Buck2 SLEEF (RW, EEPROM) not used Buck2 Mode SLEEF Buck2 Vo SLEEP er Name - Buck2 Power (RW, EEPROM)	Set Buck2 operation mode in SLEEP stat	Buck2 Vo ACTIVE[3:0] ate[00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved e Buck2 = 1.1V + 0.05V x Buck2 Vo SLEEP[3:0]	<00 <00 <00 <00 0x03 <0
Registe Type - [7:6] [5:4] [3:0] Registe Type -	er Name - Buck2 SLEEF (RW, EEPROM) not used Buck2 Mode SLEEF Buck2 Vo SLEEP er Name - Buck2 Power (RW, EEPROM) not used	Set Buck2 operation mode in SLEEP stat Set Buck2 output voltage in SLEEP stat On	Buck2 Vo ACTIVE[3:0] ate[00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved e Buck2 = 1.1V + 0.05V x Buck2 Vo SLEEP[3:0]	<00 <00 <00 <00 0x03 <0
Registe Type - [7:6] [5:4] [3:0] [3:0] [3:0] [3:0]	er Name - Buck2 SLEEF (RW, EEPROM) hot used Buck2 Mode SLEEF Buck2 Vo SLEEP er Name - Buck2 Power (RW, EEPROM) hot used Buck2 Power On Delay	P Set Buck2 operation mode in SLEEP stat Set Buck2 output voltage in SLEEP stat On Delay timed from the beginning of powe on sequence	Buck2 Vo ACTIVE[3:0] ate00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved e Buck2 = 1.1V + 0.05V x Buck2 Vo SLEEP[3:0] r- 0: 0ms	<00 <00 <00 0x03 <0000 <0000
Registe Type - [7:6] [5:4] [3:0] [3:0] [3:0] [3:0]	er Name - Buck2 SLEEF (RW, EEPROM) not used Buck2 Mode SLEEF Buck2 Vo SLEEP er Name - Buck2 Power (RW, EEPROM) not used Buck2 Power On	P Set Buck2 operation mode in SLEEP stat Set Buck2 output voltage in SLEEP stat On Delay timed from the beginning of powe on sequence	Buck2 Vo ACTIVE[3:0] ate[00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved e Buck2 = 1.1V + 0.05V x Buck2 Vo SLEEP[3:0] r- 0: 0ms 1: 1ms 	<00 <00 <00 0x03 <0000 <0000
Registe Type - [7:6] [5:4] [3:0] [3:0] [3:0] [3:0] [5:4] [5:4] [5:4] [5:4] [5:4] [5:4] [5:4] [5:4] [5:4]	er Name - Buck2 SLEEF (RW, EEPROM) not used Buck2 Mode SLEEF Buck2 Vo SLEEP er Name - Buck2 Power (RW, EEPROM) not used Buck2 Power On Delay er Name - Buck2 Power (RW, EEPROM)	P Set Buck2 operation mode in SLEEP stat Set Buck2 output voltage in SLEEP stat On Delay timed from the beginning of powe on sequence	Buck2 Vo ACTIVE[3:0] ate[00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved e Buck2 = 1.1V + 0.05V x Buck2 Vo SLEEP[3:0] r- 0: 0ms 1: 1ms 	<00 <00 <00 0x03 <00 <0000 <0000
Registe Type - [7:6] [5:4] [3:0] [3:0] [3:0] [3:0] [3:0] [5:4] [5:	er Name - Buck2 SLEEF (RW, EEPROM) not used Buck2 Mode SLEEF Buck2 Vo SLEEP er Name - Buck2 Power (RW, EEPROM) not used Buck2 Power On Delay er Name - Buck2 Power (RW, EEPROM)	Set Buck2 operation mode in SLEEP stat Set Buck2 output voltage in SLEEP stat On Delay timed from the beginning of powe on sequence Off	Buck2 Vo ACTIVE[3:0] ateD0: Auto PFM/PWM mode D1: Forced PWM mode 1x: Reserved e Buck2 = 1.1V + 0.05V x Buck2 Vo SLEEP[3:0] r- D: Oms 1: 1ms 127: 127ms	0x02 <00 <001 0x03 0x03 <0000 <0000 0x3B
Registe Type - [7:6] [5:4] [3:0] [3:0] [3:0] [3:0] [5:4] [5:4] [5:4] [5:4] [5:4] [5:4] [5:4] [5:4] [5:4]	er Name - Buck2 SLEEF (RW, EEPROM) not used Buck2 Mode SLEEF Buck2 Vo SLEEP er Name - Buck2 Power (RW, EEPROM) not used Buck2 Power On Delay er Name - Buck2 Power (RW, EEPROM)	P Set Buck2 operation mode in SLEEP stat Set Buck2 output voltage in SLEEP stat On Delay timed from the beginning of powe on sequence	Buck2 Vo ACTIVE[3:0] ateD0: Auto PFM/PWM mode D1: Forced PWM mode 1x: Reserved e Buck2 = 1.1V + 0.05V x Buck2 Vo SLEEP[3:0] r- D: Oms 1: 1ms 127: 127ms	<00 <00 <001 0x03 <00 <0000 <0000



Type -	(RW, EEPROM)			
[7:6]	Buck2 TSoftStart	Set Buck2 soft-start time	00: 4ms	<01
			01: 2ms	
			10: 1ms	
			11: 0.5ms	
[5:4]	Buck2 TShutDown	Set Buck2 shutdown period.	00: 4ms	<01
_		Note: this setting sets the Shut Down SR	01: 2ms	
		when Shutdown Option Buck is set to	10: 1ms	
		2b'00, 2b'01 or 2b'10. In addition, when	11: 0.5ms	
		CEN goes from high to low, the shutdown		
		period starts to count from the time when		
		the last rail is turned off. At the end of the		
		shutdown period the FSM transitions to		
		{STANDBY} then onward to {RESET}.		
[3:2]	Buck2 DVS SRup	Set Buck2 output ramp-up slew rate	00: 2mV/µs	<10
1			01: 4mV/µs	
			10: 8mV/µs	
[1.0]	Buck2 DVS SRdn	Cat Ruck2 autnut roma down alow rate	11: 16mV/µs	<10
[1:0]	BUCKZ DVS SRUI	Set Buck2 output ramp-down slew rate	00: 2mV/µs 01: 4mV/µs	<10
			10: 8mV/µs	
			11: 16mV/µs	
Registe	er Name - Buck2 Config			0x06
[7]	not used	•	.	-
[7] [6:5]	Buck2 Phase Sync	Set Buck2 phase shift relative to the inter-		-
		nal clock when Buck1 Phase Sync EN is	01: 90deg	-
	Buck2 Phase Sync		01: 90deg 10: 180deg	-
[6:5]	Buck2 Phase Sync Delay	hal clock when Buck1 Phase Sync EN is enabled	01: 90deg 10: 180deg 11: 270deg	<00
	Buck2 Phase Sync	hal clock when Buck1 Phase Sync EN is enabled Set Buck2 switching frequency when in	01: 90deg 10: 180deg	<00
[6:5]	Buck2 Phase Sync Delay	hal clock when Buck1 Phase Sync EN is enabled	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz	<00
[6:5]	Buck2 Phase Sync Delay	hal clock when Buck1 Phase Sync EN is enabled Set Buck2 switching frequency when in	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz	<00
[6:5]	Buck2 Phase Sync Delay	hal clock when Buck1 Phase Sync EN is enabled Set Buck2 switching frequency when in	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz	<00
[6:5]	Buck2 Phase Sync Delay	hal clock when Buck1 Phase Sync EN is enabled Set Buck2 switching frequency when in	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz	<00
[6:5]	Buck2 Phase Sync Delay	hal clock when Buck1 Phase Sync EN is enabled Set Buck2 switching frequency when in	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz	<00
[6:5]	Buck2 Phase Sync Delay Buck2 SW Freq	hal clock when Buck1 Phase Sync EN is enabled Set Buck2 switching frequency when in PWM operation	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 100: 1.11MHz 101: 1.33MHz 110: 1.54MHz 111: 1.67MHz	<00
[6:5]	Buck2 Phase Sync Delay	hal clock when Buck1 Phase Sync EN is enabled Set Buck2 switching frequency when in	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 100: 1.11MHz 101: 1.33MHz 110: 1.54MHz 111: 1.67MHz 00: Disabled	<00
[6:5]	Buck2 Phase Sync Delay Buck2 SW Freq	hal clock when Buck1 Phase Sync EN is enabled Set Buck2 switching frequency when in PWM operation	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 100: 1.11MHz 101: 1.33MHz 110: 1.54MHz 111: 1.67MHz 00: Disabled 01: Slow	<00
[6:5]	Buck2 Phase Sync Delay Buck2 SW Freq	hal clock when Buck1 Phase Sync EN is enabled Set Buck2 switching frequency when in PWM operation	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 100: 1.11MHz 101: 1.33MHz 110: 1.54MHz 111: 1.67MHz 00: Disabled 01: Slow 10: Medium	<00
[6:5] [4:2] [1:0]	Buck2 Phase Sync Delay Buck2 SW Freq Buck2 Discharge	hal clock when Buck1 Phase Sync EN is enabled Set Buck2 switching frequency when in PWM operation Set Buck2 output discharge resistance	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 100: 1.11MHz 101: 1.33MHz 110: 1.54MHz 111: 1.67MHz 00: Disabled 01: Slow	<00
[6:5] [4:2] [1:0] Registe	Buck2 Phase Sync Delay Buck2 SW Freq Buck2 Discharge er Name - Buck3 Enable	hal clock when Buck1 Phase Sync EN is enabled Set Buck2 switching frequency when in PWM operation Set Buck2 output discharge resistance	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 100: 1.11MHz 101: 1.33MHz 110: 1.54MHz 111: 1.67MHz 00: Disabled 01: Slow 10: Medium	<00
[6:5] [4:2] [1:0] Registe	Buck2 Phase Sync Delay Buck2 SW Freq Buck2 Discharge	hal clock when Buck1 Phase Sync EN is enabled Set Buck2 switching frequency when in PWM operation Set Buck2 output discharge resistance	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 100: 1.11MHz 101: 1.33MHz 110: 1.54MHz 111: 1.67MHz 00: Disabled 01: Slow 10: Medium	<00
[6:5] [4:2] [1:0] Registe	Buck2 Phase Sync Delay Buck2 SW Freq Buck2 Discharge er Name - Buck3 Enable	hal clock when Buck1 Phase Sync EN is enabled Set Buck2 switching frequency when in PWM operation Set Buck2 output discharge resistance	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 100: 1.11MHz 101: 1.33MHz 110: 1.54MHz 111: 1.67MHz 00: Disabled 01: Slow 10: Medium	<00 <00 <10 0x07
[6:5] [4:2] [1:0] Registe Type -	Buck2 Phase Sync Delay Buck2 SW Freq Buck2 Discharge er Name - Buck3 Enable (RW, EEPROM)	hal clock when Buck1 Phase Sync EN is enabled Set Buck2 switching frequency when in PWM operation Set Buck2 output discharge resistance	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 100: 1.11MHz 101: 1.33MHz 110: 1.54MHz 111: 1.67MHz 00: Disabled 01: Slow 10: Medium	<00 <00 <10 0x07 <00
[6:5] [4:2] [1:0] Registe Type - [7:5] [4]	Buck2 Phase Sync Delay Buck2 SW Freq Buck2 Discharge er Name - Buck3 Enable (RW, EEPROM) hot used Buck3 Phase Sync EN	hal clock when Buck1 Phase Sync EN is enabled Set Buck2 switching frequency when in PWM operation Set Buck2 output discharge resistance Enable Buck3 Phase Synchronization function	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 100: 1.11MHz 101: 1.33MHz 110: 1.54MHz 111: 1.67MHz 00: Disabled 01: Slow 10: Medium 11: Fast	<00 <00 <10 0x07 <00 <00
[6:5] [4:2] [1:0] Registe Type - [7:5]	Buck2 Phase Sync Delay Buck2 SW Freq Buck2 Discharge er Name - Buck3 Enable (RW, EEPROM) hot used Buck3 Phase Sync	hal clock when Buck1 Phase Sync EN is enabled Set Buck2 switching frequency when in PWM operation Set Buck2 output discharge resistance Set Buck2 output discharge resistance Enable Buck3 Phase Synchronization function Enable Buck3 PFM Spread Spectrum	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 100: 1.11MHz 101: 1.33MHz 110: 1.54MHz 111: 1.67MHz 00: Disabled 01: Slow 10: Medium 11: Fast 0: Disabled 1: Enabled 0: Disabled 0: Disabled	<00 <00 <10 0x07 <00 <00
[6:5] [4:2] [1:0] Registe Type - [7:5] [4] [3]	Buck2 Phase Sync Delay Buck2 SW Freq Buck2 Discharge Buck2 Discharge er Name - Buck3 Enable (RW, EEPROM) hot used Buck3 Phase Sync EN Buck3 SS EN	hal clock when Buck1 Phase Sync EN is enabled Set Buck2 switching frequency when in PWM operation Set Buck2 output discharge resistance Set Buck2 output discharge resistance	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 100: 1.11MHz 101: 1.33MHz 110: 1.54MHz 111: 1.67MHz 00: Disabled 01: Slow 10: Medium 11: Fast 0: Disabled 1: Enabled 0: Disabled 1: Enabled 1: Enabled	<00 <00 <10 0x07 <00 <00 <00 <00
[6:5] [4:2] [1:0] Registe Type - [7:5] [4]	Buck2 Phase Sync Delay Buck2 SW Freq Buck2 Discharge er Name - Buck3 Enable (RW, EEPROM) hot used Buck3 Phase Sync EN	hal clock when Buck1 Phase Sync EN is enabled Set Buck2 switching frequency when in PWM operation Set Buck2 output discharge resistance Set Buck2 output discharge resistance Enable Buck3 Phase Synchronization function Enable Buck3 PFM Spread Spectrum	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 100: 1.11MHz 101: 1.33MHz 110: 1.54MHz 111: 1.67MHz 00: Disabled 01: Slow 10: Medium 11: Fast 02: Disabled 11: Enabled 03: Disabled 12: Enabled 12: Enabled 13: Enabled 14: Enabled 15: Disabled 15: Disabled 15: Disabled 16: Disabled 17: Enabled 17: Disabled 17: Enabled 18: Enabled 19: Disabled 19: Disabled 10: Disabled	<00 <00 <10 0x07 <00 <00 <00 <00
[6:5] [4:2] [1:0] Registe Type - [4] [3] [2]	Buck2 Phase Sync Delay Buck2 SW Freq Buck2 Discharge Buck2 Discharge er Name - Buck3 Enable (RW, EEPROM) not used Buck3 Phase Sync EN Buck3 ABS EN Buck3 ABS EN	Anal clock when Buck1 Phase Sync EN is enabled Set Buck2 switching frequency when in PWM operation Set Buck2 output discharge resistance Set Buck2 output discharge resistance Enable Buck3 Phase Synchronization function Enable Buck3 PFM Spread Spectrum function in PFM mode Enable Buck3 ABS (Ultrasonic) mode	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 100: 1.13MHz 110: 1.54MHz 111: 1.67MHz 00: Disabled 01: Slow 10: Medium 11: Fast 02: Disabled 11: Enabled 03: Disabled 11: Enabled 04: Disabled 11: Enabled 05: Disabled 12: Enabled 12: Disabled 13: Enabled 14: Enabled 15: Disabled 15: Disabled 16: Disabled 17: Enabled 17: Disabled 17: Enabled 18: Disabled 19: Disabled 19: Disabled 19: Disabled 10: Disabled	<00 <00 <10 0x07 <00 <00 <00 <00 <00 <10
[6:5] [4:2] [1:0] Registe Type - [7:5] [4] [3]	Buck2 Phase Sync Delay Buck2 SW Freq Buck2 Discharge Buck2 Discharge er Name - Buck3 Enable (RW, EEPROM) hot used Buck3 Phase Sync EN Buck3 SS EN	hal clock when Buck1 Phase Sync EN is enabled Set Buck2 switching frequency when in PWM operation Set Buck2 output discharge resistance Set Buck2 output discharge resistance	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 100: 1.13MHz 110: 1.54MHz 111: 1.67MHz 00: Disabled 01: Slow 10: Medium 11: Fast 02: Disabled 11: Fast 03: Disabled 12: Enabled 04: Disabled 12: Enabled 05: Disabled 12: Enabled 13: Enabled 14: Enabled 15: Disabled 15: Disabled 15: Disabled 16: Disabled 17: Enabled 17: Disabled 17: Enabled 18: Enabled 19: Disabled 19: Disabled 19: Disabled 10:	<00 <00 <10 0x07 <00 <00 <00 <00 <00 <10
[6:5] [4:2] [1:0] [1:0] Registe Type - [4] [3] [2] [1]	Buck2 Phase Sync Delay Buck2 SW Freq Buck2 Discharge Buck2 Discharge er Name - Buck3 Enable (RW, EEPROM) hot used Buck3 Phase Sync EN Buck3 SS EN Buck3 ABS EN Buck3 ABS EN	hal clock when Buck1 Phase Sync EN is enabled Set Buck2 switching frequency when in PWM operation Set Buck2 output discharge resistance Set Buck2 output discharge resistance Enable Buck3 Phase Synchronization function Enable Buck3 PFM Spread Spectrum function in PFM mode Enable Buck3 ABS (Ultrasonic) mode Enable Buck3 in SLEEP state	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 100: 1.13MHz 110: 1.54MHz 111: 1.67MHz 00: Disabled 01: Slow 10: Medium 11: Fast 02: Disabled 11: Enabled 03: Disabled 11: Enabled 04: Disabled 12: Enabled 05: Disabled 12: Enabled 13: Enabled 14: Enabled 15: Disabled 14: Enabled 15: Disabled 15: Enabled 15: Disabled 16: Disabled 16: Disabled 17: Enabled 17: Enabled 17: Enabled 18: Enabled 19: Disabled 19: Disabled 19: Disabled 10:	<00 <00 <10 0x07 <00 <00 <00 <00 <10 <10 <10 <10
[6:5] [4:2] [1:0] Registe Type - [4] [3] [2]	Buck2 Phase Sync Delay Buck2 SW Freq Buck2 Discharge Buck2 Discharge er Name - Buck3 Enable (RW, EEPROM) not used Buck3 Phase Sync EN Buck3 ABS EN Buck3 ABS EN	Anal clock when Buck1 Phase Sync EN is enabled Set Buck2 switching frequency when in PWM operation Set Buck2 output discharge resistance Set Buck2 output discharge resistance Enable Buck3 Phase Synchronization function Enable Buck3 PFM Spread Spectrum function in PFM mode Enable Buck3 ABS (Ultrasonic) mode	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 100: 1.13MHz 110: 1.54MHz 111: 1.67MHz 00: Disabled 01: Slow 10: Medium 11: Fast 02: Disabled 11: Fast 03: Disabled 12: Enabled 04: Disabled 12: Enabled 05: Disabled 12: Enabled 13: Enabled 14: Enabled 15: Disabled 15: Disabled 15: Disabled 16: Disabled 17: Enabled 17: Disabled 17: Enabled 18: Enabled 19: Disabled 19: Disabled 19: Disabled 10:	<pre> </pre> <pre> </pre> <pre> </pre> <pre> </pre> <pre> </pre> <pre> </pre> <pre> </pre> <pre> </pre> <pre> </pre> <pre> </pre>

0x2F		r Name - Buck3 ACTIV RW, EEPROM)	E		0x00 / 0
	[7:6]	not used			<00>
	[5:4]	Buck3 Mode ACTIVE	Set Buck3 operation mode in ACTIVE state	00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved	<00>
	[3:0]	Buck3 Vo ACTIVE	Set Buck3 output voltage in ACTIVE state	Buck3 = 1.8V + 0.1V x Buck3_Vo_ACTIVE[3:0]	<0000>
0x30		r Name - Buck3 SLEEF RW, EEPROM)			0x00 / 0
	[7:6]	not used			<00>
	[5:4]		P Set Buck3 operation mode in SLEEP state	00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved	<00>
	[3:0]	Buck3 Vo SLEEP	Set Buck3 output voltage in SLEEP state	Buck3 = 1.8V + 0.1V x Buck3_Vo_SLEEP[3:0]	<0000>
0x31		r Name - Buck3 Power RW, EEPROM)	On		0x02/2
	[7]	not used			<0>
	[/] [6:0]	Buck3 Power On	Delay timed from the beginning of power-	D: Oms	<0000010
	[0:0]	Delay	on sequence	1: 1ms	0000010
		Dolay			
0x32	-	r Name - Buck3 Power		 127: 127ms	0x3C / 60
0x32	Type - (r Name - Buck3 Power RW, EEPROM)		 127: 127ms	
0x32	Туре - ([7]	r Name - Buck3 Power RW, EEPROM) not used	Off		<0>
0x32	Type - (r Name - Buck3 Power RW, EEPROM)		0: 0ms 1: 1ms 	
	Type - ([7] [6:0]	r Name - Buck3 Power RW, EEPROM) not used Buck3 Power Off Delay	Off Delay timed from the beginning of power-	ρ: 0ms	<0> <0111100
0x32	Type - ([7] [6:0] Register Type - (r Name - Buck3 Power RW, EEPROM) hot used Buck3 Power Off Delay r Name - Buck3 SR RW, EEPROM)	Off Delay timed from the beginning of power- off sequence	0: 0ms 1: 1ms 127: 127ms	<0> <0111100 0x5A / 90
	Type - ([7] [6:0] Registe	r Name - Buck3 Power RW, EEPROM) not used Buck3 Power Off Delay r Name - Buck3 SR	Off Delay timed from the beginning of power-	0: 0ms 1: 1ms 	<0> <0111100
	Type - ([7] [6:0] Type - ([7:6]	r Name - Buck3 Power RW, EEPROM) hot used Buck3 Power Off Delay r Name - Buck3 SR RW, EEPROM)	Off Delay timed from the beginning of power- off sequence Set Buck3 soft-start time Set Buck3 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to 2b'00, 2b'01 or 2b'10. In addition, when CEN goes from high to low, the shutdown period starts to count from the time when the last rail is turned off. At the end of the shutdown period the FSM transitions to (STANDBY) then onward to {RESET}.	0: 0ms 1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms	<0> <0111100 0x5A / 90
	Type - ([7] [6:0] Registe Type - ([7:6]	r Name - Buck3 Power RW, EEPROM) hot used Buck3 Power Off Delay r Name - Buck3 SR RW, EEPROM) Buck3 TSoftStart	Off Delay timed from the beginning of power- off sequence Set Buck3 soft-start time Set Buck3 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to 2b'00, 2b'01 or 2b'10. In addition, when CEN goes from high to low, the shutdown period starts to count from the time when the last rail is turned off. At the end of the shutdown period the FSM transitions to	0: 0ms 1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms	<0> <0111100 0x5A / 90 <01>

vno - l	er Name - Buck3 Config (RW, EEPROM)			0x1A /
i ype - (
7]	not used			<0>
6:5]	Buck3 Phase Sync	Set Buck3 phase shift relative to the inter-	00: 0deg	<00
-	Delay		01: 90deg	
		enabled	10: 180deg	
			11: 270deg	
4:2]	Buck3 SW Freq	Set Buck3 switching frequency when in	000: 0.667MHz	<11(
-		PWM operation	001: 0.769MHz	
		'	010: 0.833MHz	
			011: 1MHz	
			100: 1.11MHz	
			101: 1.33MHz	
			110: 1.54MHz	
			111: 1.67MHz	10
1:0]	Buck3 Discharge	Set Buck3 output discharge resistance	00: Disabled	<10
			01: Slow	
			10: Medium	
			11: Fast	
	r Name - Buck4 Enable (RW, EEPROM)			0x07
7:5]	not used			<000
4]	Buck4 Phase Sync	Enable Buck4 Phase Synchronization	0: Disabled	<0>
	EN	function	1: Enabled	
3]	Buck4 SS EN	Enable Buck4 PFM Spread Spectrum	0: Disabled	<0>
		function in PFM mode	1: Enabled	
2]	Buck4 ABS EN	Enable Buck4 ABS (Ultrasonic) mode	0: Disabled	<1>
-1			1: Enabled	•
			0: Disabled	· .
11	Buck4 EN SI FEP	Enable Blick4 in SLEEP state		<15
1]	Buck4 EN SLEEP	Enable Buck4 in SLEEP state		<1>
-			1: Enabled	
1] 0]	Buck4 EN SLEEP Buck4 EN ACTIVE	Enable Buck4 in SLEEP state	1: Enabled 0: Disabled	
0]	Buck4 EN ACTIVE	Enable Buck4 in ACTIVE state	1: Enabled	<1>
0] Registe Гуре - (Enable Buck4 in ACTIVE state	1: Enabled 0: Disabled	<1> 0x0F /
0] Registe Гуре - (7:6]	Buck4 EN ACTIVE er Name - Buck4 ACTIV	Enable Buck4 in ACTIVE state E	1: Enabled 0: Disabled 1: Enabled	<12 0x0F <00
0] Registe Гуре - (Buck4 EN ACTIVE Tr Name - Buck4 ACTIV (RW, EEPROM)	Enable Buck4 in ACTIVE state	1: Enabled 0: Disabled 1: Enabled 00: Auto PFM/PWM mode	<12 0x0F <00
0] Registe Гуре - (7:6]	Buck4 EN ACTIVE or Name - Buck4 ACTIV (RW, EEPROM) not used	Enable Buck4 in ACTIVE state E	1: Enabled 0: Disabled 1: Enabled 00: Auto PFM/PWM mode 01: Forced PWM mode	<1> 0x0F / <00
0] Registe Гуре - (7:6] 5:4]	Buck4 EN ACTIVE Pr Name - Buck4 ACTIV (RW, EEPROM) not used Buck4 Mode ACTIVE	Enable Buck4 in ACTIVE state E Set Buck4 operation mode in ACTIVE state	1: Enabled 0: Disabled 1: Enabled 00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved	<1: 0x0F <00 <00
0] Registe Гуре - (7:6]	Buck4 EN ACTIVE Tr Name - Buck4 ACTIV (RW, EEPROM) not used Buck4 Mode	Enable Buck4 in ACTIVE state E Set Buck4 operation mode in ACTIVE state	1: Enabled 0: Disabled 1: Enabled 00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved Codes 0-8 decimal	<1: 0x0F <00 <00
0] Registe Гуре - (7:6] 5:4]	Buck4 EN ACTIVE Pr Name - Buck4 ACTIV (RW, EEPROM) not used Buck4 Mode ACTIVE	Enable Buck4 in ACTIVE state E Set Buck4 operation mode in ACTIVE state	1: Enabled 0: Disabled 1: Enabled 00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved Codes 0-8 decimal Vo= 0.8V + 0.05V x Buck4_Vo_AC-	<1: 0x0F <00 <00
0] Registe Гуре - (7:6] 5:4]	Buck4 EN ACTIVE Pr Name - Buck4 ACTIV (RW, EEPROM) not used Buck4 Mode ACTIVE	Enable Buck4 in ACTIVE state E Set Buck4 operation mode in ACTIVE state	1: Enabled 0: Disabled 1: Enabled 00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved Codes 0-8 decimal Vo= 0.8V + 0.05V x Buck4_Vo_AC- TIVE[3:0]	<12 0x0F <00 <00
0] Registe Гуре - (7:6] 5:4]	Buck4 EN ACTIVE Pr Name - Buck4 ACTIV (RW, EEPROM) not used Buck4 Mode ACTIVE	Enable Buck4 in ACTIVE state E Set Buck4 operation mode in ACTIVE state	1: Enabled 0: Disabled 1: Enabled 00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved Codes 0-8 decimal Vo= 0.8V + 0.05V x Buck4_Vo_AC-	<13 <13 0x0F / <00 <00
0] Registe Гуре - (7:6] 5:4]	Buck4 EN ACTIVE Pr Name - Buck4 ACTIV (RW, EEPROM) not used Buck4 Mode ACTIVE	Enable Buck4 in ACTIVE state E Set Buck4 operation mode in ACTIVE state	1: Enabled 0: Disabled 1: Enabled 00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved Codes 0-8 decimal Vo= 0.8V + 0.05V x Buck4_Vo_AC- TIVE[3:0] Codes 9-15 decimal	<12 0x0F <00 <00
0] Registe Гуре - (7:6] 5:4]	Buck4 EN ACTIVE Pr Name - Buck4 ACTIV (RW, EEPROM) not used Buck4 Mode ACTIVE	Enable Buck4 in ACTIVE state E Set Buck4 operation mode in ACTIVE state	1: Enabled 0: Disabled 1: Enabled 00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved Codes 0-8 decimal Vo= 0.8V + 0.05V x Buck4_Vo_AC- TIVE[3:0]	<1> 0x0F / <00 <00
0] Registe Гуре - (7:6] 5:4] 3:0]	Buck4 EN ACTIVE Pr Name - Buck4 ACTIV (RW, EEPROM) not used Buck4 Mode ACTIVE	Enable Buck4 in ACTIVE state E Set Buck4 operation mode in ACTIVE state Set Buck4 output voltage in ACTIVE state	1: Enabled 0: Disabled 1: Enabled 00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved Codes 0-8 decimal Vo= 0.8V + 0.05V x Buck4_Vo_AC- TIVE[3:0] Codes 9-15 decimal	<12 0x0F / <00 <00
0] Registe [ype - (7:6] 5:4] 3:0] Registe	Buck4 EN ACTIVE Pr Name - Buck4 ACTIV (RW, EEPROM) hot used Buck4 Mode ACTIVE Buck4 Vo ACTIVE Buck4 Vo ACTIVE	Enable Buck4 in ACTIVE state E Set Buck4 operation mode in ACTIVE state Set Buck4 output voltage in ACTIVE state	1: Enabled 0: Disabled 1: Enabled 00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved Codes 0-8 decimal Vo= 0.8V + 0.05V x Buck4_Vo_AC- TIVE[3:0] Codes 9-15 decimal	<12 0x0F / <00 <00
0] Registe [ype - (7:6] 5:4] 3:0] Registe	Buck4 EN ACTIVE Pr Name - Buck4 ACTIV (RW, EEPROM) hot used Buck4 Mode ACTIVE Buck4 Vo ACTIVE	Enable Buck4 in ACTIVE state E Set Buck4 operation mode in ACTIVE state Set Buck4 output voltage in ACTIVE state	1: Enabled 0: Disabled 1: Enabled 00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved Codes 0-8 decimal Vo= 0.8V + 0.05V x Buck4_Vo_AC- TIVE[3:0] Codes 9-15 decimal	<1> 0x0F / <00 <00
0] Registe [ype - (7:6] 5:4] 3:0] Registe	Buck4 EN ACTIVE Pr Name - Buck4 ACTIV (RW, EEPROM) hot used Buck4 Mode ACTIVE Buck4 Vo ACTIVE Buck4 Vo ACTIVE	Enable Buck4 in ACTIVE state E Set Buck4 operation mode in ACTIVE state Set Buck4 output voltage in ACTIVE state	1: Enabled 0: Disabled 1: Enabled 00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved Codes 0-8 decimal Vo= 0.8V + 0.05V x Buck4_Vo_AC- TIVE[3:0] Codes 9-15 decimal	<1> 0x0F / <00 <00 <111
0] Registe [ype - (7:6] 5:4] 3:0] Registe [ype - (Buck4 EN ACTIVE Pr Name - Buck4 ACTIV (RW, EEPROM) hot used Buck4 Mode ACTIVE Buck4 Vo ACTIVE Buck4 Vo ACTIVE (RW, EEPROM) hot used	Enable Buck4 in ACTIVE state E Set Buck4 operation mode in ACTIVE state Set Buck4 output voltage in ACTIVE state	1: Enabled 0: Disabled 1: Enabled 00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved Codes 0-8 decimal Vo= 0.8V + 0.05V x Buck4_Vo_AC- TIVE[3:0] Codes 9-15 decimal Vo= 1.5, 1.6, 1.8, 1.85, 2.2, 2.5, 3.3	<1> 0x0F / <00 <00 <111
0] Registe [ype - (7:6] 5:4] 3:0] Registe [ype - (7:6]	Buck4 EN ACTIVE Pr Name - Buck4 ACTIV (RW, EEPROM) hot used Buck4 Mode ACTIVE Buck4 Vo ACTIVE Buck4 Vo ACTIVE (RW, EEPROM) hot used	Enable Buck4 in ACTIVE state E Set Buck4 operation mode in ACTIVE state Set Buck4 output voltage in ACTIVE state	1: Enabled 0: Disabled 1: Enabled 00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved Codes 0-8 decimal Vo= 0.8V + 0.05V x Buck4_Vo_AC- TIVE[3:0] Codes 9-15 decimal Vo= 1.5, 1.6, 1.8, 1.85, 2.2, 2.5, 3.3	<1> 0x0F / <00 <00 <111 0x0F / <00
0] Registe [ype - (7:6] 5:4] 3:0] Registe [ype - (7:6]	Buck4 EN ACTIVE Pr Name - Buck4 ACTIV (RW, EEPROM) hot used Buck4 Mode ACTIVE Buck4 Vo ACTIVE Buck4 Vo ACTIVE (RW, EEPROM) hot used	Enable Buck4 in ACTIVE state E Set Buck4 operation mode in ACTIVE state Set Buck4 output voltage in ACTIVE state	1: Enabled 0: Disabled 1: Enabled 00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved Codes 0-8 decimal Vo= 0.8V + 0.05V x Buck4_Vo_AC- TIVE[3:0] Codes 9-15 decimal Vo= 1.5, 1.6, 1.8, 1.85, 2.2, 2.5, 3.3 00: Auto PFM/PWM mode 01: Forced PWM mode	<12 0x0F / <00 <00 <111 0x0F / <00
0] Registe [ype - (7:6] 5:4] 3:0] Registe [ype - (7:6] 5:4]	Buck4 EN ACTIVE Pr Name - Buck4 ACTIV (RW, EEPROM) hot used Buck4 Mode ACTIVE Buck4 Vo ACTIVE Buck4 Vo ACTIVE (RW, EEPROM) not used Buck4 Mode SLEEF	Enable Buck4 in ACTIVE state E Set Buck4 operation mode in ACTIVE state Set Buck4 output voltage in ACTIVE state	1: Enabled 0: Disabled 1: Enabled 00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved Codes 0-8 decimal Vo= 0.8V + 0.05V x Buck4_Vo_AC- TIVE[3:0] Codes 9-15 decimal Vo= 1.5, 1.6, 1.8, 1.85, 2.2, 2.5, 3.3 00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved	<12 0x0F / <00 <00 <111 0x0F / <00 <00
0] Registe [ype - (7:6] 5:4] 3:0] Registe [ype - (7:6]	Buck4 EN ACTIVE Pr Name - Buck4 ACTIV (RW, EEPROM) hot used Buck4 Mode ACTIVE Buck4 Vo ACTIVE Buck4 Vo ACTIVE (RW, EEPROM) hot used	Enable Buck4 in ACTIVE state E Set Buck4 operation mode in ACTIVE state Set Buck4 output voltage in ACTIVE state	1: Enabled 0: Disabled 1: Enabled 00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved Codes 0-8 decimal Vo= 0.8V + 0.05V x Buck4_Vo_AC- TIVE[3:0] Codes 9-15 decimal Vo= 1.5, 1.6, 1.8, 1.85, 2.2, 2.5, 3.3 00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved Codes 0-8 decimal	<1> 0x0F / <00 <00 <111 0x0F / <00
0] Registe [ype - (7:6] 5:4] 3:0] Registe [ype - (7:6] 5:4]	Buck4 EN ACTIVE Pr Name - Buck4 ACTIV (RW, EEPROM) hot used Buck4 Mode ACTIVE Buck4 Vo ACTIVE Buck4 Vo ACTIVE (RW, EEPROM) not used Buck4 Mode SLEEF	Enable Buck4 in ACTIVE state E Set Buck4 operation mode in ACTIVE state Set Buck4 output voltage in ACTIVE state	1: Enabled 0: Disabled 1: Enabled 00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved Codes 0-8 decimal Vo= 0.8V + 0.05V x Buck4_Vo_AC- TIVE[3:0] Codes 9-15 decimal Vo= 1.5, 1.6, 1.8, 1.85, 2.2, 2.5, 3.3 00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved Codes 0-8 decimal Vo= 0.8V + 0.05V x	<12 0x0F / <00 <00 <111 0x0F / <00 <00
0] Registe [ype - (7:6] 5:4] 3:0] Registe [ype - (7:6] 5:4]	Buck4 EN ACTIVE Pr Name - Buck4 ACTIV (RW, EEPROM) hot used Buck4 Mode ACTIVE Buck4 Vo ACTIVE Buck4 Vo ACTIVE (RW, EEPROM) not used Buck4 Mode SLEEF	Enable Buck4 in ACTIVE state E Set Buck4 operation mode in ACTIVE state Set Buck4 output voltage in ACTIVE state	1: Enabled 0: Disabled 1: Enabled 00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved Codes 0-8 decimal Vo= 0.8V + 0.05V x Buck4_Vo_AC- TIVE[3:0] Codes 9-15 decimal Vo= 1.5, 1.6, 1.8, 1.85, 2.2, 2.5, 3.3 00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved Codes 0-8 decimal Vo= 0.8V + 0.05V x Buck4_Vo_SLEEP[3:0]	<12 0x0F / <00 <00 <111 0x0F / <00 <00
0] Registe [ype - (7:6] 5:4] 3:0] Registe [ype - (7:6] 5:4]	Buck4 EN ACTIVE Pr Name - Buck4 ACTIV (RW, EEPROM) hot used Buck4 Mode ACTIVE Buck4 Vo ACTIVE Buck4 Vo ACTIVE (RW, EEPROM) not used Buck4 Mode SLEEF	Enable Buck4 in ACTIVE state E Set Buck4 operation mode in ACTIVE state Set Buck4 output voltage in ACTIVE state	1: Enabled 0: Disabled 1: Enabled 00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved Codes 0-8 decimal Vo= 0.8V + 0.05V x Buck4_Vo_AC- TIVE[3:0] Codes 9-15 decimal Vo= 1.5, 1.6, 1.8, 1.85, 2.2, 2.5, 3.3 00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved Codes 0-8 decimal Vo= 0.8V + 0.05V x	<1> 0x0F / <00 <00 <111 0x0F / <00 <00



•	r Name - Buck4 Power (RW, EEPROM)	On		0x0A / 1
[7]	not used			<0>
[6:0]	Buck4 Power On Delay	Delay timed from the beginning of power- on sequence	0: 0ms 1: 1ms	<000101
			 127: 127ms	
	r Name - Buck4 Power (RW, EEPROM)	Off		0x00/0
[7] [6:0]	not used Buck4 Power Off	Delay timed from the beginning of power-	0: 0ms	<0><0>
[0.0]	Delay	off sequence	1: 1ms 	<00000
			127: 127ms	
	r Name - Buck4 SR (RW, EEPROM)			0x5A / 9
[7:6]	Buck4 TSoftStart	Set Buck4 soft-start time	00: 4ms 01: 2ms 10: 1ms	<01>
[5:4]	Buck4 TShutDown	Set Buck4 shutdown period. Note: this setting sets the Shut Down SR	11: 0.5ms 00: 4ms 01: 2ms	<01>
		when Shutdown Option Buck is set to 2b'00, 2b'01 or 2b'10. In addition, when CEN goes from high to low, the shutdown period starts to count from the time when the last rail is turned off. At the end of the shutdown period the FSM transitions to	10: 1ms 11: 0.5ms	
[3:2]	Buck4 DVS SRup	{STANDBY} then onward to {RESET}. Set Buck4 output ramp-up slew rate	00: 2mV/µs	<10>
[•]			01: 4mV/μs 10: 8mV/μs 11: 16mV/μs	
[1:0]	Buck4 DVS SRdn		00: 2mV/µs 01: 4mV/µs 10: 8mV/µs 11: 16mV/µs	<10>
0	r Name - Buck4 Config (RW, EEPROM)			0x1A / 2
[7]	not used			<0>
[7] [6:5]	Buck4 Phase Sync Delay	Set Buck4 phase shift relative to the inter- hal clock when Buck1 Phase Sync EN is enabled	01: 90deg 10: 180deg	<00>
[4:2]	Buck4 SW Freq	Set Buck4 switching frequency when in PWM operation	11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 101: 1.33MHz 110: 1.54MHz	<110>
			111: 1.67MHz	



	gister Name - Buck5 Ena e - (RW, EEPROM)	ble		0x07 / 7
1.76				
[7:5] not used			<000>
[4]	Buck5 Phase Sy EN	nc Enable Buck5 Phase Synchronization function	0: Disabled 1: Enabled	<0>
[3]	Buck5 SS EN	Enable Buck5 PFM Spread Spectrum function in PFM mode	0: Disabled 1: Enabled	<0>
[2]	Buck5 ABS EN	Enable Buck5 ABS (Ultrasonic) mode	0: Disabled 1: Enabled	<1>
[1]	Buck5 EN SLEEI	P Enable Buck5 in SLEEP state	0: Disabled 1: Enabled	<1>
[0]	Buck5 EN ACTIV	E Enable Buck5 in ACTIVE state	0: Disabled 1: Enabled	<1>
	gister Name - Buck5 AC e - (RW, EEPROM)	TIVE		0x00 / (
[7:5] not used			<000>
[4:3		Set Buck5 operation mode in ACTIVE state	00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved	<00>
[2:0]	i] Buck5 Vo ACTIV	E Set Buck5 output voltage in ACTIVE state		<000>
)x3E Red	nister Name - Buck5 SLE	EP	111: 3.3V	0x00/0
-	gister Name - Buck5 SLE e - (RW, EEPROM)	EP	111: 3.3V	0x00 / (
Тур	e - (RW, EEPROM)	EP	111: 3.3V	
U 0	e - (RW, EEPROM)	EP EP Set Buck5 operation mode in SLEEP state	900: Auto PFM/PWM mode 01: Forced PWM mode	
Тур [7:5]	e - (RW, EEPROM)] not used] Buck5 Mode SLE	EP Set Buck5 operation mode in SLEEP state	e00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved 000: 1.2V 001: 1.5V 010: 1.6V 011: 1.8V 100: 1.85V 101: 2.2V 110: 2.5V	<000> <00>
Typ [7:5 [4:3 [2:0	e - (RW, EEPROM)] not used] Buck5 Mode SLE	EP Set Buck5 operation mode in SLEEP state Set Buck5 output voltage in SLEEP state	e00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved 000: 1.2V 001: 1.5V 010: 1.6V 011: 1.8V 100: 1.85V 101: 2.2V	<000>
Typ [7:5 [4:3 [2:0	je - (RW, EEPROM) hot used Buck5 Mode SLE Buck5 Vo SLEEF gister Name - Buck5 Pov e - (RW, EEPROM)	EP Set Buck5 operation mode in SLEEP state Set Buck5 output voltage in SLEEP state	e00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved 000: 1.2V 001: 1.5V 010: 1.6V 011: 1.8V 100: 1.85V 101: 2.2V 110: 2.5V	<000> <00> <000> <000>
Typ [7:5 [4:3] [2:0] [2:0] [7]	e - (RW, EEPROM) hot used Buck5 Mode SLE Buck5 Vo SLEEF gister Name - Buck5 Powee - (RW, EEPROM) hot used	EP Set Buck5 operation mode in SLEEP state Set Buck5 output voltage in SLEEP state	e00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved 000: 1.2V 001: 1.5V 010: 1.6V 011: 1.8V 100: 1.85V 101: 2.2V 110: 2.5V 111: 3.3V	<000> <00> <000> <000> 0x0F / 1 <0>
Typ [7:5 [4:3 [2:0	e - (RW, EEPROM) hot used Buck5 Mode SLE Buck5 Vo SLEEF gister Name - Buck5 Powee - (RW, EEPROM) hot used	EP Set Buck5 operation mode in SLEEP state Set Buck5 output voltage in SLEEP state	e00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved 000: 1.2V 001: 1.5V 010: 1.6V 011: 1.8V 100: 1.85V 101: 2.2V 110: 2.5V	<000> <00> <000> <000>
Typ [7:5 [4:3] [2:0 [2:0 [2:0 [7]] [6:0	e - (RW, EEPROM) not used Buck5 Mode SLE Buck5 Vo SLEEF Buck5 Vo SLEEF sister Name - Buck5 Pow e - (RW, EEPROM) hot used Buck5 Power On Delay	EP Set Buck5 operation mode in SLEEP state Set Buck5 output voltage in SLEEP state //er On Delay timed from the beginning of power- on sequence	e00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved 000: 1.2V 001: 1.5V 010: 1.6V 011: 1.8V 100: 1.85V 101: 2.2V 110: 2.5V 111: 3.3V	<000> <00> <000> <000> 0x0F / 1 <0> <0001111
Typ [7:5 [4:3 [2:0] [2:0] [2:0 [2:0 [2:0 [2:0 [2:0 [2:0] [2:0	e - (RW, EEPROM) hot used Buck5 Mode SLE Buck5 Vo SLEEF gister Name - Buck5 Pov e - (RW, EEPROM) not used Buck5 Power On	EP Set Buck5 operation mode in SLEEP state Set Buck5 output voltage in SLEEP state //er On Delay timed from the beginning of power- on sequence	e00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved 000: 1.2V 001: 1.5V 010: 1.6V 011: 1.8V 100: 1.85V 101: 2.2V 110: 2.5V 111: 3.3V	<000> <00> <000> <000> 0x0F / 1 <0> <0001111
Typ [7:5 [4:3 [2:0] [2:0] [2:0 [2:0 [2:0 [2:0 [2:0 [2:0] [2:0	e - (RW, EEPROM) not used Buck5 Mode SLE Buck5 Vo SLEEF Buck5 Vo SLEEF Buck5 Power On Not used Buck5 Power On Delay gister Name - Buck5 Pow	EP Set Buck5 operation mode in SLEEP state Set Buck5 output voltage in SLEEP state //er On Delay timed from the beginning of power- on sequence	e00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved 000: 1.2V 001: 1.5V 010: 1.6V 011: 1.8V 100: 1.85V 101: 2.2V 110: 2.5V 111: 3.3V	<000> <00> <000> <000> 0x0F / 1 <0> <0001111
Typ [7:5 [4:3 [2:0] [2:0	e - (RW, EEPROM) not used Buck5 Mode SLE Buck5 Vo SLEEF Buck5 Vo SLEEF sister Name - Buck5 Power On not used Buck5 Power On Delay sister Name - Buck5 Power On Delay hot used hot used	EP Set Buck5 operation mode in SLEEP state Set Buck5 output voltage in SLEEP state ver On Delay timed from the beginning of power- on sequence ver Off	D0: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved 000: 1.2V 001: 1.5V 010: 1.6V 011: 1.8V 100: 1.85V 101: 2.2V 110: 2.5V 111: 3.3V D: 0ms 1: 1ms 127: 127ms	<000> <00> <000> <000> 0x0F / 1 <0> <000111



Registe				
Type -	(RW, EEPROM)			
[7:6]	Buck5 TSoftStart	Set Buck5 soft-start time	00: 4ms	<0'
[]			01: 2ms	, i i i i i i i i i i i i i i i i i i i
			10: 1ms	
			11: 0.5ms	
[5:4]	Buck5 TShutDown	Set Buck5 shutdown period.	00: 4ms	<0'
[01.]			01: 2ms	Ũ
		when Shutdown Option Buck is set to	10: 1ms	
		2b'00, 2b'01 or 2b'10. In addition, when	11: 0.5ms	
		CEN goes from high to low, the shutdown		
		period starts to count from the time when		
		the last rail is turned off. At the end of the		
		shutdown period the FSM transitions to		
		{STANDBY} then onward to {RESET}.		
[3:2]	Buck5 DVS SRup	Set Buck5 output ramp-up slew rate	00: 2mV/µs	<1
			01: 4mV/μs	
			10: 8mV/µs	
			11: 16mV/µs	
[1:0]	Buck5 DVS SRdn	Set Buck5 output ramp-down slew rate	00: 2mV/µs	<10
			01: 4mV/µs	
			10: 8mV/µs	
			11: 16mV/µs	
[7]	(RW, EEPROM)			<
	not used	Set Buck5 phase shift relative to the inter-	D0: Odea	
[7] [6:5]		Set Buck5 phase shift relative to the inter- nal clock when Buck1 Phase Sync EN is	00: 0deg 01: 90deg	-
	hot used Buck5 Phase Sync		01: 90deg	-
	hot used Buck5 Phase Sync	hal clock when Buck1 Phase Sync EN is enabled		
	hot used Buck5 Phase Sync	nal clock when Buck1 Phase Sync EN is enabled	01: 90deg 10: 180deg	<0
[6:5]	hot used Buck5 Phase Sync Delay	hal clock when Buck1 Phase Sync EN is enabled Set Buck5 switching frequency when in PWM operation	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz	<0
[6:5]	hot used Buck5 Phase Sync Delay	hal clock when Buck1 Phase Sync EN is enabled Set Buck5 switching frequency when in PWM operation	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz	<0
[6:5]	hot used Buck5 Phase Sync Delay	hal clock when Buck1 Phase Sync EN is enabled Set Buck5 switching frequency when in PWM operation	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz	<0
[6:5]	hot used Buck5 Phase Sync Delay	hal clock when Buck1 Phase Sync EN is enabled Set Buck5 switching frequency when in PWM operation	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz	<0
[6:5]	hot used Buck5 Phase Sync Delay	hal clock when Buck1 Phase Sync EN is enabled Set Buck5 switching frequency when in PWM operation	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 100: 1.33MHz	<0
[6:5]	hot used Buck5 Phase Sync Delay	hal clock when Buck1 Phase Sync EN is enabled Set Buck5 switching frequency when in PWM operation	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 100: 1.11MHz 101: 1.33MHz 110: 1.54MHz	<0
[6:5]	hot used Buck5 Phase Sync Delay Buck5 SW Freq	hal clock when Buck1 Phase Sync EN is enabled Set Buck5 switching frequency when in PWM operation	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 100: 1.11MHz 101: 1.33MHz 110: 1.54MHz 111: 1.67MHz	<11
[6:5]	hot used Buck5 Phase Sync Delay	hal clock when Buck1 Phase Sync EN is enabled Set Buck5 switching frequency when in PWM operation Set Buck5 output discharge resistance	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 100: 1.11MHz 101: 1.33MHz 110: 1.54MHz 111: 1.67MHz 00: Disabled	<0
[6:5]	hot used Buck5 Phase Sync Delay Buck5 SW Freq	hal clock when Buck1 Phase Sync EN is enabled Set Buck5 switching frequency when in PWM operation Set Buck5 output discharge resistance	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 100: 1.11MHz 101: 1.33MHz 110: 1.54MHz 111: 1.67MHz 00: Disabled 01: Slow	<0
[6:5]	hot used Buck5 Phase Sync Delay Buck5 SW Freq	hal clock when Buck1 Phase Sync EN is enabled Set Buck5 switching frequency when in PWM operation Set Buck5 output discharge resistance	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 100: 1.11MHz 101: 1.33MHz 110: 1.54MHz 111: 1.67MHz 00: Disabled 01: Slow 10: Medium	<0
[6:5] [4:2] [1:0]	hot used Buck5 Phase Sync Delay Buck5 SW Freq Buck5 Discharge	hal clock when Buck1 Phase Sync EN is enabled Set Buck5 switching frequency when in PWM operation Set Buck5 output discharge resistance	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 100: 1.11MHz 101: 1.33MHz 110: 1.54MHz 111: 1.67MHz 00: Disabled 01: Slow	<0 <11
[6:5] [4:2] [1:0]	hot used Buck5 Phase Sync Delay Buck5 SW Freq Buck5 Discharge er Name - Buck6 Enable	hal clock when Buck1 Phase Sync EN is enabled Set Buck5 switching frequency when in PWM operation Set Buck5 output discharge resistance	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 100: 1.11MHz 101: 1.33MHz 110: 1.54MHz 111: 1.67MHz 00: Disabled 01: Slow 10: Medium	<11
[6:5] [4:2] [1:0]	hot used Buck5 Phase Sync Delay Buck5 SW Freq Buck5 Discharge	hal clock when Buck1 Phase Sync EN is enabled Set Buck5 switching frequency when in PWM operation Set Buck5 output discharge resistance	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 100: 1.11MHz 101: 1.33MHz 110: 1.54MHz 111: 1.67MHz 00: Disabled 01: Slow 10: Medium	<11
[6:5] [4:2] [1:0]	hot used Buck5 Phase Sync Delay Buck5 SW Freq Buck5 Discharge er Name - Buck6 Enable	hal clock when Buck1 Phase Sync EN is enabled Set Buck5 switching frequency when in PWM operation Set Buck5 output discharge resistance	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 100: 1.11MHz 101: 1.33MHz 110: 1.54MHz 111: 1.67MHz 00: Disabled 01: Slow 10: Medium	<0 <11 <1 <1 <1 <1 <1 <1 <1 <1 <1 <1 <1 <1
[6:5] [4:2] [1:0] Registe Type - [7:5]	hot used Buck5 Phase Sync Delay Buck5 SW Freq Buck5 Discharge er Name - Buck6 Enable (RW, EEPROM)	hal clock when Buck1 Phase Sync EN is enabled Set Buck5 switching frequency when in PWM operation Set Buck5 output discharge resistance	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 100: 1.11MHz 101: 1.33MHz 110: 1.54MHz 111: 1.67MHz 00: Disabled 01: Slow 10: Medium	<11 <11 0x07
[6:5] [4:2] [1:0] Registe Type -	hot used Buck5 Phase Sync Delay Buck5 SW Freq Buck5 Discharge er Name - Buck6 Enable (RW, EEPROM)	hal clock when Buck1 Phase Sync EN is enabled Set Buck5 switching frequency when in PWM operation Set Buck5 output discharge resistance	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 100: 1.11MHz 101: 1.33MHz 110: 1.54MHz 111: 1.67MHz 00: Disabled 01: Slow 10: Medium 11: Fast	<11 <11 0x07
[6:5] [4:2] [1:0] Registe Type - [7:5] [4]	hot used Buck5 Phase Sync Delay Buck5 SW Freq Buck5 Discharge er Name - Buck6 Enable (RW, EEPROM) hot used Buck6 Phase Sync	hal clock when Buck1 Phase Sync EN is enabled Set Buck5 switching frequency when in PWM operation Set Buck5 output discharge resistance Enable Buck6 Phase Synchronization	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 100: 1.11MHz 101: 1.33MHz 110: 1.54MHz 111: 1.67MHz 00: Disabled 01: Slow 10: Medium 11: Fast 0: Disabled	<0 <11 <11 <1 <1 <1 <1 <1 <1 <1 <1 <1 <1 <
[6:5] [4:2] [1:0] Registe Type - [7:5]	hot used Buck5 Phase Sync Delay Buck5 SW Freq Buck5 Discharge Buck5 Discharge er Name - Buck6 Enable (RW, EEPROM) hot used Buck6 Phase Sync EN	hal clock when Buck1 Phase Sync EN is enabled Set Buck5 switching frequency when in PWM operation Set Buck5 output discharge resistance Set Buck5 output discharge resistance Enable Buck6 Phase Synchronization function Enable Buck6 PFM Spread Spectrum	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 100: 1.11MHz 101: 1.33MHz 110: 1.54MHz 111: 1.67MHz 00: Disabled 01: Slow 10: Medium 11: Fast 0: Disabled 1: Enabled	<0 <11 <11 <1 <1 <1 <1 <1 <1 <1 <1 <1 <1 <
[6:5] [4:2] [1:0] Registe Type - [7:5] [4] [3]	hot used Buck5 Phase Sync Delay Buck5 SW Freq Buck5 Discharge Buck5 Discharge er Name - Buck6 Enable (RW, EEPROM) hot used Buck6 Phase Sync EN Buck6 SS EN	hal clock when Buck1 Phase Sync EN is enabled Set Buck5 switching frequency when in PWM operation Set Buck5 output discharge resistance Set Buck5 output discharge resistance Enable Buck6 Phase Synchronization function Enable Buck6 PFM Spread Spectrum function in PFM mode	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 100: 1.11MHz 101: 1.33MHz 110: 1.54MHz 111: 1.67MHz 00: Disabled 01: Slow 10: Medium 11: Fast 0: Disabled 1: Enabled 0: Disabled 0: Disabled	<01 <11 <11 0x07 <00 <00 <00 <00 <00 <00 <00 <00 <00 <
[6:5] [4:2] [1:0] Registe Type - [7:5] [4]	hot used Buck5 Phase Sync Delay Buck5 SW Freq Buck5 Discharge Buck5 Discharge er Name - Buck6 Enable (RW, EEPROM) hot used Buck6 Phase Sync EN	hal clock when Buck1 Phase Sync EN is enabled Set Buck5 switching frequency when in PWM operation Set Buck5 output discharge resistance Set Buck5 output discharge resistance Enable Buck6 Phase Synchronization function Enable Buck6 PFM Spread Spectrum	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 100: 1.11MHz 101: 1.33MHz 110: 1.54MHz 111: 1.67MHz 00: Disabled 01: Slow 10: Medium 11: Fast 0: Disabled 1: Enabled 0: Disabled 1: Enabled 1: Enabled	<01 <11 <11 0x07 <00 <00 <00 <00 <00 <00 <00 <00 <00 <
[6:5] [4:2] [1:0] Registe Type - [7:5] [4] [3] [2]	hot used Buck5 Phase Sync Delay Buck5 SW Freq Buck5 Discharge Buck5 Discharge er Name - Buck6 Enable (RW, EEPROM) hot used Buck6 Phase Sync EN Buck6 SS EN	hal clock when Buck1 Phase Sync EN is enabled Set Buck5 switching frequency when in PWM operation Set Buck5 output discharge resistance Set Buck5 output discharge resistance Enable Buck6 Phase Synchronization function Enable Buck6 PFM Spread Spectrum function in PFM mode	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 100: 1.11MHz 101: 1.33MHz 110: 1.54MHz 111: 1.67MHz 00: Disabled 01: Slow 10: Medium 11: Fast 0: Disabled 1: Enabled 0: Disabled 1: Enabled 0: Disabled 1: Enabled 0: Disabled 1: Enabled 0: Disabled	<01 <11 0x07 0x07 <00 <00 <00 <00 <00 <00 <00 <00 <00 <
[6:5] [4:2] [1:0] Registe Type - [7:5] [4] [3]	hot used Buck5 Phase Sync Delay Buck5 SW Freq Buck5 Discharge Buck5 Discharge er Name - Buck6 Enable (RW, EEPROM) hot used Buck6 Phase Sync EN Buck6 SS EN Buck6 ABS EN	hal clock when Buck1 Phase Sync EN is enabled Set Buck5 switching frequency when in PWM operation Set Buck5 output discharge resistance Set Buck5 output discharge resistance Enable Buck6 Phase Synchronization function Enable Buck6 PFM Spread Spectrum function in PFM mode Enable Buck6 ABS (Ultrasonic) mode	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 100: 1.11MHz 101: 1.33MHz 110: 1.54MHz 111: 1.67MHz 00: Disabled 01: Slow 10: Medium 11: Fast 0: Disabled 1: Enabled 0: Disabled 1: Enabled 0: Disabled 1: Enabled 0: Disabled 1: Enabled 0: Disabled 1: Enabled 0: Disabled 1: Enabled	<0 <11 <11 <11 <1 <1 <1 <1 <1 <1 <1 <1 <1
[6:5] [4:2] [1:0] Registe Type - [7:5] [4] [3] [2]	hot used Buck5 Phase Sync Delay Buck5 SW Freq Buck5 Discharge Buck5 Discharge er Name - Buck6 Enable (RW, EEPROM) hot used Buck6 Phase Sync EN Buck6 SS EN Buck6 ABS EN	hal clock when Buck1 Phase Sync EN is enabled Set Buck5 switching frequency when in PWM operation Set Buck5 output discharge resistance Set Buck5 output discharge resistance Enable Buck6 Phase Synchronization function Enable Buck6 PFM Spread Spectrum function in PFM mode Enable Buck6 ABS (Ultrasonic) mode	01: 90deg 10: 180deg 11: 270deg 000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 100: 1.13MHz 110: 1.54MHz 111: 1.67MHz 00: Disabled 01: Slow 10: Medium 11: Fast 02: Disabled 11: Enabled 03: Disabled 12: Enabled 04: Disabled 12: Enabled 05: Disabled 14: Enabled 05: Disabled 15: Enabled 15: Disabled 16: Enabled 17: Enabled 1	<00 <00 <11 <11 <10 <10 <00 <00 <00 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10 <10

	er Name - Buck6 ACTIVI (RW, EEPROM)			0xD0 / 2
i ype -	(RW, EEFROW)			
[7]	Link Buck6 to Buck2	Link the sequencing of Buck 6 to Buck 2	0: Buck 6 and Buck 2 soft-start inde- pendently 1: Buck 6 and Buck 2 soft-start	<1>
[6]	VTTREF EN	When VTTREF EN is set to '1', buck6	together 0: Disabled	<1>
[0]		(VTT) = VREFOUT	1: Enabled	
[5:4]	Buck6 Mode ACTIVE	Set Buck6 operation mode in ACTIVE state	00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved	<01>
[3:0]	reserved			<0000
Regist	er Name - Buck6 SLEEP			0xC0 / 1
Type -	(RW, EEPROM)			
[7:6]	EnPD VTTRef	Config the pull down resistor for VTTREF	00: Disabled	<11>
			01: Slow 10: Medium 11: Fast	
[5:4]	Buck6 Mode SLEEP	Set Buck6 operation mode in SLEEP state		<00>
[3:0]	reserved		TX. INESEIVED	<0000
	er Name - Buck6 Power	On		00000 0x0A / 1
	(RW, EEPROM)			
[7]	not used	E		<0>
[6:0]	Buck6 Power On Delay	Delay timed from the beginning of power- on sequence	0: 0ms 1: 1ms 	<000101
			127: 127ms	
	er Name - Buck6 Power	Off		0x00 /
	er Name - Buck6 Power (RW, EEPROM)	Off		0x00 /
		Off		0x00/ <0>
Type -	(RW, EEPROM) hot used Buck6 Power Off	Delay timed from the beginning of power-	ρ: 0ms	
Type -	(RW, EEPROM)		0: 0ms 1: 1ms	<0>
Type -	(RW, EEPROM) hot used Buck6 Power Off	Delay timed from the beginning of power-	1: 1ms 	<0>
Type - [7] [6:0] Regista	(RW, EEPROM) hot used Buck6 Power Off	Delay timed from the beginning of power-		<0> <000000
Type - [7] [6:0] Regista Type -	(RW, EEPROM) hot used Buck6 Power Off Delay er Name - Buck6 SR (RW, EEPROM)	Delay timed from the beginning of power- off sequence	1: 1ms 127: 127ms	<0> <000000 0x5A / 5
Type - [7] [6:0] Registe	(RW, EEPROM) not used Buck6 Power Off Delay er Name - Buck6 SR	Delay timed from the beginning of power-	1: 1ms 	<0> <000000 0x5A / 5
Type - [7] [6:0] Regista Type -	(RW, EEPROM) hot used Buck6 Power Off Delay er Name - Buck6 SR (RW, EEPROM)	Delay timed from the beginning of power- off sequence	1: 1ms 127: 127ms 00: 4ms	<0> <000000 0x5A / 5
Type - [7] [6:0] Regista Type - [7:6]	(RW, EEPROM) hot used Buck6 Power Off Delay er Name - Buck6 SR (RW, EEPROM) Buck6 TSoftStart	Delay timed from the beginning of power- off sequence Set Buck6 soft-start time	1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms	<0> <000000 0x5A / S <01>
Type - [7] [6:0] Regista Type -	(RW, EEPROM) hot used Buck6 Power Off Delay er Name - Buck6 SR (RW, EEPROM)	Delay timed from the beginning of power- off sequence Set Buck6 soft-start time Set Buck6 shutdown period.	1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms	<0> <000000 0x5A / S
Type - [7] [6:0] Regista Type - [7:6]	(RW, EEPROM) hot used Buck6 Power Off Delay er Name - Buck6 SR (RW, EEPROM) Buck6 TSoftStart	Delay timed from the beginning of power- off sequence Set Buck6 soft-start time Set Buck6 shutdown period. Note: this setting sets the Shut Down SR	1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms	<0> <000000 0x5A / S <01>
Type - [7] [6:0] Regista Type - [7:6]	(RW, EEPROM) hot used Buck6 Power Off Delay er Name - Buck6 SR (RW, EEPROM) Buck6 TSoftStart	Delay timed from the beginning of power- off sequence Set Buck6 soft-start time Set Buck6 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to	1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms	<0> <000000 0x5A / 9 <01>
Type - [7] [6:0] Regista Type - [7:6]	(RW, EEPROM) hot used Buck6 Power Off Delay er Name - Buck6 SR (RW, EEPROM) Buck6 TSoftStart	Delay timed from the beginning of power- off sequence Set Buck6 soft-start time Set Buck6 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to 2b'00, 2b'01 or 2b'10. In addition, when	1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms	<0> <000000 0x5A / S <01>
Type - [7] [6:0] Regista Type - [7:6]	(RW, EEPROM) hot used Buck6 Power Off Delay er Name - Buck6 SR (RW, EEPROM) Buck6 TSoftStart	Delay timed from the beginning of power- off sequence Set Buck6 soft-start time Set Buck6 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to 2b'00, 2b'01 or 2b'10. In addition, when CEN goes from high to low, the shutdown	1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms	<0> <000000 0x5A / 5 <01>
Type - [7] [6:0] Regista Type - [7:6]	(RW, EEPROM) hot used Buck6 Power Off Delay er Name - Buck6 SR (RW, EEPROM) Buck6 TSoftStart	Delay timed from the beginning of power- off sequence Set Buck6 soft-start time Set Buck6 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to 2b'00, 2b'01 or 2b'10. In addition, when	1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms	<0> <000000 0x5A / S <01>
Type - [7] [6:0] Regista Type - [7:6]	(RW, EEPROM) hot used Buck6 Power Off Delay er Name - Buck6 SR (RW, EEPROM) Buck6 TSoftStart	Delay timed from the beginning of power- off sequence Set Buck6 soft-start time Set Buck6 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to 2b'00, 2b'01 or 2b'10. In addition, when CEN goes from high to low, the shutdown period starts to count from the time when	1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms	<0> <000000 0x5A / S <01>
Type - [7] [6:0] Regista Type - [7:6]	(RW, EEPROM) hot used Buck6 Power Off Delay er Name - Buck6 SR (RW, EEPROM) Buck6 TSoftStart	Delay timed from the beginning of power- off sequence Set Buck6 soft-start time Set Buck6 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to 2b'00, 2b'01 or 2b'10. In addition, when CEN goes from high to low, the shutdown period starts to count from the time when the last rail is turned off. At the end of the	1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms	<0> <000000 0x5A / S <01>
Type - [7] [6:0] Regista Type - [7:6]	(RW, EEPROM) hot used Buck6 Power Off Delay er Name - Buck6 SR (RW, EEPROM) Buck6 TSoftStart	Delay timed from the beginning of power- off sequence Set Buck6 soft-start time Set Buck6 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to 2b'00, 2b'01 or 2b'10. In addition, when CEN goes from high to low, the shutdown period starts to count from the time when the last rail is turned off. At the end of the shutdown period the FSM transitions to	1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 2mV/µs	<0> <000000 0x5A / S <01>
Type - [7] [6:0] Regista Type - [7:6]	(RW, EEPROM) hot used Buck6 Power Off Delay er Name - Buck6 SR (RW, EEPROM) Buck6 TSoftStart Buck6 TShutDown	Delay timed from the beginning of power- off sequence Set Buck6 soft-start time Set Buck6 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to 2b'00, 2b'01 or 2b'10. In addition, when CEN goes from high to low, the shutdown period starts to count from the time when the last rail is turned off. At the end of the shutdown period the FSM transitions to (STANDBY) then onward to {RESET}.	1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 2mV/µs 01: 4mV/µs	<0> <000000 0x5A / 9 <01>
Type - [7] [6:0] Regista Type - [7:6]	(RW, EEPROM) hot used Buck6 Power Off Delay er Name - Buck6 SR (RW, EEPROM) Buck6 TSoftStart Buck6 TShutDown	Delay timed from the beginning of power- off sequence Set Buck6 soft-start time Set Buck6 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to 2b'00, 2b'01 or 2b'10. In addition, when CEN goes from high to low, the shutdown period starts to count from the time when the last rail is turned off. At the end of the shutdown period the FSM transitions to (STANDBY) then onward to {RESET}.	1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 10: 1ms 11: 0.5ms 00: 2mV/µs 01: 4mV/µs 10: 8mV/µs	<0> <000000 0x5A / 9 <01>
Type - [7] [6:0] Regista Type - [7:6] [5:4]	(RW, EEPROM) hot used Buck6 Power Off Delay er Name - Buck6 SR (RW, EEPROM) Buck6 TSoftStart Buck6 TShutDown Buck6 DVS SRup	Delay timed from the beginning of power- off sequence Set Buck6 soft-start time Set Buck6 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to 2b'00, 2b'01 or 2b'10. In addition, when CEN goes from high to low, the shutdown period starts to count from the time when the last rail is turned off. At the end of the shutdown period the FSM transitions to (STANDBY) then onward to {RESET}. Set Buck6 output ramp-up slew rate	1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 10: 1ms 11: 0.5ms 00: 2mV/µs 01: 4mV/µs 10: 8mV/µs 11: 16mV/µs	<0> <000000 0x5A / S <01> <01> <10>
Type - [7] [6:0] Regista Type - [7:6]	(RW, EEPROM) hot used Buck6 Power Off Delay er Name - Buck6 SR (RW, EEPROM) Buck6 TSoftStart Buck6 TShutDown	Delay timed from the beginning of power- off sequence Set Buck6 soft-start time Set Buck6 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to 2b'00, 2b'01 or 2b'10. In addition, when CEN goes from high to low, the shutdown period starts to count from the time when the last rail is turned off. At the end of the shutdown period the FSM transitions to (STANDBY) then onward to {RESET}.	1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 10: 1ms 11: 0.5ms 00: 2mV/µs 01: 4mV/µs 10: 8mV/µs 11: 16mV/µs 00: 2mV/µs	<0> <000000 0x5A / 9 <01>
Type - [7] [6:0] Regista Type - [7:6] [5:4]	(RW, EEPROM) hot used Buck6 Power Off Delay er Name - Buck6 SR (RW, EEPROM) Buck6 TSoftStart Buck6 TShutDown Buck6 DVS SRup	Delay timed from the beginning of power- off sequence Set Buck6 soft-start time Set Buck6 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to 2b'00, 2b'01 or 2b'10. In addition, when CEN goes from high to low, the shutdown period starts to count from the time when the last rail is turned off. At the end of the shutdown period the FSM transitions to (STANDBY) then onward to {RESET}. Set Buck6 output ramp-up slew rate	1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 10: 1ms 11: 0.5ms 00: 2mV/µs 01: 4mV/µs 10: 8mV/µs 11: 16mV/µs	<0> <000000 0x5A / S <01> <01> <10>



.,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	r Name - Buck6 Config RW, EEPROM)			0x0
[7]	not used			<
[6:5]	Buck6 Phase Sync	Set Buck6 phase shift relative to the inter-		<
	Delay	nal clock when Buck1 Phase Sync EN is	01: 90deg	
		enabled	10: 180deg	
			11: 270deg	
[4:2]	Buck6 SW Freq	Set Buck6 switching frequency when in	000: 0.667MHz	<(
		PWM operation	001: 0.769MHz	
			010: 0.833MHz	
			011: 1MHz	
			100: 1.11MHz	
			101: 1.33MHz	
			110: 1.54MHz	
			111: 1.67MHz	
[1:0]	Buck6 Discharge	Set Buck6 output discharge resistance	00: Disabled	<
	Ű	when it is configured as an individual regu	-01: Slow	
		lator	10: Medium	
			11: Fast	
Renister	r Name - LDO1 ACTIVE	1		0x70
0	RW, EEPROM)	-		0.70
, i he - ($(\mathbf{v}, \mathbf{L}\mathbf{L})$			
[7]	LDO1 Bypass	Set LDO1 to bypass mode	0: Normal LDO mode	<
L' J	LDO I Dypass			
61	LDO1 EN ACTIVE	Enable DO1 in ACTIVE state	1: Bypass mode	
[6]	LDUT EN ACTIVE	Enable LDO1 in ACTIVE state	0: Disabled	•
15.01			1: Enabled	
[5:3]	LUU1 Vo 1 ACTIVE	Set LDO1 output voltage in ACTIVE state		<′
		when LDO_SEL1 = HIGH	001: 0.9V	
			010: 1.2V	I
			011: 1.5V	
			100: 1.8V	
			101: 2.5V	
			110: 3V	
			111: 3.3V	
[2:0]	LDO1 Vo 0 ACTIVE	Set LDO1 output voltage in ACTIVE state		<'
		when LDO_SEL1 = LOW	001: 0.9V	
			010: 1.2V	
			011: 1.5V	
			100: 1.8V	
			101: 2.5V	
			110 ⁻ 3V	
			111: 3.3V	00
	r Name - LDO1 SLEEP			0x0
і уре - (RW, EEPROM)			
	not used			<0
7./1	HUL USEU		0. Disabled	
[7:4]			0: Disabled	
[7:4] [3]	LDO1 EN SLEEP	Enable LDO1 in SLEEP state		
[3]	LDO1 EN SLEEP		1: Enabled	
		Set LDO1 output voltage in SLEEP state	1: Enabled 000: 0.8V	<
[3]	LDO1 EN SLEEP		1: Enabled 000: 0.8V 001: 0.9V	<
[3]	LDO1 EN SLEEP	Set LDO1 output voltage in SLEEP state	1: Enabled 000: 0.8V 001: 0.9V 010: 1.2V	<'
[3]	LDO1 EN SLEEP	Set LDO1 output voltage in SLEEP state	1: Enabled 000: 0.8V 001: 0.9V	<
[3]	LDO1 EN SLEEP	Set LDO1 output voltage in SLEEP state	1: Enabled 000: 0.8V 001: 0.9V 010: 1.2V	<
[3]	LDO1 EN SLEEP	Set LDO1 output voltage in SLEEP state	1: Enabled 000: 0.8V 001: 0.9V 010: 1.2V 011: 1.5V	<
[3]	LDO1 EN SLEEP	Set LDO1 output voltage in SLEEP state	1: Enabled 000: 0.8V 001: 0.9V 010: 1.2V 011: 1.5V 100: 1.8V	<
[3]	LDO1 EN SLEEP	Set LDO1 output voltage in SLEEP state	1: Enabled 000: 0.8V 001: 0.9V 010: 1.2V 011: 1.5V 100: 1.8V 101: 2.5V 110: 3V	<
[3]	LDO1 EN SLEEP	Set LDO1 output voltage in SLEEP state (LDO_SEL1 pin change is ignored)	1: Enabled 000: 0.8V 001: 0.9V 010: 1.2V 011: 1.5V 100: 1.8V 101: 2.5V	
[3] [2:0] Register	LDO1 EN SLEEP LDO1 Vo SLEEP r Name - LDO1 Power (Set LDO1 output voltage in SLEEP state (LDO_SEL1 pin change is ignored)	1: Enabled 000: 0.8V 001: 0.9V 010: 1.2V 011: 1.5V 100: 1.8V 101: 2.5V 110: 3V	
[3] [2:0] Register	LDO1 EN SLEEP	Set LDO1 output voltage in SLEEP state (LDO_SEL1 pin change is ignored)	1: Enabled 000: 0.8V 001: 0.9V 010: 1.2V 011: 1.5V 100: 1.8V 101: 2.5V 110: 3V	
[3] [2:0] Register	LDO1 EN SLEEP LDO1 Vo SLEEP r Name - LDO1 Power (Set LDO1 output voltage in SLEEP state (LDO_SEL1 pin change is ignored)	1: Enabled 000: 0.8V 001: 0.9V 010: 1.2V 011: 1.5V 100: 1.8V 101: 2.5V 110: 3V	
[3] [2:0] Registel Type - (LDO1 EN SLEEP LDO1 Vo SLEEP r Name - LDO1 Power (RW, EEPROM)	Set LDO1 output voltage in SLEEP state (LDO_SEL1 pin change is ignored)	1: Enabled 000: 0.8V 001: 0.9V 010: 1.2V 011: 1.5V 100: 1.8V 101: 2.5V 110: 3V	0x0
[3] [2:0] Register Type - ([7]	LDO1 EN SLEEP LDO1 Vo SLEEP r Name - LDO1 Power (RW, EEPROM) not used	Set LDO1 output voltage in SLEEP state (LDO_SEL1 pin change is ignored) Dn	1: Enabled 000: 0.8V 001: 0.9V 010: 1.2V 011: 1.5V 100: 1.8V 101: 2.5V 110: 3V 111: 3.3V	0x0
[3] [2:0] Registel Type - (LDO1 EN SLEEP LDO1 Vo SLEEP r Name - LDO1 Power (RW, EEPROM) not used LDO1 Power On	Set LDO1 output voltage in SLEEP state (LDO_SEL1 pin change is ignored) On Delay timed from the beginning of power-	1: Enabled 000: 0.8V 001: 0.9V 010: 1.2V 011: 1.5V 100: 1.8V 101: 2.5V 110: 3V 111: 3.3V 0: 0ms	0x0
[3] [2:0] Register Type - ([7]	LDO1 EN SLEEP LDO1 Vo SLEEP r Name - LDO1 Power (RW, EEPROM) not used	Set LDO1 output voltage in SLEEP state (LDO_SEL1 pin change is ignored) Dn	1: Enabled 000: 0.8V 001: 0.9V 010: 1.2V 011: 1.5V 100: 1.8V 101: 2.5V 110: 3V 111: 3.3V	0x0



i ype - (er Name - LDO1 Power (RW, EEPROM)	Off		0x00 /
[7]	not used			<0>
[6:0]	LDO1 Power Off Delay	Delay timed from the beginning of power- off sequence	0: 0ms 1: 1ms	<000000
			 127: 127ms	
	er Name - LDO1 SR (RW, EEPROM)		•	0x5A /
17.01			bo. 4	-04
[7:6]	LDO1 TSoftStart	Set LDO1 soft-start time	00: 4ms	<01>
			01: 2ms	
			10: 1ms	
			11: 0.5ms	
[5:4]	LDO1 TShutDown	Set LDO1 shutdown period.	00: 4ms	<01>
		U U U U U U U U U U U U U U U U U U U	01: 2ms	
		when Shutdown Option Buck is set to	10: 1ms	
		2b'00, 2b'01 or 2b'10. In addition, when	11: 0.5ms	
		CEN goes from high to low, the shutdown		
		period starts to count from the time when		
		the last rail is turned off. At the end of the		
		shutdown period the FSM transitions to		
<u> </u>		{STANDBY} then onward to {RESET}.		
[3:2]	LDO1 DVS SRup	Set LDO1 output ramp-up slew rate	00: 2mV/µs	<10>
			01: 4mV/µs	
1			10: 8mV/µs	
			11: 16mV/µs	
[1:0]	LDO1 DVS SRdn	Set LDO1 output ramp-down slew rate	00: 2mV/µs	<10>
		1	01: 4mV/µs	1
			01. 4πν/μ5	
			10: 8mV/μs	
-	er Name - LDO2 ACTIV (RW, EEPROM)	E	10: 8mV/µs	0x7C / 1
Type - (E Set LDO2 to bypass mode	10: 8mV/μs 11: 16mV/μs 0: Normal LDO mode	0x7C / ^ <0>
Type - ((RW, EEPROM) LDO2 Bypass	Set LDO2 to bypass mode	10: 8mV/μs 11: 16mV/μs	
Type - ([7]	(RW, EEPROM)		10: 8mV/µs 11: 16mV/µs 0: Normal LDO mode 1: Bypass mode 0: Disabled	
Type - ([7] [6]	(RW, EEPROM) LDO2 Bypass LDO2 EN ACTIVE	Set LDO2 to bypass mode Enable LDO2 in ACTIVE state	10: 8mV/µs 11: 16mV/µs 0: Normal LDO mode 1: Bypass mode 0: Disabled 1: Enabled	<0>
Type - ([7] [6]	(RW, EEPROM) LDO2 Bypass LDO2 EN ACTIVE	Set LDO2 to bypass mode Enable LDO2 in ACTIVE state Set LDO2 output voltage in ACTIVE state	10: 8mV/µs 11: 16mV/µs 0: Normal LDO mode 1: Bypass mode 0: Disabled 1: Enabled 000: 0.8V	<0>
Type - ([7] [6]	(RW, EEPROM) LDO2 Bypass LDO2 EN ACTIVE	Set LDO2 to bypass mode Enable LDO2 in ACTIVE state Set LDO2 output voltage in ACTIVE state when LDO_SEL2 = HIGH	10: 8mV/µs 11: 16mV/µs 0: Normal LDO mode 1: Bypass mode 0: Disabled 1: Enabled 000: 0.8V 001: 0.9V	<0>
Type - ((RW, EEPROM) LDO2 Bypass LDO2 EN ACTIVE	Set LDO2 to bypass mode Enable LDO2 in ACTIVE state Set LDO2 output voltage in ACTIVE state when LDO_SEL2 = HIGH	10: 8mV/µs 11: 16mV/µs 0: Normal LDO mode 1: Bypass mode 0: Disabled 1: Enabled 000: 0.8V 001: 0.9V 010: 1.2V	<0>
Type - ([7] [6]	(RW, EEPROM) LDO2 Bypass LDO2 EN ACTIVE	Set LDO2 to bypass mode Enable LDO2 in ACTIVE state Set LDO2 output voltage in ACTIVE state when LDO_SEL2 = HIGH	10: 8mV/µs 11: 16mV/µs 0: Normal LDO mode 1: Bypass mode 0: Disabled 1: Enabled 000: 0.8V 001: 0.9V	<0>
Type - ([7] [6]	(RW, EEPROM) LDO2 Bypass LDO2 EN ACTIVE	Set LDO2 to bypass mode Enable LDO2 in ACTIVE state Set LDO2 output voltage in ACTIVE state when LDO_SEL2 = HIGH	10: 8mV/µs 11: 16mV/µs 0: Normal LDO mode 1: Bypass mode 0: Disabled 1: Enabled 000: 0.8V 001: 0.9V 010: 1.2V	<0>
Type - ([7] [6]	(RW, EEPROM) LDO2 Bypass LDO2 EN ACTIVE	Set LDO2 to bypass mode Enable LDO2 in ACTIVE state Set LDO2 output voltage in ACTIVE state when LDO_SEL2 = HIGH	10: 8mV/µs 11: 16mV/µs 0: Normal LDO mode 1: Bypass mode 0: Disabled 1: Enabled 000: 0.8V 001: 0.9V 010: 1.2V 011: 1.5V	<0>
Type - ([7] [6]	(RW, EEPROM) LDO2 Bypass LDO2 EN ACTIVE	Set LDO2 to bypass mode Enable LDO2 in ACTIVE state Set LDO2 output voltage in ACTIVE state when LDO_SEL2 = HIGH	10: 8mV/µs 11: 16mV/µs 0: Normal LDO mode 1: Bypass mode 0: Disabled 1: Enabled 000: 0.8V 001: 0.9V 010: 1.2V 011: 1.5V 100: 1.8V	<0>
Type - ([7] [6]	(RW, EEPROM) LDO2 Bypass LDO2 EN ACTIVE	Set LDO2 to bypass mode Enable LDO2 in ACTIVE state Set LDO2 output voltage in ACTIVE state when LDO_SEL2 = HIGH	10: 8mV/µs 11: 16mV/µs 0: Normal LDO mode 1: Bypass mode 0: Disabled 1: Enabled 000: 0.8V 001: 0.9V 010: 1.2V 011: 1.5V 100: 1.8V 101: 2.5V	<0>
Type - ([7] [6] [5:3]	(RW, EEPROM) LDO2 Bypass LDO2 EN ACTIVE LDO2 Vo 1 ACTIVE	Set LDO2 to bypass mode Enable LDO2 in ACTIVE state Set LDO2 output voltage in ACTIVE state when LDO_SEL2 = HIGH	10: 8mV/µs 11: 16mV/µs 0: Normal LDO mode 1: Bypass mode 0: Disabled 1: Enabled 000: 0.8V 001: 0.9V 010: 1.2V 011: 1.5V 100: 1.8V 101: 2.5V 110: 3V 111: 3.3V	<0> <1> <111;
Type - ([7] [6] [5:3]	(RW, EEPROM) LDO2 Bypass LDO2 EN ACTIVE LDO2 Vo 1 ACTIVE	Set LDO2 to bypass mode Enable LDO2 in ACTIVE state Set LDO2 output voltage in ACTIVE state when LDO_SEL2 = HIGH	10: 8mV/µs 11: 16mV/µs 0: Normal LDO mode 1: Bypass mode 0: Disabled 1: Enabled 000: 0.8V 001: 0.9V 010: 1.2V 011: 1.5V 100: 1.8V 101: 2.5V 110: 3V 111: 3.3V 000: 0.8V	<0> <1> <1111;
Type - ([7] [6] [5:3]	(RW, EEPROM) LDO2 Bypass LDO2 EN ACTIVE LDO2 Vo 1 ACTIVE	Set LDO2 to bypass mode Enable LDO2 in ACTIVE state Set LDO2 output voltage in ACTIVE state when LDO_SEL2 = HIGH E Set LDO2 output voltage in ACTIVE state when LDO_SEL2 = LOW	10: 8mV/µs 11: 16mV/µs 0: Normal LDO mode 1: Bypass mode 0: Disabled 1: Enabled 000: 0.8V 001: 0.9V 010: 1.2V 011: 1.5V 100: 1.8V 101: 2.5V 110: 3V 111: 3.3V 000: 0.8V 001: 0.9V	<0> <1> <1111;
Type - ([7] [6]	(RW, EEPROM) LDO2 Bypass LDO2 EN ACTIVE LDO2 Vo 1 ACTIVE	Set LDO2 to bypass mode Enable LDO2 in ACTIVE state Set LDO2 output voltage in ACTIVE state when LDO_SEL2 = HIGH E Set LDO2 output voltage in ACTIVE state when LDO_SEL2 = LOW	10: 8mV/µs 11: 16mV/µs 0: Normal LDO mode 1: Bypass mode 0: Disabled 1: Enabled 000: 0.8V 001: 0.9V 010: 1.2V 011: 1.5V 100: 1.8V 101: 2.5V 110: 3V 111: 3.3V 000: 0.8V 001: 0.9V 010: 1.2V	<0>
Type - ([7] [6] [5:3]	(RW, EEPROM) LDO2 Bypass LDO2 EN ACTIVE LDO2 Vo 1 ACTIVE	Set LDO2 to bypass mode Enable LDO2 in ACTIVE state Set LDO2 output voltage in ACTIVE state when LDO_SEL2 = HIGH E Set LDO2 output voltage in ACTIVE state when LDO_SEL2 = LOW	10: 8mV/µs 11: 16mV/µs 11: 16mV/µs 0: Normal LDO mode 1: Bypass mode 0: Disabled 1: Enabled 000: 0.8V 001: 0.9V 010: 1.2V 011: 1.5V 100: 1.8V 101: 2.5V 111: 3.3V 100: 0.8V 001: 0.9V 001: 0.9V 010: 1.2V 011: 1.5V	<0> <1> <1111;
Type - ([7] [6] [5:3]	(RW, EEPROM) LDO2 Bypass LDO2 EN ACTIVE LDO2 Vo 1 ACTIVE	Set LDO2 to bypass mode Enable LDO2 in ACTIVE state Set LDO2 output voltage in ACTIVE state when LDO_SEL2 = HIGH E Set LDO2 output voltage in ACTIVE state when LDO_SEL2 = LOW	10: 8mV/µs 11: 16mV/µs 11: 16mV/µs 0: Normal LDO mode 1: Bypass mode 0: Disabled 1: Enabled 000: 0.8V 001: 0.9V 010: 1.2V 011: 1.5V 100: 1.8V 101: 2.5V 111: 3.3V 100: 0.8V 001: 0.9V 001: 0.9V 010: 1.2V 011: 1.5V 100: 1.8V 100: 1.8V 100: 1.8V	<0> <1> <111;
Type - ([7] [6] [5:3]	(RW, EEPROM) LDO2 Bypass LDO2 EN ACTIVE LDO2 Vo 1 ACTIVE	Set LDO2 to bypass mode Enable LDO2 in ACTIVE state Set LDO2 output voltage in ACTIVE state when LDO_SEL2 = HIGH E Set LDO2 output voltage in ACTIVE state when LDO_SEL2 = LOW	10: 8mV/µs 11: 16mV/µs 11: 16mV/µs 0: Normal LDO mode 1: Bypass mode 0: Disabled 1: Enabled 000: 0.8V 001: 0.9V 010: 1.2V 011: 1.5V 100: 1.8V 101: 2.5V 111: 3.3V 100: 0.8V 001: 0.9V 001: 0.9V 010: 1.2V 011: 1.5V	<0> <1> <111;

	(RW, EEPROM)			0x0
[7:4]	not used			<00
[3]	LDO2 EN SLEEP	Enable LDO2 in SLEEP state	0: Disabled 1: Enabled	<
[2:0]	LDO2 Vo SLEEP	Set LDO2 output voltage in SLEEP state (LDO_SEL2 pin is ignored)	000: 0.8V 001: 0.9V 010: 1.2V	<1
			011: 1.5V 100: 1.8V 101: 2.5V 110: 3V	
Decisto	r Name - LDO2 Power		111: 3.3V	0x0
	(RW, EEPROM)	UII .		0.00
[7]	not used			<
[6:0]	LDO2 Power On	Delay timed from the beginning of power-	0: 0ms	<000
[0.0]	Delay	on sequence	1: 1ms	<000
			 127: 127ms	
Dogisto	r Name - LDO2 Power	0#	121. 121113	0x(
Type - ([7]	hot used		h a	
	not used LDO2 Power Off Delay	Delay timed from the beginning of power- off sequence	0: 0ms 1: 1ms	
[7] [6:0]	LDO2 Power Off Delay			<000
[7] [6:0] Registe	LDO2 Power Off		1: 1ms 	<000
[7] [6:0] Registe Type - (LDO2 Power Off Delay r Name - LDO2 SR		1: 1ms 	<000 0x5,
[7] [6:0] Registe	LDO2 Power Off Delay r Name - LDO2 SR (RW, EEPROM)	off sequence	1: 1ms 127: 127ms	<000 0x5,
[7] [6:0] Registe Type - (LDO2 Power Off Delay r Name - LDO2 SR (RW, EEPROM)	off sequence	1: 1ms 127: 127ms 00: 4ms	<000 0x5.
[7] [6:0] Registe Type - (LDO2 Power Off Delay r Name - LDO2 SR (RW, EEPROM)	off sequence	1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms	<000
[7] [6:0] Registe Type - (LDO2 Power Off Delay r Name - LDO2 SR (RW, EEPROM)	off sequence	1: 1ms 127: 127ms 00: 4ms 01: 2ms	<000 0x5
[7] [6:0] Registe Type - ([7:6]	LDO2 Power Off Delay r Name - LDO2 SR (RW, EEPROM) LDO2 TSoftStart	off sequence Set LDO2 soft-start time	1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms	<000 0x5
[7] [6:0] Registe Type - ([7:6]	LDO2 Power Off Delay r Name - LDO2 SR (RW, EEPROM) LDO2 TSoftStart	off sequence Set LDO2 soft-start time Set LDO2 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to	1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms	<000 0x5
[7] [6:0] Registe Type - ([7:6]	LDO2 Power Off Delay r Name - LDO2 SR (RW, EEPROM) LDO2 TSoftStart	Set LDO2 soft-start time Set LDO2 soft-start time Set LDO2 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to 2b'00, 2b'01 or 2b'10. In addition, when	1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms	<000 0x5
[7] [6:0] Registe Type - ([7:6]	LDO2 Power Off Delay r Name - LDO2 SR (RW, EEPROM) LDO2 TSoftStart	Set LDO2 soft-start time Set LDO2 soft-start time Set LDO2 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to 2b'00, 2b'01 or 2b'10. In addition, when CEN goes from high to low, the shutdown	1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms	<000 0x5
[7] [6:0] Registe Type - ([7:6]	LDO2 Power Off Delay r Name - LDO2 SR (RW, EEPROM) LDO2 TSoftStart	Set LDO2 soft-start time Set LDO2 soft-start time Set LDO2 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to 2b'00, 2b'01 or 2b'10. In addition, when CEN goes from high to low, the shutdown period starts to count from the time when	1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms	<000 0x5
[7] [6:0] Registe Type - ([7:6]	LDO2 Power Off Delay r Name - LDO2 SR (RW, EEPROM) LDO2 TSoftStart	Set LDO2 soft-start time Set LDO2 soft-start time Set LDO2 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to 2b'00, 2b'01 or 2b'10. In addition, when CEN goes from high to low, the shutdown period starts to count from the time when the last rail is turned off. At the end of the	1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms	<000 0x5
[7] [6:0] Registe Type - ([7:6]	LDO2 Power Off Delay r Name - LDO2 SR (RW, EEPROM) LDO2 TSoftStart	Set LDO2 soft-start time Set LDO2 soft-start time Set LDO2 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to 2b'00, 2b'01 or 2b'10. In addition, when CEN goes from high to low, the shutdown period starts to count from the time when the last rail is turned off. At the end of the shutdown period the FSM transitions to	1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms	<000 0x5
[7] [6:0] Registe Type - ([7:6]	LDO2 Power Off Delay r Name - LDO2 SR (RW, EEPROM) LDO2 TSoftStart	Set LDO2 soft-start time Set LDO2 soft-start time Set LDO2 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to 2b'00, 2b'01 or 2b'10. In addition, when CEN goes from high to low, the shutdown period starts to count from the time when the last rail is turned off. At the end of the shutdown period the FSM transitions to (STANDBY) then onward to {RESET}.	1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms	<000 0x5
[7] [6:0] Registe Type - ([7:6]	LDO2 Power Off Delay r Name - LDO2 SR (RW, EEPROM) LDO2 TSoftStart	Set LDO2 soft-start time Set LDO2 soft-start time Set LDO2 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to 2b'00, 2b'01 or 2b'10. In addition, when CEN goes from high to low, the shutdown period starts to count from the time when the last rail is turned off. At the end of the shutdown period the FSM transitions to	1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 5ms	<000 0x5. <
[7] [6:0] Registe Type - ([7:6]	LDO2 Power Off Delay r Name - LDO2 SR (RW, EEPROM) LDO2 TSoftStart	Set LDO2 soft-start time Set LDO2 soft-start time Set LDO2 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to 2b'00, 2b'01 or 2b'10. In addition, when CEN goes from high to low, the shutdown period starts to count from the time when the last rail is turned off. At the end of the shutdown period the FSM transitions to (STANDBY) then onward to {RESET}.	1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 10: 1ms 11: 0.5ms 00: 2mV/µs 01: 4mV/µs	<000 0x5. <
[7] [6:0] Registe Type - ([7:6]	LDO2 Power Off Delay r Name - LDO2 SR (RW, EEPROM) LDO2 TSoftStart	Set LDO2 soft-start time Set LDO2 soft-start time Set LDO2 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to 2b'00, 2b'01 or 2b'10. In addition, when CEN goes from high to low, the shutdown period starts to count from the time when the last rail is turned off. At the end of the shutdown period the FSM transitions to (STANDBY) then onward to {RESET}.	1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 11: 0.5ms 00: 2mV/µs 01: 4mV/µs 10: 8mV/µs	<000 0x5. <
[7] [6:0] Registe Type - ([7:6] [5:4]	LDO2 Power Off Delay r Name - LDO2 SR (RW, EEPROM) LDO2 TSoftStart LDO2 TShutDown	Set LDO2 soft-start time Set LDO2 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to 2b'00, 2b'01 or 2b'10. In addition, when CEN goes from high to low, the shutdown period starts to count from the time when the last rail is turned off. At the end of the shutdown period the FSM transitions to (STANDBY) then onward to {RESET}. Set LDO2 output ramp-up slew rate	1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 11: 0.5ms 00: 2mV/µs 01: 4mV/µs 10: 8mV/µs 11: 16mV/µs	<000 0x5
[7] [6:0] Registe Type - ([7:6]	LDO2 Power Off Delay r Name - LDO2 SR (RW, EEPROM) LDO2 TSoftStart	Set LDO2 soft-start time Set LDO2 soft-start time Set LDO2 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to 2b'00, 2b'01 or 2b'10. In addition, when CEN goes from high to low, the shutdown period starts to count from the time when the last rail is turned off. At the end of the shutdown period the FSM transitions to (STANDBY) then onward to {RESET}.	1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 10: 1ms 11: 0.5ms 00: 2mV/µs 01: 4mV/µs 10: 8mV/µs 11: 16mV/µs 00: 2mV/µs	<000 0x5, <(
[7] [6:0] Registe Type - ([7:6] [5:4]	LDO2 Power Off Delay r Name - LDO2 SR (RW, EEPROM) LDO2 TSoftStart LDO2 TShutDown	Set LDO2 soft-start time Set LDO2 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to 2b'00, 2b'01 or 2b'10. In addition, when CEN goes from high to low, the shutdown period starts to count from the time when the last rail is turned off. At the end of the shutdown period the FSM transitions to (STANDBY) then onward to {RESET}. Set LDO2 output ramp-up slew rate	1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 11: 0.5ms 00: 2mV/µs 01: 4mV/µs 10: 8mV/µs 11: 16mV/µs	

Registe				
i ype -	(RW, EEPROM)			
[7]	LDO3 EN SLEEP	Enable LDO3 in SLEEP state	0: Disabled	<1>
			1: Enabled	
[6]	LDO3 EN ACTIVE	Enable LDO3 in ACTIVE state	0: Disabled	<1>
[-			1: Enabled	
[5:3]	LDO3 Vo SLEEP	Set LDO3 output voltage in SLEEP state	000: 0.8V	<101
			001: 0.9V	
			010: 1.2V	
			011: 1.5V	
			100: 1.8V	
			101: 2.5V	
			110: 3V	
			111: 3.3V	
[2:0]	LDO3 Vo ACTIVE	Set LDO3 output voltage in ACTIVE state	000: 0.8V	<101
			001: 0.9V	
			010: 1.2V	
			011: 1.5V	
			100: 1.8V	
1			101: 2.5V	
			110: 3V	
1			111: 3.3V	
Registe	r Name - LDO3 Power	Ön		0x02
	(RW, EEPROM)			
[7]	not used			<0>
10.01		Delay timed from the beginning of neuror	0: 0ms	-00000
[6:0]	LDO3 Power On	Delay timed from the beginning of power-	0. 01110	<00000
[6:0]	LDO3 Power On Delay	on sequence	1: 1ms	<00000
[6:0]				<00000
	Delay	on sequence		<00000
		on sequence	1: 1ms 	<00000 0x46 /
Registe	Delay	on sequence	1: 1ms 	
Registe	Delay er Name - LDO3 Power	on sequence	1: 1ms 	
Registe Type - (Delay er Name - LDO3 Power	on sequence	1: 1ms 	0x46 /
Registe	Delay er Name - LDO3 Power (RW, EEPROM)	on sequence Off	1: 1ms 	0x46 / <0>
Registe Type - (Delay er Name - LDO3 Power (RW, EEPROM) not used LDO3 Power Off	on sequence Off Delay timed from the beginning of power-	1: 1ms 127: 127ms 0: 0ms	0x46 / <0>
Registe Type - (Delay er Name - LDO3 Power (RW, EEPROM) not used	on sequence Off	1: 1ms 127: 127ms	0x46 / <0>
Registe Type - (Delay er Name - LDO3 Power (RW, EEPROM) not used LDO3 Power Off	on sequence Off Delay timed from the beginning of power-	1: 1ms 127: 127ms 0: 0ms 1: 1ms 	0x46 / <0>
Registe Type - ([7] [6:0]	Delay er Name - LDO3 Power (RW, EEPROM) not used LDO3 Power Off Delay	on sequence Off Delay timed from the beginning of power-	1: 1ms 127: 127ms 0: 0ms	
Registe Type - ([7] [6:0] Registe	Delay er Name - LDO3 Power (RW, EEPROM) hot used LDO3 Power Off Delay er Name - LDO3 SR	on sequence Off Delay timed from the beginning of power-	1: 1ms 127: 127ms 0: 0ms 1: 1ms 	0x46 / <0> <10001
Registe Type - ([7] [6:0] Registe	Delay er Name - LDO3 Power (RW, EEPROM) not used LDO3 Power Off Delay	on sequence Off Delay timed from the beginning of power-	1: 1ms 127: 127ms 0: 0ms 1: 1ms 	0x46 / <0> <10001
Registe Type - [7] [6:0] Registe Type -	Delay er Name - LDO3 Power (RW, EEPROM) hot used LDO3 Power Off Delay er Name - LDO3 SR (RW, EEPROM)	on sequence Off Delay timed from the beginning of power- off sequence	1: 1ms 127: 127ms 0: 0ms 1: 1ms 127: 127ms	0x46 / <0> <10001
Registe Type - I [7] [6:0] Registe	Delay er Name - LDO3 Power (RW, EEPROM) hot used LDO3 Power Off Delay er Name - LDO3 SR	on sequence Off Delay timed from the beginning of power-	1: 1ms 127: 127ms 0: 0ms 1: 1ms 127: 127ms 00: 4ms	0x46 / <0> <10001
Registe Type - [7] [6:0] Registe Type -	Delay er Name - LDO3 Power (RW, EEPROM) hot used LDO3 Power Off Delay er Name - LDO3 SR (RW, EEPROM)	on sequence Off Delay timed from the beginning of power- off sequence	1: 1ms 127: 127ms 0: 0ms 1: 1ms 127: 127ms 00: 4ms 01: 2ms	0x46 / <0> <10001
Registe Type - [7] [6:0] Registe Type -	Delay er Name - LDO3 Power (RW, EEPROM) hot used LDO3 Power Off Delay er Name - LDO3 SR (RW, EEPROM)	on sequence Off Delay timed from the beginning of power- off sequence	1: 1ms 127: 127ms 0: 0ms 1: 1ms 127: 127ms 00: 4ms	0x46 / <0> <10001
Registe Type - [7] [6:0] Registe Type -	Delay er Name - LDO3 Power (RW, EEPROM) hot used LDO3 Power Off Delay er Name - LDO3 SR (RW, EEPROM)	on sequence Off Delay timed from the beginning of power- off sequence	1: 1ms 127: 127ms 0: 0ms 1: 1ms 127: 127ms 00: 4ms 01: 2ms	0x46 / <0> <10001
Registe Type - [7] [6:0] Registe Type -	Delay er Name - LDO3 Power (RW, EEPROM) hot used LDO3 Power Off Delay er Name - LDO3 SR (RW, EEPROM)	on sequence Off Delay timed from the beginning of power- off sequence	1: 1ms 127: 127ms 0: 0ms 1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms	0x46 / <0> <10001 0x5A / <01:
Registe Type - ([7] [6:0] Registe Type - (Delay er Name - LDO3 Power (RW, EEPROM) hot used LDO3 Power Off Delay er Name - LDO3 SR (RW, EEPROM) LDO3 TSoftStart	on sequence Off Delay timed from the beginning of power- off sequence Set LDO3 soft-start time	1: 1ms 127: 127ms 0: 0ms 1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms	0x46 / <0> <10001 0x5A / <01
Registe Type - ([7] [6:0] Registe Type - (Delay er Name - LDO3 Power (RW, EEPROM) hot used LDO3 Power Off Delay er Name - LDO3 SR (RW, EEPROM) LDO3 TSoftStart	on sequence Off Delay timed from the beginning of power- off sequence Set LDO3 soft-start time Set LDO3 shutdown period. Note: this setting sets the Shut Down SR	1: 1ms 127: 127ms 0: 0ms 1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms	0x46 / <0> <10001 0x5A / <011
Registe Type - ([7] [6:0] Registe Type - (Delay er Name - LDO3 Power (RW, EEPROM) hot used LDO3 Power Off Delay er Name - LDO3 SR (RW, EEPROM) LDO3 TSoftStart	on sequence Off Delay timed from the beginning of power- off sequence Set LDO3 soft-start time Set LDO3 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to	1: 1ms 127: 127ms 0: 0ms 1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms	0x46 / <0> <10001 0x5A / <01:
Registe Type - ([7] [6:0] Registe Type - (Delay er Name - LDO3 Power (RW, EEPROM) hot used LDO3 Power Off Delay er Name - LDO3 SR (RW, EEPROM) LDO3 TSoftStart	on sequence Off Delay timed from the beginning of power- off sequence Set LDO3 soft-start time Set LDO3 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to 2b'00, 2b'01 or 2b'10. In addition, when	1: 1ms 127: 127ms 0: 0ms 1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms	0x46 / <0> <10001 0x5A / <01:
Registe Type - ([7] [6:0] Registe Type - (Delay er Name - LDO3 Power (RW, EEPROM) hot used LDO3 Power Off Delay er Name - LDO3 SR (RW, EEPROM) LDO3 TSoftStart	on sequence Off Delay timed from the beginning of power- off sequence Set LDO3 soft-start time Set LDO3 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to 2b'00, 2b'01 or 2b'10. In addition, when CEN goes from high to low, the shutdown	1: 1ms 127: 127ms 0: 0ms 1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms	0x46 / <0> <10001 0x5A / <01:
Registe Type - ([7] [6:0] Registe Type - (Delay er Name - LDO3 Power (RW, EEPROM) hot used LDO3 Power Off Delay er Name - LDO3 SR (RW, EEPROM) LDO3 TSoftStart	Off Delay timed from the beginning of power- off sequence Set LDO3 soft-start time Set LDO3 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to 2b'00, 2b'01 or 2b'10. In addition, when CEN goes from high to low, the shutdown period starts to count from the time when	1: 1ms 127: 127ms 0: 0ms 1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms	0x46 / <0> <10001 0x5A / <01:
Registe Type - ([7] [6:0] Registe Type - (Delay er Name - LDO3 Power (RW, EEPROM) hot used LDO3 Power Off Delay er Name - LDO3 SR (RW, EEPROM) LDO3 TSoftStart	Off Delay timed from the beginning of power- off sequence Set LDO3 soft-start time Set LDO3 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to 2b'00, 2b'01 or 2b'10. In addition, when CEN goes from high to low, the shutdown period starts to count from the time when the last rail is turned off. At the end of the	1: 1ms 127: 127ms 0: 0ms 1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms	0x46 / <0> <10001 0x5A / <01:
Registe Type - ([7] [6:0] Registe Type - (Delay er Name - LDO3 Power (RW, EEPROM) hot used LDO3 Power Off Delay er Name - LDO3 SR (RW, EEPROM) LDO3 TSoftStart	Off Delay timed from the beginning of power- off sequence Set LDO3 soft-start time Set LDO3 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to 2b'00, 2b'01 or 2b'10. In addition, when CEN goes from high to low, the shutdown period starts to count from the time when the last rail is turned off. At the end of the shutdown period the FSM transitions to	1: 1ms 127: 127ms 0: 0ms 1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms	0x46 / <0> <10001 0x5A / <01:
Registe Type - ([7] [6:0] [7:6] [5:4]	Delay er Name - LDO3 Power (RW, EEPROM) not used LDO3 Power Off Delay er Name - LDO3 SR (RW, EEPROM) LDO3 TSoftStart LDO3 TSoftStart	Off Delay timed from the beginning of power- off sequence Set LDO3 soft-start time Set LDO3 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to 2b'00, 2b'01 or 2b'10. In addition, when CEN goes from high to low, the shutdown period starts to count from the time when the last rail is turned off. At the end of the shutdown period the FSM transitions to (STANDBY) then onward to {RESET}.	1: 1ms 127: 127ms 0: 0ms 1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms	0x46 / <0> <10001 0x5A / <01: <01:
Registe Type - ([7] [6:0] Registe Type - (Delay er Name - LDO3 Power (RW, EEPROM) hot used LDO3 Power Off Delay er Name - LDO3 SR (RW, EEPROM) LDO3 TSoftStart	Off Delay timed from the beginning of power- off sequence Set LDO3 soft-start time Set LDO3 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to 2b'00, 2b'01 or 2b'10. In addition, when CEN goes from high to low, the shutdown period starts to count from the time when the last rail is turned off. At the end of the shutdown period the FSM transitions to	1: 1ms 127: 127ms 0: 0ms 1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 10: 1ms 11: 0.5ms	0x46 / <0> <10001
Registe Type - ([7] [6:0] [7:6] [5:4]	Delay er Name - LDO3 Power (RW, EEPROM) not used LDO3 Power Off Delay er Name - LDO3 SR (RW, EEPROM) LDO3 TSoftStart LDO3 TSoftStart	Off Delay timed from the beginning of power- off sequence Set LDO3 soft-start time Set LDO3 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to 2b'00, 2b'01 or 2b'10. In addition, when CEN goes from high to low, the shutdown period starts to count from the time when the last rail is turned off. At the end of the shutdown period the FSM transitions to (STANDBY) then onward to {RESET}.	1: 1ms 127: 127ms 0: 0ms 1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 11: 0.5ms 00: 2mV/µs 01: 4mV/µs	0x46 / <0> <10001 0x5A / <01: <01:
Registe Type - ([7] [6:0] [7:6] [5:4]	Delay er Name - LDO3 Power (RW, EEPROM) not used LDO3 Power Off Delay er Name - LDO3 SR (RW, EEPROM) LDO3 TSoftStart LDO3 TSoftStart	Off Delay timed from the beginning of power- off sequence Set LDO3 soft-start time Set LDO3 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to 2b'00, 2b'01 or 2b'10. In addition, when CEN goes from high to low, the shutdown period starts to count from the time when the last rail is turned off. At the end of the shutdown period the FSM transitions to (STANDBY) then onward to {RESET}.	1: 1ms 127: 127ms 0: 0ms 1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 11: 0.5ms 00: 2mV/µs 01: 4mV/µs 10: 8mV/µs	0x46 / <0> <10001 0x5A / <01: <01:
Registe Type - 1 [6:0] [6:0] [7:6] [5:4]	Delay er Name - LDO3 Power (RW, EEPROM) not used LDO3 Power Off Delay er Name - LDO3 SR (RW, EEPROM) LDO3 TSoftStart LDO3 TShutDown LDO3 DVS SRup	on sequence Off Delay timed from the beginning of power- off sequence Set LDO3 soft-start time Set LDO3 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to 2b'00, 2b'01 or 2b'10. In addition, when CEN goes from high to low, the shutdown period starts to count from the time when the last rail is turned off. At the end of the shutdown period the FSM transitions to (STANDBY) then onward to {RESET}. Set LDO3 output ramp-up slew rate	1: 1ms 127: 127ms 0: 0ms 1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 11: 0.5ms	0x46 / <0> <10001 0x5A / <01: <01: <01: <10:
Registe Type - ([7] [6:0] [7:6] [5:4]	Delay er Name - LDO3 Power (RW, EEPROM) not used LDO3 Power Off Delay er Name - LDO3 SR (RW, EEPROM) LDO3 TSoftStart LDO3 TSoftStart	Off Delay timed from the beginning of power- off sequence Set LDO3 soft-start time Set LDO3 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to 2b'00, 2b'01 or 2b'10. In addition, when CEN goes from high to low, the shutdown period starts to count from the time when the last rail is turned off. At the end of the shutdown period the FSM transitions to (STANDBY) then onward to {RESET}.	1: 1ms 127: 127ms 0: 0ms 1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 11: 0.5ms	0x46 / <0> <10001 0x5A / <01: <01: <01: <10:
Registe Type - 1 [6:0] [6:0] [7:6] [5:4]	Delay er Name - LDO3 Power (RW, EEPROM) not used LDO3 Power Off Delay er Name - LDO3 SR (RW, EEPROM) LDO3 TSoftStart LDO3 TShutDown LDO3 DVS SRup	on sequence Off Delay timed from the beginning of power- off sequence Set LDO3 soft-start time Set LDO3 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to 2b'00, 2b'01 or 2b'10. In addition, when CEN goes from high to low, the shutdown period starts to count from the time when the last rail is turned off. At the end of the shutdown period the FSM transitions to (STANDBY) then onward to {RESET}. Set LDO3 output ramp-up slew rate	1: 1ms 127: 127ms 0: 0ms 1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 11: 0.5ms 00: 2mV/µs 01: 4mV/µs 10: 8mV/µs 11: 16mV/µs 00: 2mV/µs 01: 4mV/µs	0x46 / <0> <10001 0x5A / <01: <01: <01: <10:
Registe Type - 1 [6:0] [6:0] [7:6] [5:4]	Delay er Name - LDO3 Power (RW, EEPROM) not used LDO3 Power Off Delay er Name - LDO3 SR (RW, EEPROM) LDO3 TSoftStart LDO3 TShutDown LDO3 DVS SRup	on sequence Off Delay timed from the beginning of power- off sequence Set LDO3 soft-start time Set LDO3 shutdown period. Note: this setting sets the Shut Down SR when Shutdown Option Buck is set to 2b'00, 2b'01 or 2b'10. In addition, when CEN goes from high to low, the shutdown period starts to count from the time when the last rail is turned off. At the end of the shutdown period the FSM transitions to (STANDBY) then onward to {RESET}. Set LDO3 output ramp-up slew rate	1: 1ms 127: 127ms 0: 0ms 1: 1ms 127: 127ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 10: 1ms 11: 0.5ms 00: 4ms 01: 2ms 10: 1ms 11: 0.5ms 11: 0.5ms	0x46 / <0> <10001 0x5A / <01: <01:



	gister Name - LDOs Config pe - (RW, EEPROM)			0x2A /
[7]	not used			<0>
[7] [6]		Set LDO3 to bypass mode	0: Normal LDO mode	<0>
[0]	EDOO Dypass		1: Bypass mode	102
[5:4	4] LDO3 Discharge	Set LDO3 output discharge resistance	00: Disabled 01: Slow	<10>
			10: Medium 11: Fast	10
[3:2	2] LDO2 Discharge	Set LDO2 output discharge resistance	00: Disabled 01: Slow 10: Medium 11: Fast	<10>
[1:(0] LDO1 Discharge	Set LDO1 output discharge resistance	00: Disabled 01: Slow 10: Medium 11: Fast	<10>
i9 Re	gister Name - Fault Latched	l Status 1	11.1 dot	0x00 /
	pe - (RW, Non EEPROM)			
[7:6	6] not used			<00>
[5]	Buck6 UV Latched	Buck6 undervoltage fault latched bit. Write 1' to clear the fault	0: OK (normal) 1: Undervoltage fault occurs	<0>
[4]		Buck5 undervoltage fault latched bit. Write 1' to clear the fault	0: OK (normal) 1: Undervoltage fault occurs	<0>
[3]			1: Undervoltage fault occurs	<0>
[2]		Buck3 undervoltage fault latched bit. Write 1' to clear the fault	1: Undervoltage fault occurs	<0>
[1]		Buck2 undervoltage fault latched bit. Write 1' to clear the fault Buck4 undervoltage fault latched bit. Write	1: Undervoltage fault occurs	<0>
[0]	Buck1 UV Latched	Buck1 undervoltage fault latched bit. Write 1' to clear the fault	0: OK (normal) 1: Undervoltage fault occurs	<0>
	gister Name - Fault Latcheo pe - (RW, Non EEPROM)	I Status 2		0x00 /
[7:4				<0000
[3]	VIO Pgood Latched	the fault	0: OK (normal) 1: VIO level below its power-good threshold	<0>
[2]		LDO3 undervoltage fault latched bit. Write 1' to clear the fault	0: OK (normal) 1: Undervoltage fault occurs	<0>
	LDO2 UV Latched	LDO2 undervoltage fault latched bit. Write	0: OK (normal) 1: Undervoltage fault occurs	-0-
[1]		1' to clear the fault		
[1] [0]	LDO1 UV Latched	LDO1 undervoltage fault latched bit. Write 1' to clear the fault	1: Ordervoltage fault occurs 0: OK (normal) 1: undervoltage fault occurs	<0>
[1] [0] B Re		LDO1 undervoltage fault latched bit. Write 1' to clear the fault	0: OK (normal)	<0>
[1] [0] B Re	LDO1 UV Latched gister Name - Fault Latched pe - (RW, Non EEPROM)	LDO1 undervoltage fault latched bit. Write 1' to clear the fault	0: OK (normal)	<0>
[1] [0] B Re Tyj	LDO1 UV Latched gister Name - Fault Latched pe - (RW, Non EEPROM) 6] hot used	LDO1 undervoltage fault latched bit. Write 1' to clear the fault 1 Status 3 Buck6 overvoltage fault latched bit. Write 1' to clear the fault	0: OK (normal) 1: undervoltage fault occurs 0: OK (normal) 1: Overvoltage fault occurs	<0> <0> 0x00 / <00>
[1] [0] B Re Typ [7:0	LDO1 UV Latched gister Name - Fault Latched pe - (RW, Non EEPROM) 6] hot used Buck6 OV Latched Buck5 OV Latched	LDO1 undervoltage fault latched bit. Write 1' to clear the fault 3 Status 3 Buck6 overvoltage fault latched bit. Write 1' to clear the fault Buck5 overvoltage fault latched bit. Write 1' to clear the fault	0: OK (normal) 1: undervoltage fault occurs 0: OK (normal)	<0> 0x00 / <00>
[1] [0] B Re Ty; [7:([5] [4] [3]	LDO1 UV Latched gister Name - Fault Latched pe - (RW, Non EEPROM) 6] hot used Buck6 OV Latched Buck5 OV Latched Buck4 OV Latched	LDO1 undervoltage fault latched bit. Write 1' to clear the fault 1 Status 3 Buck6 overvoltage fault latched bit. Write 1' to clear the fault Buck5 overvoltage fault latched bit. Write 1' to clear the fault Buck4 overvoltage fault latched bit. Write 1' to clear the fault	0: OK (normal) 1: undervoltage fault occurs 0: OK (normal) 1: Overvoltage fault occurs 0: OK (normal) 1: Overvoltage fault occurs 0: OK (normal) 1: Overvoltage fault occurs	<0> 0x007 <002 <02 <02 <02 <02 <02
[1] [0] B Re Ty; [7:([5] [4]	LDO1 UV Latched gister Name - Fault Latched pe - (RW, Non EEPROM) 6] hot used Buck6 OV Latched Buck5 OV Latched Buck4 OV Latched Buck3 OV Latched	LDO1 undervoltage fault latched bit. Write 1' to clear the fault 1 Status 3 Buck6 overvoltage fault latched bit. Write 1' to clear the fault Buck5 overvoltage fault latched bit. Write 1' to clear the fault Buck4 overvoltage fault latched bit. Write 1' to clear the fault Buck3 overvoltage fault latched bit. Write 1' to clear the fault Buck3 overvoltage fault latched bit. Write 1' to clear the fault	0: OK (normal) 1: undervoltage fault occurs 0: OK (normal) 1: Overvoltage fault occurs	<0> 0x00 / <00> <0>
[1] [0] B Re Ty; [7:([5] [4] [3]	LDO1 UV Latched gister Name - Fault Latched pe - (RW, Non EEPROM) 6] hot used Buck6 OV Latched Buck5 OV Latched Buck4 OV Latched Buck3 OV Latched Buck2 OV Latched	LDO1 undervoltage fault latched bit. Write 1' to clear the fault 1 Status 3 Buck6 overvoltage fault latched bit. Write 1' to clear the fault Buck5 overvoltage fault latched bit. Write 1' to clear the fault Buck4 overvoltage fault latched bit. Write 1' to clear the fault Buck3 overvoltage fault latched bit. Write 1' to clear the fault Buck3 overvoltage fault latched bit. Write 1' to clear the fault Buck2 overvoltage fault latched bit. Write 1' to clear the fault Buck2 overvoltage fault latched bit. Write 1' to clear the fault	0: OK (normal) 1: undervoltage fault occurs 0: OK (normal) 1: Overvoltage fault occurs 0: OK (normal) 1: Overvoltage fault occurs 0: OK (normal) 1: Overvoltage fault occurs 0: OK (normal)	<0> 0x007 <002 <02 <02 <02 <02 <02



0x5C	-	er Name - Fault Latched	Status 4		0x00 / 0
	Туре - ((RW, Non EEPROM)			
	[7:1]	not used			<0000000
	[0]	Buck1 HC Latched	Buck1 high current warning latched bit. Write '1' to clear the fault	0: OK (normal) 1: High-current fault occurs	<0>
0x5D		r Name - Fault Latched (RW, Non EEPROM)	Status 5		0x01 / 1
	[7:1]	not used			<0000000
	[0]	NVM Read Com- plete	This bit is set to '1' by the device at the end of {READ_EE} if EEPROM values are read into the registers successfully	0: Failed data loading 1: Completed data loading	<1>
0x5E	-	r Name - Fault Latched (RW, Non EEPROM)	Status 6		0x00 / 0
	[7]	PgoodCCBAT Latched	VBAT Pgood latched bit. Write '1' to clear the fault. This bit is edge sensitive.	1: Battery voltage is below its power- good threshold	<0>
	[6]	VREFIN UVLO Latched	VREFIN UVLO fault latched bit. Write '1' to clear the fault.	0: OK (normal) 1: VREFIN UVLO occurs	<0>
	[5]	AVDD UVPD Latched	AVDD undervoltage power down fault atched bit. Write '1' to clear the fault.	0: OK (normal) 1: AVDD UVPD occurs	<0>
	[4]	NVM Error Latched	This bit gets set when any of the following conditions occurs:	0: OK (normal) 1: ECC error detected, insufficient EEPROM voltage or invalid EEPROM data	<0>
	[3]	CRST Triggered	Write '1' to clear this bit which clears the detail bit(s) in 0x83/4/5. CRST Triggered latched bit. Write '1' to	0: OK (normal)	<0>
	[2]	Latched WDT Error Latched	clear the fault WDT Error latched bit. Write '1' to clear the		<0>
	[1]	OTP Latched		1: WDT Error occurs 0: OK (normal)	<0>
	[0]	OTP WARN Latched	1' to clear the fault Over temperature warning latched bit. Write '1' to clear the fault	1: Over temperature fault occurs 0: OK (normal) 1: Over temperature warning occurs	<0>
0x5F		er Name - Fault Live Sta (Read-Only)			0x00 / 0
	[7:6]	not used			<00>
	[5]	Buck6 UV Live	Buck6 undervoltage fault live bit. This bit is automatically cleared when the fault con- dition subsides.	. ,	<0>
	[4]	Buck5 UV Live	Buck5 undervoltage fault live bit. This bit is automatically cleared when the fault con- dition subsides.		<0>
	[3]	Buck4 UV Live	Buck4 undervoltage fault live bit. This bit is automatically cleared when the fault con- dition subsides.		<0>
	[2]	Buck3 UV Live	Buck3 undervoltage fault live bit. This bit is automatically cleared when the fault con- dition subsides.	1: Undervoltage fault occurs	<0>
	[1]	Buck2 UV Live	Buck2 undervoltage fault live bit. This bit is automatically cleared when the fault con- dition subsides.		<0>
	[0]	Buck1 UV Live	Buck1 undervoltage fault live bit. This bit is automatically cleared when the fault con- dition subsides.		<0>



	er Name - Fault Live Sta	atus 2	0x00/0
Туре -	(Read-Only)		
[7:3]	not used		<00000
[2]	LDO3 PGood Live	LDO3 Pgood live bit. This bit is monitored 0: PGood HIGH when the LDO is enabled and disabled. 1: PGood LOW	<0>
[1]	LDO2 PGood Live	LDO2 Pgood live bit. This bit is monitored 0: PGood HIGH	<0>
[0]	LDO1 PGood Live	when the LDO is enabled and disabled. 1: PGood LOW LDO1 Pgood live bit. This bit is monitored 0: PGood HIGH	<0>
_		when the LDO is enabled and disabled. 1: PGood LOW	0.00/0
	er Name - Fault Live Sta (Read-Only)	itus 3	0x00 / (
[7:6]	not used		<00>
[5]	Buck6 OV Live	Buck6 overvoltage fault live bit. This bit is 0: OK (normal) automatically cleared when the fault con- 1: Overvoltage fault occurs	<0>
		dition subsides.	
[4]	Buck5 OV Live	Buck5 overvoltage fault live bit. This bit is 0: OK (normal) automatically cleared when the fault con- dition subsides.	<0>
[3]	Buck4 OV Live	Buck4 overvoltage fault live bit. This bit is 0: OK (normal)	<0>
r~1	DUCKY OV LIVE	automatically cleared when the fault con- dition subsides.	
[2]	Buck3 OV Live	Buck3 overvoltage fault live bit. This bit is 0: OK (normal)	<0>
		automatically cleared when the fault con- 1: Overvoltage fault occurs dition subsides.	
[1]	Buck2 OV Live	Buck2 overvoltage fault live bit. This bit is 0: OK (normal) automatically cleared when the fault con- dition subsides.	<0>
[0]	Buck1 OV Live	Buck1 overvoltage fault live bit. This bit is 0: OK (normal)	<0>
		automatically cleared when the fault con- 1: Overvoltage fault occurs	101
		automatically cleared when the fault con- dition subsides.	
Regist	er Name - Fault Live Sta (Read-Only)	automatically cleared when the fault con- dition subsides.	0x00 / (
Regist Type - [7:1]	er Name - Fault Live Sta	automatically cleared when the fault con- dition subsides. atus 4	0x00 / 0
Regist Type -	er Name - Fault Live Sta (Read-Only)	automatically cleared when the fault con- dition subsides.	0x00 / (
Regist Type - [7:1] [0] Regist	er Name - Fault Live Sta (Read-Only) not used Buck1 HC Live er Name - Fault Live Sta	automatically cleared when the fault condition subsides. 1: Overvoltage fault occurs attus 4 0: OK (normal) Buck1 high current warning live bit. This bit is automatically cleared when the fault condition subsides. 0: OK (normal)	0x00 / 0 <000000 <0>
Regist Type - [7:1] [0] Regist	er Name - Fault Live Sta (Read-Only) not used Buck1 HC Live	automatically cleared when the fault condition subsides. 1: Overvoltage fault occurs attus 4 0: OK (normal) Buck1 high current warning live bit. This bit is automatically cleared when the fault condition subsides. 0: OK (normal)	0x00 / 0 <000000 <0>
Regist Type - [7:1] [0] Regist	er Name - Fault Live Sta (Read-Only) not used Buck1 HC Live er Name - Fault Live Sta	automatically cleared when the fault con- dition subsides. 1: Overvoltage fault occurs automatically cleared when the fault bit is automatically cleared when the fault condition subsides. 0: OK (normal) 1: High-current fault occurs 1: High-current fault occurs VBAT Pgood live bit. This bit is automati- cally cleared when the fault 0: OK (normal)	0x00 / 0 <000000 <0>
Regist Type - [7:1] [0] Regist Type -	er Name - Fault Live Sta (Read-Only) not used Buck1 HC Live er Name - Fault Live Sta (Read-Only)	automatically cleared when the fault con- dition subsides. 1: Overvoltage fault occurs automatically cleared when the fault condition subsides. 0: OK (normal) bit is automatically cleared when the fault condition subsides. 1: High-current fault occurs automatically cleared when the fault condition subsides. 0: OK (normal) automatically cleared when the fault condition subsides. 1: High-current fault occurs automatically cleared when the fault condition subsides. 0: OK (normal) automatically cleared when the fault condition sub-sides. 0: OK (normal) 0: OK (normal) 1: PgoodCCBAT fault occurs o: OK (normal) 0: OK (normal)	0x00 / 0 <000000 <0> 0x00 / 0
Regist Type - [7:1] [0] Regist Type -	er Name - Fault Live Sta (Read-Only) not used Buck1 HC Live er Name - Fault Live Sta (Read-Only) PgoodCCBAT Live	automatically cleared when the fault con- dition subsides. 1: Overvoltage fault occurs automatically cleared when the fault sautomatically cleared when the fault condition subsides. 0: OK (normal) VBAT Pgood live bit. This bit is automati- cally cleared when the fault condition sub- sides. 0: OK (normal) VREFIN UVLO fault live bit. This bit is automatically cleared when the fault con- dition subsides. 0: OK (normal) 1: PgoodCCBAT fault occurs 0: OK (normal) 1: VREFIN UVLO fault live bit. This bit is automatically cleared when the fault con- dition subsides. 0: OK (normal)	0x00 / 0 <000000 <0> 0x00 / 0 <0>
Regist Type - [7:1] [0] Regist Type -	er Name - Fault Live Sta (Read-Only) not used Buck1 HC Live er Name - Fault Live Sta (Read-Only) PgoodCCBAT Live	automatically cleared when the fault condition subsides. 1: Overvoltage fault occurs automatically cleared when the fault condition subsides. 0: OK (normal) Buck1 high current warning live bit. This pit is automatically cleared when the fault condition subsides. 0: OK (normal) bit is automatically cleared when the fault condition subsides. 0: OK (normal) vBAT Pgood live bit. This bit is automati- cally cleared when the fault condition subsides. 0: OK (normal) VREFIN UVLO fault live bit. This bit is automatically cleared when the fault condition subsides. 0: OK (normal) VREFIN UVLO fault live bit. This bit is automatically cleared when the fault condition subsides. 0: OK (normal) AVDD undervoltage power down live bit. 0: OK (normal) This bit is automatically cleared when the 0: OK (normal) 1: VREFIN UVLO occurs 0: OK (normal)	0x00 / 0 <000000 <0> 0x00 / 0 <0>
Regist Type - [7:1] [0] Regist Type - [7] [6]	er Name - Fault Live Sta (Read-Only) not used Buck1 HC Live er Name - Fault Live Sta (Read-Only) PgoodCCBAT Live VREFIN UVLO Live AVDD UVPD Live	automatically cleared when the fault condition subsides. 1: Overvoltage fault occurs automatically cleared when the fault sautomatically cleared when the fault condition subsides. 0: OK (normal) bit is automatically cleared when the fault condition subsides. 0: OK (normal) vBAT Pgood live bit. This bit is automati-cally cleared when the fault condition subsides. 0: OK (normal) vBAT Pgood live bit. This bit is automati-cally cleared when the fault condition subsides. 0: OK (normal) vREFIN UVLO fault live bit. This bit is automatically cleared when the fault condition subsides. 0: OK (normal) vREFIN UVLO fault live bit. This bit is automatically cleared when the fault condition subsides. 0: OK (normal) VREFIN UVLO fault live bit. This bit is automatically cleared when the fault condition-fault condition subsides. 0: OK (normal) VREFIN UVLO fault live bit. This bit is automatically cleared when the fault condition-fault condition subsides. 0: OK (normal) AVDD undervoltage power down live bit. 0: OK (normal)	0x00 / 0 <000000 <0> 0x00 / 0 <0> <0> <0>
Regist Type - [7:1] [0] Regist Type - [7] [6]	er Name - Fault Live Sta (Read-Only) not used Buck1 HC Live er Name - Fault Live Sta (Read-Only) PgoodCCBAT Live VREFIN UVLO Live AVDD UVPD Live not used	automatically cleared when the fault condition subsides. 1: Overvoltage fault occurs automatically cleared when the fault saturation subsides. 0: OK (normal) Buck1 high current warning live bit. This pit is automatically cleared when the fault condition subsides. 0: OK (normal) VBAT Pgood live bit. This bit is automati-condition subsides. 0: OK (normal) VBAT Pgood live bit. This bit is automati-cally cleared when the fault condition subsides. 0: OK (normal) VREFIN UVLO fault live bit. This bit is automatically cleared when the fault condition subsides. 0: OK (normal) VREFIN UVLO fault live bit. This bit is automatically cleared when the fault condition subsides. 0: OK (normal) AVDD undervoltage power down live bit. This bit is automatically cleared when the fault condition subsides. 0: OK (normal) AVDD undervoltage power down live bit. This bit is automatically cleared when the fault condition subsides. 0: OK (normal) 1: AVDD UVPD occurs 1: AVDD UVPD occurs	<pre>0x00 / 0 <0> 0x00 / 0 <0> 0x00 / 0 <0> 0x00 / 0 <0> <0> <0> <0> <0> <0> <0> <0> <0> <0</pre>
Regist Type - [7:1] [0] Regist Type - [7] [6]	er Name - Fault Live Sta (Read-Only) not used Buck1 HC Live er Name - Fault Live Sta (Read-Only) PgoodCCBAT Live VREFIN UVLO Live AVDD UVPD Live not used	automatically cleared when the fault con- dition subsides. 1: Overvoltage fault occurs Buck1 high current warning live bit. This bit is automatically cleared when the fault condition subsides. 0: OK (normal) 1: High-current fault occurs 1: High-current fault occurs VBAT Pgood live bit. This bit is automati- condition subsides. 0: OK (normal) VBAT Pgood live bit. This bit is automati- cally cleared when the fault condition sub- sides. 0: OK (normal) VREFIN UVLO fault live bit. This bit is automatically cleared when the fault con- dition subsides. 0: OK (normal) AVDD undervoltage power down live bit. This bit is automatically cleared when the fault condition subsides. 0: OK (normal) 1: AVDD UVPD occurs 1: AVDD UVPD occurs eCRST Triggered live bit. This bit is auto- matically cleared when the fault condition 0: OK (normal) 1: The FSM is currently transitioning	0x00/0 <000000 <0> 0x00/0 <0> <0> <0>
Regist Type - [7:1] [0] Regist Type - [7] [6]	er Name - Fault Live Sta (Read-Only) not used Buck1 HC Live er Name - Fault Live Sta (Read-Only) PgoodCCBAT Live VREFIN UVLO Live AVDD UVPD Live not used	automatically cleared when the fault con- dition subsides. 1: Overvoltage fault occurs Buck1 high current warning live bit. This bit is automatically cleared when the fault condition subsides. 0: OK (normal) 1: High-current fault occurs 1: High-current fault occurs condition subsides. 0: OK (normal) ttus 6 0: OK (normal) VBAT Pgood live bit. This bit is automati- cally cleared when the fault condition sub- sides. 0: OK (normal) VREFIN UVLO fault live bit. This bit is automatically cleared when the fault con- dition subsides. 0: OK (normal) VREFIN UVLO fault live bit. This bit is automatically cleared when the fault con- dition subsides. 0: OK (normal) VDD undervoltage power down live bit. fault condition subsides. 0: OK (normal) eCRST Triggered live bit. This bit is auto- matically cleared when the fault condition subsides. 0: OK (normal) WDT Error live bit. This bit is automatically cleared when the fault condition subsides. 0: OK (normal) WDT Error live bit. This bit is automatically cleared when the fault condition subsides. 0: OK (normal)	<pre>0x00 / 0 <0> 0x00 / 0 <0> 0x00 / 0 <0> 0x00 / 0 <0> <0> <0> <0> <0> <0> <0> <0> <0> <0</pre>
Regist Type - [7:1] [0] Regist Type - [7] [6] [5] [4] [3] [2]	er Name - Fault Live Sta (Read-Only) not used Buck1 HC Live er Name - Fault Live Sta (Read-Only) PgoodCCBAT Live VREFIN UVLO Live VREFIN UVLO Live AVDD UVPD Live not used CRST Triggered Liv WDT Error Live	automatically cleared when the fault con- dition subsides. 1: Overvoltage fault occurs Buck1 high current warning live bit. This bit is automatically cleared when the fault condition subsides. 0: OK (normal) 1: High-current fault occurs 1: High-current fault occurs vBAT Pgood live bit. This bit is automati- cally cleared when the fault condition sub- sides. 0: OK (normal) VREFIN UVLO fault live bit. This bit is automatically cleared when the fault con- dition subsides. 0: OK (normal) VREFIN UVLO fault live bit. This bit is automatically cleared when the fault con- dition subsides. 0: OK (normal) AVDD undervoltage power down live bit. fault condition subsides. 0: OK (normal) CRST Triggered live bit. This bit is auto- matically cleared when the fault condition subsides. 0: OK (normal) WDT Error live bit. This bit is auto- matically cleared when the fault condition subsides. 0: OK (normal) WDT Error live bit. This bit is auto- matically cleared when the fault condition subsides. 0: OK (normal) WDT Error live bit. This bit is auto- matically cleared when the fault condition subsides. 0: OK (normal) 1: The FSM is currently transitioning be either IORESET or FAULT_OUT 0: OK (normal) 1: The watchdog timer has expired and is not currently counting 0: out currently counting	<pre> 0x00 / 0 </pre> <pre> <pre> </pre> </pre>
Regist Type - [7:1] [0] Regist Type - [7] [6] [5] [4] [3]	er Name - Fault Live Sta (Read-Only) not used Buck1 HC Live er Name - Fault Live Sta (Read-Only) PgoodCCBAT Live VREFIN UVLO Live AVDD UVPD Live not used CRST Triggered Liv	automatically cleared when the fault con- dition subsides. 1: Overvoltage fault occurs sture 4 1: Overvoltage fault occurs Buck1 high current warning live bit. This bit is automatically cleared when the fault condition subsides. 0: OK (normal) 1: High-current fault occurs 1: High-current fault occurs condition subsides. 0: OK (normal) ture 6 1: PgoodCCBAT fault occurs VBAT Pgood live bit. This bit is automati- cally cleared when the fault condition sub- sides. 0: OK (normal) VREFIN UVLO fault live bit. This bit is automatically cleared when the fault con- dition subsides. 0: OK (normal) VDD undervoltage power down live bit. fault condition subsides. 0: OK (normal) eCRST Triggered live bit. This bit is auto- matically cleared when the fault condition subsides. 0: OK (normal) eCRST Triggered live bit. This bit is auto- matically cleared when the fault condition subsides. 0: OK (normal) 0: DT Error live bit. This bit is automatically cleared when the fault condition subsides. 0: OK (normal) 1: The watchdog timer has expired and is not currently counting Over temperature fault live bit. This bit is automatically cleared when the fault con- tion 0: OK (normal) 1: Over temperature fault live bit. This bit is automatically cleared when the fault con- tion 0: OK (normal)	<pre> 0x00 / 0 </pre> <pre> <pre> </pre> </pre>
Regist Type - [7:1] [0] Regist Type - [7] [6] [5] [4] [3] [2]	er Name - Fault Live Sta (Read-Only) not used Buck1 HC Live er Name - Fault Live Sta (Read-Only) PgoodCCBAT Live VREFIN UVLO Live VREFIN UVLO Live AVDD UVPD Live not used CRST Triggered Liv WDT Error Live	automatically cleared when the fault con- dition subsides. 1: Overvoltage fault occurs sture 4 1: Overvoltage fault occurs Buck1 high current warning live bit. This bit is automatically cleared when the fault condition subsides. 0: OK (normal) 1: High-current fault occurs 1: High-current fault occurs condition subsides. 0: OK (normal) ture 6 1: PgoodCCBAT fault occurs VBAT Pgood live bit. This bit is automati- cally cleared when the fault condition sub- sides. 0: OK (normal) VREFIN UVLO fault live bit. This bit is automatically cleared when the fault con- dition subsides. 0: OK (normal) VDD undervoltage power down live bit. This bit is automatically cleared when the fault condition subsides. 0: OK (normal) eCRST Triggered live bit. This bit is auto- matically cleared when the fault condition subsides. 0: OK (normal) 0: OK (normal) 1: The FSM is currently transitioning to either IORESET or FAULT_OUT WDT Error live bit. This bit is automatically cleared when the fault condition subsides. 0: OK (normal) 0: Careed when the fault condition subsides. 0: OK (normal) 0: Leared when the fault condition subsides. 1: The watchdog timer has expired and is not currently counting 0ver temperature fault live bit. This bit is bit is 0: OK (normal)	<pre> 0x00 / 0 </pre> <pre> <pre> </pre> </pre>

-	er Name - nINT Mask ´ (RW, EEPROM)		0x0
[7:6]	not used		<(
[5]	Buck6 UV nINT	Configure INT# pin response to Buck6 UV 0: Unm	J.
	Mask	fault INT# pi 1: Mask pin	undervoltage fault from INT#
[4]	Buck5 UV nINT	Configure INT# pin response to Buck5 UV 0: Unm	
	Mask	fault INT# pi	
		Din I: Mask	undervoltage fault from INT#
[3]	Buck4 UV nINT	Configure INT# pin response to Buck4 UV 0: Unm	ask undervoltage fault from <
	Mask	fault INT# pi	
			undervoltage fault from INT#
		pin	
[2]	Buck3 UV nINT	Configure INT# pin response to Buck3 UV D: Unm	
	Mask	fault INT# pi	undervoltage fault from INT#
		pin	undervoltage laut normin 1#
[1]	Buck2 UV nINT	Configure INT# pin response to Buck2 UV 0: Unm	ask undervoltage fault from <
	Mask	fault INT# pi	-
		1: Mask	undervoltage fault from INT#
		pin	
[0]	Buck1 UV nINT	Configure INT# pin response to Buck1 UV 0: Unm	
	Mask	fault INT# pi	undervoltage fault from INT#
		Din I. Mase	undervoltage laut from in 1#
	er Name - nINT Mask 2 (RW, EEPROM)		0x(
[7:4]	not used		<00
[3]	VIO Pgood nINT	Configure INT# pin response to the loss of 0: Unm	-
	mask	VIO Pgood INT# pi	
			VIO Pgood fault from INT#
[2]	DO3 UV nINT Ma	pin skConfigure INT# pin response to LDO3 UV 0: Unm	ask undervoltage fault from <
L J		fault INT# pin response to EDOS OV 0. Onin fault	
			undervoltage fault from INT#
		pin	ů
[1]	LDO2 UV nINT Ma	skConfigure INT# pin response to LDO2 UV 0: Unm	
		fault INT# pi	
			undervoltage fault from INT#
[0]		pin skConfigure INT# pin response to LDO1 UV 0: Unm	ask undervoltage fault from <
[0]		fault IN I # pin response to LDO1 UV D: Unm fault	-
			undervoltage fault from INT#
		pin	



0	er Name - nINT Mask : (RW, EEPROM)	3		0x00 /
[7:6]	not used			<00>
[5]	Buck6 OV nINT Mask	Configure INT# pin response to Buck6 O∨ fault	′D: Unmask over-voltage fault from INT# pin 1: Mask over-voltage fault from INT# pin	<0>
[4]	Buck5 OV nINT Mask	Configure INT# pin response to Buck5 OV fault	D: Unmask over-voltage fault from INT# pin 1: Mask over-voltage fault from INT# pin	<0>
[3]	Buck4 OV nINT Mask	Configure INT# pin response to Buck4 OV fault	D: Unmask over-voltage fault from INT# pin 1: Mask over-voltage fault from INT# pin	<0>
[2]	Buck3 OV nINT Mask	Configure INT# pin response to Buck3 OV fault	0: Unmask over-voltage fault from INT# pin 1: Mask over-voltage fault from INT# pin	<0>
[1]	Buck2 OV nINT Mask	Configure INT# pin response to Buck2 OV fault	D: Unmask over-voltage fault from INT# pin 1: Mask over-voltage fault from INT# pin	<0>
[0]	Buck1 OV nINT Mask	Configure INT# pin response to Buck1 OV fault	D: Unmask over-voltage fault from INT# pin 1: Mask over-voltage fault from INT# pin	<0>
Type - (er Name - nINT Mask (RW, EEPROM)	4		0x00 / <000000
[7:1] [0]	not used Buck1 HC nINT	Configure INT# response to Buck1 high	0: Upmask bigb ourront fault from	<000000
נטן	Mask	Configure IN I# response to Buck'i high current warning event	0: Unmask high-current fault from INT# pin 1: Mask high-current fault from INT# pin	<0>



Mask VBAT Pgood NT# pin 1 Mask Pgood CCBAT fault from NT# pin 1.0 Mask VREFIN UVLO fault from NT# pin 3) VREFIN UVLO INIT Configure INT# response to VREFIN UVLO fault from fault VREFIN UVLO fault from NT# pin 5) AVDD UVPD NINT Configure INT# response to AVDD UVPD UVD fault from fault VREFIN UVLO fault from NT# pin 6) AVDD UVPD NINT Configure INT# response to AVDD UVPD 5. Unmask VREFIN INT# pin fault VREFIN UVLO fault from NT# pin 4) NVM Error nINT Configure INT# response to RNM Error NM ask 0. Unmask NVM Error from INT# pin in VREFIN UVLO Fault from NT# pin 3) CRST Triggered fault from INT# pin NIT# pin VREFIN UVLO Fault from NIT# pin VREFIN UVLO Fault from NIT# pin VREFIN UVLO Fault from NIT# pin 2) WDT Error nINT Configure INT# response to WDT Error Tom INT# pin 1. Mask WDT Error from INT# pin 1. Mask WDT Error from INT# pin 1. Mask WDT Error from INT# pin 1. Mask VOF Terror INT# pin 1. Mask CVer Temp fault from INT# pin 1. Wask OVEr Temp fault from INT# pin 1. Wask CVer Temp Warning from NT# pin 41 DTP WARN NINT Configure INT# response to DTP warning 5. Unmask OVEr Temp Warning from 1. Wask CVer Temp Warning from 1. Wask CVer Temp Warning from 1. W1# pin 50 DTP WARN NINT Configure the device response to Buck5 UV fault does not shut do		er Name - nINT Mask 6			0x00
Mask VBAT Pgood NT# pin 1 Mask PgoodCCBAT fault from NT# pin 3) VREFIN UVLO nINT Configure INT# response to VREFIN Ummask VREFIN UVLO fault from 5) AVDD UVPD nINT Configure INT# response to AVDU UVD UVDD UVPD fault from 6) AVDD UVPD nINT Configure INT# response to AVDU UVDD UVDD UVPD fault from 6) AVDE Eror nINT Configure INT# response to CRST Trig Dinask VREFIN UVLO fault from 7) Ummask AVDD UVPD fault from INT# pin 41 Mask Configure INT# response to CRST Trig Dinask ORET Triggered fault from 7) Configure INT# response to WDT Error Dinmask WDT Error from INT# pin 10 OTP rINT Mask Configure INT# response to OTP fault Dinmask Over Temp fault from INT# pin 11 OTP WARN NINT Configure INT# response to OTP warmag Dinmask Over Temp Warming from 12 DTP WARN NINT Configure INT# response to OTP warmag Dinmask Over Temp Warming from 13 DUK& UV Disable Configure the devi	I ype -	(KW, EEPROM)			
Mask VBAT Pgood NT# pin 1 Mask PgoodCCBAT fault from NT# pin 3) VREFIN UVLO nINT Configure INT# response to VREFIN Ummask VREFIN UVLO fault from 5) AVDD UVPD nINT Configure INT# response to AVDU UVD UVDD UVPD fault from 6) AVDD UVPD nINT Configure INT# response to AVDU UVDD UVDD UVPD fault from 6) AVDE Eror nINT Configure INT# response to CRST Trig Dinask VREFIN UVLO fault from 7) Ummask AVDD UVPD fault from INT# pin 41 Mask Configure INT# response to CRST Trig Dinask ORET Triggered fault from 7) Configure INT# response to WDT Error Dinmask WDT Error from INT# pin 10 OTP rINT Mask Configure INT# response to OTP fault Dinmask Over Temp fault from INT# pin 11 OTP WARN NINT Configure INT# response to OTP warmag Dinmask Over Temp Warming from 12 DTP WARN NINT Configure INT# response to OTP warmag Dinmask Over Temp Warming from 13 DUK& UV Disable Configure the devi					
1: Mask PgoodCCBAT fault from NT# pin 5) WREFIN UVLO nINT Mask Configure INT# response to VREFIN UVLO fault from NT# pin 5) AVDD UVPD nINT Mask Configure INT# response to AVDD UVPD 2: Unmask AVDD UVPD fault from NT# pin 5) AVDD UVPD nINT Mask Configure INT# response to AVDD UVPD 2: Unmask AVDD UVPD fault from NT# pin 6) AVDD UVPD nINT Mask Configure INT# response to NVM Error D: Unmask AVDD UVPD fault from INT# pin 4) NVM Error nINT Mask Configure INT# response to CRST Trig- D: Unmask CRST Triggered fault from NT# pin 3) CRST friggered nINT Mask Configure INT# response to CRST Trig- D: Unmask VDE Error from INT# pin 4) OTP rINT Mask Configure INT# response to VDT Error D: Unmask VDE Error from INT# pin 7) OTP nINT Mask Configure INT# response to OTP fault Unmask VDE Tror from INT# pin 1) OTP NARN NINT Configure INT# response to OTP warning Unmask Over Temp fault from INT# pin 1) OTP WARN NINT Configure INT# response to OTP warning Unmask Over Temp Warning from NT# pin 2) Mask Configure tint# response to Buck5 D: UV fault does not shut down any rail 3) Buck6 UV Disable Configure the device response to Buck5 D: UV fault does not shut down any r	[7]	PgoodCCBAT nINT	Configure INT# response to the loss of	0: Unmask PgoodCCBAT fault from	<0>
INT# pin INT# pin INT# pin INT# pin 3) VREFIN_UVLO nINT Configure INT# response to VREFIN D. Ummask VREFIN_UVLO fault from NT# pin 5) AVDD UVPD nINT Configure INT# response to AVDD UVPD J. Ummask AVDD UVPD fault from nut 5) AVDD UVPD nINT Configure INT# response to AVDD UVPD J. Ummask AVDE DUVPD fault from not the pin 41 NVM Error nINT Configure INT# response to RNST Trig. 30 CRST Triggered fault nINT Mask Configure INT# response to WDT Error Ummask (VRET right from NIT# pin 41 WDT Error nINT Configure INT# response to OTP fault D. Unmask OVer Temp fault from NIT# pin 51 WDT Error nINT Configure INT# response to OTP fault D. Ummask Over Temp fault from NIT# pin 51 DTP WARN NINT Configure INT# response to OTP warming D. Ummask Over Temp Warming from NIT# pin 52 DTP WARN NINT Configure INT# response to DTP warming D. UV fault does not shut down any revent 53 Buck6 UV Disable Configure the device response to		Mask	VBAT Pgood		
5] WREFIN UVLO nINT Configure INT# response to VREFIN D: Unmask VREFIN UVLO fault from NT# pin 5] AVDD UVPD nINT Configure INT# response to AVDD UVPD D: Unmask AVDD UVPD fault from fault 5] AVDD UVPD nINT Configure INT# response to AVDD UVPD D: Unmask AVDD UVPD fault from fault 4] NVM Error nINT Configure INT# response to NVM Error Mask D: Unmask NVM Error from INT# pin 1: Mask NVM Error from INT# pin 1: Mask CRST Triggered fault from NT# pin 3] CRST friggered Configure INT# response to CRST Trig- promask CRST Triggered fault from 1: Mask CRST Triggered fault from NT# pin 2] WDT Error nINT Configure INT# response to VDT Error D: Unmask VDT Error from INT# pin 1: Mask CRST Triggered fault from NT# pin 1] OTP NINT Mask Configure INT# response to DTP fault D: Unmask VDT Error from INT# pin 1: Mask CVer Temp Warning from NT# pin 1] OTP WARN NINT Configure INT# response to DTP warning 1: Wask CVer Temp Warning from NT# pin 2] Dut sade Configure the device response to Buck5 D: UV fault does not shut down any 1: Wask CVer Temp Warning from NT# pin 3] Buck5 UV Disable Configure the device response to Buck5 D: UV fault does not shut d				1: Mask PgoodCCBAT fault from	
Mask UVLO fault NT# pin 5 AVDD UVPD nINT Configure INT# response to AVDD UVPD Timask AVDD UVPD fault from Mask NVM Error nINT Configure INT# response to NVM Error Configure INT# response to NVM Error 41 NVM Error nINT Configure INT# response to NVM Error Umask NVM Error from INT# pin 33 CRST Triggered Configure INT# response to VDT Error Umask CRST Triggered fault from 41 NVM Error nINT Configure INT# response to VDT Error Ummask CRST Triggered fault from 7 Mask event 1. Mask WDT Error from INT# pin 7 Mask Event 1. Mask WDT Error from INT# pin 11 OTP NINT Mask Configure INT# response to OTP fault D. Unmask Over Temp fault from 12 OTP WARN NINT Configure INT# response to OTP warning D. Ummask Over Temp Warning from 13 Configure INT# response to OTP warning D. Unmask Over Temp Warning from 14 Dot used Configure the device response to Buck5 D. UV fault does not shut down any 76 hot used				INT# pin	
1: Mask VREFIN UVLO fault from NT# pin 1: Mask VREFIN UVLO fault from NT# pin 5] AVDD UVPD nINT Mask Configure INT# response to AVDD UVPD D : Unmask AVDD UVPD fault from I.* Mask AVDD UVPD fault from INT# pin 4] NVM Error nINT Mask Configure INT# response to RNT Fig. : Unmask NVM Error from INT# pin 3] CRST friggered nINT Mask Configure INT# response to CRST Trig. : Unmask CRST friggered fault from INT# pin 2] WDT Error nINT Configure INT# response to OTP fault : Ummask CRST friggered fault from NT# pin 2] WDT Error nINT Configure INT# response to OTP fault : Ummask CRST friggered fault from NT# pin 1] DTP INIT Mask Configure INT# response to OTP fault : Ummask VWD Error from INT# pin 1] OTP WARN NIT Configure INT# response to OTP warming : Ummask VWD Error from INT# pin 1] OTP WARN NIT Configure INT# response to OTP warming : Ummask VWD Error from INT# pin 2] Mask Error from INT# pin 3] Crefigure the device response to Buck D : Ummask VWD Error from INT# pin 4] Buck5	[6]	VREFIN UVLO nINT	Configure INT# response to VREFIN	0: Unmask VREFIN UVLO fault from	<0>
Int# pin Int# pin 5] AVDD UVPD nINT Configure INT# response to AVDD UVPD 3: Unmask AVDD UVPD fault from INT# pin 4] NVM Error nINT Configure INT# response to NVM Error 2: Unmask NVM Error from INT# pin 4] NVM Error nINT Configure INT# response to CRST Trig- 2: Unmask NVM Error from INT# pin 3] CRST Triggered Configure INT# response to CRST Trig- 2: Unmask CRST Triggered fault from INT# pin 4] WDT Error nINT Configure INT# response to WDT Error 1: Mask WDT Error from INT# pin 2] MOT Error nINT Configure INT# response to OTP fault 0: Unmask VDT Error from INT# pin 1] OTP nINT Mask Configure INT# response to OTP warning 0: Unmask VDT Error from INT# pin 1] OTP VWARN nINT Configure INT# response to OTP warning 0: Unmask Over Temp Warning from 1] OTP WARN nINT Configure INT# response to Buck6 D: UV fault does not shut down any 2:6] hot used Configure the device response to Buck6 D: UV fault does not shut down any 3]		Mask	UVLO fault	INT# pin	
5] AVDD UVPD NINT Mask Configure INT# response to AVDD UVPD f: Umask AVDD UVPD fault from ault <				1: Mask VREFIN UVLO fault from	
Mask ault INT# pin 1 Mask ault I: Mask AVDUVPD fault from INT# pin 41 NVM Error niNT Configure INT# response to NVM Error D: Unmask NVM Error from INT# pin 31 CRST Triggered Configure INT# response to CRST Trig D: Unmask CRST Triggered fault from INT# pin 32 CMST Error nINT Configure INT# response to WDT Error D: Unmask WDT Error from INT# pin 41 Mask event D: Unmask VDT Error from INT# pin 42 WDT Error nINT Configure INT# response to WDT Error D: Unmask Over Temp fault from INT# pin 43 Configure INT# response to OTP fault D: Unmask Over Temp fault from INT# pin 44 OTP nINT Mask Configure INT# response to OTP warning f: Umask Over Temp Varning from 45 Pin Configure INT# response to OTP warning f: Umask Over Temp Warning from 46 OTP WARN NINT Configure INT# response to OTP warning f: Umask Over Temp Warning from 47.6] hot used Configure the device response to Buck6 D: UV fault does not shut down any 48 Buck6 UV Disable <td></td> <td></td> <td></td> <td>INT# pin</td> <td></td>				INT# pin	
Mask ault INT# pin 1 Mask ault I: Mask AVDUVPD fault from INT# pin 41 NVM Error niNT Configure INT# response to NVM Error D: Unmask NVM Error from INT# pin 31 CRST Triggered Configure INT# response to CRST Trig D: Unmask CRST Triggered fault from INT# pin 32 CMST Error nINT Configure INT# response to WDT Error D: Unmask WDT Error from INT# pin 41 Mask event D: Unmask VDT Error from INT# pin 42 WDT Error nINT Configure INT# response to WDT Error D: Unmask Over Temp fault from INT# pin 43 Configure INT# response to OTP fault D: Unmask Over Temp fault from INT# pin 44 OTP nINT Mask Configure INT# response to OTP warning f: Umask Over Temp Varning from 45 Pin Configure INT# response to OTP warning f: Umask Over Temp Warning from 46 OTP WARN NINT Configure INT# response to OTP warning f: Umask Over Temp Warning from 47.6] hot used Configure the device response to Buck6 D: UV fault does not shut down any 48 Buck6 UV Disable <td>[5]</td> <td>AVDD UVPD nINT</td> <td>Configure INT# response to AVDD UVPD</td> <td>0: Unmask AVDD UVPD fault from</td> <td><0></td>	[5]	AVDD UVPD nINT	Configure INT# response to AVDD UVPD	0: Unmask AVDD UVPD fault from	<0>
Image: space of the s			÷ .		
4] NVM Error nINT Configure INT# response to NVM Error D: Unmask WVM Error from INT# pin <1				1: Mask AVDD UVPD fault from INT#	
4] NVM Error nINT Configure INT# response to NVM Error D: Unmask WVM Error from INT# pin <1					
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1] LDO2 UV Disable Configure the device response to LDO2 0: UV fault does not shut down any rail <	[5] [4] [3] [2] [1] [0] Registe Type -	Buck6 UV Disable Buck5 UV Disable Buck4 UV Disable Buck3 UV Disable Buck2 UV Disable Buck1 UV Disable Buck1 UV Disable er Name - Fault Config 2 (RW, EEPROM)	UV fault Configure the device response to Buck5 UV fault Configure the device response to Buck4 UV fault Configure the device response to Buck3 UV fault Configure the device response to Buck2 UV fault Configure the device response to Buck1 UV fault Configure the device response to Buck1 UV fault	rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault shuts down all the rails 0: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails	<1> <1> <1> <1> <1> <1> <1> 0x07 <0000
UV fault rail 1: UV fault shuts down all the rails 0] LDO1 UV Disable Configure the device response to LDO1 0: UV fault does not shut down any view of ault UV fault rail	[5] [4] [3] [2] [1] [0] Type - [7:3]	Buck6 UV Disable Buck5 UV Disable Buck4 UV Disable Buck3 UV Disable Buck2 UV Disable Buck1 UV Disable Buck1 UV Disable er Name - Fault Config 2 (RW, EEPROM)	UV fault Configure the device response to Buck5 UV fault Configure the device response to Buck4 UV fault Configure the device response to Buck3 UV fault Configure the device response to Buck2 UV fault Configure the device response to Buck1 UV fault Configure the device response to Buck1 UV fault	rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails	<1> <1> <1> <1> <1> <1> <1> 0x07 <0000
1: UV fault shuts down all the rails 0] LDO1 UV Disable Configure the device response to LDO1 0: UV fault does not shut down any <*	[5] [4] [3] [2] [1] [0] [7] [7:3] [2]	Buck6 UV Disable Buck5 UV Disable Buck4 UV Disable Buck3 UV Disable Buck2 UV Disable Buck1 UV Disable Buck1 UV Disable er Name - Fault Config 2 (RW, EEPROM) hot used LDO3 UV Disable	UV fault Configure the device response to Buck5 UV fault Configure the device response to Buck4 UV fault Configure the device response to Buck3 UV fault Configure the device response to Buck2 UV fault Configure the device response to Buck1 UV fault Configure the device response to Buck1 UV fault	rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault shuts down all the rails 0: UV fault shuts down all the rails 0: UV fault shuts down all the rails 1: UV fault shuts down all the rails 1: UV fault shuts down all the rails 1: UV fault shuts down all the rails	<1> <1> <1> <1> <1> <1> <1> <1> 0x07 <0x007 <1>
0] LDO1 UV Disable Configure the device response to LDO1 0: UV fault does not shut down any < UV fault rail	[5] [4] [3] [2] [1] [0] Type - [7:3]	Buck6 UV Disable Buck5 UV Disable Buck4 UV Disable Buck3 UV Disable Buck2 UV Disable Buck1 UV Disable Buck1 UV Disable er Name - Fault Config 2 (RW, EEPROM) hot used LDO3 UV Disable	UV fault Configure the device response to Buck5 UV fault Configure the device response to Buck4 UV fault Configure the device response to Buck3 UV fault Configure the device response to Buck2 UV fault Configure the device response to Buck1 UV fault Configure the device response to LDO3 UV fault Configure the device response to LDO3 UV fault	rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail	<1> <1> <1> <1> <1> <1> <1> <1> 0x07 <0x007 <1>
UV fault rail	[5] [4] [3] [2] [1] [0] [7] [7:3] [2]	Buck6 UV Disable Buck5 UV Disable Buck4 UV Disable Buck3 UV Disable Buck2 UV Disable Buck1 UV Disable Buck1 UV Disable er Name - Fault Config 2 (RW, EEPROM) hot used LDO3 UV Disable	UV fault Configure the device response to Buck5 UV fault Configure the device response to Buck4 UV fault Configure the device response to Buck3 UV fault Configure the device response to Buck2 UV fault Configure the device response to Buck1 UV fault Configure the device response to LDO3 UV fault Configure the device response to LDO3 UV fault	rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail	<1> <1> <1> <1> <1> <1> <1> 0x07 <0000
	[5] [4] [3] [2] [1] [0] Regista Type - [7:3] [2] [1]	Buck6 UV Disable Buck5 UV Disable Buck4 UV Disable Buck3 UV Disable Buck2 UV Disable Buck1 UV Disable Buck1 UV Disable er Name - Fault Config 2 (RW, EEPROM) not used LDO3 UV Disable LDO2 UV Disable	UV fault Configure the device response to Buck5 UV fault Configure the device response to Buck4 UV fault Configure the device response to Buck3 UV fault Configure the device response to Buck2 UV fault Configure the device response to Buck1 UV fault Configure the device response to LDO3 UV fault Configure the device response to LDO3 UV fault	rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 1: UV fault shuts down all the rails 1: UV fault shuts down all the rails 1: UV fault does not shut down any rail 1: UV fault shuts down all the rails 1: UV fault shuts down all the rails 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail the rails	<1> <1> <1> <1> <1> <1> <1> 0x07 <0x007 <1> <1>
	[5] [4] [3] [2] [1] [0] [7] [7:3] [2]	Buck6 UV Disable Buck5 UV Disable Buck4 UV Disable Buck3 UV Disable Buck2 UV Disable Buck1 UV Disable Buck1 UV Disable er Name - Fault Config 2 (RW, EEPROM) not used LDO3 UV Disable LDO2 UV Disable	UV fault Configure the device response to Buck5 UV fault Configure the device response to Buck4 UV fault Configure the device response to Buck3 UV fault Configure the device response to Buck2 UV fault Configure the device response to Buck1 UV fault Configure the device response to LDO3 UV fault Configure the device response to LDO3 UV fault Configure the device response to LDO2 UV fault	rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault shuts down all the rails 1: UV fault does not shut down any rail 1: UV fault shuts down all the rails 1: UV fault does not shut down any rail 1: UV fault shuts down all the rails 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail	<1> <1> <1> <1> <1> <1> <1> <1> 0x07 <0x007 <1>
	[5] [4] [3] [2] [1] [0] Regista Type - [7:3] [2] [1]	Buck6 UV Disable Buck5 UV Disable Buck4 UV Disable Buck3 UV Disable Buck2 UV Disable Buck1 UV Disable Buck1 UV Disable er Name - Fault Config 2 (RW, EEPROM) not used LDO3 UV Disable LDO2 UV Disable	UV fault Configure the device response to Buck5 UV fault Configure the device response to Buck4 UV fault Configure the device response to Buck3 UV fault Configure the device response to Buck2 UV fault Configure the device response to Buck1 UV fault Configure the device response to LDO3 UV fault Configure the device response to LDO3 UV fault Configure the device response to LDO2 UV fault	rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault shuts down all the rails 0: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail 1: UV fault shuts down all the rails 1: UV fault does not shut down any rail 1: UV fault does not shut down any rail	<1> <1> <1> <1> <1> <1> <1> 0x07 <0x007 <1> <1>



Type -	er Name - Fault Config 3 (RW, EEPROM)			0x7F / 12
i ype -				
[7]	not used			<0>
[6]	VREFIN UVLO Dis- Configure the device response to VREFIN D: VREFIN UVLO fault does not shut			
[0]	able	UVLO fault	down any rail 1: VREFIN UVLO fault shuts down all the rails	<1>
[5]	Buck6 OV Disable	Configure the device response to Buck6 OV fault	0: OV fault does not shut down any rail 1: OV fault shuts down all the rails	<1>
[4]	Buck5 OV Disable	Configure the device response to Buck5 OV fault	 OV fault does not shut down any rail OV fault shuts down all the rails 	<1>
[3]	Buck4 OV Disable	Configure the device response to Buck4 OV fault	 OV fault does not shut down any rail OV fault shuts down all the rails 	<1>
[2]	Buck3 OV Disable	Configure the device response to Buck3 OV fault	 OV fault does not shut down any rail OV fault shuts down all the rails 	<1>
[1]	Buck2 OV Disable	Configure the device response to Buck2 OV fault	 OV fault does not shut down any rail OV fault shuts down all the rails 	<1>
[0]	Buck1 OV Disable	Configure the device response to Buck1 OV fault	0: OV fault does not shut down any rail 1: OV fault shuts down all the rails	<1>
	er Name - Block EN (RW, EEPROM)			0x00 / (
[7]	SLEEP State EN	Configure the device to enter {SLEEP}. This bit is not EEPROM backed	0: Exit SLEEP state 1: Enter SLEEP state	<0>
[6]	RTC EN	Enable the RTC. This bit is battery backed		<0>
[5]	CC Charger EN	Enable the coin cell battery charger. This bit is not EEPROM backed	0: Disabled 1: Enabled	<0>
[4]	CCBAT COMP EN	Enable the VBAT comparator	0: Disabled 1: Enabled	<0>
[3]	WD EN	Enable the watchdog timer	0: Disabled 1: Enabled	<0>
[2]	WD PD EN	Enable the power-down feature when the watchdog timer expires	0: Disabled 1: Enabled	<0>
[1]	WD RST EN	Enable the reset feature when the watch- dog timer expires	0: Disabled 1: Enabled	<0>
[0]	CRST Fault EN	Enable the power-down feature when the CRST_IN# is asserted	0: Disabled 1: Enabled	<0>
0	er Name - Software Res (RW, Non EEPROM)	et		0x00 /
[7:2]	not used			<000000
[1]	Warm Reset	Configure the device to do a warm reset	0: Normal 1: Warm reset	<0>
[0] x6E Registe	Cold Reset	Configure the device to do a cold reset	0: Normal 1: Cold reset	<0>
	er Name - I2C Trigger P (RW, Non EEPROM)			0xA8 / 16
[7:0]	I2C Trigger Power Off key	Read-only. But when a data is written to this register,		<1010100



51	r Name - Config 1 (RW, EEPROM)			0xFB / 251
[7]	Charge Current	Set the charge current level of the coin cell		<1>
0.51	Level	battery charger when it is enabled	1: 60µA	-111>
[6:5]	Thermal Warning	Set the thermal warning temperature ris-	00: 105C	<11>
	Threshold	ing threshold	01: 110C	
			10: 115C 11: 120C	
[4.2]	Buckt Lligh Current	Set the buckt high ourrent worning thread		<11>
[4:3]	Threshold	Set the buck1 high current warning thresh	00. 4A 01: 5A	<112
	Threshold	old	10: 5.5A	
10.41			11:6A	10.41
[2:1]	AVDD UVPD Config	Set the AVDD Under Voltage Power Down		<01>
		falling threshold	01: 2.7V	
			10: 3.0V	
101	DWDONLO (11: 4.25V	
[0]	PWRON Config	Set the PWRON configuration	0: On/off switch	<1>
	er Name - Config 2		1: Long push button	0xF8 / 248
[7:4]	VCCBAT	Set the coin cell battery termination volt- age	4'b0000 - 4'b1111: 1.8V + 0.1V*VCCBAT[3:0]	<1111>
[3:2]	reserved	aye	0.1V VCCBAT[5.0]	<10>
<u>[]</u>	10001104			
[1.0]	PWRON Hold Perio	dSet the period in which the PWRON needs	00·1s	<00>
[1:0]	PWRON Hold Perio	dSet the period in which the PWRON needs		<00>
[1:0]	PWRON Hold Perio	to stay high/low when it is configured as	01: 1.5s	<00>
[1:0]	PWRON Hold Perio		01: 1.5s 10: 2s	<00>
		to stay high/low when it is configured as	01: 1.5s	
Registe	PWRON Hold Perio er Name - Config 3 (RW, EEPROM)	to stay high/low when it is configured as	01: 1.5s 10: 2s	<00> 0x17 / 23
Registe Type - ([7:5]	er Name - Config 3	to stay high/low when it is configured as	01: 1.5s 10: 2s	
Registe Type - (er Name - Config 3 (RW, EEPROM)	to stay high/low when it is configured as long push button Set the timeout period in which VIO_P-	01: 1.5s 10: 2s	0x17/23
Registe Type - ([7:5]	er Name - Config 3 (RW, EEPROM) not used	to stay high/low when it is configured as long push button	01: 1.5s 10: 2s 11: 3s	0x17/23 <000>
Registe Type - ([7:5]	er Name - Config 3 (RW, EEPROM) not used	to stay high/low when it is configured as long push button Set the timeout period in which VIO_P-	01: 1.5s 10: 2s 11: 3s 00: Indefinite 01: 0.5ms	0x17/23 <000>
Registe Type - ([7:5]	er Name - Config 3 (RW, EEPROM) not used	to stay high/low when it is configured as long push button Set the timeout period in which VIO_P- good is monitored. If VIO_Pgood is	01: 1.5s 10: 2s 11: 3s 00: Indefinite 01: 0.5ms 10: 1ms	0x17/23 <000>
Registe Type - ([7:5]	er Name - Config 3 (RW, EEPROM) not used	to stay high/low when it is configured as ong push button Set the timeout period in which VIO_P- good is monitored. If VIO_Pgood is asserted before the timer expires, then the	01: 1.5s 10: 2s 11: 3s 00: Indefinite 01: 0.5ms 10: 1ms 11: 2ms	0x17/23 <000>
Registe Type - ([7:5]	er Name - Config 3 (RW, EEPROM) not used	Set the timeout period in which VIO_P- good is monitored. If VIO_Pgood is asserted before the timer expires, then the FSM transitions to {STANDBY} before the	01: 1.5s 10: 2s 11: 3s 00: Indefinite 01: 0.5ms 10: 1ms 11: 2ms	0x17/23 <000>
Registe Type - ([7:5]	er Name - Config 3 (RW, EEPROM) not used	Set the timeout period in which VIO_P- good is monitored. If VIO_Pgood is asserted before the timer expires, then the FSM transitions to {STANDBY} before the end of the timeout period. If VIO_Pgood is not	01: 1.5s 10: 2s 11: 3s 00: Indefinite 01: 0.5ms 10: 1ms 11: 2ms	0x17/23 <000>
Registe Type - ([7:5]	er Name - Config 3 (RW, EEPROM) not used	Set the timeout period in which VIO_P- good is monitored. If VIO_Pgood is asserted before the timer expires, then the FSM transitions to {STANDBY} before the end of the timeout period. If VIO_Pgood is not asserted when the timer expires, then the	01: 1.5s 10: 2s 11: 3s 00: Indefinite 01: 0.5ms 10: 1ms 11: 2ms	0x17/23 <000>
Registe Type - ([7:5]	er Name - Config 3 (RW, EEPROM) not used	Set the timeout period in which VIO_P- good is monitored. If VIO_Pgood is asserted before the timer expires, then the FSM transitions to {STANDBY} before the end of the timeout period. If VIO_Pgood is not	01: 1.5s 10: 2s 11: 3s 00: Indefinite 01: 0.5ms 10: 1ms 11: 2ms	0x17/23 <000>
Registe Type - ([7:5] [4:3]	er Name - Config 3 (RW, EEPROM) hot used VIO Timeout	Set the timeout period in which VIO_P- good is monitored. If VIO_Pgood is asserted before the timer expires, then the FSM transitions to {STANDBY} before the end of the timeout period. If VIO_Pgood is not asserted when the timer expires, then the FSM transitions to {FAULT_OUT}.	01: 1.5s 10: 2s 11: 3s 00: Indefinite 01: 0.5ms 10: 1ms 11: 2ms 0: No delay	0x17 / 23 <000> <10>
Registe Type - ([7:5] [4:3]	er Name - Config 3 (RW, EEPROM) hot used VIO Timeout	Set the timeout period in which VIO_P- good is monitored. If VIO_Pgood is asserted before the timer expires, then the FSM transitions to {STANDBY} before the end of the timeout period. If VIO_Pgood is not asserted when the timer expires, then the FSM transitions to {FAULT_OUT}. Set the time delay from the completion of	01: 1.5s 10: 2s 11: 3s 00: Indefinite 01: 0.5ms 10: 1ms 11: 2ms 0: No delay	0x17 / 23 <000> <10>
Registe Type - ([7:5] [4:3]	er Name - Config 3 (RW, EEPROM) hot used VIO Timeout	Set the timeout period in which VIO_P- good is monitored. If VIO_Pgood is asserted before the timer expires, then the FSM transitions to {STANDBY} before the end of the timeout period. If VIO_Pgood is not asserted when the timer expires, then the FSM transitions to {FAULT_OUT}. Set the time delay from the completion of power-off sequence to the start of power-	01: 1.5s 10: 2s 11: 3s 00: Indefinite 01: 0.5ms 10: 1ms 11: 2ms 0: No delay 1: 15ms	0x17 / 23 <000> <10>
Registe Type - ([7:5] [4:3]	er Name - Config 3 (RW, EEPROM) hot used VIO Timeout	Set the timeout period in which VIO_P- good is monitored. If VIO_Pgood is asserted before the timer expires, then the FSM transitions to {STANDBY} before the end of the timeout period. If VIO_Pgood is not asserted when the timer expires, then the FSM transitions to {FAULT_OUT}. Set the time delay from the completion of power-off sequence to the start of power-	01: 1.5s 10: 2s 11: 3s 00: Indefinite 01: 0.5ms 10: 1ms 11: 2ms 0: No delay 1: 15ms 2: 31ms 3: 63ms	0x17 / 23 <000> <10>
Registe Type - ([7:5] [4:3]	er Name - Config 3 (RW, EEPROM) hot used VIO Timeout	Set the timeout period in which VIO_P- good is monitored. If VIO_Pgood is asserted before the timer expires, then the FSM transitions to {STANDBY} before the end of the timeout period. If VIO_Pgood is not asserted when the timer expires, then the FSM transitions to {FAULT_OUT}. Set the time delay from the completion of power-off sequence to the start of power-	01: 1.5s 10: 2s 11: 3s 00: Indefinite 01: 0.5ms 10: 1ms 11: 2ms 0: No delay 1: 15ms 2: 31ms 3: 63ms 4: 95ms	0x17 / 23 <000> <10>
Registe Type - ([7:5] [4:3]	er Name - Config 3 (RW, EEPROM) hot used VIO Timeout	Set the timeout period in which VIO_P- good is monitored. If VIO_Pgood is asserted before the timer expires, then the FSM transitions to {STANDBY} before the end of the timeout period. If VIO_Pgood is not asserted when the timer expires, then the FSM transitions to {FAULT_OUT}. Set the time delay from the completion of power-off sequence to the start of power-	01: 1.5s 10: 2s 11: 3s 00: Indefinite 01: 0.5ms 10: 1ms 11: 2ms 0: No delay 1: 15ms 2: 31ms 3: 63ms	0x17 / 23 <000> <10>



	er Name - MPIO0 Powe (RW, EEPROM)	er On		0x46
i ypc				
[7]	not used			<(
[6:0]	MPIO0 Power On	Delay timed from the beginning of power-	Bits[6:0] decodes:	<1000
	Delay	on sequence. The alternative function of bits[3:0] is to select which regulator is used for the PGood when MPIO0 is con- figured as PGood output. Refer to the set- tings for details	Alternative decodes of bits[3:0]: 0000: Buck1 0001: Buck2 0010: Buck3	
			0011: Buck4 0100: Buck5 0101: Buck6 0110: LDO1 0111: LDO2 1000: LDO3 1001: VTTREF 1010: AND of all regulators PGood	
	er Name - MPIO0 Powe (RW, EEPROM)	er Off		0x0
[7]	not used			<
[6:0]	MPIO0 Power Off	Delay timed from the beginning of power-	0: 0ms	<000
[0.0]	Delay	off sequence	1: 1ms 	
-	er Name - MPIO1 Powe	er On	127: 127ms	0x14
Type -	(RW, EEPROM)	er On	127: 127ms	
-		Pelay timed from the beginning of power-		<
Type - ((RW, EEPROM)		Bits[6:0] decodes: 0: 0ms 1: 1ms 127: 127ms Alternative decodes of bits[3:0]: 0000: Buck1 0001: Buck2 0010: Buck3 0011: Buck4 0100: Buck5 0101: Buck6 0110: LDO1 0111: LDO2 1000: LDO3 1001: VTTREF	<(
Type - ([7] [6:0]	(RW, EEPROM) not used MPIO1 Power On	Delay timed from the beginning of power- on sequence. The alternative function of bits[3:0] is to select which regulator is used for the PGood when MPIO1 is con- figured as PGood output. Refer to the set- tings for details	Bits[6:0] decodes: 0: 0ms 1: 1ms 127: 127ms Alternative decodes of bits[3:0]: 0000: Buck1 0001: Buck2 0010: Buck3 0011: Buck4 0100: Buck5 0101: Buck6 0110: LDO1 0111: LDO2 1000: LDO3	<001
Type - ([7] [6:0]	(RW, EEPROM) hot used MPIO1 Power On Delay	Delay timed from the beginning of power- on sequence. The alternative function of bits[3:0] is to select which regulator is used for the PGood when MPIO1 is con- figured as PGood output. Refer to the set- tings for details	Bits[6:0] decodes: 0: 0ms 1: 1ms 127: 127ms Alternative decodes of bits[3:0]: 0000: Buck1 0001: Buck2 0010: Buck3 0011: Buck4 0100: Buck5 0101: Buck6 0110: LDO1 0111: LDO2 1000: LDO3 1001: VTTREF	<001
Type - ([7] [6:0] Registe Type - ((RW, EEPROM) hot used MPIO1 Power On Delay Pelay er Name - MPIO1 Powe	Delay timed from the beginning of power- on sequence. The alternative function of bits[3:0] is to select which regulator is used for the PGood when MPIO1 is con- figured as PGood output. Refer to the set- tings for details	Bits[6:0] decodes: 0: 0ms 1: 1ms 127: 127ms Alternative decodes of bits[3:0]: 0000: Buck1 0001: Buck2 0010: Buck3 0011: Buck4 0100: Buck5 0101: Buck6 0110: LDO1 0111: LDO2 1000: LDO3 1001: VTTREF	<0010
Type - ([7] [6:0]	(RW, EEPROM) not used MPI01 Power On Delay	Delay timed from the beginning of power- on sequence. The alternative function of bits[3:0] is to select which regulator is used for the PGood when MPIO1 is con- figured as PGood output. Refer to the set- tings for details	Bits[6:0] decodes: 0: 0ms 1: 1ms 127: 127ms Alternative decodes of bits[3:0]: 0000: Buck1 0001: Buck2 0010: Buck3 0011: Buck4 0100: Buck5 0101: Buck6 0110: LDO1 0111: LDO2 1000: LDO3 1001: VTTREF	0x14 <() <0010
Type - ([7] [6:0] Registe Type - ((RW, EEPROM) not used MPIO1 Power On Delay r Name - MPIO1 Power (RW, EEPROM) hot used	Delay timed from the beginning of power- on sequence. The alternative function of bits[3:0] is to select which regulator is used for the PGood when MPIO1 is con- figured as PGood output. Refer to the set- tings for details	Bits[6:0] decodes: 0: 0ms 1: 1ms 127: 127ms Alternative decodes of bits[3:0]: 0000: Buck1 0001: Buck2 0010: Buck3 0011: Buck4 0100: Buck5 0101: Buck6 0110: LDO1 0111: LDO2 1000: LDO3 1001: VTTREF 1010: AND of all regulators PGood	< <001

•	r Name - MPIO2 Powe RW, EEPROM)	er On		0x04 / 4
[7]	not used			<0>
[6:0]	MPIO2 Power On Delay	Delay timed from the beginning of power- on sequence. The alternative function of bits[3:0] is to select which regulator is used for the PGood when MPIO2 is con- figured as PGood output. Refer to the set- tings for details	0: 0ms 1: 1ms 127: 127ms Alternative decodes of bits[3:0]: 0000: Buck1 0001: Buck2 0010: Buck3 0011: Buck4 0100: Buck5 0101: Buck6 0110: LDO1 0111: LDO2 1000: LDO3	<0000100
			1001: VTTREF 1010: AND of all regulators PGood	
	r Name - MPIO2 Powe RW, EEPROM)	er Off		0x00 / 0
[7] [6:0]	not used MPIO2 Power Off	Delay timed from the beginning of power-		<0> <0000000
	Delay r Name - MPIO3 Powe	off sequence. The alternative function of bits[2:0] is to set the frequency when MPIO2 is configured as 32K_CLK. Refer to the settings for details	0: 0ms 1: 1ms 1: 1ms 1: 27: 127ms Alternative decodes of bits[2:0]: 000: 32.768kHz 001: 16.384kHz 010: 8.192kHz 011: 4.096kHz 100: 2.048kHz 100: 2.048kHz 101: 1.024kHz 110: 512Hz 111: 256Hz	0x00 / 0
	RW, EEPROM)			0,000,0
[7]	not used			<0>
[6:0]	MPIO3 Power On Delay	Delay timed from the beginning of power- on sequence. The alternative function of bits[3:0] is to select which regulator is used for the PGood when MPIO3 is con- figured as PGood output. Refer to the set- tings for details	Bits[6:0] decodes: 0: 0ms 1: 1ms 127: 127ms Alternative decodes of bits[3:0]: 0000: Buck1 0001: Buck2 0010: Buck3 0011: Buck4 0100: Buck5 0101: Buck6 0110: LDO1	<0000000



	er Name - MPIO3 Powe (RW, EEPROM)	er Off		0x00 /
- - -	(,,			
7]	not used			<0>
6:0]	MPIO3 Power Off	Delay timed from the beginning of power-	0: 0ms	<00000
	Delay	off sequence	1: 1ms	
			 127: 127ms	
Registe	er Name - MPIO4 Powe	er On	127. 1271115	0x00 /
	(RW, EEPROM)			
7]	not used			<0>
6:0]	MPIO4 Power On	Delay timed from the beginning of power-	Bits[6:0] decodes:	<00000
	Delay	on sequence. The alternative function of	0: 0ms	
		bits[3:0] is to select which regulator is	1: 1ms	
		used for the PGood when MPIO4 is con-		
		figured as PGood output. Refer to the set		
		tings for details	Alternative decodes of bits[3:0]:	
			0000: Buck1	
			0001: Buck2 0010: Buck3	
			0010. Buck3 0011: Buck4	
			0100: Buck5	
			0101: Buck6	
			0110: LDO1	
			0111: LDO2	
			1000: LDO3	
			1000: LDO3	
-	er Name - MPIO4 Powe (RW, EEPROM)	er Off	1000: LDO3 1001: VTTREF	0x00 /
Гуре -	(RW, EEPROM)	er Off	1000: LDO3 1001: VTTREF	
Гуре - 7]	(RW, EEPROM)		1000: LDO3 1001: VTTREF 1010: AND of all regulators PGood	<0>
Гуре -	(RW, EEPROM) hot used MPIO4 Power Off	Delay timed from the beginning of power-	1000: LDO3 1001: VTTREF 1010: AND of all regulators PGood Bits[6:0] decodes:	<0>
Гуре - 7]	(RW, EEPROM)	Delay timed from the beginning of power- off sequence. The alternative function of	1000: LDO3 1001: VTTREF 1010: AND of all regulators PGood Bits[6:0] decodes: 0: 0ms	<0>
Гуре - 7]	(RW, EEPROM) hot used MPIO4 Power Off	Delay timed from the beginning of power- off sequence. The alternative function of bits[3:0] is used to set the timeout period	1000: LDO3 1001: VTTREF 1010: AND of all regulators PGood Bits[6:0] decodes:	<0>
Гуре - 7]	(RW, EEPROM) hot used MPIO4 Power Off	Delay timed from the beginning of power- off sequence. The alternative function of bits[3:0] is used to set the timeout period when MPIO4 is configured as Watchdog	1000: LDO3 1001: VTTREF 1010: AND of all regulators PGood Bits[6:0] decodes: 0: 0ms 1: 1ms 	<0>
Гуре - 7]	(RW, EEPROM) hot used MPIO4 Power Off	Delay timed from the beginning of power- off sequence. The alternative function of bits[3:0] is used to set the timeout period when MPIO4 is configured as Watchdog Timer Reset. Refer to the settings for	1000: LDO3 1001: VTTREF 1010: AND of all regulators PGood Bits[6:0] decodes: 0: 0ms 1: 1ms 127: 127ms	<0>
Гуре - 7]	(RW, EEPROM) hot used MPIO4 Power Off	Delay timed from the beginning of power- off sequence. The alternative function of bits[3:0] is used to set the timeout period when MPIO4 is configured as Watchdog	1000: LDO3 1001: VTTREF 1010: AND of all regulators PGood Bits[6:0] decodes: 0: 0ms 1: 1ms 127: 127ms Alternative decodes of bits[3:0]:	<0>
Гуре - 7]	(RW, EEPROM) hot used MPIO4 Power Off	Delay timed from the beginning of power- off sequence. The alternative function of bits[3:0] is used to set the timeout period when MPIO4 is configured as Watchdog Timer Reset. Refer to the settings for	1000: LDO3 1001: VTTREF 1010: AND of all regulators PGood Bits[6:0] decodes: 0: 0ms 1: 1ms 127: 127ms	<0>
Гуре - 7]	(RW, EEPROM) hot used MPIO4 Power Off	Delay timed from the beginning of power- off sequence. The alternative function of bits[3:0] is used to set the timeout period when MPIO4 is configured as Watchdog Timer Reset. Refer to the settings for	1000: LDO3 1001: VTTREF 1010: AND of all regulators PGood Bits[6:0] decodes: 0: 0ms 1: 1ms 127: 127ms Alternative decodes of bits[3:0]: 0000: 1ms	<0>
Гуре - 7]	(RW, EEPROM) hot used MPIO4 Power Off	Delay timed from the beginning of power- off sequence. The alternative function of bits[3:0] is used to set the timeout period when MPIO4 is configured as Watchdog Timer Reset. Refer to the settings for	1000: LDO3 1001: VTTREF 1010: AND of all regulators PGood Bits[6:0] decodes: 0: 0ms 1: 1ms 127: 127ms Alternative decodes of bits[3:0]: 0000: 1ms 0001: 2ms 0010: 4ms 0011: 8ms	<0>
Гуре - 7]	(RW, EEPROM) hot used MPIO4 Power Off	Delay timed from the beginning of power- off sequence. The alternative function of bits[3:0] is used to set the timeout period when MPIO4 is configured as Watchdog Timer Reset. Refer to the settings for	1000: LDO3 1001: VTTREF 1010: AND of all regulators PGood Bits[6:0] decodes: 0: 0ms 1: 1ms 127: 127ms Alternative decodes of bits[3:0]: 0000: 1ms 0001: 2ms 0010: 4ms 0011: 8ms 0100: 16ms	<0>
Гуре - 7]	(RW, EEPROM) hot used MPIO4 Power Off	Delay timed from the beginning of power- off sequence. The alternative function of bits[3:0] is used to set the timeout period when MPIO4 is configured as Watchdog Timer Reset. Refer to the settings for	1000: LDO3 1001: VTTREF 1010: AND of all regulators PGood Bits[6:0] decodes: 0: 0ms 1: 1ms 127: 127ms Alternative decodes of bits[3:0]: 0000: 1ms 0001: 2ms 0010: 4ms 0011: 8ms 0100: 16ms 0101: 32ms	<0>
Гуре - 7]	(RW, EEPROM) hot used MPIO4 Power Off	Delay timed from the beginning of power- off sequence. The alternative function of bits[3:0] is used to set the timeout period when MPIO4 is configured as Watchdog Timer Reset. Refer to the settings for	1000: LDO3 1001: VTTREF 1010: AND of all regulators PGood Bits[6:0] decodes: 0: 0ms 1: 1ms 127: 127ms Alternative decodes of bits[3:0]: 0000: 1ms 0000: 1ms 0001: 2ms 0010: 4ms 0011: 8ms 0100: 16ms 0101: 32ms 0110: 64ms	<0>
Гуре - 7]	(RW, EEPROM) hot used MPIO4 Power Off	Delay timed from the beginning of power- off sequence. The alternative function of bits[3:0] is used to set the timeout period when MPIO4 is configured as Watchdog Timer Reset. Refer to the settings for	1000: LDO3 1001: VTTREF 1010: AND of all regulators PGood Bits[6:0] decodes: 0: 0ms 1: 1ms 127: 127ms Alternative decodes of bits[3:0]: 0000: 1ms 0000: 1ms 0001: 2ms 0010: 4ms 0011: 8ms 0100: 16ms 0101: 32ms 0110: 64ms 0111: 128ms	<0>
Гуре - 7]	(RW, EEPROM) hot used MPIO4 Power Off	Delay timed from the beginning of power- off sequence. The alternative function of bits[3:0] is used to set the timeout period when MPIO4 is configured as Watchdog Timer Reset. Refer to the settings for	1000: LDO3 1001: VTTREF 1010: AND of all regulators PGood Bits[6:0] decodes: 0: 0ms 1: 1ms 127: 127ms Alternative decodes of bits[3:0]: 0000: 1ms 0000: 1ms 0001: 2ms 0010: 4ms 0011: 8ms 0100: 16ms 0101: 32ms 0110: 64ms 0111: 128ms 1000: 256ms	<0>
Гуре - 7]	(RW, EEPROM) hot used MPIO4 Power Off	Delay timed from the beginning of power- off sequence. The alternative function of bits[3:0] is used to set the timeout period when MPIO4 is configured as Watchdog Timer Reset. Refer to the settings for	1000: LDO3 1001: VTTREF 1010: AND of all regulators PGood Bits[6:0] decodes: 0: 0ms 1: 1ms 127: 127ms Alternative decodes of bits[3:0]: 0000: 1ms 0000: 1ms 0001: 2ms 0010: 4ms 0011: 8ms 0100: 16ms 0101: 32ms 0110: 64ms 0111: 128ms 1000: 256ms 1001: 512ms	<0>
Гуре - 7]	(RW, EEPROM) hot used MPIO4 Power Off	Delay timed from the beginning of power- off sequence. The alternative function of bits[3:0] is used to set the timeout period when MPIO4 is configured as Watchdog Timer Reset. Refer to the settings for	1000: LDO3 1001: VTTREF 1010: AND of all regulators PGood Bits[6:0] decodes: 0: 0ms 1: 1ms 127: 127ms Alternative decodes of bits[3:0]: 0000: 1ms 0000: 1ms 0001: 2ms 0010: 4ms 0011: 8ms 0100: 16ms 0101: 32ms 0110: 64ms 0111: 128ms 1000: 256ms 1001: 512ms 1010: 1.024s	<0>
Гуре - 7]	(RW, EEPROM) hot used MPIO4 Power Off	Delay timed from the beginning of power- off sequence. The alternative function of bits[3:0] is used to set the timeout period when MPIO4 is configured as Watchdog Timer Reset. Refer to the settings for	1000: LDO3 1001: VTTREF 1010: AND of all regulators PGood Bits[6:0] decodes: 0: 0ms 1: 1ms 127: 127ms Alternative decodes of bits[3:0]: 0000: 1ms 0000: 1ms 0001: 2ms 0010: 4ms 0011: 8ms 0100: 16ms 0101: 32ms 0110: 64ms 0111: 128ms 1000: 256ms 1001: 512ms 1010: 1.024s 1011: 2.048s	<0>
Гуре - 7]	(RW, EEPROM) hot used MPIO4 Power Off	Delay timed from the beginning of power- off sequence. The alternative function of bits[3:0] is used to set the timeout period when MPIO4 is configured as Watchdog Timer Reset. Refer to the settings for	1000: LDO3 1001: VTTREF 1010: AND of all regulators PGood Bits[6:0] decodes: 0: 0ms 1: 1ms 127: 127ms Alternative decodes of bits[3:0]: 0000: 1ms 0000: 1ms 0001: 2ms 0010: 4ms 0011: 8ms 0100: 16ms 0110: 16ms 0111: 32ms 0110: 64ms 0111: 128ms 1000: 256ms 1001: 512ms 1001: 512ms 1010: 1.024s 1011: 2.048s 1100: 4.096s	<0>
Гуре - 7]	(RW, EEPROM) hot used MPIO4 Power Off	Delay timed from the beginning of power- off sequence. The alternative function of bits[3:0] is used to set the timeout period when MPIO4 is configured as Watchdog Timer Reset. Refer to the settings for	1000: LDO3 1001: VTTREF 1010: AND of all regulators PGood Bits[6:0] decodes: 0: 0ms 1: 1ms 127: 127ms Alternative decodes of bits[3:0]: 0000: 1ms 0000: 1ms 0001: 2ms 0010: 4ms 0011: 8ms 0100: 16ms 0101: 32ms 0110: 64ms 0111: 128ms 1000: 256ms 1001: 512ms 1010: 1.024s 1011: 2.048s	0x00 / <0>



C Regist	(RW, EEPROM)			0x00 / 0
51				
[7]	not used			<0>
[6:0]	MPIO5 Power On	Delay timed from the beginning of power-	Bits[6:0] decodes	<0000000
[0.0]	Delay	on sequence. The alternative function of	0: 0ms	-0000000
		bits[3:0] is used to select which regulator is used for the PGood when MPIO5 is con-		
		figured as PGood output. Refer to the set-		
		tings for details	Alternative decodes of bits[3:0]:	
			0000: Buck1	
			0001: Buck2	
			0010: Buck3	
			0011: Buck4	
			0100: Buck5	
			0101: Buck6	
			0110: LDO1	
			0111: LDO2	
			1000: LDO3	
			1001: VTTREF	
			1010: AND of all regulators PGood	
D Regist			1010. AND OF all regulators F Good	0.00.10
5	er Name - MPIO5 Powe (RW, EEPROM)			0x00 / 0
[7]	not used			<0>
[6:0]	MPIO5 Power Off	Delay timed from the beginning of power-	0: 0ms	<0000000
[0.0]			1: 1ms	-0000000
	Dolov			
	Delay	off sequence	1. 1115	
	Delay	off sequence		
-	Delay er Name - MPIO Input : (Read-Only)		1. mis 127: 127ms	0x00 / 0
Type -	er Name - MPIO Input : (Read-Only)			0x00 / 0
Type - [7:6]	er Name - MPIO Input : (Read-Only) not used	Status	 127: 127ms	<00>
Type -	er Name - MPIO Input : (Read-Only)		 127: 127ms 0: Low	
Type - [7:6] [5]	er Name - MPIO Input : (Read-Only) not used	Status	 127: 127ms 0: Low 1: High	<00>
Type - [7:6]	er Name - MPIO Input : (Read-Only) not used MPIO5 Status	Status Read back the live status of MPIO5	 127: 127ms 0: Low 1: High 0: Low	<00>
Type - [7:6] [5] [4]	rer Name - MPIO Input : (Read-Only) not used MPIO5 Status MPIO4 Status	Status Read back the live status of MPIO5 Read back the live status of MPIO4	 127: 127ms 0: Low 1: High 0: Low 1: High	<00>
Type - [7:6] [5]	er Name - MPIO Input : (Read-Only) not used MPIO5 Status	Status Read back the live status of MPIO5	 127: 127ms 0: Low 1: High 0: Low 1: High 0: Low 0: Low	<00> <0> <0>
Type - [7:6] [5] [4] [3]	not used MPIO5 Status MPIO4 Status MPIO3 Status	Status Read back the live status of MPIO5 Read back the live status of MPIO4 Read back the live status of MPIO3	 127: 127ms 0: Low 1: High 0: Low 1: High 0: Low 1: High 1: High	<00> <0> <0> <0> <0>
Type - [7:6] [5] [4]	rer Name - MPIO Input : (Read-Only) not used MPIO5 Status MPIO4 Status	Status Read back the live status of MPIO5 Read back the live status of MPIO4	 127: 127ms 0: Low 1: High 0: Low 1: High 0: Low 1: High 0: Low 1: High 0: Low	<00> <0> <0>
Type - [7:6] [5] [4] [3] [2]	not used MPIO5 Status MPIO3 Status MPIO3 Status MPIO2 Status	Status Read back the live status of MPIO5 Read back the live status of MPIO4 Read back the live status of MPIO3 Read back the live status of MPIO2	 127: 127ms 0: Low 1: High 0: Low 1: High 0: Low 1: High 0: Low 1: High 0: Low 1: High	<00> <0> <0> <0> <0> <0>
Type - [7:6] [5] [4] [3]	not used MPIO5 Status MPIO4 Status MPIO3 Status	Status Read back the live status of MPIO5 Read back the live status of MPIO4 Read back the live status of MPIO3	 127: 127ms 0: Low 1: High 0: Low 1: High 0: Low 1: High 0: Low 1: High 0: Low 1: High 0: Low	<00> <0> <0> <0> <0>
Type - [7:6] [5] [4] [3] [2] [1]	rer Name - MPIO Input (Read-Only) not used MPIO5 Status MPIO4 Status MPIO3 Status MPIO2 Status MPIO2 Status	Status Read back the live status of MPIO5 Read back the live status of MPIO4 Read back the live status of MPIO3 Read back the live status of MPIO2 Read back the live status of MPIO1	 127: 127ms 0: Low 1: High 0: Low 1: High 0: Low 1: High 0: Low 1: High 0: Low 1: High 0: Low 1: High	<00> <0> <0> <0> <0> <0> <0> <0>
Type - [7:6] [5] [4] [3] [2]	not used MPIO5 Status MPIO3 Status MPIO3 Status MPIO2 Status	Status Read back the live status of MPIO5 Read back the live status of MPIO4 Read back the live status of MPIO3 Read back the live status of MPIO2	 127: 127ms 0: Low 1: High 0: Low 1: High 0: Low 1: High 0: Low 1: High 0: Low 1: High 0: Low 1: High 0: Low	<00> <0> <0> <0> <0> <0>
Type - [7:6] [5] [4] [3] [2] [1] [0]	er Name - MPIO Input : (Read-Only) not used MPIO5 Status MPIO4 Status MPIO3 Status MPIO2 Status MPIO1 Status MPIO1 Status MPIO1 Status	Status Read back the live status of MPIO5 Read back the live status of MPIO4 Read back the live status of MPIO3 Read back the live status of MPIO2 Read back the live status of MPIO1 Read back the live status of MPIO1	 127: 127ms 0: Low 1: High 0: Low 1: High 0: Low 1: High 0: Low 1: High 0: Low 1: High 0: Low 1: High	<00> <0> <0> <0> <0> <0> <0> <0> <0>
Type - [7:6] [5] [4] [3] [2] [1] [0] F Regist	rer Name - MPIO Input (Read-Only) not used MPIO5 Status MPIO4 Status MPIO3 Status MPIO2 Status MPIO2 Status	Status Read back the live status of MPIO5 Read back the live status of MPIO4 Read back the live status of MPIO3 Read back the live status of MPIO2 Read back the live status of MPIO1 Read back the live status of MPIO1	 127: 127ms 0: Low 1: High 0: Low 1: High 0: Low 1: High 0: Low 1: High 0: Low 1: High 0: Low 1: High 0: Low	<00> <0> <0> <0> <0> <0> <0> <0> <0>
Type - [7:6] [5] [4] [3] [2] [1] [0] F Regist	er Name - MPIO Input : (Read-Only) not used MPIO5 Status MPIO4 Status MPIO3 Status MPIO2 Status MPIO1 Status MPIO1 Status MPIO0 Status er Name - MPIO I2C O	Status Read back the live status of MPIO5 Read back the live status of MPIO4 Read back the live status of MPIO3 Read back the live status of MPIO2 Read back the live status of MPIO1 Read back the live status of MPIO1	 127: 127ms 0: Low 1: High 0: Low 1: High 0: Low 1: High 0: Low 1: High 0: Low 1: High 0: Low 1: High 0: Low	<00> <0> <0> <0> <0> <0> <0> <0>
Type - [7:6] [5] [4] [3] [2] [1] [0] F Regist Type - [7:6]	er Name - MPIO Input : (Read-Only) not used MPIO5 Status MPIO3 Status MPIO3 Status MPIO2 Status MPIO1 Status MPIO1 Status er Name - MPIO I2C O (RW, Non EEPROM)	Read back the live status of MPIO5 Read back the live status of MPIO4 Read back the live status of MPIO3 Read back the live status of MPIO2 Read back the live status of MPIO1 Read back the live status of MPIO1 utput	 127: 127ms 0: Low 1: High 0: Low 1: High 0: Low 1: High 0: Low 1: High 0: Low 1: High 0: Low 1: High 0: Low 1: High	<00> <0> <0> <0> <0> <0> <0> <0> <0> <0>
Type - [7:6] [5] [4] [3] [2] [1] [0] Type -	er Name - MPIO Input : (Read-Only) not used MPIO5 Status MPIO4 Status MPIO3 Status MPIO2 Status MPIO1 Status MPIO1 Status MPIO0 Status er Name - MPIO I2C O (RW, Non EEPROM)	Status Read back the live status of MPIO5 Read back the live status of MPIO4 Read back the live status of MPIO3 Read back the live status of MPIO2 Read back the live status of MPIO1 Set the status of MPIO5 when its function	 127: 127ms 0: Low 1: High 0: Low	<00> <0> <0> <0> <0> <0> <0> <0> <0> <0>
Type - [7:6] [5] [4] [3] [2] [1] [0] F Regist Type - [7:6]	er Name - MPIO Input : (Read-Only) not used MPIO5 Status MPIO3 Status MPIO3 Status MPIO2 Status MPIO1 Status MPIO1 Status er Name - MPIO I2C O (RW, Non EEPROM)	Status Read back the live status of MPIO5 Read back the live status of MPIO4 Read back the live status of MPIO3 Read back the live status of MPIO2 Read back the live status of MPIO1 Set the status of MPIO5 when its function is set to "Output from I2C output" Set the status of MPIO4 when its function	0: Low 1: High 0: Low	<00> <0> <0> <0> <0> <0> <0> <0> <0> <0>
Type - [7:6] [5] [4] [3] [2] [1] [0] F Regist Type - [7:6] [5]	er Name - MPIO Input : (Read-Only) not used MPIO5 Status MPIO3 Status MPIO2 Status MPIO1 Status MPIO1 Status MPIO0 Status er Name - MPIO I2C O (RW, Non EEPROM) not used MPIO5 I2C Output MPIO4 I2C Output	Read back the live status of MPIO5 Read back the live status of MPIO4 Read back the live status of MPIO3 Read back the live status of MPIO2 Read back the live status of MPIO1 Set the status of MPIO5 when its function is set to "Output from I2C output" Set the status of MPIO4 when its function is set to "Output from I2C output"	0: Low 1: High 0: Low 1: High 1: High 1: High 1: High 1: High 1: High 1: High 1: High 1: High 1: High	<00> <0> <0> <0> <0> <0> <0> <0> <0> <0>
Type - [7:6] [5] [4] [3] [2] [1] [0] F Regist Type - [7:6] [5]	er Name - MPIO Input : (Read-Only) not used MPIO5 Status MPIO3 Status MPIO2 Status MPIO1 Status MPIO1 Status MPIO0 Status er Name - MPIO I2C O (RW, Non EEPROM) not used MPIO5 I2C Output	Read back the live status of MPIO5 Read back the live status of MPIO4 Read back the live status of MPIO3 Read back the live status of MPIO2 Read back the live status of MPIO1 Set the status of MPIO5 when its function is set to "Output from I2C output" Set the status of MPIO4 when its function is set to "Output from I2C output"	0: Low 1: High 0: Low 1: High 1: High 1: High 1: High 1: High 1: High 1: High 1: High 1: High 1: High	<00> <0> <0> <0> <0> <0> <0> <0> <0> <0>
Type - [7:6] [5] [4] [3] [2] [1] [0] [7:6] [5] [4]	er Name - MPIO Input : (Read-Only) not used MPIO5 Status MPIO3 Status MPIO2 Status MPIO1 Status MPIO1 Status MPIO0 Status er Name - MPIO I2C O (RW, Non EEPROM) not used MPIO5 I2C Output MPIO4 I2C Output	Read back the live status of MPIO5 Read back the live status of MPIO4 Read back the live status of MPIO3 Read back the live status of MPIO2 Read back the live status of MPIO1 Set the status of MPIO5 when its function is set to "Output from I2C output" Set the status of MPIO4 when its function is set to "Output from I2C output"	0: Low 1: High 0: Low 1: High 1: High 1: High 1: High 1: High 1: High 1: High 1: High 1: High 1: High	<00> <0> <0> <0> <0> <0> <0> <0> <0> <0>
Type - [7:6] [5] [4] [3] [2] [1] [0] [7:6] [5] [4] [3]	er Name - MPIO Input : (Read-Only) not used MPIO5 Status MPIO3 Status MPIO2 Status MPIO1 Status MPIO1 Status MPIO0 Status er Name - MPIO I2C O (RW, Non EEPROM) not used MPIO5 I2C Output MPIO4 I2C Output	Read back the live status of MPIO5 Read back the live status of MPIO4 Read back the live status of MPIO3 Read back the live status of MPIO2 Read back the live status of MPIO2 Read back the live status of MPIO1 Set the status of MPIO5 when its function is set to "Output from I2C output" Set the status of MPIO3 when its function is set to "Output from I2C output" Set the status of MPIO3 when its function is set to "Output from I2C output"	0: Low 1: High 0: Set low 1: Set high 0: Set low 1: Set high 0: Set low	<00> <0> <0> <0> <0> <0> <0> <0> <0> <0>
Type - [7:6] [5] [4] [3] [2] [1] [0] [7:6] [5] [4]	er Name - MPIO Input : (Read-Only) not used MPIO5 Status MPIO3 Status MPIO2 Status MPIO1 Status MPIO1 Status MPIO0 Status er Name - MPIO I2C O (RW, Non EEPROM) not used MPIO5 I2C Output MPIO3 I2C Output	Read back the live status of MPIO5 Read back the live status of MPIO4 Read back the live status of MPIO3 Read back the live status of MPIO2 Read back the live status of MPIO2 Read back the live status of MPIO1 Set the status of MPIO5 when its function is set to "Output from I2C output" Set the status of MPIO3 when its function is set to "Output from I2C output" Set the status of MPIO3 when its function is set to "Output from I2C output" Set the status of MPIO3 when its function is set to "Output from I2C output" Set the status of MPIO3 when its function is set to "Output from I2C output"	127: 127ms 127: 127ms 0: Low 1: High 0: Low 1: Set high 0: Set low	<pre><0> <0> <0> <0> <0> <0> <0> <0> <0> <0></pre>
Type - [7:6] [5] [4] [3] [2] [1] [0] [7] [7] [7:6] [5] [4] [3] [2]	er Name - MPIO Input : (Read-Only) not used MPIO5 Status MPIO3 Status MPIO2 Status MPIO1 Status MPIO1 Status MPIO0 Status er Name - MPIO I2C O (RW, Non EEPROM) not used MPIO5 I2C Output MPIO3 I2C Output MPIO2 I2C Output	Status Read back the live status of MPIO5 Read back the live status of MPIO4 Read back the live status of MPIO3 Read back the live status of MPIO2 Read back the live status of MPIO2 Read back the live status of MPIO1 Set the status of MPIO5 when its function is set to "Output from I2C output" Set the status of MPIO3 when its function is set to "Output from I2C output" Set the status of MPIO3 when its function is set to "Output from I2C output" Set the status of MPIO2 when its function is set to "Output from I2C output" Set the status of MPIO2 when its function is set to "Output from I2C output"	127: 127ms 127: 127ms 0: Low 1: High 0: Low 1: Set high 0: Set low 1: Set high	<00> <0> <0> <0> <0> <0> <0> <0> <0> <0>
Type - [7:6] [5] [4] [3] [2] [1] [0] [7:6] [5] [4] [3]	er Name - MPIO Input : (Read-Only) not used MPIO5 Status MPIO3 Status MPIO2 Status MPIO1 Status MPIO1 Status MPIO0 Status er Name - MPIO I2C O (RW, Non EEPROM) not used MPIO5 I2C Output MPIO3 I2C Output	Status Read back the live status of MPIO5 Read back the live status of MPIO4 Read back the live status of MPIO3 Read back the live status of MPIO2 Read back the live status of MPIO2 Read back the live status of MPIO1 Set the status of MPIO5 when its function is set to "Output from I2C output" Set the status of MPIO3 when its function is set to "Output from I2C output" Set the status of MPIO3 when its function is set to "Output from I2C output" Set the status of MPIO2 when its function is set to "Output from I2C output" Set the status of MPIO2 when its function is set to "Output from I2C output" Set the status of MPIO2 when its function is set to "Output from I2C output" Set the status of MPIO2 when its function is set to "Output from I2C output" Set the status of MPIO2 when its function is set to "Output from I2C output"	127: 127ms 127: 127ms 0: Low 1: High 0: Low 1: Set high 0: Set low	<00> <0> <0> <0> <0> <0> <0> <0> <0> <0>
Type - [7:6] [5] [4] [3] [2] [1] [0] [7] [7] [7:6] [5] [4] [3] [2]	er Name - MPIO Input : (Read-Only) not used MPIO5 Status MPIO3 Status MPIO2 Status MPIO1 Status MPIO1 Status MPIO0 Status er Name - MPIO I2C O (RW, Non EEPROM) not used MPIO5 I2C Output MPIO3 I2C Output MPIO2 I2C Output	Status Read back the live status of MPIO5 Read back the live status of MPIO4 Read back the live status of MPIO3 Read back the live status of MPIO2 Read back the live status of MPIO1 Set the status of MPIO5 when its function is set to "Output from I2C output" Set the status of MPIO3 when its function is set to "Output from I2C output" Set the status of MPIO2 when its function is set to "Output from I2C output" Set the status of MPIO2 when its function is set to "Output from I2C output" Set the status of MPIO2 when its function is set to "Output from I2C output" Set the status of MPIO2 when its function is set to "Output from I2C output" Set the status of MPIO2 when its function is set to "Output from I2C output" Set the status of MPIO1 when its function is set to "Output from I2C output"	127: 127ms 0: Low 1: High 0: Low 1: Set high 0: Set low 1: Set high	<00> <0> <0> <0> <0> <0> <0> <0> <0> <0>



-	r Name - MPIO Assert RW, EEPROM)	on		0x3
[7:6]	not used			<
[5]	MPIO5 Assertion	Configure the MPIO5 operation during	0: A reset output will NOT be	<
[-]		transition between {ACTIVE} and {SLEEP}		
			will NOT be de-asserted) in SLEEP	
		VR EN output	state	
			1: A reset output will be asserted (or	
			an external VR enable be de-	
			asserted) in SLEEP state	
[4]	MPIO4 Assertion	Configure the MPIO4 operation during	D: A reset output will NOT be	
[7]		transition between {ACTIVE} and {SLEEP}		
			will NOT be de-asserted) in SLEEP	
		VR EN output	state	
			1: A reset output will be asserted (or	
			an external VR enable be de-	
[3]	MPIO3 Assertion	Configure the MPIO3 operation during	asserted) in SLEEP state	
[3]	WIFIOS ASSELLION		0: A reset output will NOT be	
		transition between {ACTIVE} and {SLEEP}		
			will NOT be de-asserted) in SLEEP	
		VR EN output	state	
			1: A reset output will be asserted (or	
			an external VR enable be de-	
101			asserted) in SLEEP state	
[2]	MPIO2 Assertion		0: A reset output will NOT be	
		transition between {ACTIVE} and {SLEEP}		
			will NOT be de-asserted) in SLEEP	
		VR EN output	state	
			1: A reset output will be asserted (or	
			an external VR enable be de-	
			asserted) in SLEEP state	
[1]	MPIO1 Assertion	Configure the MPIO1 operation during	0: A reset output will NOT be	
		transition between {ACTIVE} and {SLEEP}		
			will NOT be de-asserted) in SLEEP	
		VR EN output	state	
			1: A reset output will be asserted (or	
			an external VR enable be de-	
[0]		Configure the MDIOC exercise during	asserted) in SLEEP state	
[0]	MPIO0 Assertion	Configure the MPIO0 operation during	0: A reset output will NOT be	
		transition between {ACTIVE} and {SLEEP}		
		when it is set to reset output or Enternal	will NOT be de-asserted) in SLEEP	
		VR EN output	state	
			1: A reset output will be asserted (or	
			an external VR enable be de-	
Pogiata	r Name - Input Pin Sta		asserted) in SLEEP state	0>
-	Read-Only)	103		07
.,,,,, (
[7:5]	not used			<
[4]	VPROG Status	Read back the live status of VPROG	0: Low	
			1: High	
[3]	LDO2VSEL Status	Read back the live status of LDO2VSEL	0: Low	
L~]			1: High	
[2]	LDO1VSEL Status	Read back the live status of LDO1VSEL	0: Low	
[4]				
[1]	PWRON Status	Read back the live status of PWRON	1: High	
		Read Dack the live status of PWRON	0: Low	
ניו			1. Liah	
[0]	CEN Status	Read back the live status of CEN	1: High 0: Low	

7:61 hot used 7:61 hot used 7:61 buck8 Mode Read back the operation status of buck8 D: PFM 1 Buck8 Mode Read back the operation status of buck8 D: PFM 131 Buck4 Mode Read back the operation status of buck3 D: PFM 121 Buck3 Mode Read back the operation status of buck3 D: PFM 111 Buck1 Mode Read back the operation status of buck2 D: PFM 111 Buck1 Mode Read back the operation status of buck1 D: PFM 111 Buck1 Mode Read back the operation status of buck1 D: PFM 112 Buck1 Mode Read back the operation status of buck2 D: PFM 113 Buck1 Mode Read back the operation status of buck2 D: PFM 114 Type - (RW, Non EEPROM) D: Bank7 ECC OK (normal) D: Bank7 ECC OK (normal) 7 EE Bank6 ECC Cor- Cleared by writing '1' to 0x5E(4) NVM D: Bank7 ECC OK (normal) 1 Fer Dank5 ECC Cor- Cleared by writing '1' to 0x5E(4) NVM D: Bank4 ECC Corrected flag 13 Feted Error bit D: Bank2 ECC OK (normal) 1 Eank2 ECC Cor- Cleared by	0x00		ode	ster Name - Report Buck N e - (Read-Only)	
5] Buck6 Mode Read back the operation status of buck6 D: PFM 4] Buck5 Mode Read back the operation status of buck3 D: PFM 3] Buck4 Mode Read back the operation status of buck3 D: PFM 4] Buck3 Mode Read back the operation status of buck3 D: PFM 7] Buck1 Mode Read back the operation status of buck3 D: PFM 11] Buck1 Mode Read back the operation status of buck3 D: PFM 11] Buck1 Mode Read back the operation status of buck3 D: PFM 11] Buck1 Mode Read back the operation status of buck3 D: PFM 11] Buck1 Mode Read back the operation status of buck3 D: PFM 11] Buck1 Mode Read back the operation status of buck3 D: PFM 11] Buck1 Mode Read back the operation status of buck3 D: PFM 12 Repister Name - ECC Detail 1 Type - (RW, Non EEPROM) D: Bank1 ECC COK (normal) 17 rected Error bit D: Bank1 ECC COK (normal) Earls ECC Cor- Cleared by writing '1' to 0x5E[4] NVM D: Bank1 ECC COK (normal) 16 EBank3 ECC Cor- Cleared by writing '1' to 0x5E[4] NVM <th></th> <th></th> <th></th> <th>e - (Read-Offiy)</th> <th>i ype -</th>				e - (Read-Offiy)	i ype -
I: PWM 41 Buck5 Mode Read back the operation status of buck5 D: PFM 33 Buck4 Mode Read back the operation status of buck4 D: PFM 34 Buck3 Mode Read back the operation status of buck3 D: PFM 37 Buck4 Mode Read back the operation status of buck3 D: PFM 37 Buck2 Mode Read back the operation status of buck2 D: PFM 38 Register Name - ECC Detail 1 D: PFM D: PFM 39 Buck1 Mode Read back the operation status of buck1 D: PFM 41 Type - (RW, Non EEPROM) D: Bank7 ECC OK (normal) D: Bank7 ECC Cor- Cleared by writing '1' to 0x5E[4] NVM D: Bank7 ECC Cor (normal) 71 EE Bank8 ECC Cor- Cleared by writing '1' to 0x5E[4] NVM D: Bank6 ECC Cor (normal) D: Bank6 ECC Cor (normal) 72 FE Bank5 ECC Cor- Cleared by writing '1' to 0x5E[4] NVM D: Bank4 ECC Cor (normal) D: Bank4 ECC Cor (normal) 73 FedBank4 ECC Cor- Cleared by writing '1' to 0x5E[4] NVM D: Bank1 ECC COr (normal) D: Bank4 ECC Cor (normal) 74 EE Bank5 ECC Cor- Cleared by writing '1' to 0x5E[4] NVM D: Bank1 ECC COK (normal)	<00			not used	[7:6]
4) Buck5 Mode Read back the operation status of buck5 D: PFM 3) Buck4 Mode Read back the operation status of buck4 D: PFM 2) Buck3 Mode Read back the operation status of buck3 D: PFM 1) Buck2 Mode Read back the operation status of buck2 D: PFM 1) Buck1 Mode Read back the operation status of buck1 D: PFM 3) Buck1 Mode Read back the operation status of buck1 D: PFM 1) Buck1 Mode Read back the operation status of buck1 D: PFM 3) Register Name - ECC Detail 1 Type - (RW, Non EEPROM) D: Bank7 ECC COK (normal) 7) EE Bank6 ECC Cor- Cleared by writing '1' to 0x5E[4] NVM D: Bank7 ECC COK (normal) rected 6) EE Bank5 ECC Cor- Cleared by writing '1' to 0x5E[4] NVM D: Bank5 ECC Cor (normal) rected flag 7) EE Bank5 ECC Cor- Cleared by writing '1' to 0x5E[4] NVM D: Bank5 ECC Cor (normal) rected flag 8) EE Bank2 ECC Cor- Cleared by writing '1' to 0x5E[4] NVM D: Bank5 ECC Cor (normal) rected flag 9) EE Bank2 ECC Cor- Cleared by writing '1' to 0x5E[4] NVM D: Bank4 ECC Cor (normal) rected flag <td< td=""><td><0</td><td></td><td>Read back the operation status of buck6</td><td>Buck6 Mode</td><td>[5]</td></td<>	<0		Read back the operation status of buck6	Buck6 Mode	[5]
3] Buck4 Mode Read back the operation status of buck4 D. PFM 2] Buck3 Mode Read back the operation status of buck3 D. PFM 1] Buck2 Mode Read back the operation status of buck3 D. PFM 1] Buck1 Mode Read back the operation status of buck1 D. PFM 1] Buck1 Mode Read back the operation status of buck1 D. PFM 1] Buck1 Mode Read back the operation status of buck1 D. PFM 1] Buck1 Mode Read back the operation status of buck1 D. PFM 1] Buck1 Mode Read back the operation status of buck1 D. PFM 1] Buck1 Mode Read back the operation status of buck3 D. PFM 1] EE Bank5 CC C Cor- Cleared by writing '1' to 0x5E[4] NVM D. Bank5 ECC OK (normal) 1: Bank5 ECC Cor- Cleared flag 1] EE Bank4 ECC Cor- Cleared by writing '1' to 0x5E[4] NVM D. Bank5 ECC OK (normal) 1: Bank4 ECC Orrected flag 2] EE Bank5 ECC Cor- Cleared by writing '1' to 0x5E[4] NVM D. Bank5 ECC OK (normal) 1: Bank3 ECC OK (normal) 1 rected Error bit 1: Bank2 ECC OK (normal)	<0	0: PFM	Read back the operation status of buck5	Buck5 Mode	[4]
2] Buck3 Mode Read back the operation status of buck3 D. PFM 1] Buck2 Mode Read back the operation status of buck2 D. PFM 1] Buck1 Mode Read back the operation status of buck1 D. PFM 1] Buck1 Mode Read back the operation status of buck1 D. PFM 1] Buck1 Mode Read back the operation status of buck1 D. PFM 1] Buck1 Mode Read back the operation status of buck1 D. PFM 1] Buck3 Mode Read back the operation status of buck2 D. PFM 1] Buck3 Mode Read back the operation status of buck1 D. PFM 1] Buck3 Mode Read back the operation status of buck2 D. PFM 1] Buck3 Mode Read back the operation status of buck2 D. PFM 1] Buck3 Mode Read back the operation status of buck2 D. PFM 1] Back3 ECC Cor Cleared by writing '1' to 0x5E[4] NVM D. Bank5 ECC OK (normal) 1 rected Error bit 1: Bank4 ECC OK (normal) 1 rected Error bit 1: Bank5 ECC Or (normal) 1 rected Error bit 1: Ban	<0	0: PFM	Read back the operation status of buck4	Buck4 Mode	[3]
11 Buck2 Mode Read back the operation status of buck2 D. PFM 10 Buck1 Mode Read back the operation status of buck1 D. PFM 11 PWM D. PFM D. PFM 12 PWM D. PFM D. PFM 13 PWM D. Bank7 ECC OK (normal) D. Bank7 ECC OK (normal) 14 Fected Error bit D. Bank6 ECC OK (normal) 15 EE Bank5 ECC Cor- Cleared by writing '1' to 0x5E[4] NVM D. Bank5 ECC OK (normal) 16 EE Bank5 ECC Cor- Cleared by writing '1' to 0x5E[4] NVM D. Bank5 ECC OK (normal) 17 rected Error bit D. Bank5 ECC OK (normal) 18 EE Bank3 ECC Cor- Cleared by writing '1' to 0x5E[4] NVM D. Bank3 ECC OK (normal) 19 EE Bank3 ECC Cor- Cleared by writing '1' to 0x5E[4] NVM D. Bank3 ECC OK (normal) 19 Fected Error bit D. Bank3 ECC OK (normal) 19 Fected Error bit Bank3 ECC COK (normal) 19 Fected Error bit D. Bank1 ECC OK (normal) 19 Fected Error bit D. Bank2 ECC COK (normal) 10 Fected Error bit <td< td=""><td><0</td><td>0: PFM</td><td>Read back the operation status of buck3</td><td>Buck3 Mode</td><td>[2]</td></td<>	<0	0: PFM	Read back the operation status of buck3	Buck3 Mode	[2]
0] Buck1 Mode Read back the operation status of buck1 b: PFM 1: PWM Register Name - ECC Detail 1 Type - (RW, Non EEPROM) T D: Bank7 ECC OK (normal) 1: Bank7 ECC OK (normal) 1: Bank6 ECC OK (normal) 1: Bank6 ECC OK (normal) 1: Bank6 ECC Cor- Cleared by writing '1' to 0x5E[4] NVM D: Bank6 ECC OK (normal) 1: Bank6 ECC Cor- Cleared by writing '1' to 0x5E[4] NVM 6] EE Bank6 ECC Cor- Cleared by writing '1' to 0x5E[4] NVM D: Bank6 ECC OK (normal) 1: Bank6 ECC OK (normal) 1: Bank4 ECC Corrected flag 7] EE Bank6 ECC Cor- Cleared by writing '1' to 0x5E[4] NVM D: Bank4 ECC OK (normal) 1: Bank4 ECC OK (normal) 1: Each4 4] EE Bank6 ECC Cor- Cleared by writing '1' to 0x5E[4] NVM D: Bank4 ECC OK (normal) 1: Bank4 ECC Corrected flag 2] EE Bank3 ECC Cor- Cleared by writing '1' to 0x5E[4] NVM D: Bank1 ECC OK (normal) 1: Bank2 ECC OK (normal) 1: Bank2 ECC OK (normal) 1: Bank2 ECC Or- Cleared by writing '1' to 0x5E[4] NVM D: Bank1 ECC OK (normal) 1: Bank0 ECC OK (normal) 1: Bank6 ECC OK (normal) 1: B	<0		Read back the operation status of buck2	Buck2 Mode	[1]
Register Name - ECC Detail 1 Type - (RW, Non EEPROM) 7] EE Bank7 ECC Cor- Cleared by writing '1' to 0x5E[4] NVM D: Bank7 ECC OK (normal) 1: Bank6 ECC cor- Cleared by writing '1' to 0x5E[4] NVM D: Bank6 ECC corrected flag 6] EE Bank6 ECC Cor- Cleared by writing '1' to 0x5E[4] NVM D: Bank6 ECC corrected flag 5] EE Bank6 ECC Cor- Cleared by writing '1' to 0x5E[4] NVM D: Bank6 ECC corrected flag 7] EE Bank6 ECC Cor- Cleared by writing '1' to 0x5E[4] NVM D: Bank7 ECC OK (normal) rected Error bit D: Bank4 ECC Corrected flag 1: Bank5 ECC Cor- Cleared by writing '1' to 0x5E[4] NVM D: Bank4 ECC Corrected flag 2: EE Bank6 ECC Cor- Cleared by writing '1' to 0x5E[4] NVM D: Bank1 ECC OK (normal) rected Error bit D: Bank1 ECC Cor (normal) rected Error bit D: Bank1 ECC OK (normal) rected Error bi	<0		Read back the operation status of buck1	Buck1 Mode	[0]
Type - (RW, Non EEPROM) 71 EE Bank7 ECC Cor- Cleared by writing '1' to 0x5E[4] NVM D: Bank7 ECC OK (normal) 1 Eact and the ected error bit D: Bank6 ECC OK (normal) 6] EE Bank5 ECC Cor- Cleared by writing '1' to 0x5E[4] NVM D: Bank6 ECC OK (normal) 1 Eact and the ected error bit D: Bank5 ECC OK (normal) 1 Eact and the ected error bit D: Bank5 ECC OK (normal) 1 EE Bank4 ECC Cor- Cleared by writing '1' to 0x5E[4] NVM D: Bank5 ECC OK (normal) 1 tected error bit D: Bank5 ECC OK (normal) 1 tected error bit D: Bank5 ECC OK (normal) 1 tected error bit D: Bank5 ECC OK (normal) 1 tected error bit D: Bank5 ECC OK (normal) 1 tected error bit D: Bank5 ECC OK (normal) 1 tected error bit D: Bank5 ECC OK (normal) 1 tected error bit D: Bank1 ECC OK (normal) 1 tected error bit D: Bank6 ECC OK (normal) 1 tected error bit D: Bank6 ECC OK (normal) 1 tected error bit D: Bank6 ECC OK (normal) 1 tected error bit D: Bank6 ECC OK (normal)<	-				_
Image: Second	0x00				
rected Error bit 1: Bank7 ECC corrected flag [6] EE Bank6 ECC Cor- Cleared by writing '1' to 0x5E[4] NVM D: Bank6 ECC Corrected flag [5] EE Bank5 ECC Cor- Cleared by writing '1' to 0x5E[4] NVM D: Bank5 ECC OK (normal) rected Error bit 1: Bank5 ECC OK (normal) rected Error bit 0: Bank4 ECC corrected flag [3] EE Bank3 ECC Cor- Cleared by writing '1' to 0x5E[4] NVM D: Bank4 ECC corrected flag [3] EE Bank3 ECC Cor- Cleared by writing '1' to 0x5E[4] NVM D: Bank4 ECC corrected flag [2] EE Bank3 ECC Cor- Cleared by writing '1' to 0x5E[4] NVM D: Bank2 ECC OK (normal) rected Error bit 1: Bank2 ECC Corrected flag [2] EE Bank4 ECC Cor- Cleared by writing '1' to 0x5E[4] NVM D: Bank2 ECC OK (normal) rected Error bit 1: Bank2 ECC OK (normal) rected Error bit 1: Bank0 ECC Corrected flag [1] EE Bank6 ECC Cor- Cleared by writing '1' to 0x5E[4] NVM D: Bank1 ECC OK (normal) rected Error bit 1: Bank0 ECC OK (normal) rected Error bit 1: Bank0 ECC OK (normal) rected Error bit 1: Bank0 ECC OK (normal) <					
[6] EE Bank6 ECC Cor- cleared by writing '1' to 0x5E[4] NVM rected D: Bank6 ECC OK (normal) 1: Bank6 ECC corrected flag [5] EE Bank4 ECC Cor- cleared by writing '1' to 0x5E[4] NVM rected D: Bank4 ECC Corrected flag [4] EE Bank4 ECC Cor- cleared by writing '1' to 0x5E[4] NVM rected D: Bank4 ECC Corrected flag [3] EE Bank3 ECC Cor- cleared by writing '1' to 0x5E[4] NVM rected D: Bank3 ECC OK (normal) 1: Bank3 ECC Corrected flag [2] EE Bank1 ECC Cor- cleared by writing '1' to 0x5E[4] NVM rected D: Bank1 ECC OK (normal) 1: Bank2 ECC Corrected flag [1] EE Bank1 ECC Cor- cleared by writing '1' to 0x5E[4] NVM rected D: Bank1 ECC OK (normal) 1: Bank2 ECC Corrected flag [1] EE Bank1 ECC Cor- cleared by writing '1' to 0x5E[4] NVM rected D: Bank1 ECC OK (normal) 1: Bank1 ECC OK (normal) 1: Bank1 ECC OK (normal) 1: Bank0 ECC Corrected flag [0] EE Bank0 ECC Cor- cleared by writing '1' to 0x5E[4] NVM rected D: Bank7 ECC OK (normal) 1: Bank0 ECC uncorrectable error flag [7] EE Bank6 ECC ErrorCleared by writing '1' to 0x5E[4] NVM Error bit D: Bank6 ECC OK (normal) 1: Bank6 ECC uncorrectable error flag [6] EE Bank6 ECC ErrorCleared by writing '1' to 0x5E[4] NVM Error bit D: Bank5 ECC OK (normal) 1: Bank4 ECC uncorrectable error flag [5] EE Bank4 ECC ErrorCleared by writing '1' to 0x5E[4] NVM Error bit D: Bank3 ECC OK (normal) 1: Bank3 ECC u	<0				[7]
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[6] EE Bank6 ECC Error Cleared by writing '1' to 0x5E[4] NVM D: Bank6 ECC OK (normal) [5] EE Bank5 ECC Error Cleared by writing '1' to 0x5E[4] NVM D: Bank5 ECC OK (normal) [5] EE Bank5 ECC Error Cleared by writing '1' to 0x5E[4] NVM D: Bank5 ECC OK (normal) [4] EE Bank4 ECC Error Cleared by writing '1' to 0x5E[4] NVM D: Bank4 ECC OK (normal) [4] EE Bank4 ECC Error Cleared by writing '1' to 0x5E[4] NVM D: Bank4 ECC OK (normal) [7] EE Bank3 ECC Error Cleared by writing '1' to 0x5E[4] NVM D: Bank3 ECC OK (normal) [8] EE Bank3 ECC Error Cleared by writing '1' to 0x5E[4] NVM D: Bank3 ECC OK (normal) [7] EE Bank2 ECC Error Cleared by writing '1' to 0x5E[4] NVM D: Bank3 ECC OK (normal) [7] EE Bank2 ECC Error Cleared by writing '1' to 0x5E[4] NVM D: Bank2 ECC OK (normal) [7] EE Bank2 ECC Error Cleared by writing '1' to 0x5E[4] NVM D: Bank2 ECC OK (normal) [7] EE Bank1 ECC Error Cleared by writing '1' to 0x5E[4] NVM D: Bank2 ECC OK (normal) [7] EE Bank1 ECC Error Cleared by writing '1' to 0x5E[4] NVM D: Bank1 ECC OK (normal)	<0	1: Bank7 ECC uncorrectable error		EE Bank7 ECC Erro	[7]
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[4] EE Bank4 ECC Error Cleared by writing '1' to 0x5E[4] NVM D: Bank4 ECC OK (normal) [4] EE Bank4 ECC Error Cleared by writing '1' to 0x5E[4] NVM D: Bank4 ECC OK (normal) [3] EE Bank3 ECC Error Cleared by writing '1' to 0x5E[4] NVM D: Bank3 ECC OK (normal) [3] EE Bank3 ECC Error Cleared by writing '1' to 0x5E[4] NVM D: Bank3 ECC OK (normal) [2] EE Bank2 ECC Error Cleared by writing '1' to 0x5E[4] NVM D: Bank2 ECC OK (normal) [2] EE Bank2 ECC Error Cleared by writing '1' to 0x5E[4] NVM D: Bank2 ECC OK (normal) [1] EE Bank1 ECC Error Cleared by writing '1' to 0x5E[4] NVM D: Bank1 ECC OK (normal)	<0	0: Bank5 ECC OK (normal)		EE Bank5 ECC Erro	[5]
[4] EE Bank4 ECC Error Cleared by writing '1' to 0x5E[4] NVM D: Bank4 ECC OK (normal) [3] EE Bank3 ECC Error Cleared by writing '1' to 0x5E[4] NVM D: Bank4 ECC OK (normal) [3] EE Bank3 ECC Error Cleared by writing '1' to 0x5E[4] NVM D: Bank3 ECC OK (normal) [3] EE Bank3 ECC Error Cleared by writing '1' to 0x5E[4] NVM D: Bank3 ECC OK (normal) [2] EE Bank2 ECC Error Cleared by writing '1' to 0x5E[4] NVM D: Bank2 ECC OK (normal) [2] EE Bank2 ECC Error Cleared by writing '1' to 0x5E[4] NVM D: Bank2 ECC OK (normal) [1] EE Bank1 ECC Error Cleared by writing '1' to 0x5E[4] NVM D: Bank1 ECC OK (normal)			Error bit		
flag [3] EE Bank3 ECC ErrorCleared by writing '1' to 0x5E[4] NVM 0: Bank3 ECC OK (normal) [3] EE Bank3 ECC ErrorCleared by writing '1' to 0x5E[4] NVM 0: Bank3 ECC OK (normal) [2] EE Bank2 ECC ErrorCleared by writing '1' to 0x5E[4] NVM 0: Bank2 ECC OK (normal) [2] EE Bank2 ECC ErrorCleared by writing '1' to 0x5E[4] NVM 0: Bank2 ECC OK (normal) [1] EE Bank1 ECC ErrorCleared by writing '1' to 0x5E[4] NVM 0: Bank1 ECC OK (normal)	<0	0: Bank4 ECC OK (normal)		EE Bank4 ECC Erro	[4]
[3] EE Bank3 ECC Error Cleared by writing '1' to 0x5E[4] NVM D: Bank3 ECC OK (normal) [3] Error bit 1: Bank3 ECC OK (normal) [2] EE Bank2 ECC Error Cleared by writing '1' to 0x5E[4] NVM D: Bank3 ECC OK (normal) [2] EE Bank2 ECC Error Cleared by writing '1' to 0x5E[4] NVM D: Bank2 ECC OK (normal) [1] EE Bank1 ECC Error Cleared by writing '1' to 0x5E[4] NVM D: Bank1 ECC OK (normal) [1] EE Bank1 ECC Error Cleared by writing '1' to 0x5E[4] NVM D: Bank1 ECC OK (normal)			Error bit		
Error bit 1: Bank3 ECC uncorrectable error flag [2] EE Bank2 ECC ErrorCleared by writing '1' to 0x5E[4] NVM Error bit 0: Bank2 ECC OK (normal) [1] EE Bank1 ECC ErrorCleared by writing '1' to 0x5E[4] NVM 0: Bank2 ECC OK (normal) [1] EE Bank1 ECC ErrorCleared by writing '1' to 0x5E[4] NVM 0: Bank1 ECC OK (normal)	<0	ě	Cleared by writing '1' to 0x5E[4] NVM	EE Bank3 ECC Erro	[3]
[2] EE Bank2 ECC ErrorCleared by writing '1' to 0x5E[4] NVM D: Bank2 ECC OK (normal) Error bit 1: Bank2 ECC uncorrectable error [1] EE Bank1 ECC ErrorCleared by writing '1' to 0x5E[4] NVM D: Bank1 ECC OK (normal)		1: Bank3 ECC uncorrectable error			
Error bit 1: Bank2 ECC uncorrectable error [1] EE Bank1 ECC ErrorCleared by writing '1' to 0x5E[4] NVM 0: Bank1 ECC OK (normal)	<0	5	Cleared by writing '1' to 0x5E[4] NVM	EE Bank2 ECC Erro	[2]
[1] EE Bank1 ECC ErrorCleared by writing '1' to 0x5E[4] NVM 0: Bank1 ECC OK (normal)		1: Bank2 ECC uncorrectable error			
	<0	ě	Cleared by writing '1' to 0x5E[4] NVM	EE Bank1 ECC Erro	[1]
Flow State		1: Bank1 ECC uncorrectable error			
flag [0] EE Bank0 ECC ErrorCleared by writing '1' to 0x5E[4] NVM 0: Bank0 ECC OK (normal)	<0	ě	Cleared by writing '1' to 0x5E[4] NVM	EE Bank0 ECC Erro	[0]
Error bit 1: Bank0 ECC uncorrectable error					1



)x85	-	r Name - EE Detail			0x00 / 0
	I ype - (RW, Non EEPROM)			
	[7:2]	not used			<000000
	[1]	Valid EE Data	Customer data is considered as valid if either of the EEPROM ID 1/2 registers are non-zero. Cleared by writing '1' to 0x5E[4]		<0>
	101		NVM Error bit		
	[0]	EE Error Latched	Cleared by writing '1' to 0x5E[4] NVM Error bit	0: OK (normal) 1: Insufficient EEPROM voltage	<0>
)x86		r Name - Spread Spec RW, EEPROM)	trum 1		0x00 / 0
	17.01	Face 00			1001
	[7:6]	Freq SS	Spread spectrum modulation frequency	00: 17.5kHz 01: 20kHz 10: 22.5kHz 11: 25kHz	<00>
	[5:4]	PWM AM	Spread spectrum modulation amplitude in PWM mode. Setting these two bits to 2b'00 disables the spread spectrum func- tion in PWM mode for all buck regulators	00: 0, 0, 0, 0, 0, 0, 0, 0	<00>
	[3:2]	Buck6 PFM AM	Buck6 spread spectrum modulation ampli- tude in PFM mode	00: -1, -1, 0, 0, 0, 0, 0, +1, +1 01: -2, -1, -1, 0, 0, +1, +1, +2 10: -3, -2, -1, 0, 0, +1, +2, +3 11: -4, -3, -1, 0, 0, +1, +3, +4	<00>
	[1:0]	Buck5 PFM AM	Buck5 spread spectrum modulation ampli- tude in PFM mode		<00>
)x87	0	r Name - Spread Spec	strum 2	_ , _, _, _, _, _, _, _, _, _, _, _,	0x00/0
	Туре - (RW, EEPROM)			
	Type - ([7:6]		Buck4 spread spectrum modulation ampli- tude in PFM mode	01: -2, -1, -1, 0, 0, +1, +1, +2 10: -3, -2, -1, 0, 0, +1, +2, +3	<00>
	[7:6]	RW, EEPROM) Buck4 PFM AM Buck3 PFM AM	tude in PFM mode Buck3 spread spectrum modulation ampli- tude in PFM mode	01: -2, -1, -1, 0, 0, +1, +1, +2 10: -3, -2, -1, 0, 0, +1, +2, +3 11: -4, -3, -1, 0, 0, +1, +3, +4 00: -1, -1, 0, 0, 0, 0, +1, +1 01: -2, -1, -1, 0, 0, +1, +1, +2 10: -3, -2, -1, 0, 0, +1, +2, +3 11: -4, -3, -1, 0, 0, +1, +3, +4	<00>
	[7:6] [5:4] [3:2]	RW, EEPROM) Buck4 PFM AM Buck3 PFM AM Buck2 PFM AM	tude in PFM mode Buck3 spread spectrum modulation ampli- tude in PFM mode Buck2 spread spectrum modulation ampli- tude in PFM mode	$\begin{array}{c} 01: -2, -1, -1, 0, 0, +1, +1, +2\\ 10: -3, -2, -1, 0, 0, +1, +2, +3\\ 11: -4, -3, -1, 0, 0, +1, +3, +4\\ 00: -1, -1, 0, 0, 0, 0, +1, +1\\ 01: -2, -1, -1, 0, 0, +1, +1, +2\\ 10: -3, -2, -1, 0, 0, +1, +2, +3\\ 11: -4, -3, -1, 0, 0, +1, +3, +4\\ 00: -1, -1, 0, 0, 0, 0, +1, +1\\ 01: -2, -1, -1, 0, 0, +1, +1, +2\\ 10: -3, -2, -1, 0, 0, +1, +1, +2\\ 10: -3, -2, -1, 0, 0, +1, +2, +3\\ 11: -4, -3, -1, 0, 0, +1, +3, +4\\ \end{array}$	
	[7:6] [5:4] [3:2] [1:0]	RW, EEPROM) Buck4 PFM AM Buck3 PFM AM Buck2 PFM AM Buck1 PFM AM	tude in PFM mode Buck3 spread spectrum modulation ampli- tude in PFM mode Buck2 spread spectrum modulation ampli- tude in PFM mode Buck1 spread spectrum modulation ampli- tude in PFM mode	$\begin{array}{c} 01: -2, -1, -1, 0, 0, +1, +1, +2\\ 10: -3, -2, -1, 0, 0, +1, +2, +3\\ 11: -4, -3, -1, 0, 0, +1, +3, +4\\ 00: -1, -1, 0, 0, 0, 0, +1, +1\\ 01: -2, -1, -1, 0, 0, +1, +1, +2\\ 10: -3, -2, -1, 0, 0, +1, +2, +3\\ 11: -4, -3, -1, 0, 0, +1, +3, +4\\ 00: -1, -1, 0, 0, 0, 0, +1, +1\\ 01: -2, -1, -1, 0, 0, +1, +1, +2\\ 10: -3, -2, -1, 0, 0, +1, +1, +2\\ 10: -3, -2, -1, 0, 0, +1, +2, +3\\ 11: -4, -3, -1, 0, 0, +1, +3, +4\\ \end{array}$	<00>
1x88	[7:6] [5:4] [3:2] [1:0] Register	RW, EEPROM) Buck4 PFM AM Buck3 PFM AM Buck2 PFM AM	tude in PFM mode Buck3 spread spectrum modulation ampli- tude in PFM mode Buck2 spread spectrum modulation ampli- tude in PFM mode Buck1 spread spectrum modulation ampli- tude in PFM mode	$\begin{array}{c} 01: -2, -1, -1, 0, 0, +1, +1, +2\\ 10: -3, -2, -1, 0, 0, +1, +2, +3\\ 11: -4, -3, -1, 0, 0, +1, +3, +4\\ 00: -1, -1, 0, 0, 0, 0, +1, +1\\ 01: -2, -1, -1, 0, 0, +1, +1, +2\\ 10: -3, -2, -1, 0, 0, +1, +2, +3\\ 11: -4, -3, -1, 0, 0, +1, +3, +4\\ 00: -1, -1, 0, 0, 0, 0, +1, +1\\ 01: -2, -1, -1, 0, 0, +1, +1, +2\\ 10: -3, -2, -1, 0, 0, +1, +1, +2\\ 10: -3, -2, -1, 0, 0, +1, +1, +2\\ 10: -3, -2, -1, 0, 0, +1, +3, +4\\ 00: -1, -1, 0, 0, 0, 0, 0, +1, +1\\ 01: -2, -1, -1, 0, 0, +1, +2, +3\\ 11: -4, -3, -1, 0, 0, +1, +1\\ 01: -2, -1, -1, 0, 0, +1, +1\\ 01: -2, -1, -1, 0, 0, +1, +1, +2\\ 10: -3, -2, -1, 0, 0, +1, +2, +3\\ \end{array}$	<00>
)x88	[7:6] [5:4] [3:2] [1:0] Register Type - (RW, EEPROM) Buck4 PFM AM Buck3 PFM AM Buck2 PFM AM Buck1 PFM AM Ruck1 PFM AM	tude in PFM mode Buck3 spread spectrum modulation ampli- tude in PFM mode Buck2 spread spectrum modulation ampli- tude in PFM mode Buck1 spread spectrum modulation ampli- tude in PFM mode	$\begin{array}{c} 01: -2, -1, -1, 0, 0, +1, +1, +2\\ 10: -3, -2, -1, 0, 0, +1, +2, +3\\ 11: -4, -3, -1, 0, 0, +1, +3, +4\\ 00: -1, -1, 0, 0, 0, 0, +1, +1\\ 01: -2, -1, -1, 0, 0, +1, +1, +2\\ 10: -3, -2, -1, 0, 0, +1, +2, +3\\ 11: -4, -3, -1, 0, 0, +1, +3, +4\\ 00: -1, -1, 0, 0, 0, 0, +1, +1\\ 01: -2, -1, -1, 0, 0, +1, +1, +2\\ 10: -3, -2, -1, 0, 0, +1, +1, +2\\ 10: -3, -2, -1, 0, 0, +1, +1, +2\\ 10: -3, -2, -1, 0, 0, +1, +3, +4\\ 00: -1, -1, 0, 0, 0, 0, 0, +1, +1\\ 01: -2, -1, -1, 0, 0, +1, +2, +3\\ 11: -4, -3, -1, 0, 0, +1, +1\\ 01: -2, -1, -1, 0, 0, +1, +1\\ 01: -2, -1, -1, 0, 0, +1, +1, +2\\ 10: -3, -2, -1, 0, 0, +1, +2, +3\\ \end{array}$	<00> <00> <00> <00>
)x88	[7:6] [5:4] [3:2] [1:0] Register	RW, EEPROM) Buck4 PFM AM Buck3 PFM AM Buck2 PFM AM Buck1 PFM AM	tude in PFM mode Buck3 spread spectrum modulation ampli- tude in PFM mode Buck2 spread spectrum modulation ampli- tude in PFM mode Buck1 spread spectrum modulation ampli- tude in PFM mode	$\begin{array}{c} 01: -2, -1, -1, 0, 0, +1, +1, +2\\ 10: -3, -2, -1, 0, 0, +1, +2, +3\\ 11: -4, -3, -1, 0, 0, +1, +3, +4\\ 00: -1, -1, 0, 0, 0, 0, +1, +1\\ 01: -2, -1, -1, 0, 0, +1, +1, +2\\ 10: -3, -2, -1, 0, 0, +1, +2, +3\\ 11: -4, -3, -1, 0, 0, +1, +3, +4\\ 00: -1, -1, 0, 0, 0, 0, +1, +1\\ 01: -2, -1, -1, 0, 0, +1, +1, +2\\ 10: -3, -2, -1, 0, 0, +1, +1, +2\\ 10: -3, -2, -1, 0, 0, +1, +1, +2\\ 10: -3, -2, -1, 0, 0, +1, +3, +4\\ 00: -1, -1, 0, 0, 0, 0, 0, +1, +1\\ 01: -2, -1, -1, 0, 0, +1, +2, +3\\ 11: -4, -3, -1, 0, 0, +1, +1\\ 01: -2, -1, -1, 0, 0, +1, +1\\ 01: -2, -1, -1, 0, 0, +1, +1, +2\\ 10: -3, -2, -1, 0, 0, +1, +2, +3\\ \end{array}$	<00>

-	er Name - Shutdown Co (RW, EEPROM)	onfig		0x02 / 2
[7:3]	not used			<00000
[2]	Shutdown Option	Config the shutdown options for all LDOs	0: Shut down with discharge resis-	<0>
[2]	LDO		tors using Shut Down SR 1: Shut down with discharge resis- tors, discharge rate set by RC	202
[1:0]	Shutdown Option Buck	regulators	00: Shut down in forced PWM using Shut Down SR 01: Shut down in PFM/PWM using Shut Down SR 10: Shut down with discharge resis- tors using Shut Down SR 11: Shut down with discharge resis- tors, discharge rate set by RC	<10>
	er Name - MPIO0 Conf (RW, EEPROM)	ig		0x0D / 1
[7:6]	not used			<00>
[5]	MPIO0 Invert	Configure the polarity of MPIO0	0: Active low 1: Active high	<0>
[4:3]	MPIO0 Type			<01>
[2:0]	MPIO0 Function	Bits[2:0] = 000 disables the function of the	000: Disabled 001: Disabled	<101>
-	er Name - MPIO1 Conf (RW, EEPROM)	ig		0x0D / 1
[7:6]	not used			<00>
[5]	MPIO1 Invert	Configure the polarity of MPIO1	0: Active low 1: Active high	<0>
[4:3]	MPIO1 Type	If bits[4:3] = 00, then the respective MPIOx pin is high impedance, and the device will still use the MPIOx power on/off delays if bits[2:0] are not set to 3'b000	00: Disabled (high impedance) 01: Open drain NMOS output	<01>
[2:0]	MPIO1 Function	Bits[2:0] = 000 disables the function of the respective MPIOx pin, and the device will	000: Disabled	<101>



-	er Name - MPIO2 Cont (RW, EEPROM)	īg		0x2C /
	()			
[7:6]	not used			<00>
[5]	MPIO2 Invert	Configure the polarity of MPIO2	0: Active low 1: Active high	<1>
[4:3]	MPIO2 Type	If bits[4:3] = 00, then the respective MPIOx pin is high impedance, and the device will still use the MPIOx power on/off delays if bits[2:0] are not set to 3'b000		<01
[2:0]	MPIO2 Function	Bits[2:0] = 000 disables the function of the respective MPIOx pin, and the device will	000: Disabled	<100
	r Name - MPIO3 Con	ig		0x20 /
Type - ((RW, EEPROM)			
[7:6]	not used			<00:
[5]	MPIO3 Invert	Configure the polarity of MPIO3	0: Active low 1: Active high	<1>
[4:3]	MPIO3 Type	If bits[4:3] = 00, then the respective MPIOx pin is high impedance, and the device will still use the MPIOx power on/off delays if bits[2:0] are not set to 3'b000		<00:
[2:0]	MPIO3 Function	Bits[2:0] = 000 disables the function of the	001: SLEEP#	<000
	r Name - MPIO4 Con (RW, EEPROM)	ïg	· · · · · · · · · · · · · · · · · · ·	0x00 /
[7:6]	not used			<00:
[5]	MPIO4 Invert	0 1 2	0: Active low 1: Active high	<0>
[4:3]	MPIO4 Type	If bits[4:3] = 00, then the respective MPIOx pin is high impedance, and the device will still use the MPIOx power on/off delays if bits[2:0] are not set to 3'b000	,	<00:
[2:0]	MPIO4 Function	Bits[2:0] = 000 disables the function of the respective MPIOx pin, and the device will		<000

Type - (RW, EEPROM) - 7:1] hot used <000000 [0] PWRON Polarity Select the polarity of the PWRON input in D: Active low <1> x95 Register Name - System Control	Туре	ster Name - MPIO5 Conf - (RW, EEPROM)	ig		0x01 / 1	
[6] MPIOS Invert Configure the polarity of MPIOS D. Active low <0> [4:3] MPIOS Type If bits[4:3] = 00, then the respective MPIOx D0: Disabled (high impedance) bit is high impedance, and the device will D1: Open drain MMOS output bit use the MPIOx power on/off delays if 10: Open drain PMOS output bit use the MPIOx power on/off delays set. <0> [2:0] MPIOS Function Bits[2:0] = 000 disables the function of the D00: Disabled respective MPIOx pin, and the device will D1: CRST IN# gonore the MPIOx power on/off delay set. <00> [3:0] MPIOS Function Bits[2:0] = 000 disables the function of the D00: Disabled respective MPIOx pin, and the device will D1: CRST IN# gonore the MPIOx power on/off delay set. <001> [4:0] Register Name - PWRON Polarity Config 010: External VR EN output 011: External VR EN output [7:1] hot used <0000000 <0000000 <11: Output from I2C output [7:1] hot used <0000000 <11: Output from I2C output <0000000 [7:1] hot used <0000000 <12: Ontput <0000000 [7:2] hot used <0000000 <12: Ontput <000000 [9] MPIO Config Lock fo prevent user from accidentally chang- ing the MPIOx config	[7·6]	not used			<00>	
[4:3] MPIO5 Type If bits[4:3] = 00, then the respective MPIOx Dio: Disabled (high impedance) pin is high impedance, and the device will Di: Open drain NMOS output to bits[2:0] are not set to 3'b000			Configure the polarity of MPIO5			
[2:0] MPIO5 Function Bits[2:0] = 000 disables the function of the b00: Disabled inspective MPIOx pin, and the device will b01: CRST_IN# espective MPIOx power on/off delay set- b10: PSGod output 101: Reserved value will b11: Input to 12C register 100: PSGod output 101: Reserved VR EN output 111: Output from I2C output 111: Dutput from I2C output 111: Dutput from I2C output 111: Output from I2C output 111: Exercise from I2C output 111: Output from I2C output 111: Output	[4:3]	MPIO5 Type	pin is high impedance, and the device will still use the MPIOx power on/off delays if	00: Disabled (high impedance) 01: Open drain NMOS output 10: Open drain PMOS output	<00>	
Type - (RW, EEPROM) 7:1] hot used 0] PWRON Polarity Select the polarity of the PWRON input in D: Active low x95 Register Name - System Control Type - (RW, Non EEPROM) 0x00 / C 7:2] hot used 7:2] hot else	[2:0]	MPIO5 Function	Bits[2:0] = 000 disables the function of the respective MPIOx pin, and the device will ignore the MPIOx power on/off delay set-	000: Disabled 001: CRST_IN# 010: External VR PGood input 011: Input to I2C register 100: PGood output 101: Reset output 110: External VR EN output	<001>	
0] PWRON Polarity both on/off switch and push button modes (1) Active low (1) <1> x95 Register Name - System Control Type - (RW, Non EEPROM) 0x00 / 0 7:2] not used <000000	0	Register Name - PWRON Polarity Config				
0] PWRON Polarity both on/off switch and push button modes (1) Active low (1) <1> x95 Register Name - System Control Type - (RW, Non EEPROM) 0x00 / 0 7:2] not used <000000	[7:1]	not used			<0000000	
x95 Register Name - System Control Type - (RW, Non EEPROM) 0x00 / C 7:2] hot used <000000		PWRON Polarity			<1>	
[1] reserved <0> [0] MPIO Config Lock To prevent user from accidentally chang- ing the MPIOx configurations. Once this bit is set to '1', it cannot be set back to '0' until POR D: Unlock the MPIOx Config registers at 0x8A - 0x8F <0> (AD Reserved for Renesas Internal Use Register Name - EEPROM ID 1 0x01 / 1 (AD Register Name - EEPROM ID 1 The EEPROM data is considered valid when EEPROM ID 1 or EEPROM ID 2 is programmed to non-zero value 0x01 / 1 (XB1 Register Name - EEPROM ID 2 0x01 / 1 0x01 / 1 (XB1 Register Name - EEPROM ID 2 0x01 / 1 (To prevent user from accidentality chang- programmed to non-zero value 0x01 / 1 (XB1 Register Name - Chip ID The EEPROM data is considered valid when EEPROM ID 1 or EEPROM ID 2 is programmed to non-zero value 0x01 / 1 (XF7 Register Name - Chip ID Type - (Read-Only) 0x00 / 0					0,000,0	
0] MPIO Config Lock To prevent user from accidentally chang- ing the MPIOx configurations. Once this bit is set to '1', it cannot be set back to '0' until POR 0: Unlock the MPIOx Config registers at 0x8A - 0x8F (AD Reserved for Renesas Internal Use (AD Register Name - EEPROM ID 1 Type - (RW, EEPROM) The EEPROM data is considered valid when EEPROM ID 1 or EEPROM ID 2 is programmed to non-zero value 0x01 / 1 (7:0] NVM Ver 1 The EEPROM data is considered valid when EEPROM ID 1 or EEPROM ID 2 is programmed to non-zero value 0x01 / 1 (7:0] NVM Ver 2 The EEPROM data is considered valid when EEPROM ID 1 or EEPROM ID 2 is programmed to non-zero value 0x01 / 1 (7:0] NVM Ver 2 The EEPROM data is considered valid when EEPROM ID 1 or EEPROM ID 2 is programmed to non-zero value 0x01 / 1 (7:0] NVM Ver 2 The EEPROM data is considered valid when EEPROM ID 2 is programmed to non-zero value 0x01 / 1 xF7 Register Name - Chip ID Type - (Read-Only) 0x00 / 0 0x00 / 0					-000000	
AD Reserved for Renesas Internal Use xB0 Register Name - EEPROM ID 1 Type - (RW, EEPROM) 0x01 / 1 7:0] NVM Ver 1 The EEPROM data is considered valid when EEPROM ID 1 or EEPROM ID 2 is programmed to non-zero value <0000000 xB1 Register Name - EEPROM ID 2 0x01 / 1 xB1 Register Name - EEPROM ID 2 0x01 / 1 Type - (RW, EEPROM) 0x01 / 1 7:0] NVM Ver 2 The EEPROM data is considered valid when EEPROM ID 1 or EEPROM ID 2 is programmed to non-zero value <0000000 xF7 Register Name - Chip ID Type - (Read-Only) 0x00 / 0	[7:2]	not used				
Type - (RW, EEPROM) The EEPROM data is considered valid when EEPROM ID 1 or EEPROM ID 2 is programmed to non-zero value <000000	[7:2] [1]	not used reserved	ing the MPIOx configurations. Once this bit is set to '1', it cannot be set back to '0'	at 0x8A - 0x8F 1: Lock the MPIOx Config registers	<0>	
when EEPROM ID 1 or EEPROM ID 2 is programmed to non-zero value 0x01 / 1 xB1 Register Name - EEPROM ID 2 0x01 / 1 Type - (RW, EEPROM) 7:0] NVM Ver 2 The EEPROM data is considered valid when EEPROM ID 1 or EEPROM ID 2 is programmed to non-zero value <0000000	[7:2] [1] [0]	not used reserved MPIO Config Lock	ing the MPIOx configurations. Once this bit is set to '1', it cannot be set back to '0' until POR	at 0x8A - 0x8F 1: Lock the MPIOx Config registers	<0>	
Type - (RW, EEPROM) [7:0] NVM Ver 2 The EEPROM data is considered valid when EEPROM ID 1 or EEPROM ID 2 is programmed to non-zero value <0000000	[7:2] [1] [0] xAD Rese xB0 Regis	not used reserved MPIO Config Lock erved for Renesas Interna ster Name - EEPROM ID	ing the MPIOx configurations. Once this bit is set to '1', it cannot be set back to '0' until POR al Use	at 0x8A - 0x8F 1: Lock the MPIOx Config registers	<0> <0>	
xF7 Register Name - Chip ID Type - (Read-Only)	[7:2] [1] [0] kAD Rese xB0 Regis Type	hot used reserved MPIO Config Lock erved for Renesas Interna ster Name - EEPROM ID - (RW, EEPROM)	Ing the MPIOx configurations. Once this bit is set to '1', it cannot be set back to '0' until POR al Use 11 The EEPROM data is considered valid when EEPROM ID 1 or EEPROM ID 2 is	at 0x8A - 0x8F 1: Lock the MPIOx Config registers	<0> <0>	
xF7 Register Name - Chip ID 0x00 / 0 Type - (Read-Only)	[7:2] [1] [0] xAD Rese xB0 Regis Type [7:0] xB1 Regis	not used reserved MPIO Config Lock erved for Renesas Interna ster Name - EEPROM ID - (RW, EEPROM) NVM Ver 1 ster Name - EEPROM ID	Ing the MPIOx configurations. Once this bit is set to '1', it cannot be set back to '0' until POR al Use 11 The EEPROM data is considered valid when EEPROM ID 1 or EEPROM ID 2 is programmed to non-zero value	at 0x8A - 0x8F 1: Lock the MPIOx Config registers	-	
	[7:2] [1] [0] xAD Rese xB0 Regis Type [7:0] xB1 Regis Type	not used reserved MPIO Config Lock erved for Renesas Interna ster Name - EEPROM ID - (RW, EEPROM) NVM Ver 1 ster Name - EEPROM ID - (RW, EEPROM)	Ing the MPIOx configurations. Once this bit is set to '1', it cannot be set back to '0' until POR al Use 11 The EEPROM data is considered valid when EEPROM ID 1 or EEPROM ID 2 is programmed to non-zero value 2 The EEPROM data is considered valid when EEPROM ID 1 or EEPROM ID 2 is	at 0x8A - 0x8F 1: Lock the MPIOx Config registers	<0> <0> 0x01 / 1 <0000000 0x01 / 1	
	(AD Rese xB0 Regis 7ype (7:0) xB1 Regis 7ype (7:0) (7:0) (7:0)	not used reserved MPIO Config Lock erved for Renesas Interna ster Name - EEPROM ID - (RW, EEPROM) NVM Ver 1 (RW, EEPROM) - (RW, EEPROM) NVM Ver 2 NVM Ver 2 ster Name - Chip ID	Ing the MPIOx configurations. Once this bit is set to '1', it cannot be set back to '0' until POR al Use 11 The EEPROM data is considered valid when EEPROM ID 1 or EEPROM ID 2 is programmed to non-zero value 2 The EEPROM data is considered valid when EEPROM ID 1 or EEPROM ID 2 is	at 0x8A - 0x8F 1: Lock the MPIOx Config registers	<0> <0> 0x01 / 1 <0000000	



0xF8	Register Name - HW REV Type - (Read-Only)				
	[7:4]	Major Rev	4-bit Major Revision	0x0 = x 0x1 = Rev A 0x2 = Rev B 0x3 = Rev C	<0001>
	[3:0]	Minor Rev	4-bit Minor Revision	0x0 = x 0x1 = 1st tape-out within a major revision 0x2 = 2nd tape-out within a major revision 0x3 = 3rd tape-out within a major revision	<0010>
0xFF		r Name - EEPROM Co (RW, Non EEPROM)	ntrol	•··	0x00 / 0
	[7:4]	not used			<0000>
	[3]	reserved			<0>
	[2]	reserved reserved			<0> <0>
		reserved	s-Write all customer registers to EEPROM	0: Do Nothing 1: Write reg data to EEPROM (cus- tomer banks), set bit LOW after write done	

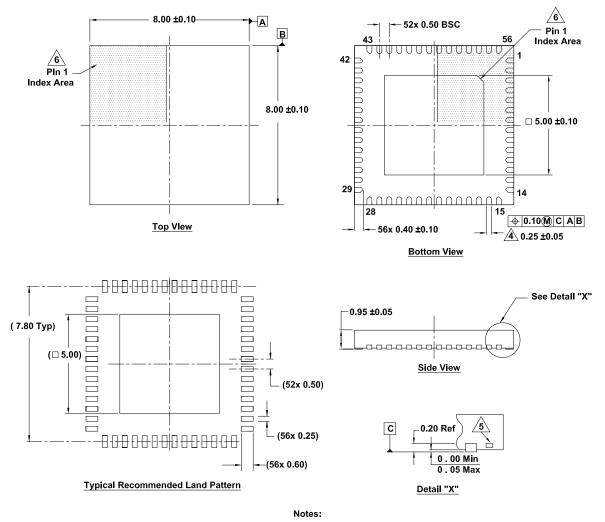


13. Package Outline Drawing

For the most recent package outline drawing, see L56.8x8I.

L56.8x8l

56 Lead Quad Flat No-lead Plastic Package (5x5mm Exposed Paddle) Rev 0, 11/20



1. Dimensions are in millimeters.

- Dimensions in () for reference only.
- 2. Dimensioning and tolerancing conform to ASME Y14.5m-1994.
- 3. Unless otherwise specified, tolerance: Decimal ±0.05
- A Dimension applies to the metallized terminal and is measured between 0.15mm and 0.30mm from the terminal tip.
- ▲ Tiebar shown (if present) is a non-functional feature.
- ▲ The configuration of the pin #1 identifier is optional, but must be located within the zone indicated. The pin #1 identifier is either a mold or mark feature.



14. Part Number Differences

This document describes the base RAA215300A2GNP#HA0 device. The other part numbers have default, or other implementation differences relative to this base part. The detailed differences are outlined in the following sections.

14.1 RAA215300A2GNP#HA1

14.1.1 Register Map Detail

Summary of differences:

PWRON Configuration: On/Off Switch

Register Pointer	Register Bit(S)	Bit(s)/Function Name	Description	Setting/Range	Default
0x6F	Register Name - Config 1 Type - (RW, EEPROM)				
	[0]	PWRON Config	Set the PWRON configuration	0: On/off switch 1: Long push button	<0>

14.2 RAA215300A2GNP#HA3

14.2.1 Register Map Detail

Summary of differences:

- Buck1, Buck3, Buck4, Buck5, LDO1 and LDO2 are disabled in {SLEEP}
- Buck6 disabled in {ACTIVE} and {SLEEP}
- Discharge resistance for all the bucks and LDOs: Fast
- Buck1 VOUT in {ACTIVE} and {SLEEP}: 0.95V
- Buck1 Power-off Delay: 15ms
- Buck1 Switching Frequency: 0.833MHz
- Buck2 VOUT in {ACTIVE} and {SLEEP}: 1.1V
- Buck2 Power-on Delay: 8ms. Power-off Delay: 0ms
- Buck3 VOUT in {ACTIVE} and {SLEEP}: 3.3V
- Buck3 Power-on Delay: 8ms. Power-off Delay: 0ms
- Buck4 VOUT in {ACTIVE} and {SLEEP}: 0.95V
- Buck4 Power-on Delay: 0ms. Power-off Delay: 20ms
- Buck4 Switching Frequency: 0.769MHz
- Buck5 VOUT in {ACTIVE} and {SLEEP}: 1.8V
- Buck5 Power-on Delay: 6ms. Power-off Delay: 5ms
- Buck 6 and Buck2 soft-start independently. VTTREF: Disabled. Buck6 Operation Mode in {ACTIVE}: Auto PFM/PWM Mode
- LDO1 VOUT when LDO_SEL1 = HIGH: 1.8V
- LDO1 Power-on Delay: 4ms. Power-off Delay: 10ms
- LDO2 VOUT when LDO_SEL2 = LOW: 3.3V
- LDO2 VOUT in {SLEEP}: 3.3V
- LDO2 Power-on Delay: 8ms



- LDO3 VOUT in {ACTIVE} and {SLEEP}: 1.8V
- LDO3 Power-on Delay: 4ms. Power-off Delay: 10ms
- MPIO0 Power-on Delay: 30ms
- MPIO1 Power-on Delay: 30ms
- Selected Regulator for MPIO2 PGood Output: Buck3
- MPIO4 Power-on Delay: 9ms
- MPIO2 Type: Full CMOS Output
- MPIO3 Polarity: Active Low. MPIO3 Function: SLEEP#
- MPIO4 Polarity: Active High. MPIO4 Type: Open Drain Output. MPIO4 Function: External VR EN Output
- EEPROM ID 2: 0x03

Register Pointer	Register Bit(s)	Bit(s)/Function Name	Description	Setting/Range	Default
0x20	Register Name - Buck1 Enable Type - (RW, EEPROM)				
	[1]	Buck1 EN SLEEP	Enable Buck1 in SLEEP state	0: Disabled 1: Enabled	<0>
	•	ame - Buck1 ACTIV V, EEPROM)	E		0x03 / 3
0x21	[3:0]	Buck1 Vo ACTIVE	Set Buck1 output voltage in ACTIVE state	4'b0000 - 4'b1110: Buck1 = 0.8V + 0.05V x Buck1_Vo_ACTIVE[3:0] 4'b1111: 1.03V	<0011>
	Register Name - Buck1 SLEEP Type - (RW, EEPROM)				
0x22	[3:0]	Buck1 Vo SLEEP	Set Buck1 output voltage in SLEEP state	4'b0000 - 4'b1110: Buck1 = 0.8V + 0.05V x Buck1_Vo_SLEEP[3:0] 4'b1111: 1.03V	<0011>
	Register Name - Buck1 Power Off Type - (RW, EEPROM)				
0x24	[6:0]	Buck1 Power Off Delay	Delay timed from the beginning of power-off sequence	0: 0ms 1: 1ms 127: 127ms	<0001111>



Register Pointer	Register Bit(s)	Bit(s)/Function Name	Description	Setting/Range	Default
	Register N Type - (RV		0x0B / 11		
0x26	[4:2]	Buck1 SW Freq	Set Buck1 switching frequency when in PWM operation	000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 101: 1.33MHz 110: 1.54MHz 111: 1.67MHz	<010>
	[1:0]	Buck1 Discharge	Set Buck1 output discharge resistance	00: Disabled 01: Slow 10: Medium 11: Fast	<11>
0x28		lame - Buck2 ACTIV V, EEPROM)	E		0x00 / 0
	[3:0]	Buck2 Vo ACTIVE	Set Buck2 output voltage in ACTIVE state	Buck2 = 1.1V + 0.05V x Buck2_Vo_ACTIVE[3:0]	<0000>
0x29	Register Name - Buck2 SLEEP Type - (RW, EEPROM)				
	[3:0]	Buck2 Vo SLEEP	Set Buck2 output voltage in SLEEP state	Buck2 = 1.1V + 0.05V x Buck2_Vo_SLEEP[3:0]	<0000>
		lame - Buck2 Power V, EEPROM)	On		0x08 / 8
0x2A	[6:0]	Buck2 Power On Delay	Delay timed from the beginning of power-on sequence	0: 0ms 1: 1ms 127: 127ms	<0001000>
	U U	lame - Buck2 Power V, EEPROM)	Off		0x00 / 0
0x2B	[6:0]	Buck2 Power Off Delay	Delay timed from the beginning of power-off sequence	0: 0ms 1: 1ms 127: 127ms	<0000000>
	Register Name - Buck2 Config Type - (RW, EEPROM)				0x07 / 7
0x2D	[1:0]	Buck2 Discharge	Set Buck2 output discharge resistance	00: Disabled 01: Slow 10: Medium 11: Fast	<11>

Register Pointer	Register Bit(s)	Bit(s)/Function Name	Description	Setting/Range	Default	
0x2E	Register Name - Buck3 Enable Type - (RW, EEPROM) 0x2E					
UNEL	[1]	Buck3 EN SLEEP	Enable Buck3 in SLEEP state	0: Disabled 1: Enabled	<0>	
0.25		lame - Buck3 ACTIV V, EEPROM)	E		0x0F / 15	
0x2F	[3:0]	Buck3 Vo ACTIVE	Set Buck3 output voltage in ACTIVE state	Buck3 = 1.8V + 0.1V x Buck3_Vo_ACTIVE[3:0]	<1111>	
0x30	•	lame - Buck3 SLEEI V, EEPROM)	>		0x0F / 15	
0x30	[3:0]	Buck3 Vo SLEEP	Set Buck3 output voltage in SLEEP state	Buck3 = 1.8V + 0.1V x Buck3_Vo_SLEEP[3:0]	<1111>	
	•	ame - Buck3 Power V, EEPROM)	On		0x08 / 8	
0x31	[6:0]	Buck3 Power On Delay	Delay timed from the beginning of power-on sequence	0: 0ms 1: 1ms 127: 127ms	<0001000>	
		lame - Buck3 Power V, EEPROM)	Off		0x00 / 0	
0x32	[6:0]	Buck3 Power Off Delay	Delay timed from the beginning of power-off sequence	0: 0ms 1: 1ms 127: 127ms	<0000000>	
		lame - Buck3 Config V, EEPROM)			0x1B / 27	
0x34	[1:0]	Buck3 Discharge	Set Buck3 output discharge resistance	00: Disabled 01: Slow 10: Medium 11: Fast	<11>	
0x35	Register N Type - (RV	0x05 / 5				
	[1]	Buck4 EN SLEEP	Enable Buck4 in SLEEP state	0: Disabled 1: Enabled	<0>	



Register Pointer	Register Bit(s)	Bit(s)/Function Name	Description	Setting/Range	Default
	Register Name - Buck4 ACTIVE Type - (RW, EEPROM)				
0x36	[3:0]	Buck4 Vo ACTIVE	Set Buck4 output voltage in ACTIVE state	Codes 0-8 decimal Vo= 0.8V + 0.05V x Buck4_Vo_ACTIVE[3:0] Codes 9-15 decimal Vo= 1.5, 1.6, 1.8, 1.85, 2.2, 2.5, 3.3	<0011>
		lame - Buck4 SLEEF V, EEPROM)	2		0x03 / 3
0x37	[3:0]	Buck4 Vo SLEEP	Set Buck4 output voltage in SLEEP state	Codes 0-8 decimal Vo= 0.8V + 0.05V x Buck4_Vo_SLEEP[3:0] Codes 9-15 decimal Vo= 1.5, 1.6, 1.8, 1.85, 2.2, 2.5, 3.3	<0011>
		ame - Buck4 Power V, EEPROM)	On		0x00 / 0
0x38	[6:0]	Buck4 Power On Delay	Delay timed from the beginning of power-on sequence	0: 0ms 1: 1ms 127: 127ms	<000000>
	Register Name - Buck4 Power Off Type - (RW, EEPROM)			0x14 / 20	
0x39	[6:0]	Buck4 Power Off Delay	Delay timed from the beginning of power-off sequence	0: 0ms 1: 1ms 127: 127ms	<0010100>



Register Pointer	Register Bit(s)	Bit(s)/Function Name	Description	Setting/Range	Default	
	Register Name - Buck4 Config Type - (RW, EEPROM)					
0x3B	[4:2]	Buck4 SW Freq	Set Buck4 switching frequency when in PWM operation	000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 101: 1.33MHz 110: 1.54MHz 111: 1.67MHz	<001>	
	[1:0]	Buck4 Discharge	Set Buck4 output discharge resistance	00: Disabled 01: Slow 10: Medium 11: Fast	<11>	
0x3C		lame - Buck5 Enable V, EEPROM)	3		0x05 / 5	
	[1]	Buck5 EN SLEEP	Enable Buck5 in SLEEP state	0: Disabled 1: Enabled	<0>	
		lame - Buck5 ACTIV V, EEPROM)	E		0x03 / 3	
0x3D	[2:0]	Buck5 Vo ACTIVE	Set Buck5 output voltage in ACTIVE state	000: 1.2V 001: 1.5V 010: 1.6V 011: 1.8V 100: 1.85V 101: 2.2V 110: 2.5V 111: 3.3V	<011>	
	•	lame - Buck5 SLEEF V, EEPROM)	2		0x03 / 3	
0x3E	[2:0]	Buck5 Vo SLEEP	Set Buck5 output voltage in SLEEP state	000: 1.2V 001: 1.5V 010: 1.6V 011: 1.8V 100: 1.85V 101: 2.2V 110: 2.5V 111: 3.3V	<011>	
		ame - Buck5 Power V, EEPROM)	On		0x06 / 6	
0x3F	[6:0]	Buck5 Power On Delay	Delay timed from the beginning of power-on sequence	0: 0ms 1: 1ms 127: 127ms	<0000110>	



Register Pointer	Register Bit(s)	Bit(s)/Function Name	Description	Setting/Range	Default
		lame - Buck5 Power V, EEPROM)	Off		0x05 / 5
0x40	[6:0]	Buck5 Power Off Delay	Delay timed from the beginning of power-off sequence	0: 0ms 1: 1ms 127: 127ms	<0000101>
		lame - Buck5 Config V, EEPROM)		·	0x1B / 27
0x42	[1:0]	Buck5 Discharge	Set Buck5 output discharge resistance	00: Disabled 01: Slow 10: Medium 11: Fast	<11>
	-	lame - Buck6 Enable V, EEPROM)	2		0x04 / 4
0x43	[1]	Buck6 EN SLEEP	Enable Buck6 in SLEEP state	0: Disabled 1: Enabled	<0>
	[0]	Buck6 EN ACTIVE	Enable Buck6 in ACTIVE state	0: Disabled 1: Enabled	<0>
	Register Name - Buck6 ACTIVE Type - (RW, EEPROM)				
0x44	[7]	Link Buck6 to Buck2	Link the sequencing of Buck 6 to Buck 2	0: Buck 6 and Buck 2 soft-start independently 1: Buck 6 and Buck 2 soft-start together	<0>
	[6]	VTTREF EN	When VTTREF EN is set to '1', buck6 (VTT) = VREFOUT	0: Disabled 1: Enabled	<0>
	[5:4]	Buck6 Mode ACTIVE	Set Buck6 operation mode in ACTIVE state	00: Auto PFM/PWM mode 01: Forced PWM mode 1x: Reserved	<00>
		lame - LDO1 ACTIV V, EEPROM)	E		0x64 / 100
0x4A	[5:3]	LDO1 Vo 1 ACTIVE	Set LDO1 output voltage in ACTIVE state when LDO_SEL1 = HIGH	000: 0.8V 001: 0.9V 010: 1.2V 011: 1.5V 100: 1.8V 101: 2.5V 110: 3V 111: 3.3V	<100>
0x4B	0x4B				0x04 / 4
	[3]	LDO1 EN SLEEP	Enable LDO1 in SLEEP state	0: Disabled 1: Enabled	<0>

Register Pointer	Register Bit(s)	Bit(s)/Function Name	Description	Setting/Range	Default
		lame - LDO1 Power V, EEPROM)	On		0x04 / 4
0x4C	[6:0]	LDO1 Power On Delay	Delay timed from the beginning of power-on sequence	0: 0ms 1: 1ms 127: 127ms	<0000100>
		lame - LDO1 Power V, EEPROM)	Off		0x0A / 10
0x4D	[6:0]	LDO1 Power Off Delay	Delay timed from the beginning of power-off sequence	0: 0ms 1: 1ms 127: 127ms	<0001010>
		lame - LDO2 ACTIV V, EEPROM)	E		0x7F / 127
0x4F	[2:0]	LDO2 Vo 0 ACTIVE	Set LDO2 output voltage in ACTIVE state when LDO_SEL2 = LOW	000: 0.8V 001: 0.9V 010: 1.2V 011: 1.5V 100: 1.8V 101: 2.5V 110: 3V 111: 3.3V	<111>
		lame - LDO2 SLEEF V, EEPROM)			0x07 / 7
	[3]	LDO2 EN SLEEP	Enable LDO2 in SLEEP state	0: Disabled 1: Enabled	<0>
0x50	[2:0]	LDO2 Vo SLEEP	Set LDO2 output voltage in SLEEP state (LDO_SEL2 pin is ignored)	000: 0.8V 001: 0.9V 010: 1.2V 011: 1.5V 100: 1.8V 101: 2.5V 110: 3V 111: 3.3V	<111>
	Register N Type - (RV	0x08 / 8			
0x51	[6:0]	LDO2 Power On Delay	Delay timed from the beginning of power-on sequence	0: 0ms 1: 1ms 127: 127ms	<0001000>

Register Pointer	Register Bit(s)	Bit(s)/Function Name	Description	Setting/Range	Default
	Register N Type - (RV		0xE4 / 228		
0x54	[5:3]	LDO3 Vo SLEEP	Set LDO3 output voltage in SLEEP state	000: 0.8V 001: 0.9V 010: 1.2V 011: 1.5V 100: 1.8V 101: 2.5V 110: 3V 111: 3.3V	<100>
	[2:0]	LDO3 Vo ACTIVE	Set LDO3 output voltage in ACTIVE state	000: 0.8V 001: 0.9V 010: 1.2V 011: 1.5V 100: 1.8V 101: 2.5V 110: 3V 111: 3.3V	<100>
	Register Name - LDO3 Power On Type - (RW, EEPROM)				
0x55	[6:0]	LDO3 Power On Delay	Delay timed from the beginning of power-on sequence	0: 0ms 1: 1ms 127: 127ms	<0000100>
		lame - LDO3 Power V, EEPROM)	Off		0x0A / 10
0x56	[6:0]	LDO3 Power Off Delay	Delay timed from the beginning of power-off sequence	0: 0ms 1: 1ms 127: 127ms	<0001010>
	-	lame - LDOs Config V, EEPROM)			0x3F / 63
	[5:4]	LDO3 Discharge	Set LDO3 output discharge resistance	00: Disabled 01: Slow 10: Medium 11: Fast	<11>
0x58	[3:2]	LDO2 Discharge	Set LDO2 output discharge resistance	00: Disabled 01: Slow 10: Medium 11: Fast	<11>
	[1:0]	LDO1 Discharge	Set LDO1 output discharge resistance	00: Disabled 01: Slow 10: Medium 11: Fast	<11>



Register Pointer	Register Bit(s)	Bit(s)/Function Name	Description	Setting/Range	Default	
	Register Name - MPIO0 Power On Type - (RW, EEPROM)					
0x72	[6:0]	MPIO0 Power On Delay	Delay timed from the beginning of power-on sequence. The alternative function of bits[3:0] is to select which regulator is used for the PGood when MPIO0 is configured as PGood output. Refer to the settings for details	Bits[6:0] decodes: 0: 0ms 1: 1ms 127: 127ms Alternative decodes of bits[3:0]: 0000: Buck1 0001: Buck2 0010: Buck3 0011: Buck4 0100: Buck5 0101: Buck6 0110: LDO1 0111: LDO2 1000: LDO3 1001: VTTREF 1010: AND of all regulators PGood	<0011110>	
		lame - MPIO1 Powe V, EEPROM)	or On		0x1E / 30	
0x74	[6:0]	MPIO1 Power On Delay	Delay timed from the beginning of power-on sequence. The alternative function of bits[3:0] is to select which regulator is used for the PGood when MPIO1 is configured as PGood output. Refer to the settings for details	Bits[6:0] decodes: 0: 0ms 1: 1ms 127: 127ms Alternative decodes of bits[3:0]: 0000: Buck1 0001: Buck2 0010: Buck3 0011: Buck4 0100: Buck5 0101: Buck6 0110: LDO1 0111: LDO2 1000: LDO3 1001: VTTREF 1010: AND of all regulators PGood	<0011110>	



Register Pointer	Register Bit(s)	Bit(s)/Function Name	Description	Setting/Range	Default
		lame - MPIO2 Powe V, EEPROM)	er On		0x02 / 2
0x76	[6:0]	MPIO2 Power On Delay	Delay timed from the beginning of power-on sequence. The alternative function of bits[3:0] is to select which regulator is used for the PGood when MPIO2 is configured as PGood output. Refer to the settings for details	Bits[6:0] decodes: 0: 0ms 1: 1ms 127: 127ms Alternative decodes of bits[3:0]: 0000: Buck1 0001: Buck2 0010: Buck3 0011: Buck4 0100: Buck5 0101: Buck6 0110: LDO1 0111: LDO2 1000: LDO3 1001: VTTREF 1010: AND of all regulators PGood	<0000010>
		lame - MPIO4 Powe V, EEPROM)	n On		0x09 / 9
0x7A	[6:0]	MPIO4 Power On Delay	Delay timed from the beginning of power-on sequence. The alternative function of bits[3:0] is to select which regulator is used for the PGood when MPIO4 is configured as PGood output. Refer to the settings for details	Bits[6:0] decodes: 0: 0ms 1: 1ms 127: 127ms Alternative decodes of bits[3:0]: 0000: Buck1 0001: Buck2 0010: Buck3 0011: Buck4 0100: Buck5 0101: Buck6 0110: LDO1 0111: LDO2 1000: LDO3 1001: VTTREF 1010: AND of all regulators PGood	<0001001>
	-	lame - MPIO2 Confi V, EEPROM)	g		0x3C / 60
0x8C	[4:3]	МРІО2 Туре	If bits[4:3] = 00, then the respective MPIOx pin is high impedance, and the device will still use the MPIOx power on/off delays if bits[2:0] are not set to 3'b000	00: Disabled (high impedance) 01: Open drain NMOS output 10: Open drain PMOS output 11: Full CMOS output	<11>



Register Pointer	Register Bit(s)	Bit(s)/Function Name	Description	Setting/Range	Default	
	Register Name - MPIO3 Config Type - (RW, EEPROM)					
	[5]	MPIO3 Invert	Configure the polarity of MPIO3	0: Active low 1: Active high	<0>	
0x8D	[2:0]	MPIO3 Function	Bits[2:0] = 000 disables the function of the respective MPIOx pin, and the device will ignore the MPIOx power on/off delay settings.	000: Disabled 001: SLEEP# 010: External VR PGood input 011: Input to I2C register 100: PGood output 101: Reset output 110: External VR EN output 111: Output from I2C output	<001>	
	Register Name - MPIO4 Config Type - (RW, EEPROM)				0x2E / 46	
	[5]	MPIO4 Invert	Configure the polarity of MPIO4	0: Active low 1: Active high	<1>	
0x8E	[4:3]	MPIO4 Type	If Bits[4:3] = 00, then the respective MPIOx pin is high impedance, and the device will still use the MPIOx power on/off delays if bits[2:0] are not set to 3'b000	00: Disabled (high impedance) 01: Open drain NMOS output 10: Open drain PMOS output 11: Full CMOS output	<01>	
	[2:0]MPIO4 FunctionBits[2:0] = 000 disables the function of the respective MPIOx pin, and the device will ignore the MPIOx power on/off delay settings.000: Disabled 001: WDT_RST# 010: External VR F 011: Input to I2C re 100: PGood output 101: Reset output 110: External VR F	001: WDT_RST# 010: External VR PGood input 011: Input to I2C register 100: PGood output	<110>			
		lame - EEPROM ID V, EEPROM)	2	·	0x03 / 3	
0xB1	[7:0]	NVM Ver 2	The EEPROM data is considered valid when EEPROM ID 1 or EEPROM ID 2 is programmed to non-zero value		<0000011>	

14.3 RAA215300A2GNP#HA5

14.3.1 Register Map Detail

Summary of differences:

- Buck1 VOUT in {ACTIVE} and {SLEEP}: 1.03V
- Buck1 Power-on Delay: 7ms. Power-off Delay: 50ms
- Buck1 Switching Frequency: 0.833MHz
- Buck2 VOUT in {ACTIVE} and {SLEEP}: 1.5V
- Buck2 Power-on Delay: 7ms. Power-off Delay: 50ms
- LDO3 VOUT in {ACTIVE} and {SLEEP}: 1.5V



- · LDO3 Power-on Delay: 10ms. Power-off Delay: 0ms
- PWRON Configuration: On/Off Switch
- MPIO1 Function: Disabled
- MPIO2 Function: Disabled
- EEPROM ID 2: 0x05

Register Pointer	Register Bit(s)	Bit(s)/Function Name	Description	Setting/Range	Default	
		lame - Buck1 ACTIV V, EEPROM)	E		0x0F / 15	
0x21	[3:0]	Buck1 Vo ACTIVE	Set Buck1 output voltage in ACTIVE state	4'b0000 - 4'b1110: Buck1 = 0.8V + 0.05V x Buck1_Vo_ACTIVE[3:0] 4'b1111: 1.03V	<1111>	
	Register Name - Buck1 SLEEP Type - (RW, EEPROM)					
0x22	[3:0]	Buck1 Vo SLEEP	Set Buck1 output voltage in SLEEP state	4'b0000 - 4'b1110: Buck1 = 0.8V + 0.05V x Buck1_Vo_SLEEP[3:0] 4'b1111: 1.03V	<1111>	
		lame - Buck1 Power V, EEPROM)	On		0x07 / 7	
0x23	[6:0]	Buck1 Power On Delay	Delay timed from the beginning of power-on sequence	0: 0ms 1: 1ms 127: 127ms	<0000111>	
	-	lame - Buck1 Power V, EEPROM)	Off		0x32 / 50	
0x24	[6:0]	Buck1 Power Off Delay	Delay timed from the beginning of power-off sequence	0: 0ms 1: 1ms 127: 127ms	<0110010>	
		lame - Buck1 Config V, EEPROM)			0x0A / 10	
0x26	[4:2]	Buck1 SW Freq	Set Buck1 switching frequency when in PWM operation	000: 0.667MHz 001: 0.769MHz 010: 0.833MHz 011: 1MHz 100: 1.11MHz 101: 1.33MHz 110: 1.54MHz 111: 1.67MHz	<010>	
0x28	-	Register Name - Buck2 ACTIVE Type - (RW, EEPROM)				
	[3:0]	Buck2 Vo ACTIVE	Set Buck2 output voltage in ACTIVE state	Buck2 = 1.1V + 0.05V x Buck2_Vo_ACTIVE[3:0]	<1000>	



Register Pointer	Register Bit(s)	Bit(s)/Function Name	Description	Setting/Range	Default
0x29		lame - Buck2 SLEEI V, EEPROM)	2		0x08 / 8
	[3:0]	Buck2 Vo SLEEP	Set Buck2 output voltage in SLEEP state	Buck2 = 1.1V + 0.05V x Buck2_Vo_SLEEP[3:0]	<1000>
		lame - Buck2 Power V, EEPROM)	On		0x07 / 7
0x2A	[6:0]	Buck2 Power On Delay	Delay timed from the beginning of power-on sequence	0: 0ms 1: 1ms 127: 127ms	<0000111>
		lame - Buck2 Power V, EEPROM)	Off		0x32 / 50
0x2B	[6:0]	Buck2 Power Off Delay	Delay timed from the beginning of power-off sequence	0: 0ms 1: 1ms 127: 127ms	<0110010>
		lame - LDO3 ACTIV V, EEPROM)	E SLEEP		0xDB / 219
0x54	[5:3]	LDO3 Vo SLEEP	Set LDO3 output voltage in SLEEP state	000: 0.8V 001: 0.9V 010: 1.2V 011: 1.5V 100: 1.8V 101: 2.5V 110: 3V 111: 3.3V	<011>
	[2:0]	LDO3 Vo ACTIVE	Set LDO3 output voltage in ACTIVE state	000: 0.8V 001: 0.9V 010: 1.2V 011: 1.5V 100: 1.8V 101: 2.5V 110: 3V 111: 3.3V	<011>
	Register N Type - (RV	0x0A / 10			
0x55	[6:0]	LDO3 Power On Delay	Delay timed from the beginning of power-on sequence	0: 0ms 1: 1ms 127: 127ms	<0001010>

Register Pointer	Register Bit(s)	Bit(s)/Function Name	Description	Setting/Range	Default	
0x56	Register Name - LDO3 Power Off Type - (RW, EEPROM)					
	[6:0]	LDO3 Power Off Delay	Delay timed from the beginning of power-off sequence	0: 0ms 1: 1ms 127: 127ms	<000000>	
0x6F	Register Name - Config 1 Type - (RW, EEPROM)					
0,01	[0]	PWRON Config	Set the PWRON configuration	0: On/off switch 1: Long push button	<0>	
0x8B	Register Name - MPIO1 Config Type - (RW, EEPROM)					
	[2:0]	MPIO1 Function	Bits[2:0] = 000 disables the function of the respective MPIOx pin, and the device will ignore the MPIOx power on/off delay settings.	000: Disabled 001: Disabled 010: External VR PGood input 011: Input to I2C register 100: PGood output 101: Reset output 110: External VR EN output 111: Output from I2C output	<000>	
0x8C	Register Name - MPIO2 Config Type - (RW, EEPROM)					
	[2:0]	MPIO2 Function	Bits[2:0] = 000 disables the function of the respective MPIOx pin, and the device will ignore the MPIOx power on/off delay settings.	000: Disabled 001: 32K_CLK 010: External VR PGood input 011: Input to I2C register 100: PGood output 101: Reset output 110: External VR EN output 111: Output from I2C output	<000>	
0xB1	Register Name - EEPROM ID 2 Type - (RW, EEPROM)					
	[7:0]	NVM Ver 2	The EEPROM data is considered valid when EEPROM ID 1 or EEPROM ID 2 is programmed to non-zero value			



15. Ordering Information

Part Number ^{[1][2]}	Part Marking	Package Description (RoHS Compliant)	Pkg. Dwg. #	Carrier Type ^[3]	Summary of Part Differences ^[4]	Supported MPUs
RAA215300A2GNP#HA0	215300B00 56 Lead,		Deel 4k	PWRON Config: Long Push Button	RZ/G2L, RZ/G2LC, RZ/V2L	
RAA215300A2GNP#HA1	215300B01	8.8mm QFN	L56.8x8I	Reel, 1k	PWRON Config: On/Off Switch	RZ/G2L, RZ/G2LC, RZ/V2L
RAA215300A2GNP#HA3	215300B03				 Output voltages of all regulators are different from the base part Power sequence is different from the base part MPIO3 Config: SLEEP# MPIO4 Config: External VR EN Output EEPROM ID 2: 0x03 	RZ/G3S with LPDDR4
RAA215300A2GNP#HA5	215300B05				 Output voltages and power sequence of Buck1/Buck2/LDO3 are different from the base part MPIO1/2 Config: Disabled PWRON Config: On/Off Switch EEPROM ID 2: 0x05 	RZ/G1E
RTKA215300DE0000BU	215300DE0000BU Evaluation board for RAA215300A2GNP#HA0		1			
RTKA215300E0000BU Socket board						

 These Pb-free plastic packaged products employ special Pb-free material sets, molding compounds/die attach materials, and 100% matte tin plate plus anneal (e3 termination finish, which is RoHS compliant and compatible with both SnPb and Pb-free soldering operations). Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J-STD-020.

2. For Moisture Sensitivity Level (MSL), see the RAA215300 product page. For more information about MSL, see TB363.

3. See TB347 for details about reel specifications.

4. For a full detailed list of differences between parts, see Part Number Differences.



16. Revision History

Revision	Date	Description
1.04	Apr 19, 2024	Added another line to the Buck4 Output Voltage DC Accuracy specification. Updated Table 11. Updated the Register Map for 0x04, 0x36, 0x37 registers. Updated the Clock and Calendar Registers [Address 0x00 to 0x06] section. Updated the Clock section. Updated Supercapacitor Backup Time section.
1.03	Jul 26, 2023	Added typical application diagram for RAA215300A2GNP#HA5. Updated Figures 11 and 13. Updated Alarm section. Updated Alarm Registers Addresses [0x0C to 0x11] section.
1.02	May 19, 2023	Added new part numbers RAA215300A2GNP#HA3 and RAA215300A2GNP#HA5 in the Part Number Differences section and the ordering information table. Updated Ordering Information table. Updated Chip Enable section.
1.01	Mar 20, 2023	Added description for VREFIN pin in the Pin Descriptions table and the Device Specific Layout Guidelines table. Updated Figures 9, 10, 11, 12 in section I2C Write Operation and I2C Read Operation. Added description in section {RESET}. Added description in section Output Discharge. Added description in section Unused Buck. Added description in section Unused LDOX. Updated VTTREF section. Added a figure and updated the description in section VREFIN UVLO. Updated External VR PGOOD Input section. Minor updates to the register map details table.
1.00	Sep 28, 2022	Initial release



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